



## TMS320F28002x Microcontrollers

### 1 Device Overview

#### 1.1 Features

- TMS320C28x 32-bit DSP core at 100 MHz
  - IEEE 754 Floating-Point Unit (FPU)
    - Support for Fast Integer Division (FINTDIV)
  - Trigonometric Math Unit (TMU)
    - Support for Nonlinear Proportional Integral Derivative (NLPID) control
  - CRC Engine and Instructions (VCRC)
  - Ten hardware breakpoints (with ERAD)
- On-chip memory
  - 128KB (64KW) of flash (ECC-protected)
  - 24KB (12KW) of RAM (ECC or parity-protected)
  - Dual-zone security
- Clock and system control
  - Two internal zero-pin 10-MHz oscillators
  - On-chip crystal oscillator or external clock input
  - Windowed watchdog timer module
  - Missing clock detection circuitry
  - Dual-clock Comparator (DCC)
- Single 3.3-V supply
  - Internal VREG generation
  - Brownout reset (BOR) circuit
- System peripherals
  - 6-channel Direct Memory Access (DMA) controller
  - 39 individually programmable multiplexed General-Purpose Input/Output (GPIO) pins
  - 16 digital inputs on analog pins
  - Enhanced Peripheral Interrupt Expansion (ePIE)
  - Multiple low-power mode (LPM) support
  - Embedded Real-time Analysis and Diagnostic (ERAD)
  - Unique Identification (UID) number
- Communications peripherals
  - One Power-Management Bus (PMBus) interface
  - Two Inter-integrated Circuit (I2C) interfaces
  - One Controller Area Network (CAN) bus port
  - Two Serial Peripheral Interface (SPI) ports
  - One Serial Communication Interface (SCI)
  - Two Local Interconnect Network (LIN) interfaces
  - Fast Serial Interface (FSI) with one transmitter and one receiver (up to 200Mbps)
- Analog system
  - Two 3.45-MSPS, 12-bit Analog-to-Digital Converters (ADCs)
    - Up to 16 external channels
  - Four integrated Post-Processing Blocks (PPB) per ADC
  - Four windowed comparators (CMPSS) with 12-bit reference Digital-to-Analog Converters (DACs)
    - Digital glitch filters
- Enhanced control peripherals
  - 14 ePWM channels with eight channels that have high-resolution capability (150-ps resolution)
    - Integrated dead-band support
    - Integrated hardware trip zones (TZs)
  - Three Enhanced Capture (eCAP) modules
    - High-resolution Capture (HRCAP) available on one of the three eCAP modules
  - Two Enhanced Quadrature Encoder Pulse (eQEP) modules with support for CW/CCW operation modes
- Configurable Logic Block (CLB)
  - Augments existing peripheral capability
  - Supports position manager solutions
- Host Interface Controller (HIC)
  - Access to internal memory from an external host
- Background CRC (BGCR)
  - One cycle CRC computation on 32 bits of data
- Diagnostic features
  - Memory Power On Self Test (MPOST)
  - Hardware Built-in Self Test (HWBIST)
- Package options:
  - 80-pin Low-profile Quad Flatpack (LQFP) [PN suffix]
  - 64-pin LQFP [PM suffix]
  - 48-pin LQFP [PT suffix]
- Temperature options:
  - S: –40°C to 125°C junction
  - Q: –40°C to 125°C free-air (AEC Q100 qualification for automotive applications)



## 1.2 Applications

- Air conditioner outdoor unit
- Door operator drive control
- Automated sorting equipment
- Textile machine
- AC charging (pile) station
- DC charging (pile) station
- EV charging station power module
- Wireless vehicle charging module
- Energy storage power conversion system (PCS)
- Central inverter
- Micro inverter
- Solar power optimizer
- String inverter
- DC/DC converter
- Inverter & motor control
- On-board (OBC) & wireless charger
- AC drive control module
- AC drive position feedback
- AC drive power stage module
- Linear motor power stage
- Servo drive position feedback
- Servo drive power stage module
- AC-input BLDC motor drive
- DC-input BLDC motor drive
- Industrial AC-DC
- Three phase UPS
- Merchant DC/DC
- Merchant network & server PSU
- Merchant telecom rectifiers

## 1.3 Description

C2000™ 32-bit microcontrollers are optimized for processing, sensing, and actuation to improve closed-loop performance in real-time control applications such as industrial motor drives; solar inverters and digital power; electrical vehicles and transportation; motor control; and sensing and signal processing.

The TMS320F28002x (F28002x) is a powerful 32-bit floating-point microcontroller unit (MCU) that lets designers incorporate crucial control peripherals, differentiated analog, and nonvolatile memory on a single device.

The real-time control subsystem is based on TI's 32-bit C28x DSP core, which provides 100 MHz of signal processing performance. The C28x CPU is further boosted by the new TMU extended instruction set, which enables fast execution of algorithms with trigonometric operations commonly found in transforms and torque loop calculations; and the VCRC extended instruction set, which reduces the latency for complex math operations commonly found in encoded applications.

The F28002x supports up to 128KB (64KW) of flash memory in one bank. Up to 24KB (12KW) of on-chip SRAM is also available in blocks of 4KB (2KW) for efficient system partitioning. Flash ECC, SRAM ECC/parity, and dual-zone security are also supported.

High-performance analog blocks are integrated on the F28002x MCU to further enable system consolidation. Two separate 12-bit ADCs provide precise and efficient management of multiple analog signals, which ultimately boosts system throughput. Four analog comparator modules provide continuous monitoring of input voltage levels for trip conditions.

The TMS320C2000™ devices contain industry-leading control peripherals with frequency-independent ePWM/HRPWM and eCAP allow for a best-in-class level of control to the system.

Connectivity is supported through various industry-standard communication ports (such as SPI, SCI, I2C, PMBus, LIN, and CAN) and offers multiple muxing options for optimal signal placement in a variety of applications. New to the C2000™ platform is Host Interface Controller (HIC), a high throughput interface that allows an external host to access resources of the TMS320F28002x. Additionally, in an industry first, the FSI enables high-speed, robust communication to complement the rich set of peripherals that are embedded in the device.

A specially enabled device variant, TMS320F28002xC, allows access to the Configurable Logic Block (CLB) for additional interfacing features and allows access to the secure ROM. See [Device Comparison](#) for more information.

The Embedded Real-Time Analysis and Diagnostic (ERAD) module enhances the debug and system analysis capabilities of the device by providing additional hardware breakpoints and counters for profiling.

To learn more about the C2000 MCUs, visit the C2000 Overview at [www.ti.com/c2000](http://www.ti.com/c2000).

**Device Information<sup>(1)</sup>**

| PART NUMBER      | PACKAGE   | BODY SIZE         |
|------------------|-----------|-------------------|
| TMS320F280025PN  | LQFP (80) | 12.0 mm × 12.0 mm |
| TMS320F280025CPN | LQFP (80) | 12.0 mm × 12.0 mm |
| TMS320F280023PN  | LQFP (80) | 12.0 mm × 12.0 mm |
| TMS320F280023CPN | LQFP (80) | 12.0 mm × 12.0 mm |
| TMS320F280025PM  | LQFP (64) | 10.0 mm × 10.0 mm |
| TMS320F280025CPM | LQFP (64) | 10.0 mm × 10.0 mm |
| TMS320F280024PM  | LQFP (64) | 10.0 mm × 10.0 mm |
| TMS320F280024CPM | LQFP (64) | 10.0 mm × 10.0 mm |
| TMS320F280023PM  | LQFP (64) | 10.0 mm × 10.0 mm |
| TMS320F280023CPM | LQFP (64) | 10.0 mm × 10.0 mm |
| TMS320F280022PM  | LQFP (64) | 10.0 mm × 10.0 mm |
| TMS320F280025PT  | LQFP (48) | 7.0 mm × 7.0 mm   |
| TMS320F280025CPT | LQFP (48) | 7.0 mm × 7.0 mm   |
| TMS320F280023PT  | LQFP (48) | 7.0 mm × 7.0 mm   |
| TMS320F280023CPT | LQFP (48) | 7.0 mm × 7.0 mm   |
| TMS320F280021PT  | LQFP (48) | 7.0 mm × 7.0 mm   |

(1) For more information on these devices, see [Mechanical](#), [Packaging](#), and [Orderable Information](#).

## 1.4 Functional Block Diagram

Figure 1-1 shows the CPU system and associated peripherals.

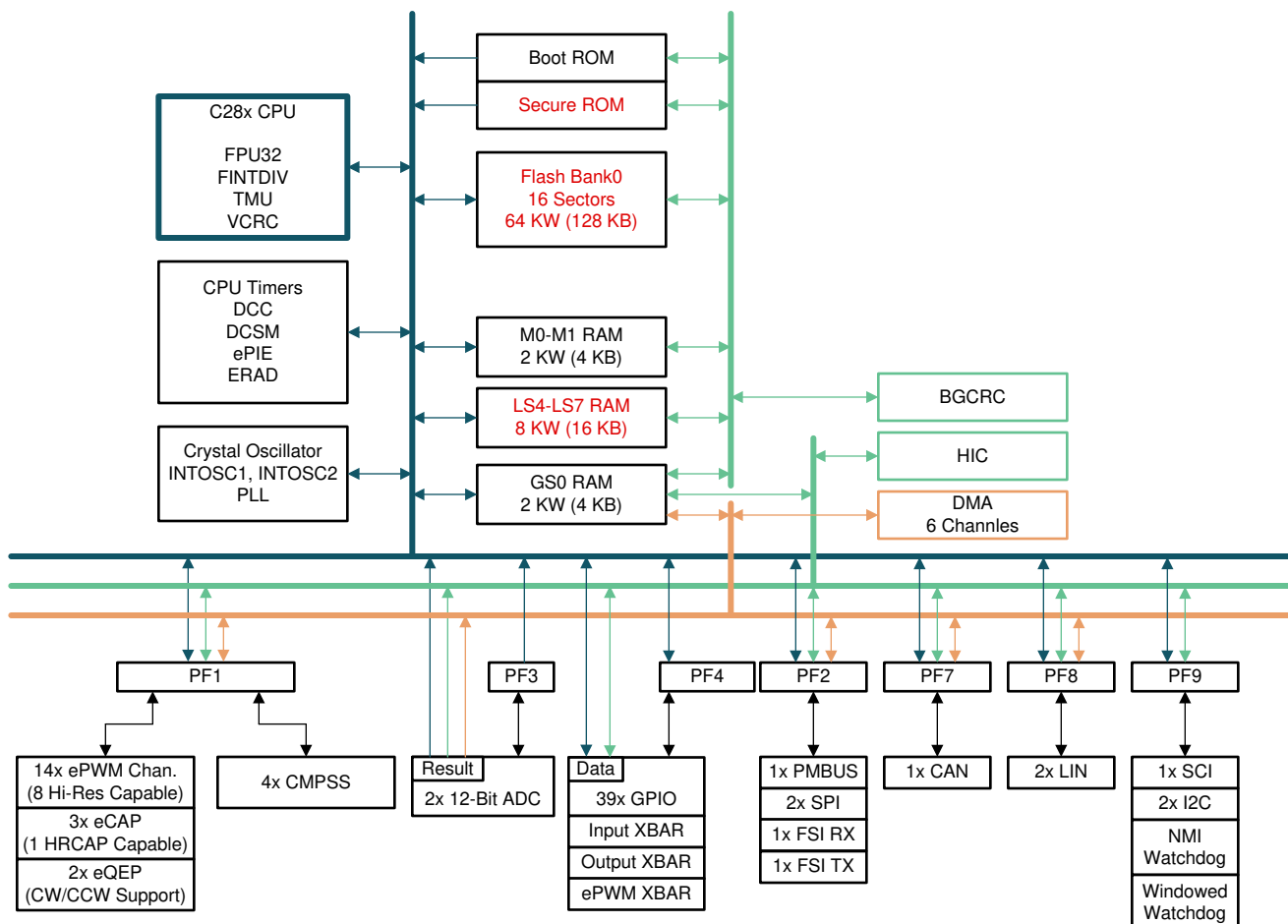


Figure 1-1. Functional Block Diagram

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## 2 Revision History

| DATE       | REVISION | NOTES           |
|------------|----------|-----------------|
| March 2020 | *        | Initial Release |

### 3 Device Comparison

Table 3-1 lists the features of the TMS320F28002x devices.

**Table 3-1. Device Comparison**

| FEATURE <sup>(1)</sup>                                 |                                     | F280025<br>F280025C                                                                                            | F280024<br>F280024C | F280023<br>F280023C | F280022 | F280021     |
|--------------------------------------------------------|-------------------------------------|----------------------------------------------------------------------------------------------------------------|---------------------|---------------------|---------|-------------|
| PROCESSOR AND ACCELERATORS                             |                                     |                                                                                                                |                     |                     |         |             |
| C28x                                                   | Frequency (MHz)                     | 100                                                                                                            |                     |                     |         |             |
|                                                        | FPU32                               | Yes (with new instructions for Fast Integer Division)                                                          |                     |                     |         |             |
|                                                        | VCRC                                | Yes                                                                                                            |                     |                     |         |             |
|                                                        | TMU – Type 1                        | Yes (with new instructions supporting NLPID)                                                                   |                     |                     |         |             |
|                                                        | Fast Integer Division               | Yes                                                                                                            |                     |                     |         |             |
| DMA – Type 0                                           |                                     | Yes                                                                                                            |                     |                     |         |             |
| MEMORY                                                 |                                     |                                                                                                                |                     |                     |         |             |
| Flash                                                  |                                     | 128KB (64KW)                                                                                                   |                     | 64KB (32KW)         |         | 32KB (16KW) |
| RAM                                                    | Dedicated and Local Shared RAM      | 20KB (10KW)                                                                                                    |                     |                     |         |             |
|                                                        | Global Shared RAM                   | 4KB (2KW)                                                                                                      |                     |                     |         |             |
|                                                        | TOTAL RAM                           | 24KB (12KW)                                                                                                    |                     |                     |         |             |
| Code security for on-chip flash and RAM                |                                     | Yes                                                                                                            |                     |                     |         |             |
| SYSTEM                                                 |                                     |                                                                                                                |                     |                     |         |             |
| Configurable Logic Block (CLB) <sup>(2)</sup>          |                                     | F280025C                                                                                                       | F280024C            | F280023C            | -       |             |
| 32-bit CPU timers                                      |                                     | 3                                                                                                              |                     |                     |         |             |
| Watchdog timer                                         |                                     | 1                                                                                                              |                     |                     |         |             |
| Nonmaskable Interrupt Watchdog (NMIWD) timers          |                                     | 1                                                                                                              |                     |                     |         |             |
| Crystal oscillator/External clock input                |                                     | 1                                                                                                              |                     |                     |         |             |
| 0-pin internal oscillator                              |                                     | 2                                                                                                              |                     |                     |         |             |
| GPIO pins                                              | 80-pin PN                           | 39                                                                                                             | –                   | 39                  | –       | 39          |
|                                                        | 64-pin PM                           | 26                                                                                                             | 24                  | 26                  | 24      | 26          |
|                                                        | 48-pin PT                           | 14                                                                                                             | –                   | 14                  | –       | 14          |
|                                                        | Additional GPIO                     | 4 (When cJTAG is used, TDI and TDO can be GPIO;<br>When INTOSC is used as clock source, X1 and X2 can be GPIO) |                     |                     |         |             |
| AIO inputs                                             | 80-pin PN                           | 16                                                                                                             |                     |                     |         |             |
|                                                        | 64-pin PM                           | 16                                                                                                             |                     |                     |         |             |
|                                                        | 48-pin PT                           | 14                                                                                                             |                     |                     |         |             |
| External interrupts                                    |                                     | 5                                                                                                              |                     |                     |         |             |
| ANALOG PERIPHERALS                                     |                                     |                                                                                                                |                     |                     |         |             |
| ADC 12-bit                                             | Number of ADCs                      | 2                                                                                                              |                     |                     |         |             |
|                                                        | MSPS                                | 3.45                                                                                                           |                     |                     |         |             |
|                                                        | Conversion Time (ns) <sup>(3)</sup> | 290                                                                                                            |                     |                     |         |             |
| ADC channels (single-ended)                            | 80-pin PN                           | 16                                                                                                             |                     |                     |         |             |
|                                                        | 64-pin PM                           | 16                                                                                                             |                     |                     |         |             |
|                                                        | 48-pin PT                           | 14                                                                                                             |                     |                     |         |             |
| Temperature sensor                                     |                                     | 1                                                                                                              |                     |                     |         |             |
| CMPSS (each has two comparators and two internal DACs) |                                     | 4                                                                                                              |                     |                     |         |             |

(1) A type change represents a major functional feature difference in a peripheral module. Within a peripheral type, there may be minor differences between devices that do not affect the basic functionality of the module.

(2) C devices include additional Motor Control libraries in ROM. Contact TI for more information.

(3) Time between start of sample-and-hold window to start of sample-and-hold window of the next conversion.

**Table 3-1. Device Comparison (continued)**

| FEATURE <sup>(1)</sup>                             |           | F280025<br>F280025C          | F280024<br>F280024C | F280023<br>F280023C | F280022 | F280021 |
|----------------------------------------------------|-----------|------------------------------|---------------------|---------------------|---------|---------|
| CONTROL PERIPHERALS <sup>(4)</sup>                 |           |                              |                     |                     |         |         |
| eCAP/HRCAP modules – Type 2                        |           | 3 (1 with HRCAP capability)  |                     |                     |         |         |
| ePWM/HRPWM channels – Type 4                       |           | 14 (8 with HRPWM capability) |                     |                     |         |         |
| eQEP modules – Type 2                              |           | 2                            |                     |                     |         |         |
| COMMUNICATION PERIPHERALS <sup>(4)</sup>           |           |                              |                     |                     |         |         |
| CAN – Type 0                                       |           | 1                            |                     |                     |         |         |
| I2C – Type 1                                       |           | 2                            |                     |                     |         |         |
| SCI – Type 0                                       |           | 1                            |                     |                     |         |         |
| SPI – Type 2                                       |           | 2                            |                     |                     |         |         |
| LIN – Type 1                                       |           | 2                            |                     |                     |         |         |
| PMBus – Type 0                                     |           | 1                            |                     |                     |         |         |
| FSI – Type 1                                       |           | 1 (1 RX and 1 TX)            |                     |                     |         |         |
| PACKAGE, TEMPERATURE, AND QUALIFICATION OPTIONS    |           |                              |                     |                     |         |         |
| S: –40°C to 125°C (T <sub>J</sub> )                | 80-pin PN | Yes                          | –                   | Yes                 | –       | –       |
|                                                    | 64-pin PM | Yes                          | –                   | Yes                 | –       | –       |
|                                                    | 48-pin PT | Yes                          | –                   | Yes                 | –       | Yes     |
| Q: –40°C to 125°C (T <sub>A</sub> ) <sup>(5)</sup> | 80-pin PN | Yes                          | –                   | Yes<br>(F280023)    | –       | –       |
|                                                    | 64-pin PM | –                            | Yes                 | –                   | Yes     | –       |
|                                                    | 48-pin PT | Yes                          | –                   | Yes<br>(F280023)    | –       | Yes     |

(4) For devices that are available in more than one package, the peripheral count listed in the smaller package is reduced because the smaller package has less device pins available. The number of peripherals internally present on the device is not reduced co

(5) The letter Q refers to AEC Q100 qualification for automotive applications.

### 3.1 Related Products

#### [TMS320F2803x Microcontrollers](#)

The F2803x series increases the pin-count and memory size options. The F2803x series also introduces the parallel control law accelerator (CLA) option.

#### [TMS320F2807x Microcontrollers](#)

The F2807x series offers the most performance, largest pin counts, flash memory sizes, and peripheral options. The F2807x series includes the latest generation of accelerators, ePWM peripherals, and analog technology.

#### [TMS320F28004x Microcontrollers](#)

The F28004x series is a reduced version of the F2807x series with the latest generational enhancements.

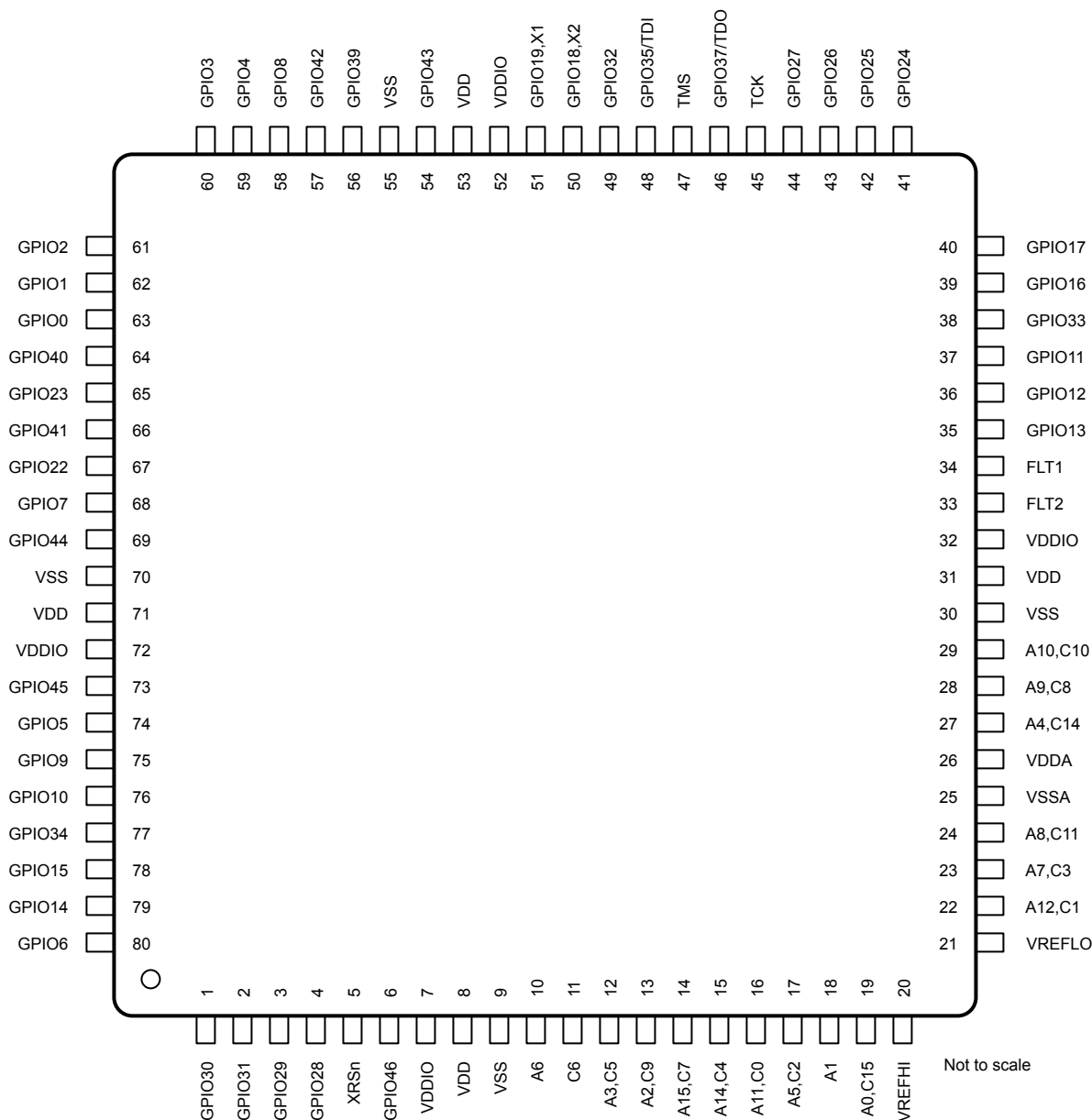
#### [TMS320F2838x Microcontrollers](#)

The F2838x series offers more performance, larger pin counts, flash memory sizes, peripheral and wide variety of connectivity options. The F2838x series includes the latest generation of accelerators, ePWM peripherals, and analog technology. Configurable logic block (CLB) versions are available.

## 4 Terminal Configuration and Functions

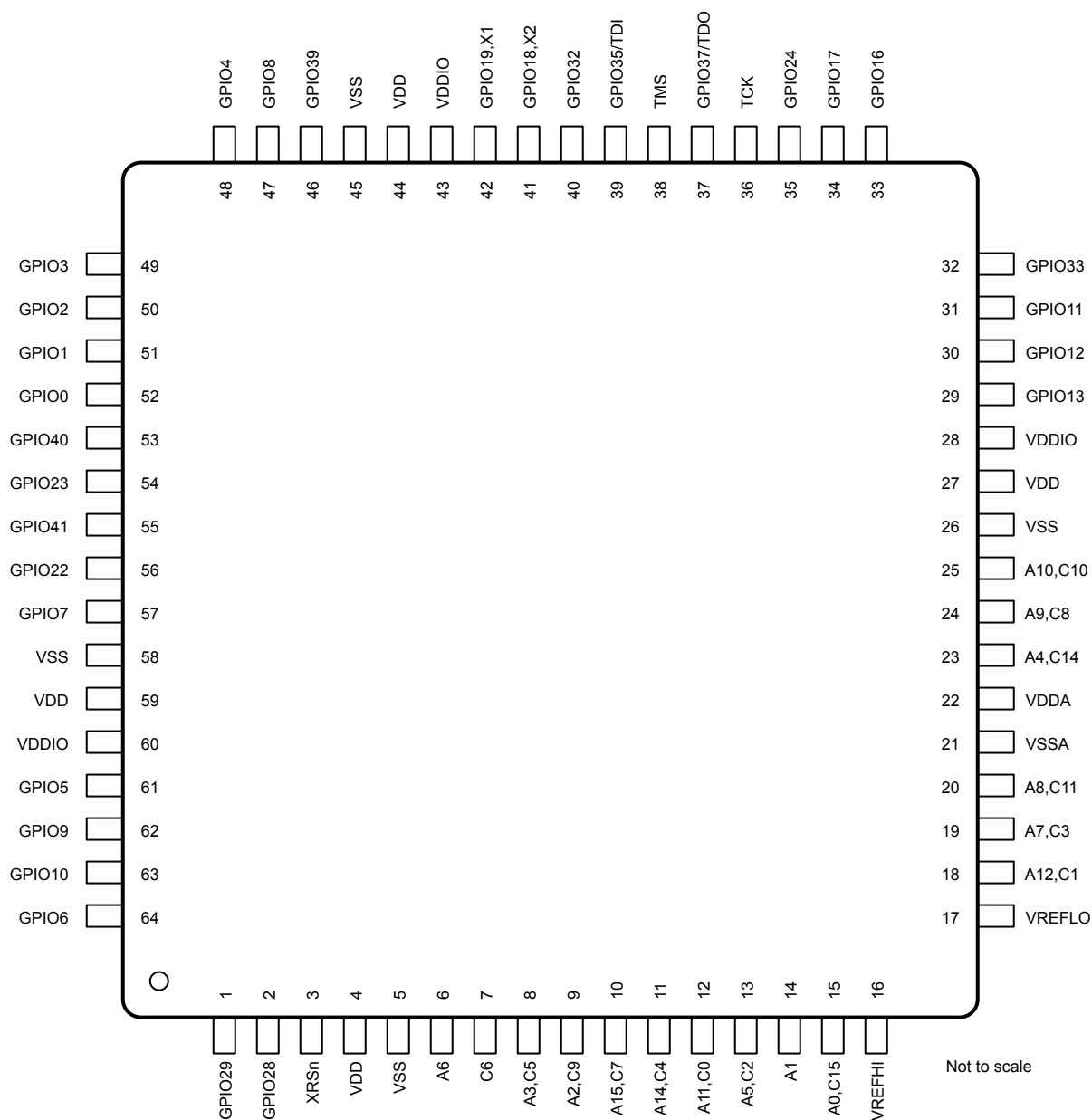
### 4.1 Pin Diagrams

Figure 4-1 shows the pin assignments on the 80-pin PN low-profile quad flatpack (Q temperature). Figure 4-2 shows the pin assignments on the 64-pin PM low-profile quad flatpack. Figure 4-3 shows the pin assignments on the 64-pin PM low-profile quad flatpack (Q temperature). Figure 4-4 shows the pin assignments on the 48-Pin PT low-profile quad flatpack.



A. Only the GPIO function is shown on GPIO terminals. See Section 4.2 for the complete, muxed signal name.

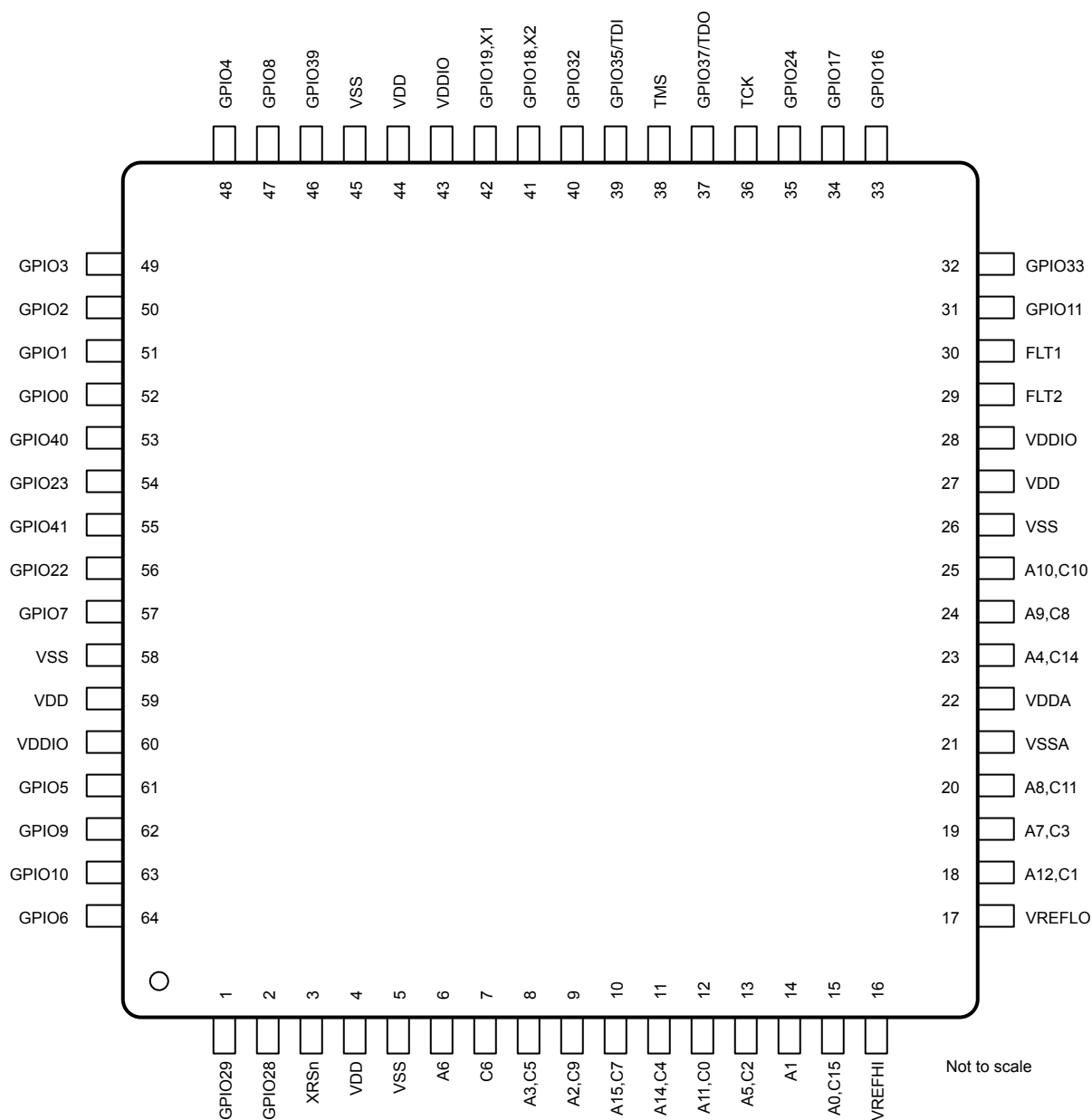
Figure 4-1. 80-Pin PN Low-Profile Quad Flatpack (Top View)



A. Only the GPIO function is shown on GPIO terminals. See [Section 4.2](#) for the complete, muxed signal name.

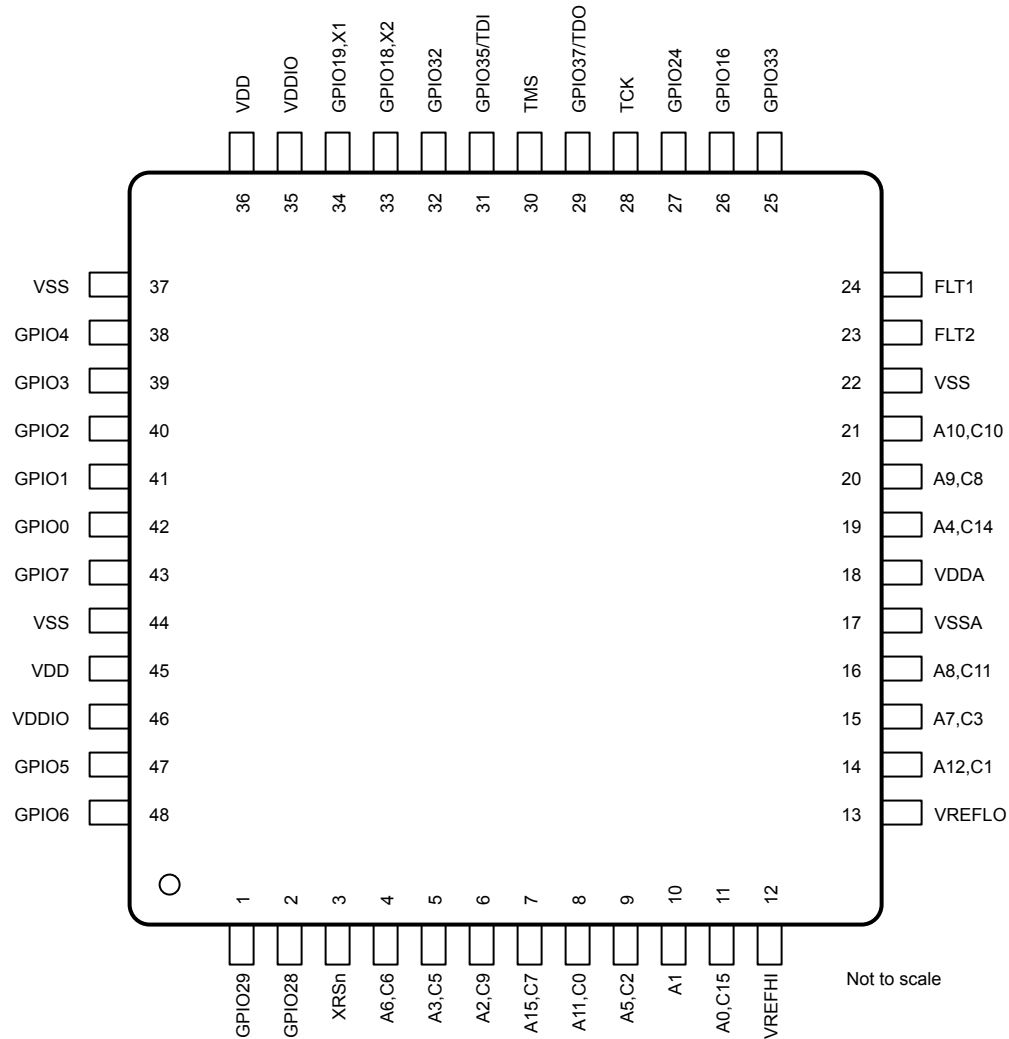
**Figure 4-2. 64-Pin PM Low-Profile Quad Flatpack (Top View)**

ADVANCE INFORMATION



A. Only the GPIO function is shown on GPIO terminals. See [Section 4.2](#) for the complete, muxed signal name.

**Figure 4-3. 64-Pin PM Low-Profile Quad Flatpack – Q-Temperature (Top View)**



A. Only the GPIO function is shown on GPIO terminals. See [Section 4.2](#) for the complete, muxed signal name.

**Figure 4-4. 48-Pin PT Low-Profile Quad Flatpack (Top View)**

## 4.2 Pin Attributes

**Table 4-1. Pin Attributes**

| SIGNAL NAME   | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                              |
|---------------|--------------|----------|--------|--------|--------|----------|------------------------------------------|
| <b>ANALOG</b> |              |          |        |        |        |          |                                          |
| A0            |              |          |        |        |        | I        | ADC-A Input 0                            |
| C15           |              |          |        |        |        | I        | ADC-C Input 15                           |
| CMP3_HP2      |              | 15       | 19     | 15     | 11     | I        | CMPSS-3 High Comparator Positive Input 2 |
| CMP3_LP2      |              |          |        |        |        | I        | CMPSS-3 Low Comparator Positive Input 2  |
| AIO231        |              |          |        |        |        | I        | Analog Pin Used For Digital Input 231    |
| A1            |              |          |        |        |        | I        | ADC-A Input 1                            |
| CMP1_HP4      |              | 14       | 18     | 14     | 10     | I        | CMPSS-1 High Comparator Positive Input 4 |
| CMP1_LP4      |              |          |        |        |        | I        | CMPSS-1 Low Comparator Positive Input 4  |
| AIO232        |              |          |        |        |        | I        | Analog Pin Used For Digital Input 232    |
| A10           |              |          |        |        |        | I        | ADC-A Input 10                           |
| C10           |              |          |        |        |        | I        | ADC-C Input 10                           |
| CMP2_HP3      |              |          |        |        |        | I        | CMPSS-2 High Comparator Positive Input 3 |
| CMP2_HN0      |              | 25       | 29     | 25     | 21     | I        | CMPSS-2 High Comparator Negative Input 0 |
| CMP2_LP3      |              |          |        |        |        | I        | CMPSS-2 Low Comparator Positive Input 3  |
| CMP2_LN0      |              |          |        |        |        | I        | CMPSS-2 Low Comparator Negative Input 0  |
| AIO230        |              |          |        |        |        | I        | Analog Pin Used For Digital Input 230    |
| A11           |              |          |        |        |        | I        | ADC-A Input 11                           |
| C0            |              |          |        |        |        | I        | ADC-C Input 0                            |
| CMP1_HP1      |              |          |        |        |        | I        | CMPSS-1 High Comparator Positive Input 1 |
| CMP1_HN1      |              | 12       | 16     | 12     | 8      | I        | CMPSS-1 High Comparator Negative Input 1 |
| CMP1_LP1      |              |          |        |        |        | I        | CMPSS-1 Low Comparator Positive Input 1  |
| CMP1_LN1      |              |          |        |        |        | I        | CMPSS-1 Low Comparator Negative Input 1  |
| AIO237        |              |          |        |        |        | I        | Analog Pin Used For Digital Input 237    |
| A12           |              |          |        |        |        | I        | ADC-A Input 12                           |
| C1            |              |          |        |        |        | I        | ADC-C Input 1                            |
| CMP2_HP1      |              |          |        |        |        | I        | CMPSS-2 High Comparator Positive Input 1 |
| CMP4_HP2      |              |          |        |        |        | I        | CMPSS-4 High Comparator Positive Input 2 |
| CMP2_HN1      |              | 18       | 22     | 18     | 14     | I        | CMPSS-2 High Comparator Negative Input 1 |
| CMP2_LP1      |              |          |        |        |        | I        | CMPSS-2 Low Comparator Positive Input 1  |
| CMP4_LP2      |              |          |        |        |        | I        | CMPSS-4 Low Comparator Positive Input 2  |
| CMP2_LN1      |              |          |        |        |        | I        | CMPSS-2 Low Comparator Negative Input 1  |
| AIO238        |              |          |        |        |        | I        | Analog Pin Used For Digital Input 238    |
| A14           |              |          |        |        |        | I        | ADC-A Input 14                           |
| C4            |              |          |        |        |        | I        | ADC-C Input 4                            |
| CMP3_HP4      |              | 11       | 15     | 11     |        | I        | CMPSS-3 High Comparator Positive Input 4 |
| CMP3_LP4      |              |          |        |        |        | I        | CMPSS-3 Low Comparator Positive Input 4  |
| AIO239        |              |          |        |        |        | I        | Analog Pin Used For Digital Input 239    |
| A15           |              |          |        |        |        | I        | ADC-A Input 15                           |
| C7            |              |          |        |        |        | I        | ADC-C Input 7                            |
| CMP1_HP3      |              |          |        |        |        | I        | CMPSS-1 High Comparator Positive Input 3 |
| CMP1_HN0      |              | 10       | 14     | 10     | 7      | I        | CMPSS-1 High Comparator Negative Input 0 |
| CMP1_LP3      |              |          |        |        |        | I        | CMPSS-1 Low Comparator Positive Input 3  |
| CMP1_LN0      |              |          |        |        |        | I        | CMPSS-1 Low Comparator Negative Input 0  |
| AIO233        |              |          |        |        |        | I        | Analog Pin Used For Digital Input 233    |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                                                                                                                                                                                                                                          |
|-------------|--------------|----------|--------|--------|--------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A2          |              |          |        |        |        | I        | ADC-A Input 2                                                                                                                                                                                                                                                                                        |
| C9          |              |          |        |        |        | I        | ADC-C Input 9                                                                                                                                                                                                                                                                                        |
| CMP1_HP0    |              | 9        | 13     | 9      | 6      | I        | CMPSS-1 High Comparator Positive Input 0                                                                                                                                                                                                                                                             |
| CMP1_LP0    |              |          |        |        |        | I        | CMPSS-1 Low Comparator Positive Input 0                                                                                                                                                                                                                                                              |
| AIO224      |              |          |        |        |        | I        | Analog Pin Used For Digital Input 224                                                                                                                                                                                                                                                                |
| A3          |              |          |        |        |        | I        | ADC-A Input 3                                                                                                                                                                                                                                                                                        |
| C5          |              |          |        |        |        | I        | ADC-C Input 5                                                                                                                                                                                                                                                                                        |
| VDAC        |              | 8        | 12     | 8      | 5      | I        | Optional external reference voltage for on-chip CMPSS DACs. There is an internal capacitor to VSSA on this pin whether used for ADC input or CMPSS DAC reference which cannot be disabled. If this pin is being used as a reference for the CMPSS DACs, place at least a 1-μF capacitor on this pin. |
| CMP3_HP3    |              |          |        |        |        | I        | CMPSS-3 High Comparator Positive Input 3                                                                                                                                                                                                                                                             |
| CMP3_HN0    |              |          |        |        |        | I        | CMPSS-3 High Comparator Negative Input 0                                                                                                                                                                                                                                                             |
| CMP3_LP3    |              |          |        |        |        | I        | CMPSS-3 Low Comparator Positive Input 3                                                                                                                                                                                                                                                              |
| CMP3_LN0    |              |          |        |        |        | I        | CMPSS-3 Low Comparator Negative Input 0                                                                                                                                                                                                                                                              |
| AIO242      |              |          |        |        |        | I        | Analog Pin Used For Digital Input 242                                                                                                                                                                                                                                                                |
| A4          |              |          |        |        |        | I        | ADC-A Input 4                                                                                                                                                                                                                                                                                        |
| C14         |              |          |        |        |        | I        | ADC-C Input 14                                                                                                                                                                                                                                                                                       |
| CMP2_HP0    |              |          |        |        |        | I        | CMPSS-2 High Comparator Positive Input 0                                                                                                                                                                                                                                                             |
| CMP4_HP3    |              |          |        |        |        | I        | CMPSS-4 High Comparator Positive Input 3                                                                                                                                                                                                                                                             |
| CMP4_HN0    |              | 23       | 27     | 23     | 19     | I        | CMPSS-4 High Comparator Negative Input 0                                                                                                                                                                                                                                                             |
| CMP2_LP0    |              |          |        |        |        | I        | CMPSS-2 Low Comparator Positive Input 0                                                                                                                                                                                                                                                              |
| CMP4_LP3    |              |          |        |        |        | I        | CMPSS-4 Low Comparator Positive Input 3                                                                                                                                                                                                                                                              |
| CMP4_LN0    |              |          |        |        |        | I        | CMPSS-4 Low Comparator Negative Input 0                                                                                                                                                                                                                                                              |
| AIO225      |              |          |        |        |        | I        | Analog Pin Used For Digital Input 225                                                                                                                                                                                                                                                                |
| A5          |              |          |        |        |        | I        | ADC-A Input 5                                                                                                                                                                                                                                                                                        |
| C2          |              |          |        |        |        | I        | ADC-C Input 2                                                                                                                                                                                                                                                                                        |
| CMP3_HP1    |              |          |        |        |        | I        | CMPSS-3 High Comparator Positive Input 1                                                                                                                                                                                                                                                             |
| CMP3_HN1    |              | 13       | 17     | 13     | 9      | I        | CMPSS-3 High Comparator Negative Input 1                                                                                                                                                                                                                                                             |
| CMP3_LP1    |              |          |        |        |        | I        | CMPSS-3 Low Comparator Positive Input 1                                                                                                                                                                                                                                                              |
| CMP3_LN1    |              |          |        |        |        | I        | CMPSS-3 Low Comparator Negative Input 1                                                                                                                                                                                                                                                              |
| AIO244      |              |          |        |        |        | I        | Analog Pin Used For Digital Input 244                                                                                                                                                                                                                                                                |
| A6          |              |          |        |        |        | I        | ADC-A Input 6                                                                                                                                                                                                                                                                                        |
| CMP1_HP2    |              | 6        | 10     | 6      | 4      | I        | CMPSS-1 High Comparator Positive Input 2                                                                                                                                                                                                                                                             |
| CMP1_LP2    |              |          |        |        |        | I        | CMPSS-1 Low Comparator Positive Input 2                                                                                                                                                                                                                                                              |
| AIO228      |              |          |        |        |        | I        | Analog Pin Used For Digital Input 228                                                                                                                                                                                                                                                                |
| A7          |              |          |        |        |        | I        | ADC-A Input 7                                                                                                                                                                                                                                                                                        |
| C3          |              |          |        |        |        | I        | ADC-C Input 3                                                                                                                                                                                                                                                                                        |
| CMP4_HN1    |              |          |        |        |        | I        | CMPSS-4 High Comparator Negative Input 1                                                                                                                                                                                                                                                             |
| CMP4_LP1    |              | 19       | 23     | 19     | 15     | I        | CMPSS-4 Low Comparator Positive Input 1                                                                                                                                                                                                                                                              |
| CMP4_LP1    |              |          |        |        |        | I        | CMPSS-4 Low Comparator Positive Input 1                                                                                                                                                                                                                                                              |
| CMP4_LN1    |              |          |        |        |        | I        | CMPSS-4 Low Comparator Negative Input 1                                                                                                                                                                                                                                                              |
| AIO245      |              |          |        |        |        | I        | Analog Pin Used For Digital Input 245                                                                                                                                                                                                                                                                |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME     | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                    |
|-----------------|--------------|----------|--------|--------|--------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A8              |              |          |        |        |        | I        | ADC-A Input 8                                                                                                                                                                                                                                                                                                                                                  |
| C11             |              |          |        |        |        | I        | ADC-C Input 11                                                                                                                                                                                                                                                                                                                                                 |
| CMP2_HP4        |              |          |        |        |        | I        | CMPSS-2 High Comparator Positive Input 4                                                                                                                                                                                                                                                                                                                       |
| CMP4_HP4        |              | 20       | 24     | 20     | 16     | I        | CMPSS-4 High Comparator Positive Input 4                                                                                                                                                                                                                                                                                                                       |
| CMP2_LP4        |              |          |        |        |        | I        | CMPSS-2 Low Comparator Positive Input 4                                                                                                                                                                                                                                                                                                                        |
| CMP4_LP4        |              |          |        |        |        | I        | CMPSS-4 Low Comparator Positive Input 4                                                                                                                                                                                                                                                                                                                        |
| AIO241          |              |          |        |        |        | I        | Analog Pin Used For Digital Input 241                                                                                                                                                                                                                                                                                                                          |
| A9              |              |          |        |        |        | I        | ADC-A Input 9                                                                                                                                                                                                                                                                                                                                                  |
| C8              |              |          |        |        |        | I        | ADC-C Input 8                                                                                                                                                                                                                                                                                                                                                  |
| CMP2_HP2        |              |          |        |        |        | I        | CMPSS-2 High Comparator Positive Input 2                                                                                                                                                                                                                                                                                                                       |
| CMP4_HP0        |              | 24       | 28     | 24     | 20     | I        | CMPSS-4 High Comparator Positive Input 0                                                                                                                                                                                                                                                                                                                       |
| CMP2_LP2        |              |          |        |        |        | I        | CMPSS-2 Low Comparator Positive Input 2                                                                                                                                                                                                                                                                                                                        |
| CMP4_LP0        |              |          |        |        |        | I        | CMPSS-4 Low Comparator Positive Input 0                                                                                                                                                                                                                                                                                                                        |
| AIO227          |              |          |        |        |        | I        | Analog Pin Used For Digital Input 227                                                                                                                                                                                                                                                                                                                          |
| C6              |              |          |        |        |        | I        | ADC-C Input 6                                                                                                                                                                                                                                                                                                                                                  |
| CMP3_HP0        |              | 7        | 11     | 7      | 4      | I        | CMPSS-3 High Comparator Positive Input 0                                                                                                                                                                                                                                                                                                                       |
| CMP3_LP0        |              |          |        |        |        | I        | CMPSS-3 Low Comparator Positive Input 0                                                                                                                                                                                                                                                                                                                        |
| AIO226          |              |          |        |        |        | I        | Analog Pin Used For Digital Input 226                                                                                                                                                                                                                                                                                                                          |
| VREFHI          |              | 16       | 20     | 16     | 12     | I        | ADC- High Reference. In external reference mode, externally drive the high reference voltage onto this pin. In internal reference mode, a voltage is driven onto this pin by the device. In either mode, place at least a 2.2-μF capacitor on this pin. This capacitor should be placed as close to the device as possible between the VREFHI and VREFLO pins. |
| VREFLO          |              | 17       | 21     | 17     | 13     | I        | ADC- Low Reference                                                                                                                                                                                                                                                                                                                                             |
| <b>GPIO</b>     |              |          |        |        |        |          |                                                                                                                                                                                                                                                                                                                                                                |
| GPIO0           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 0                                                                                                                                                                                                                                                                                                                                 |
| EPWM1_A         | 1            |          |        |        |        | O        | ePWM-1 Output A                                                                                                                                                                                                                                                                                                                                                |
| I2CA_SDA        | 6            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Data                                                                                                                                                                                                                                                                                                                            |
| SPIA_STE        | 7            | 52       | 63     | 52     | 42     | I/O      | SPI-A Slave Transmit Enable (STE)                                                                                                                                                                                                                                                                                                                              |
| FSIRXA_CLK      | 9            |          |        |        |        | I        | FSIRX-A Input Clock                                                                                                                                                                                                                                                                                                                                            |
| CLB_OUTPUTXBAR8 | 11           |          |        |        |        | O        | CLB Output X-BAR Output 8                                                                                                                                                                                                                                                                                                                                      |
| HIC_BASESEL1    | 15           |          |        |        |        | I        | HIC Base Address Range Select 1                                                                                                                                                                                                                                                                                                                                |
| GPIO1           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 1                                                                                                                                                                                                                                                                                                                                 |
| EPWM1_B         | 1            |          |        |        |        | O        | ePWM-1 Output B                                                                                                                                                                                                                                                                                                                                                |
| I2CA_SCL        | 6            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Clock                                                                                                                                                                                                                                                                                                                           |
| SPIA_SOMI       | 7            | 51       | 62     | 51     | 41     | I/O      | SPI-A Slave Out, Master In (SOMI)                                                                                                                                                                                                                                                                                                                              |
| CLB_OUTPUTXBAR7 | 11           |          |        |        |        | O        | CLB Output X-BAR Output 7                                                                                                                                                                                                                                                                                                                                      |
| HIC_A2          | 13           |          |        |        |        | I        | HIC Address 2                                                                                                                                                                                                                                                                                                                                                  |
| FSITXA_TDM_D1   | 14           |          |        |        |        | O        | FSITX-A_TDM Data Output 1                                                                                                                                                                                                                                                                                                                                      |
| HIC_D10         | 15           |          |        |        |        | I/O      | HIC Data 10                                                                                                                                                                                                                                                                                                                                                    |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME     | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                            |
|-----------------|--------------|----------|--------|--------|--------|----------|----------------------------------------|
| GPIO2           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 2         |
| EPWM2_A         | 1            |          |        |        |        | O        | ePWM-2 Output A                        |
| OUTPUTXBAR1     | 5            |          |        |        |        | O        | Output X-BAR Output 1                  |
| PMBUS_A_SDA     | 6            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Data  |
| SPIA_SIMO       | 7            |          |        |        |        | I/O      | SPI-A Slave In, Master Out (SIMO)      |
| SCIA_TX         | 9            | 50       | 61     | 50     | 40     | O        | SCI-A Transmit Data                    |
| FSIRXA_D1       | 10           |          |        |        |        | I        | FSIRX-A Data Input 1                   |
| I2CB_SDA        | 11           |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Data    |
| HIC_A1          | 13           |          |        |        |        | I        | HIC Address 1                          |
| CANA_TX         | 14           |          |        |        |        | O        | CAN-A Transmit                         |
| HIC_D9          | 15           |          |        |        |        | I/O      | HIC Data 9                             |
| GPIO3           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 3         |
| EPWM2_B         | 1            |          |        |        |        | O        | ePWM-2 Output B                        |
| OUTPUTXBAR2     | 2, 5         |          |        |        |        | O        | Output X-BAR Output 2                  |
| PMBUS_A_SCL     | 6            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Clock |
| SPIA_CLK        | 7            |          |        |        |        | I/O      | SPI-A Clock                            |
| SCIA_RX         | 9            | 49       | 60     | 49     | 39     | I        | SCI-A Receive Data                     |
| FSIRXA_D0       | 10           |          |        |        |        | I        | FSIRX-A Data Input 0                   |
| I2CB_SCL        | 11           |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Clock   |
| HIC_NOE         | 13           |          |        |        |        | O        | HIC Output Enable                      |
| CANA_RX         | 14           |          |        |        |        | I        | CAN-A Receive                          |
| HIC_D4          | 15           |          |        |        |        | I/O      | HIC Data 4                             |
| GPIO4           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 4         |
| EPWM3_A         | 1            |          |        |        |        | O        | ePWM-3 Output A                        |
| OUTPUTXBAR3     | 5            |          |        |        |        | O        | Output X-BAR Output 3                  |
| CANA_TX         | 6            |          |        |        |        | O        | CAN-A Transmit                         |
| SPIB_CLK        | 7            |          |        |        |        | I/O      | SPI-B Clock                            |
| EQEP2_STROBE    | 9            | 48       | 59     | 48     | 38     | I/O      | eQEP-2 Strobe                          |
| FSIRXA_CLK      | 10           |          |        |        |        | I        | FSIRX-A Input Clock                    |
| CLB_OUTPUTXBAR6 | 11           |          |        |        |        | O        | CLB Output X-BAR Output 6              |
| HIC_BASESEL2    | 13           |          |        |        |        | I        | HIC Base Address Range Select 2        |
| HIC_NWE         | 15           |          |        |        |        | I        | HIC Data Write Enable                  |
| GPIO5           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 5         |
| EPWM3_B         | 1            |          |        |        |        | O        | ePWM-3 Output B                        |
| OUTPUTXBAR3     | 3            |          |        |        |        | O        | Output X-BAR Output 3                  |
| CANA_RX         | 6            |          |        |        |        | I        | CAN-A Receive                          |
| SPIA_STE        | 7            |          |        |        |        | I/O      | SPI-A Slave Transmit Enable (STE)      |
| FSITXA_D1       | 9            | 61       | 74     | 61     | 47     | O        | FSITX-A Data Output 1                  |
| CLB_OUTPUTXBAR5 | 10           |          |        |        |        | O        | CLB Output X-BAR Output 5              |
| HIC_A7          | 13           |          |        |        |        | I        | HIC Address 7                          |
| HIC_D4          | 14           |          |        |        |        | I/O      | HIC Data 4                             |
| HIC_D15         | 15           |          |        |        |        | I/O      | HIC Data 15                            |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME     | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                |
|-----------------|--------------|----------|--------|--------|--------|----------|--------------------------------------------|
| GPIO6           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 6             |
| EPWM4_A         | 1            |          |        |        |        | O        | ePWM-4 Output A                            |
| OUTPUTXBAR4     | 2            |          |        |        |        | O        | Output X-BAR Output 4                      |
| SYNCOU          | 3            |          |        |        |        | O        | External ePWM Synchronization Pulse        |
| EQEP1_A         | 5            |          |        |        |        | I        | eQEP-1 Input A                             |
| SPIB_SOMI       | 7            | 64       | 80     | 64     | 48     | I/O      | SPI-B Slave Out, Master In (SOMI)          |
| FSITXA_D0       | 9            |          |        |        |        | O        | FSITX-A Data Output 0                      |
| FSITXA_D1       | 11           |          |        |        |        | O        | FSITX-A Data Output 1                      |
| HIC_NBE1        | 13           |          |        |        |        | I        | HIC Byte Enable 1                          |
| CLB_OUTPUTXBAR8 | 14           |          |        |        |        | O        | CLB Output X-BAR Output 8                  |
| HIC_D14         | 15           |          |        |        |        | I/O      | HIC Data 14                                |
| GPIO7           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 7             |
| EPWM4_B         | 1            |          |        |        |        | O        | ePWM-4 Output B                            |
| OUTPUTXBAR5     | 3            |          |        |        |        | O        | Output X-BAR Output 5                      |
| EQEP1_B         | 5            |          |        |        |        | I        | eQEP-1 Input B                             |
| SPIB_SIMO       | 7            | 57       | 68     | 57     | 43     | I/O      | SPI-B Slave In, Master Out (SIMO)          |
| FSITXA_CLK      | 9            |          |        |        |        | O        | FSITX-A Output Clock                       |
| CLB_OUTPUTXBAR2 | 10           |          |        |        |        | O        | CLB Output X-BAR Output 2                  |
| HIC_A6          | 13           |          |        |        |        | I        | HIC Address 6                              |
| HIC_D14         | 15           |          |        |        |        | I/O      | HIC Data 14                                |
| GPIO8           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 8             |
| EPWM5_A         | 1            |          |        |        |        | O        | ePWM-5 Output A                            |
| ADCSOAO         | 3            |          |        |        |        | O        | ADC Start of Conversion A for External ADC |
| EQEP1_STROBE    | 5            |          |        |        |        | I/O      | eQEP-1 Strobe                              |
| SCIA_TX         | 6            |          |        |        |        | O        | SCI-A Transmit Data                        |
| SPIA_SIMO       | 7            |          |        |        |        | I/O      | SPI-A Slave In, Master Out (SIMO)          |
| I2CA_SCL        | 9            | 47       | 58     | 47     |        | I/OD     | I2C-A Open-Drain Bidirectional Clock       |
| FSITXA_D1       | 10           |          |        |        |        | O        | FSITX-A Data Output 1                      |
| CLB_OUTPUTXBAR5 | 11           |          |        |        |        | O        | CLB Output X-BAR Output 5                  |
| HIC_A0          | 13           |          |        |        |        | I        | HIC Address 0                              |
| FSITXA_TDM_CLK  | 14           |          |        |        |        | O        | FSITX-A_TDM Output Clock                   |
| HIC_D8          | 15           |          |        |        |        | I/O      | HIC Data 8                                 |
| GPIO9           | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 9             |
| EPWM5_B         | 1            |          |        |        |        | O        | ePWM-5 Output B                            |
| OUTPUTXBAR6     | 3            |          |        |        |        | O        | Output X-BAR Output 6                      |
| EQEP1_INDEX     | 5            |          |        |        |        | I/O      | eQEP-1 Index                               |
| SCIA_RX         | 6            |          |        |        |        | I        | SCI-A Receive Data                         |
| SPIA_CLK        | 7            | 62       | 75     | 62     |        | I/O      | SPI-A Clock                                |
| FSITXA_D0       | 10           |          |        |        |        | O        | FSITX-A Data Output 0                      |
| LINB_RX         | 11           |          |        |        |        | I        | LIN-B Receive                              |
| HIC_BASESEL0    | 13           |          |        |        |        | I        | HIC Base Address Range Select 0            |
| I2CB_SCL        | 14           |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Clock       |
| HIC_NRDY        | 15           |          |        |        |        | O        | HIC Ready                                  |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME   | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                        |
|---------------|--------------|----------|--------|--------|--------|----------|----------------------------------------------------|
| GPIO10        | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 10                    |
| EPWM6_A       | 1            |          |        |        |        | O        | ePWM-6 Output A                                    |
| ADC SOCBO     | 3            |          |        |        |        | O        | ADC Start of Conversion B for External ADC         |
| EQEP1_A       | 5            |          |        |        |        | I        | eQEP-1 Input A                                     |
| SPIA_SOMI     | 7            | 63       | 76     | 63     |        | I/O      | SPI-A Slave Out, Master In (SOMI)                  |
| I2CA_SDA      | 9            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Data                |
| FSITXA_CLK    | 10           |          |        |        |        | O        | FSITX-A Output Clock                               |
| LINB_TX       | 11           |          |        |        |        | O        | LIN-B Transmit                                     |
| HIC_NWE       | 13           |          |        |        |        | I        | HIC Data Write Enable                              |
| FSITXA_TDM_D0 | 14           |          |        |        |        | O        | FSITX-A_TDM Data Output 0                          |
| GPIO11        | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 11                    |
| EPWM6_B       | 1            |          |        |        |        | O        | ePWM-6 Output B                                    |
| OUTPUTXBAR7   | 3            |          |        |        |        | O        | Output X-BAR Output 7                              |
| EQEP1_B       | 5            |          |        |        |        | I        | eQEP-1 Input B                                     |
| SPIA_STE      | 7            |          |        |        |        | I/O      | SPI-A Slave Transmit Enable (STE)                  |
| FSIRXA_D1     | 9            | 31       | 37     | 31     |        | I        | FSIRX-A Data Input 1                               |
| LINB_RX       | 10           |          |        |        |        | I        | LIN-B Receive                                      |
| EQEP2_A       | 11           |          |        |        |        | I        | eQEP-2 Input A                                     |
| SPIA_SIMO     | 13           |          |        |        |        | I/O      | SPI-A Slave In, Master Out (SIMO)                  |
| HIC_D6        | 14           |          |        |        |        | I/O      | HIC Data 6                                         |
| HIC_NBE0      | 15           |          |        |        |        | I        | HIC Byte Enable 0                                  |
| GPIO12        | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 12                    |
| EPWM7_A       | 1            |          |        |        |        | O        | ePWM-7 Output A                                    |
| EQEP1_STROBE  | 5            |          |        |        |        | I/O      | eQEP-1 Strobe                                      |
| PMBUS_CTL     | 7            |          |        |        |        | I/O      | PMBus-A Control Signal - Slave Input/Master Output |
| FSIRXA_D0     | 9            |          | 36     | 30     |        | I        | FSIRX-A Data Input 0                               |
| LINB_TX       | 10           |          |        |        |        | O        | LIN-B Transmit                                     |
| SPIA_CLK      | 11           |          |        |        |        | I/O      | SPI-A Clock                                        |
| CANA_RX       | 13           |          |        |        |        | I        | CAN-A Receive                                      |
| HIC_D13       | 14           |          |        |        |        | I/O      | HIC Data 13                                        |
| HIC_INT       | 15           |          |        |        |        | O        | HIC Device Interrupt                               |
| GPIO13        | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 13                    |
| EPWM7_B       | 1            |          |        |        |        | O        | ePWM-7 Output B                                    |
| EQEP1_INDEX   | 5            |          |        |        |        | I/O      | eQEP-1 Index                                       |
| PMBUS_ALERT   | 7            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Alert             |
| FSIRXA_CLK    | 9            |          | 35     | 29     |        | I        | FSIRX-A Input Clock                                |
| LINB_RX       | 10           |          |        |        |        | I        | LIN-B Receive                                      |
| SPIA_SOMI     | 11           |          |        |        |        | I/O      | SPI-A Slave Out, Master In (SOMI)                  |
| CANA_TX       | 13           |          |        |        |        | O        | CAN-A Transmit                                     |
| HIC_D11       | 14           |          |        |        |        | I/O      | HIC Data 11                                        |
| HIC_D5        | 15           |          |        |        |        | I/O      | HIC Data 5                                         |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME     | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                                                     |
|-----------------|--------------|----------|--------|--------|--------|----------|-----------------------------------------------------------------------------------------------------------------|
| GPIO14          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 14                                                                                 |
| I2CB_SDA        | 5            |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Data                                                                             |
| OUTPUTXBAR3     | 6            |          |        |        |        | O        | Output X-BAR Output 3                                                                                           |
| PMBUS_A_SDA     | 7            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Data                                                                           |
| SPIB_CLK        | 9            |          | 79     |        |        | I/O      | SPI-B Clock                                                                                                     |
| EQEP2_A         | 10           |          |        |        |        | I        | eQEP-2 Input A                                                                                                  |
| LINB_TX         | 11           |          |        |        |        | O        | LIN-B Transmit                                                                                                  |
| EPWM3_A         | 13           |          |        |        |        | O        | ePWM-3 Output A                                                                                                 |
| CLB_OUTPUTXBAR7 | 14           |          |        |        |        | O        | CLB Output X-BAR Output 7                                                                                       |
| HIC_D15         | 15           |          |        |        |        | I/O      | HIC Data 15                                                                                                     |
| GPIO15          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 15                                                                                 |
| I2CB_SCL        | 5            |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Clock                                                                            |
| OUTPUTXBAR4     | 6            |          |        |        |        | O        | Output X-BAR Output 4                                                                                           |
| PMBUS_A_SCL     | 7            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Clock                                                                          |
| SPIB_STE        | 9            |          | 78     |        |        | I/O      | SPI-B Slave Transmit Enable (STE)                                                                               |
| EQEP2_B         | 10           |          |        |        |        | I        | eQEP-2 Input B                                                                                                  |
| LINB_RX         | 11           |          |        |        |        | I        | LIN-B Receive                                                                                                   |
| EPWM3_B         | 13           |          |        |        |        | O        | ePWM-3 Output B                                                                                                 |
| CLB_OUTPUTXBAR6 | 14           |          |        |        |        | O        | CLB Output X-BAR Output 6                                                                                       |
| HIC_D12         | 15           |          |        |        |        | I/O      | HIC Data 12                                                                                                     |
| GPIO16          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 16                                                                                 |
| SPIA_SIMO       | 1            |          |        |        |        | I/O      | SPI-A Slave In, Master Out (SIMO)                                                                               |
| OUTPUTXBAR7     | 3            |          |        |        |        | O        | Output X-BAR Output 7                                                                                           |
| EPWM5_A         | 5            |          |        |        |        | O        | ePWM-5 Output A                                                                                                 |
| SCIA_TX         | 6            |          |        |        |        | O        | SCI-A Transmit Data                                                                                             |
| EQEP1_STROBE    | 9            |          |        |        |        | I/O      | eQEP-1 Strobe                                                                                                   |
| PMBUS_A_SCL     | 10           | 33       | 39     | 33     | 26     | I/OD     | PMBus-A Open-Drain Bidirectional Clock                                                                          |
| XCLKOUT         | 11           |          |        |        |        | O        | External Clock Output. This pin outputs a divided-down version of a chosen clock signal from within the device. |
| EQEP2_B         | 13           |          |        |        |        | I        | eQEP-2 Input B                                                                                                  |
| SPIB_SOMI       | 14           |          |        |        |        | I/O      | SPI-B Slave Out, Master In (SOMI)                                                                               |
| HIC_D1          | 15           |          |        |        |        | I/O      | HIC Data 1                                                                                                      |
| GPIO17          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 17                                                                                 |
| SPIA_SOMI       | 1            |          |        |        |        | I/O      | SPI-A Slave Out, Master In (SOMI)                                                                               |
| OUTPUTXBAR8     | 3            |          |        |        |        | O        | Output X-BAR Output 8                                                                                           |
| EPWM5_B         | 5            |          |        |        |        | O        | ePWM-5 Output B                                                                                                 |
| SCIA_RX         | 6            | 34       | 40     | 34     |        | I        | SCI-A Receive Data                                                                                              |
| EQEP1_INDEX     | 9            |          |        |        |        | I/O      | eQEP-1 Index                                                                                                    |
| PMBUS_A_SDA     | 10           |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Data                                                                           |
| CANA_TX         | 11           |          |        |        |        | O        | CAN-A Transmit                                                                                                  |
| HIC_D2          | 15           |          |        |        |        | I/O      | HIC Data 2                                                                                                      |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME     | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                                                                                                                                                                                                                                                     |
|-----------------|--------------|----------|--------|--------|--------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GPIO18_X2       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 18_X2                                                                                                                                                                                                                                                                              |
| SPIA_CLK        | 1            |          |        |        |        | I/O      | SPI-A Clock                                                                                                                                                                                                                                                                                                     |
| CANA_RX         | 3            |          |        |        |        | I        | CAN-A Receive                                                                                                                                                                                                                                                                                                   |
| EPWM6_A         | 5            |          |        |        |        | O        | ePWM-6 Output A                                                                                                                                                                                                                                                                                                 |
| I2CA_SCL        | 6            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Clock                                                                                                                                                                                                                                                                            |
| EQEP2_A         | 9            |          |        |        |        | I        | eQEP-2 Input A                                                                                                                                                                                                                                                                                                  |
| PMBUSA_CTL      | 10           | 41       | 50     | 41     | 33     | I/O      | PMBus-A Control Signal - Slave Input/Master Output                                                                                                                                                                                                                                                              |
| XCLKOUT         | 11           |          |        |        |        | O        | External Clock Output. This pin outputs a divided-down version of a chosen clock signal from within the device.                                                                                                                                                                                                 |
| LINB_TX         | 13           |          |        |        |        | O        | LIN-B Transmit                                                                                                                                                                                                                                                                                                  |
| FSITXA_TDM_CLK  | 14           |          |        |        |        | O        | FSITX-A_TDM Output Clock                                                                                                                                                                                                                                                                                        |
| HIC_INT         | 15           |          |        |        |        | O        | HIC Device Interrupt                                                                                                                                                                                                                                                                                            |
| X2              | ALT          |          |        |        |        | O        | Crystal oscillator output.                                                                                                                                                                                                                                                                                      |
| GPIO19_X1       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 19_X1                                                                                                                                                                                                                                                                              |
| SPIA_STE        | 1            |          |        |        |        | I/O      | SPI-A Slave Transmit Enable (STE)                                                                                                                                                                                                                                                                               |
| CANA_TX         | 3            |          |        |        |        | O        | CAN-A Transmit                                                                                                                                                                                                                                                                                                  |
| EPWM6_B         | 5            |          |        |        |        | O        | ePWM-6 Output B                                                                                                                                                                                                                                                                                                 |
| I2CA_SDA        | 6            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Data                                                                                                                                                                                                                                                                             |
| EQEP2_B         | 9            |          |        |        |        | I        | eQEP-2 Input B                                                                                                                                                                                                                                                                                                  |
| PMBUSA_ALERT    | 10           |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Alert                                                                                                                                                                                                                                                                          |
| CLB_OUTPUTXBAR1 | 11           | 42       | 51     | 42     | 34     | O        | CLB Output X-BAR Output 1                                                                                                                                                                                                                                                                                       |
| LINB_RX         | 13           |          |        |        |        | I        | LIN-B Receive                                                                                                                                                                                                                                                                                                   |
| FSITXA_TDM_D0   | 14           |          |        |        |        | O        | FSITX-A_TDM Data Output 0                                                                                                                                                                                                                                                                                       |
| HIC_NBE0        | 15           |          |        |        |        | I        | HIC Byte Enable 0                                                                                                                                                                                                                                                                                               |
| X1              | ALT          |          |        |        |        | I        | Crystal oscillator input or single-ended clock input. The device initialization software must configure this pin before the crystal oscillator is enabled. To use this oscillator, a quartz crystal circuit must be connected to X1 and X2. This pin can also be used to feed a single-ended 3.3-V level clock. |
| GPIO22          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 22                                                                                                                                                                                                                                                                                 |
| EQEP1_STROBE    | 1            |          |        |        |        | I/O      | eQEP-1 Strobe                                                                                                                                                                                                                                                                                                   |
| SPIB_CLK        | 6            |          |        |        |        | I/O      | SPI-B Clock                                                                                                                                                                                                                                                                                                     |
| LINA_TX         | 9            |          |        |        |        | O        | LIN-A Transmit                                                                                                                                                                                                                                                                                                  |
| CLB_OUTPUTXBAR1 | 10           | 56       | 67     | 56     |        | O        | CLB Output X-BAR Output 1                                                                                                                                                                                                                                                                                       |
| LINB_TX         | 11           |          |        |        |        | O        | LIN-B Transmit                                                                                                                                                                                                                                                                                                  |
| HIC_A5          | 13           |          |        |        |        | I        | HIC Address 5                                                                                                                                                                                                                                                                                                   |
| EPWM4_A         | 14           |          |        |        |        | O        | ePWM-4 Output A                                                                                                                                                                                                                                                                                                 |
| HIC_D13         | 15           |          |        |        |        | I/O      | HIC Data 13                                                                                                                                                                                                                                                                                                     |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME  | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                |
|--------------|--------------|----------|--------|--------|--------|----------|----------------------------------------------------------------------------|
| GPIO23       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 23                                            |
| EQEP1_INDEX  | 1            |          |        |        |        | I/O      | eQEP-1 Index                                                               |
| SPIB_STE     | 6            |          |        |        |        | I/O      | SPI-B Slave Transmit Enable (STE)                                          |
| LINA_RX      | 9            | 54       | 65     | 54     |        | I        | LIN-A Receive                                                              |
| LINB_RX      | 11           |          |        |        |        | I        | LIN-B Receive                                                              |
| HIC_A3       | 13           |          |        |        |        | I        | HIC Address 3                                                              |
| EPWM4_B      | 14           |          |        |        |        | O        | ePWM-4 Output B                                                            |
| HIC_D11      | 15           |          |        |        |        | I/O      | HIC Data 11                                                                |
| GPIO24       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 24                                            |
| OUTPUTXBAR1  | 1            |          |        |        |        | O        | Output X-BAR Output 1                                                      |
| EQEP2_A      | 2            |          |        |        |        | I        | eQEP-2 Input A                                                             |
| SPIB_SIMO    | 6            |          |        |        |        | I/O      | SPI-B Slave In, Master Out (SIMO)                                          |
| LINB_TX      | 9            | 35       | 41     | 35     | 27     | O        | LIN-B Transmit                                                             |
| PMBUSA_SCL   | 10           |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Clock                                     |
| SCIA_TX      | 11           |          |        |        |        | O        | SCI-A Transmit Data                                                        |
| ERRORSTS     | 13           |          |        |        |        | O        | Error Status Output. When used, this signal requires an external pulldown. |
| HIC_D3       | 15           |          |        |        |        | I/O      | HIC Data 3                                                                 |
| GPIO25       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 25                                            |
| OUTPUTXBAR2  | 1            |          |        |        |        | O        | Output X-BAR Output 2                                                      |
| EQEP2_B      | 2            |          |        |        |        | I        | eQEP-2 Input B                                                             |
| EQEP1_A      | 5            |          |        |        |        | I        | eQEP-1 Input A                                                             |
| SPIB_SOMI    | 6            |          | 42     |        |        | I/O      | SPI-B Slave Out, Master In (SOMI)                                          |
| FSITXA_D1    | 9            |          |        |        |        | O        | FSITX-A Data Output 1                                                      |
| PMBUSA_SDA   | 10           |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Data                                      |
| SCIA_RX      | 11           |          |        |        |        | I        | SCI-A Receive Data                                                         |
| HIC_BASESEL0 | 14           |          |        |        |        | I        | HIC Base Address Range Select 0                                            |
| GPIO26       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 26                                            |
| OUTPUTXBAR3  | 1, 5         |          |        |        |        | O        | Output X-BAR Output 3                                                      |
| EQEP2_INDEX  | 2            |          |        |        |        | I/O      | eQEP-2 Index                                                               |
| SPIB_CLK     | 6            |          |        |        |        | I/O      | SPI-B Clock                                                                |
| FSITXA_D0    | 9            |          | 43     |        |        | O        | FSITX-A Data Output 0                                                      |
| PMBUSA_CTL   | 10           |          |        |        |        | I/O      | PMBus-A Control Signal - Slave Input/Master Output                         |
| I2CA_SDA     | 11           |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Data                                        |
| HIC_D0       | 14           |          |        |        |        | I/O      | HIC Data 0                                                                 |
| HIC_A1       | 15           |          |        |        |        | I        | HIC Address 1                                                              |
| GPIO27       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 27                                            |
| OUTPUTXBAR4  | 1, 5         |          |        |        |        | O        | Output X-BAR Output 4                                                      |
| EQEP2_STROBE | 2            |          |        |        |        | I/O      | eQEP-2 Strobe                                                              |
| SPIB_STE     | 6            |          |        |        |        | I/O      | SPI-B Slave Transmit Enable (STE)                                          |
| FSITXA_CLK   | 9            |          | 44     |        |        | O        | FSITX-A Output Clock                                                       |
| PMBUSA_ALERT | 10           |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Alert                                     |
| I2CA_SCL     | 11           |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Clock                                       |
| HIC_D1       | 14           |          |        |        |        | I/O      | HIC Data 1                                                                 |
| HIC_A4       | 15           |          |        |        |        | I        | HIC Address 4                                                              |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME  | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                |
|--------------|--------------|----------|--------|--------|--------|----------|----------------------------------------------------------------------------|
| GPIO28       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 28                                            |
| SCIA_RX      | 1            |          |        |        |        | I        | SCI-A Receive Data                                                         |
| EPWM7_A      | 3            |          |        |        |        | O        | ePWM-7 Output A                                                            |
| OUTPUTXBAR5  | 5            |          |        |        |        | O        | Output X-BAR Output 5                                                      |
| EQEP1_A      | 6            |          |        |        |        | I        | eQEP-1 Input A                                                             |
| EQEP2_STROBE | 9            | 2        | 4      | 2      | 2      | I/O      | eQEP-2 Strobe                                                              |
| LINA_TX      | 10           |          |        |        |        | O        | LIN-A Transmit                                                             |
| SPIB_CLK     | 11           |          |        |        |        | I/O      | SPI-B Clock                                                                |
| ERRORSTS     | 13           |          |        |        |        | O        | Error Status Output. When used, this signal requires an external pulldown. |
| I2CB_SDA     | 14           |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Data                                        |
| HIC_NOE      | 15           |          |        |        |        | O        | HIC Output Enable                                                          |
| GPIO29       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 29                                            |
| SCIA_TX      | 1            |          |        |        |        | O        | SCI-A Transmit Data                                                        |
| EPWM7_B      | 3            |          |        |        |        | O        | ePWM-7 Output B                                                            |
| OUTPUTXBAR6  | 5            |          |        |        |        | O        | Output X-BAR Output 6                                                      |
| EQEP1_B      | 6            |          |        |        |        | I        | eQEP-1 Input B                                                             |
| EQEP2_INDEX  | 9            | 1        | 3      | 1      | 1      | I/O      | eQEP-2 Index                                                               |
| LINA_RX      | 10           |          |        |        |        | I        | LIN-A Receive                                                              |
| SPIB_STE     | 11           |          |        |        |        | I/O      | SPI-B Slave Transmit Enable (STE)                                          |
| ERRORSTS     | 13           |          |        |        |        | O        | Error Status Output. When used, this signal requires an external pulldown. |
| I2CB_SCL     | 14           |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Clock                                       |
| HIC_NCS      | 15           |          |        |        |        | I        | HIC Chip Select                                                            |
| GPIO30       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 30                                            |
| CANA_RX      | 1            |          |        |        |        | I        | CAN-A Receive                                                              |
| SPIB_SIMO    | 3            |          |        |        |        | I/O      | SPI-B Slave In, Master Out (SIMO)                                          |
| OUTPUTXBAR7  | 5            |          | 1      |        |        | O        | Output X-BAR Output 7                                                      |
| EQEP1_STROBE | 6            |          |        |        |        | I/O      | eQEP-1 Strobe                                                              |
| FSIRXA_CLK   | 9            |          |        |        |        | I        | FSIRX-A Input Clock                                                        |
| EPWM1_A      | 11           |          |        |        |        | O        | ePWM-1 Output A                                                            |
| HIC_D8       | 14           |          |        |        |        | I/O      | HIC Data 8                                                                 |
| GPIO31       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 31                                            |
| CANA_TX      | 1            |          |        |        |        | O        | CAN-A Transmit                                                             |
| SPIB_SOMI    | 3            |          |        |        |        | I/O      | SPI-B Slave Out, Master In (SOMI)                                          |
| OUTPUTXBAR8  | 5            |          |        |        |        | O        | Output X-BAR Output 8                                                      |
| EQEP1_INDEX  | 6            |          | 2      |        |        | I/O      | eQEP-1 Index                                                               |
| FSIRXA_D1    | 9            |          |        |        |        | I        | FSIRX-A Data Input 1                                                       |
| EPWM1_B      | 11           |          |        |        |        | O        | ePWM-1 Output B                                                            |
| HIC_D10      | 14           |          |        |        |        | I/O      | HIC Data 10                                                                |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                                                                                                                                                                                                      |
|-------------|--------------|----------|--------|--------|--------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GPIO32      | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 32                                                                                                                                                                                                                                  |
| I2CA_SDA    | 1            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Data                                                                                                                                                                                                                              |
| SPIB_CLK    | 3            |          |        |        |        | I/O      | SPI-B Clock                                                                                                                                                                                                                                                      |
| LINA_TX     | 6            | 40       | 49     | 40     | 32     | O        | LIN-A Transmit                                                                                                                                                                                                                                                   |
| FSIRXA_D0   | 9            |          |        |        |        | I        | FSIRX-A Data Input 0                                                                                                                                                                                                                                             |
| CANA_TX     | 10           |          |        |        |        | O        | CAN-A Transmit                                                                                                                                                                                                                                                   |
| ADCSOCBO    | 13           |          |        |        |        | O        | ADC Start of Conversion B for External ADC                                                                                                                                                                                                                       |
| HIC_INT     | 15           |          |        |        |        | O        | HIC Device Interrupt                                                                                                                                                                                                                                             |
| GPIO33      | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 33                                                                                                                                                                                                                                  |
| I2CA_SCL    | 1            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Clock                                                                                                                                                                                                                             |
| SPIB_STE    | 3            |          |        |        |        | I/O      | SPI-B Slave Transmit Enable (STE)                                                                                                                                                                                                                                |
| OUTPUTXBAR4 | 5            |          |        |        |        | O        | Output X-BAR Output 4                                                                                                                                                                                                                                            |
| LINA_RX     | 6            | 32       | 38     | 32     | 25     | I        | LIN-A Receive                                                                                                                                                                                                                                                    |
| FSIRXA_CLK  | 9            |          |        |        |        | I        | FSIRX-A Input Clock                                                                                                                                                                                                                                              |
| CANA_RX     | 10           |          |        |        |        | I        | CAN-A Receive                                                                                                                                                                                                                                                    |
| EQEP2_B     | 11           |          |        |        |        | I        | eQEP-2 Input B                                                                                                                                                                                                                                                   |
| ADCSOCAO    | 13           |          |        |        |        | O        | ADC Start of Conversion A for External ADC                                                                                                                                                                                                                       |
| HIC_D0      | 15           |          |        |        |        | I/O      | HIC Data 0                                                                                                                                                                                                                                                       |
| GPIO34      | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 34                                                                                                                                                                                                                                  |
| OUTPUTXBAR1 | 1            |          |        |        |        | O        | Output X-BAR Output 1                                                                                                                                                                                                                                            |
| PMBUSA_SDA  | 6            |          | 77     |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Data                                                                                                                                                                                                                            |
| HIC_NBE1    | 13           |          |        |        |        | I        | HIC Byte Enable 1                                                                                                                                                                                                                                                |
| I2CB_SDA    | 14           |          |        |        |        | I/OD     | I2C-B Open-Drain Bidirectional Data                                                                                                                                                                                                                              |
| HIC_D9      | 15           |          |        |        |        | I/O      | HIC Data 9                                                                                                                                                                                                                                                       |
| GPIO35      | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 35                                                                                                                                                                                                                                  |
| SCIA_RX     | 1            |          |        |        |        | I        | SCI-A Receive Data                                                                                                                                                                                                                                               |
| I2CA_SDA    | 3            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Data                                                                                                                                                                                                                              |
| CANA_RX     | 5            |          |        |        |        | I        | CAN-A Receive                                                                                                                                                                                                                                                    |
| PMBUSA_SCL  | 6            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Clock                                                                                                                                                                                                                           |
| LINA_RX     | 7            |          |        |        |        | I        | LIN-A Receive                                                                                                                                                                                                                                                    |
| EQEP1_A     | 9            | 39       | 48     | 39     | 31     | I        | eQEP-1 Input A                                                                                                                                                                                                                                                   |
| PMBUSA_CTL  | 10           |          |        |        |        | I/O      | PMBus-A Control Signal - Slave Input/Master Output                                                                                                                                                                                                               |
| HIC_NWE     | 14           |          |        |        |        | I        | HIC Data Write Enable                                                                                                                                                                                                                                            |
| TDI         | 15           |          |        |        |        | I        | JTAG Test Data Input (TDI) - TDI is the default mux selection for the pin. The internal pullup is disabled by default. The internal pullup should be enabled or an external pullup added on the board if this pin is used as JTAG TDI to avoid a floating input. |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME     | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                                                                                                                                                                                                                                                                                      |
|-----------------|--------------|----------|--------|--------|--------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GPIO37          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 37                                                                                                                                                                                                                                                                                                  |
| OUTPUTXBAR2     | 1            |          |        |        |        | O        | Output X-BAR Output 2                                                                                                                                                                                                                                                                                                            |
| I2CA_SCL        | 3            |          |        |        |        | I/OD     | I2C-A Open-Drain Bidirectional Clock                                                                                                                                                                                                                                                                                             |
| SCIA_TX         | 5            |          |        |        |        | O        | SCI-A Transmit Data                                                                                                                                                                                                                                                                                                              |
| CANA_TX         | 6            |          |        |        |        | O        | CAN-A Transmit                                                                                                                                                                                                                                                                                                                   |
| LINA_TX         | 7            |          |        |        |        | O        | LIN-A Transmit                                                                                                                                                                                                                                                                                                                   |
| EQEP1_B         | 9            | 37       | 46     | 37     | 29     | I        | eQEP-1 Input B                                                                                                                                                                                                                                                                                                                   |
| PMBUSA_ALERT    | 10           |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Alert                                                                                                                                                                                                                                                                                           |
| HIC_NRDY        | 14           |          |        |        |        | O        | HIC Ready                                                                                                                                                                                                                                                                                                                        |
| TDO             | 15           |          |        |        |        | O        | JTAG Test Data Output (TDO) - TDO is the default mux selection for the pin. The internal pullup is disabled by default. The TDO function will tristate when there is no JTAG activity, leaving this pin floating; the internal pullup should be enabled or an external pullup added on the board to avoid a floating GPIO input. |
| GPIO39          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 39                                                                                                                                                                                                                                                                                                  |
| FSIRXA_CLK      | 7            |          |        |        |        | I        | FSIRX-A Input Clock                                                                                                                                                                                                                                                                                                              |
| EQEP2_INDEX     | 9            |          |        |        |        | I/O      | eQEP-2 Index                                                                                                                                                                                                                                                                                                                     |
| CLB_OUTPUTXBAR2 | 11           | 46       | 56     | 46     |        | O        | CLB Output X-BAR Output 2                                                                                                                                                                                                                                                                                                        |
| SYNCOUT         | 13           |          |        |        |        | O        | External ePWM Synchronization Pulse                                                                                                                                                                                                                                                                                              |
| EQEP1_INDEX     | 14           |          |        |        |        | I/O      | eQEP-1 Index                                                                                                                                                                                                                                                                                                                     |
| HIC_D7          | 15           |          |        |        |        | I/O      | HIC Data 7                                                                                                                                                                                                                                                                                                                       |
| GPIO40          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 40                                                                                                                                                                                                                                                                                                  |
| SPIB_SIMO       | 1            |          |        |        |        | I/O      | SPI-B Slave In, Master Out (SIMO)                                                                                                                                                                                                                                                                                                |
| EPWM2_B         | 5            |          |        |        |        | O        | ePWM-2 Output B                                                                                                                                                                                                                                                                                                                  |
| PMBUSA_SDA      | 6            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Data                                                                                                                                                                                                                                                                                            |
| FSIRXA_D0       | 7            | 53       | 64     | 53     |        | I        | FSIRX-A Data Input 0                                                                                                                                                                                                                                                                                                             |
| EQEP1_A         | 10           |          |        |        |        | I        | eQEP-1 Input A                                                                                                                                                                                                                                                                                                                   |
| LINB_TX         | 11           |          |        |        |        | O        | LIN-B Transmit                                                                                                                                                                                                                                                                                                                   |
| HIC_NBE1        | 14           |          |        |        |        | I        | HIC Byte Enable 1                                                                                                                                                                                                                                                                                                                |
| HIC_D5          | 15           |          |        |        |        | I/O      | HIC Data 5                                                                                                                                                                                                                                                                                                                       |
| GPIO41          | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 41                                                                                                                                                                                                                                                                                                  |
| EPWM2_A         | 5            |          |        |        |        | O        | ePWM-2 Output A                                                                                                                                                                                                                                                                                                                  |
| PMBUSA_SCL      | 6            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Clock                                                                                                                                                                                                                                                                                           |
| FSIRXA_D1       | 7            |          |        |        |        | I        | FSIRX-A Data Input 1                                                                                                                                                                                                                                                                                                             |
| EQEP1_B         | 10           | 55       | 66     | 55     |        | I        | eQEP-1 Input B                                                                                                                                                                                                                                                                                                                   |
| LINB_RX         | 11           |          |        |        |        | I        | LIN-B Receive                                                                                                                                                                                                                                                                                                                    |
| HIC_A4          | 13           |          |        |        |        | I        | HIC Address 4                                                                                                                                                                                                                                                                                                                    |
| SPIB_SOMI       | 14           |          |        |        |        | I/O      | SPI-B Slave Out, Master In (SOMI)                                                                                                                                                                                                                                                                                                |
| HIC_D12         | 15           |          |        |        |        | I/O      | HIC Data 12                                                                                                                                                                                                                                                                                                                      |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME                  | MUX POSITION | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP | PIN TYPE | DESCRIPTION                                                  |
|------------------------------|--------------|----------|--------|--------|--------|----------|--------------------------------------------------------------|
| GPIO42                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 42                              |
| LINA_RX                      | 2            |          |        |        |        | I        | LIN-A Receive                                                |
| OUTPUTXBAR5                  | 3            |          |        |        |        | O        | Output X-BAR Output 5                                        |
| PMBUSA_CTL                   | 5            |          |        |        |        | I/O      | PMBus-A Control Signal - Slave Input/Master Output           |
| I2CA_SDA                     | 6            |          | 57     |        |        | I/OD     | I2C-A Open-Drain Bidirectional Data                          |
| EQEP1_STROBE                 | 10           |          |        |        |        | I/O      | eQEP-1 Strobe                                                |
| CLB_OUTPUTXBAR3              | 11           |          |        |        |        | O        | CLB Output X-BAR Output 3                                    |
| HIC_D2                       | 14           |          |        |        |        | I/O      | HIC Data 2                                                   |
| HIC_A6                       | 15           |          |        |        |        | I        | HIC Address 6                                                |
| GPIO43                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 43                              |
| OUTPUTXBAR6                  | 3            |          |        |        |        | O        | Output X-BAR Output 6                                        |
| PMBUSA_ALERT                 | 5            |          |        |        |        | I/OD     | PMBus-A Open-Drain Bidirectional Alert                       |
| I2CA_SCL                     | 6            |          | 54     |        |        | I/OD     | I2C-A Open-Drain Bidirectional Clock                         |
| EQEP1_INDEX                  | 10           |          |        |        |        | I/O      | eQEP-1 Index                                                 |
| CLB_OUTPUTXBAR4              | 11           |          |        |        |        | O        | CLB Output X-BAR Output 4                                    |
| HIC_D3                       | 14           |          |        |        |        | I/O      | HIC Data 3                                                   |
| HIC_A7                       | 15           |          |        |        |        | I        | HIC Address 7                                                |
| GPIO44                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 44                              |
| OUTPUTXBAR7                  | 3            |          |        |        |        | O        | Output X-BAR Output 7                                        |
| EQEP1_A                      | 5            |          |        |        |        | I        | eQEP-1 Input A                                               |
| FSITXA_CLK                   | 7            |          | 69     |        |        | O        | FSITX-A Output Clock                                         |
| CLB_OUTPUTXBAR3              | 10           |          |        |        |        | O        | CLB Output X-BAR Output 3                                    |
| HIC_D7                       | 13           |          |        |        |        | I/O      | HIC Data 7                                                   |
| HIC_D5                       | 15           |          |        |        |        | I/O      | HIC Data 5                                                   |
| GPIO45                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 45                              |
| OUTPUTXBAR8                  | 3            |          |        |        |        | O        | Output X-BAR Output 8                                        |
| FSITXA_D0                    | 7            |          | 73     |        |        | O        | FSITX-A Data Output 0                                        |
| CLB_OUTPUTXBAR4              | 10           |          |        |        |        | O        | CLB Output X-BAR Output 4                                    |
| HIC_D6                       | 15           |          |        |        |        | I/O      | HIC Data 6                                                   |
| GPIO46                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 46                              |
| LINA_TX                      | 3            |          | 6      |        |        | O        | LIN-A Transmit                                               |
| FSITXA_D1                    | 7            |          |        |        |        | O        | FSITX-A Data Output 1                                        |
| HIC_NWE                      | 15           |          |        |        |        | I        | HIC Data Write Enable                                        |
| GPIO61                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 61                              |
| GPIO62                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 62                              |
| GPIO63                       | 0, 4, 8, 12  |          |        |        |        | I/O      | General-Purpose Input Output 63                              |
| <b>TEST, JTAG, AND RESET</b> |              |          |        |        |        |          |                                                              |
| FLT1                         |              | 30       | 34     |        | 24     | I/O      | Flash test pin 1. Reserved for TI. Must be left unconnected. |
| FLT2                         |              | 29       | 33     |        | 23     | I/O      | Flash test pin 2. Reserved for TI. Must be left unconnected. |
| TCK                          |              | 36       | 45     | 36     | 28     | I        | JTAG test clock with internal pullup.                        |

**Table 4-1. Pin Attributes (continued)**

| SIGNAL NAME             | MUX POSITION | 64 QFP-Q      | 80 QFP        | 64 QFP        | 48 QFP     | PIN TYPE | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-------------------------|--------------|---------------|---------------|---------------|------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TMS                     |              | 38            | 47            | 38            | 30         | I/O      | JTAG test-mode select (TMS) with internal pullup. This serial control input is clocked into the TAP controller on the rising edge of TCK. This device does not have a TRSTn pin. An external pullup resistor (recommended 2.2 kΩ) on the TMS pin to VDDIO should be placed on the board to keep JTAG in reset during normal operation.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| XRSn                    |              | 3             | 5             | 3             | 3          | I/OD     | Device Reset (in) and Watchdog Reset (out). During a power-on condition, this pin is driven low by the device. An external circuit may also drive this pin to assert a device reset. This pin is also driven low by the MCU when a watchdog reset occurs. During watchdog reset, the XRSn pin is driven low for the watchdog reset duration of 512 OSCCLK cycles. A resistor between 2.2 kΩ and 10 kΩ should be placed between XRSn and VDDIO. If a capacitor is placed between XRSn and VSS for noise filtering, it should be 100 nF or smaller. These values will allow the watchdog to properly drive the XRSn pin to VOL within 512 OSCCLK cycles when the watchdog reset is asserted. This pin is an open-drain output with an internal pullup. If this pin is driven by an external device, it should be done using an open-drain device. |
| <b>POWER AND GROUND</b> |              |               |               |               |            |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| VDD                     |              | 4, 27, 44, 59 | 8, 31, 53, 71 | 4, 27, 44, 59 | 36, 45     |          | 1.2-V Digital Logic Power Pins. TI recommends placing a decoupling capacitor near each VDD pin with a total capacitance of approximately 22 μF.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| VDDA                    |              | 22            | 26            | 22            | 18         |          | 3.3-V Analog Power Pins. Place a minimum 2.2-μF decoupling capacitor on each pin.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| VDDIO                   |              | 28, 43, 60    | 7, 32, 52, 72 | 28, 43, 60    | 35, 46     |          | 3.3-V Digital I/O Power Pins. Place a minimum 0.1-μF decoupling capacitor on each pin.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| VSS                     |              | 5, 26, 45, 58 | 9, 30, 55, 70 | 5, 26, 45, 58 | 22, 37, 44 |          | Digital Ground                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| VSSA                    |              | 21            | 25            | 21            | 17         |          | Analog Ground                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

## 4.3 Signal Descriptions

### 4.3.1 Analog Signals

Table 4-2. Analog Signals

| SIGNAL NAME | DESCRIPTION                           | PIN TYPE | GPIO | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP |
|-------------|---------------------------------------|----------|------|----------|--------|--------|--------|
| A0          | ADC-A Input 0                         | I        |      | 15       | 19     | 15     | 11     |
| A1          | ADC-A Input 1                         | I        |      | 14       | 18     | 14     | 10     |
| A2          | ADC-A Input 2                         | I        |      | 9        | 13     | 9      | 6      |
| A3          | ADC-A Input 3                         | I        |      | 8        | 12     | 8      | 5      |
| A4          | ADC-A Input 4                         | I        |      | 23       | 27     | 23     | 19     |
| A5          | ADC-A Input 5                         | I        |      | 13       | 17     | 13     | 9      |
| A6          | ADC-A Input 6                         | I        |      | 6        | 10     | 6      | 4      |
| A7          | ADC-A Input 7                         | I        |      | 19       | 23     | 19     | 15     |
| A8          | ADC-A Input 8                         | I        |      | 20       | 24     | 20     | 16     |
| A9          | ADC-A Input 9                         | I        |      | 24       | 28     | 24     | 20     |
| A10         | ADC-A Input 10                        | I        |      | 25       | 29     | 25     | 21     |
| A11         | ADC-A Input 11                        | I        |      | 12       | 16     | 12     | 8      |
| A12         | ADC-A Input 12                        | I        |      | 18       | 22     | 18     | 14     |
| A14         | ADC-A Input 14                        | I        |      | 11       | 15     | 11     |        |
| A15         | ADC-A Input 15                        | I        |      | 10       | 14     | 10     | 7      |
| AIO224      | Analog Pin Used For Digital Input 224 | I        |      | 9        | 13     | 9      | 6      |
| AIO225      | Analog Pin Used For Digital Input 225 | I        |      | 23       | 27     | 23     | 19     |
| AIO226      | Analog Pin Used For Digital Input 226 | I        |      | 7        | 11     | 7      | 4      |
| AIO227      | Analog Pin Used For Digital Input 227 | I        |      | 24       | 28     | 24     | 20     |
| AIO228      | Analog Pin Used For Digital Input 228 | I        |      | 6        | 10     | 6      | 4      |
| AIO230      | Analog Pin Used For Digital Input 230 | I        |      | 25       | 29     | 25     | 21     |
| AIO231      | Analog Pin Used For Digital Input 231 | I        |      | 15       | 19     | 15     | 11     |
| AIO232      | Analog Pin Used For Digital Input 232 | I        |      | 14       | 18     | 14     | 10     |
| AIO233      | Analog Pin Used For Digital Input 233 | I        |      | 10       | 14     | 10     | 7      |
| AIO237      | Analog Pin Used For Digital Input 237 | I        |      | 12       | 16     | 12     | 8      |
| AIO238      | Analog Pin Used For Digital Input 238 | I        |      | 18       | 22     | 18     | 14     |
| AIO239      | Analog Pin Used For Digital Input 239 | I        |      | 11       | 15     | 11     |        |
| AIO241      | Analog Pin Used For Digital Input 241 | I        |      | 20       | 24     | 20     | 16     |
| AIO242      | Analog Pin Used For Digital Input 242 | I        |      | 8        | 12     | 8      | 5      |
| AIO244      | Analog Pin Used For Digital Input 244 | I        |      | 13       | 17     | 13     | 9      |
| AIO245      | Analog Pin Used For Digital Input 245 | I        |      | 19       | 23     | 19     | 15     |
| C0          | ADC-C Input 0                         | I        |      | 12       | 16     | 12     | 8      |
| C1          | ADC-C Input 1                         | I        |      | 18       | 22     | 18     | 14     |
| C2          | ADC-C Input 2                         | I        |      | 13       | 17     | 13     | 9      |
| C3          | ADC-C Input 3                         | I        |      | 19       | 23     | 19     | 15     |
| C4          | ADC-C Input 4                         | I        |      | 11       | 15     | 11     |        |
| C5          | ADC-C Input 5                         | I        |      | 8        | 12     | 8      | 5      |
| C6          | ADC-C Input 6                         | I        |      | 7        | 11     | 7      | 4      |
| C7          | ADC-C Input 7                         | I        |      | 10       | 14     | 10     | 7      |
| C8          | ADC-C Input 8                         | I        |      | 24       | 28     | 24     | 20     |
| C9          | ADC-C Input 9                         | I        |      | 9        | 13     | 9      | 6      |
| C10         | ADC-C Input 10                        | I        |      | 25       | 29     | 25     | 21     |
| C11         | ADC-C Input 11                        | I        |      | 20       | 24     | 20     | 16     |

**Table 4-2. Analog Signals (continued)**

| SIGNAL NAME | DESCRIPTION                              | PIN TYPE | GPIO | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP |
|-------------|------------------------------------------|----------|------|----------|--------|--------|--------|
| C14         | ADC-C Input 14                           | I        |      | 23       | 27     | 23     | 19     |
| C15         | ADC-C Input 15                           | I        |      | 15       | 19     | 15     | 11     |
| CMP1_HN0    | CMPSS-1 High Comparator Negative Input 0 | I        |      | 10       | 14     | 10     | 7      |
| CMP1_HN1    | CMPSS-1 High Comparator Negative Input 1 | I        |      | 12       | 16     | 12     | 8      |
| CMP1_HP0    | CMPSS-1 High Comparator Positive Input 0 | I        |      | 9        | 13     | 9      | 6      |
| CMP1_HP1    | CMPSS-1 High Comparator Positive Input 1 | I        |      | 12       | 16     | 12     | 8      |
| CMP1_HP2    | CMPSS-1 High Comparator Positive Input 2 | I        |      | 6        | 10     | 6      | 4      |
| CMP1_HP3    | CMPSS-1 High Comparator Positive Input 3 | I        |      | 10       | 14     | 10     | 7      |
| CMP1_HP4    | CMPSS-1 High Comparator Positive Input 4 | I        |      | 14       | 18     | 14     | 10     |
| CMP1_LN0    | CMPSS-1 Low Comparator Negative Input 0  | I        |      | 10       | 14     | 10     | 7      |
| CMP1_LN1    | CMPSS-1 Low Comparator Negative Input 1  | I        |      | 12       | 16     | 12     | 8      |
| CMP1_LP0    | CMPSS-1 Low Comparator Positive Input 0  | I        |      | 9        | 13     | 9      | 6      |
| CMP1_LP1    | CMPSS-1 Low Comparator Positive Input 1  | I        |      | 12       | 16     | 12     | 8      |
| CMP1_LP2    | CMPSS-1 Low Comparator Positive Input 2  | I        |      | 6        | 10     | 6      | 4      |
| CMP1_LP3    | CMPSS-1 Low Comparator Positive Input 3  | I        |      | 10       | 14     | 10     | 7      |
| CMP1_LP4    | CMPSS-1 Low Comparator Positive Input 4  | I        |      | 14       | 18     | 14     | 10     |
| CMP2_HN0    | CMPSS-2 High Comparator Negative Input 0 | I        |      | 25       | 29     | 25     | 21     |
| CMP2_HN1    | CMPSS-2 High Comparator Negative Input 1 | I        |      | 18       | 22     | 18     | 14     |
| CMP2_HP0    | CMPSS-2 High Comparator Positive Input 0 | I        |      | 23       | 27     | 23     | 19     |
| CMP2_HP1    | CMPSS-2 High Comparator Positive Input 1 | I        |      | 18       | 22     | 18     | 14     |
| CMP2_HP2    | CMPSS-2 High Comparator Positive Input 2 | I        |      | 24       | 28     | 24     | 20     |
| CMP2_HP3    | CMPSS-2 High Comparator Positive Input 3 | I        |      | 25       | 29     | 25     | 21     |
| CMP2_HP4    | CMPSS-2 High Comparator Positive Input 4 | I        |      | 20       | 24     | 20     | 16     |
| CMP2_LN0    | CMPSS-2 Low Comparator Negative Input 0  | I        |      | 25       | 29     | 25     | 21     |
| CMP2_LN1    | CMPSS-2 Low Comparator Negative Input 1  | I        |      | 18       | 22     | 18     | 14     |
| CMP2_LP0    | CMPSS-2 Low Comparator Positive Input 0  | I        |      | 23       | 27     | 23     | 19     |
| CMP2_LP1    | CMPSS-2 Low Comparator Positive Input 1  | I        |      | 18       | 22     | 18     | 14     |
| CMP2_LP2    | CMPSS-2 Low Comparator Positive Input 2  | I        |      | 24       | 28     | 24     | 20     |
| CMP2_LP3    | CMPSS-2 Low Comparator Positive Input 3  | I        |      | 25       | 29     | 25     | 21     |
| CMP2_LP4    | CMPSS-2 Low Comparator Positive Input 4  | I        |      | 20       | 24     | 20     | 16     |
| CMP3_HN0    | CMPSS-3 High Comparator Negative Input 0 | I        |      | 8        | 12     | 8      | 5      |
| CMP3_HN1    | CMPSS-3 High Comparator Negative Input 1 | I        |      | 13       | 17     | 13     | 9      |
| CMP3_HP0    | CMPSS-3 High Comparator Positive Input 0 | I        |      | 7        | 11     | 7      | 4      |
| CMP3_HP1    | CMPSS-3 High Comparator Positive Input 1 | I        |      | 13       | 17     | 13     | 9      |
| CMP3_HP2    | CMPSS-3 High Comparator Positive Input 2 | I        |      | 15       | 19     | 15     | 11     |
| CMP3_HP3    | CMPSS-3 High Comparator Positive Input 3 | I        |      | 8        | 12     | 8      | 5      |
| CMP3_HP4    | CMPSS-3 High Comparator Positive Input 4 | I        |      | 11       | 15     | 11     |        |
| CMP3_LN0    | CMPSS-3 Low Comparator Negative Input 0  | I        |      | 8        | 12     | 8      | 5      |
| CMP3_LN1    | CMPSS-3 Low Comparator Negative Input 1  | I        |      | 13       | 17     | 13     | 9      |
| CMP3_LP0    | CMPSS-3 Low Comparator Positive Input 0  | I        |      | 7        | 11     | 7      | 4      |
| CMP3_LP1    | CMPSS-3 Low Comparator Positive Input 1  | I        |      | 13       | 17     | 13     | 9      |
| CMP3_LP2    | CMPSS-3 Low Comparator Positive Input 2  | I        |      | 15       | 19     | 15     | 11     |
| CMP3_LP3    | CMPSS-3 Low Comparator Positive Input 3  | I        |      | 8        | 12     | 8      | 5      |
| CMP3_LP4    | CMPSS-3 Low Comparator Positive Input 4  | I        |      | 11       | 15     | 11     |        |
| CMP4_HN0    | CMPSS-4 High Comparator Negative Input 0 | I        |      | 23       | 27     | 23     | 19     |
| CMP4_HN1    | CMPSS-4 High Comparator Negative Input 1 | I        |      | 19       | 23     | 19     | 15     |
| CMP4_HP0    | CMPSS-4 High Comparator Positive Input 0 | I        |      | 24       | 28     | 24     | 20     |

**Table 4-2. Analog Signals (continued)**

| SIGNAL NAME | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                          | PIN TYPE | GPIO | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP |
|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|----------|--------|--------|--------|
| CMP4_HP2    | CMPSS-4 High Comparator Positive Input 2                                                                                                                                                                                                                                                                                                                             | I        |      | 18       | 22     | 18     | 14     |
| CMP4_HP3    | CMPSS-4 High Comparator Positive Input 3                                                                                                                                                                                                                                                                                                                             | I        |      | 23       | 27     | 23     | 19     |
| CMP4_HP4    | CMPSS-4 High Comparator Positive Input 4                                                                                                                                                                                                                                                                                                                             | I        |      | 20       | 24     | 20     | 16     |
| CMP4_LN0    | CMPSS-4 Low Comparator Negative Input 0                                                                                                                                                                                                                                                                                                                              | I        |      | 23       | 27     | 23     | 19     |
| CMP4_LN1    | CMPSS-4 Low Comparator Negative Input 1                                                                                                                                                                                                                                                                                                                              | I        |      | 19       | 23     | 19     | 15     |
| CMP4_LP0    | CMPSS-4 Low Comparator Positive Input 0                                                                                                                                                                                                                                                                                                                              | I        |      | 24       | 28     | 24     | 20     |
| CMP4_LP1    | CMPSS-4 Low Comparator Positive Input 1                                                                                                                                                                                                                                                                                                                              | I        |      | 19       | 23     | 19     | 15     |
| CMP4_LP2    | CMPSS-4 Low Comparator Positive Input 2                                                                                                                                                                                                                                                                                                                              | I        |      | 18       | 22     | 18     | 14     |
| CMP4_LP3    | CMPSS-4 Low Comparator Positive Input 3                                                                                                                                                                                                                                                                                                                              | I        |      | 23       | 27     | 23     | 19     |
| CMP4_LP4    | CMPSS-4 Low Comparator Positive Input 4                                                                                                                                                                                                                                                                                                                              | I        |      | 20       | 24     | 20     | 16     |
| VDAC        | Optional external reference voltage for on-chip CMPSS DACs. There is an internal capacitor to VSSA on this pin whether used for ADC input or CMPSS DAC reference which cannot be disabled. If this pin is being used as a reference for the CMPSS DACs, place at least a 1- $\mu$ F capacitor on this pin.                                                           | I        |      | 8        | 12     | 8      | 5      |
| VREFHI      | ADC- High Reference. In external reference mode, externally drive the high reference voltage onto this pin. In internal reference mode, a voltage is driven onto this pin by the device. In either mode, place at least a 2.2- $\mu$ F capacitor on this pin. This capacitor should be placed as close to the device as possible between the VREFHI and VREFLO pins. | I        |      | 16       | 20     | 16     | 12     |
| VREFLO      | ADC- Low Reference                                                                                                                                                                                                                                                                                                                                                   | I        |      | 17       | 21     | 17     | 13     |

### 4.3.2 Digital Signals

**Table 4-3. Digital Signals**

| SIGNAL NAME     | DESCRIPTION                                | PIN TYPE | GPIO                         | 64 QFP-Q               | 80 QFP                        | 64 QFP                     | 48 QFP             |
|-----------------|--------------------------------------------|----------|------------------------------|------------------------|-------------------------------|----------------------------|--------------------|
| ADCSOAO         | ADC Start of Conversion A for External ADC | O        | 33, 8                        | 32, 47                 | 38, 58                        | 32, 47                     | 25                 |
| ADCSOCBO        | ADC Start of Conversion B for External ADC | O        | 10, 32                       | 40, 63                 | 49, 76                        | 40, 63                     | 32                 |
| CANA_RX         | CAN-A Receive                              | I        | 12, 18, 3, 30, 33, 35, 5     | 32, 39, 41, 49, 61     | 1, 36, 38, 48, 50, 60, 74     | 30, 32, 39, 41, 49, 61     | 25, 31, 33, 39, 47 |
| CANA_TX         | CAN-A Transmit                             | O        | 13, 17, 19, 2, 31, 32, 37, 4 | 34, 37, 40, 42, 48, 50 | 2, 35, 40, 46, 49, 51, 59, 61 | 29, 34, 37, 40, 42, 48, 50 | 29, 32, 34, 38, 40 |
| CLB_OUTPUTXBAR1 | CLB Output X-BAR Output 1                  | O        | 19, 22                       | 42, 56                 | 51, 67                        | 42, 56                     | 34                 |
| CLB_OUTPUTXBAR2 | CLB Output X-BAR Output 2                  | O        | 39, 7                        | 46, 57                 | 56, 68                        | 46, 57                     | 43                 |
| CLB_OUTPUTXBAR3 | CLB Output X-BAR Output 3                  | O        | 42, 44                       |                        | 57, 69                        |                            |                    |
| CLB_OUTPUTXBAR4 | CLB Output X-BAR Output 4                  | O        | 43, 45                       |                        | 54, 73                        |                            |                    |
| CLB_OUTPUTXBAR5 | CLB Output X-BAR Output 5                  | O        | 5, 8                         | 47, 61                 | 58, 74                        | 47, 61                     | 47                 |
| CLB_OUTPUTXBAR6 | CLB Output X-BAR Output 6                  | O        | 15, 4                        | 48                     | 59, 78                        | 48                         | 38                 |
| CLB_OUTPUTXBAR7 | CLB Output X-BAR Output 7                  | O        | 1, 14                        | 51                     | 62, 79                        | 51                         | 41                 |
| CLB_OUTPUTXBAR8 | CLB Output X-BAR Output 8                  | O        | 0, 6                         | 52, 64                 | 63, 80                        | 52, 64                     | 42, 48             |
| EPWM1_A         | ePWM-1 Output A                            | O        | 0, 30                        | 52                     | 1, 63                         | 52                         | 42                 |
| EPWM1_B         | ePWM-1 Output B                            | O        | 1, 31                        | 51                     | 2, 62                         | 51                         | 41                 |
| EPWM2_A         | ePWM-2 Output A                            | O        | 2, 41                        | 50, 55                 | 61, 66                        | 50, 55                     | 40                 |
| EPWM2_B         | ePWM-2 Output B                            | O        | 3, 40                        | 49, 53                 | 60, 64                        | 49, 53                     | 39                 |
| EPWM3_A         | ePWM-3 Output A                            | O        | 14, 4                        | 48                     | 59, 79                        | 48                         | 38                 |
| EPWM3_B         | ePWM-3 Output B                            | O        | 15, 5                        | 61                     | 74, 78                        | 61                         | 47                 |
| EPWM4_A         | ePWM-4 Output A                            | O        | 22, 6                        | 56, 64                 | 67, 80                        | 56, 64                     | 48                 |
| EPWM4_B         | ePWM-4 Output B                            | O        | 23, 7                        | 54, 57                 | 65, 68                        | 54, 57                     | 43                 |
| EPWM5_A         | ePWM-5 Output A                            | O        | 16, 8                        | 33, 47                 | 39, 58                        | 33, 47                     | 26                 |
| EPWM5_B         | ePWM-5 Output B                            | O        | 17, 9                        | 34, 62                 | 40, 75                        | 34, 62                     |                    |
| EPWM6_A         | ePWM-6 Output A                            | O        | 10, 18                       | 41, 63                 | 50, 76                        | 41, 63                     | 33                 |
| EPWM6_B         | ePWM-6 Output B                            | O        | 11, 19                       | 31, 42                 | 37, 51                        | 31, 42                     | 34                 |
| EPWM7_A         | ePWM-7 Output A                            | O        | 12, 28                       | 2                      | 36, 4                         | 2, 30                      | 2                  |
| EPWM7_B         | ePWM-7 Output B                            | O        | 13, 29                       | 1                      | 3, 35                         | 1, 29                      | 1                  |
| EQEP1_A         | eQEP-1 Input A                             | I        | 10, 25, 28, 35, 40, 44, 6    | 2, 39, 53, 63, 64      | 4, 42, 48, 64, 69, 76, 80     | 2, 39, 53, 63, 64          | 2, 31, 48          |
| EQEP1_B         | eQEP-1 Input B                             | I        | 11, 29, 37, 41, 7            | 1, 31, 37, 55, 57      | 3, 37, 46, 66, 68             | 1, 31, 37, 55, 57          | 1, 29, 43          |
| EQEP1_INDEX     | eQEP-1 Index                               | I/O      | 13, 17, 23, 31, 39, 43, 9    | 34, 46, 54, 62         | 2, 35, 40, 54, 56, 65, 75     | 29, 34, 46, 54, 62         |                    |
| EQEP1_STROBE    | eQEP-1 Strobe                              | I/O      | 12, 16, 22, 30, 42, 8        | 33, 47, 56             | 1, 36, 39, 57, 58, 67         | 30, 33, 47, 56             | 26                 |
| EQEP2_A         | eQEP-2 Input A                             | I        | 11, 14, 18, 24               | 31, 35, 41             | 37, 41, 50, 79                | 31, 35, 41                 | 27, 33             |
| EQEP2_B         | eQEP-2 Input B                             | I        | 15, 16, 19, 25, 33           | 32, 33, 42             | 38, 39, 42, 51, 78            | 32, 33, 42                 | 25, 26, 34         |

**Table 4-3. Digital Signals (continued)**

| SIGNAL NAME    | DESCRIPTION                                                                | PIN TYPE | GPIO                 | 64 QFP-Q       | 80 QFP                | 64 QFP             | 48 QFP     |
|----------------|----------------------------------------------------------------------------|----------|----------------------|----------------|-----------------------|--------------------|------------|
| EQEP2_INDEX    | eQEP-2 Index                                                               | I/O      | 26, 29, 39           | 1, 46          | 3, 43, 56             | 1, 46              | 1          |
| EQEP2_STROBE   | eQEP-2 Strobe                                                              | I/O      | 27, 28, 4            | 2, 48          | 4, 44, 59             | 2, 48              | 2, 38      |
| ERRORSTS       | Error Status Output. When used, this signal requires an external pulldown. | O        | 24, 28, 29           | 1, 2, 35       | 3, 4, 41              | 1, 2, 35           | 1, 2, 27   |
| FSIRXA_CLK     | FSIRX-A Input Clock                                                        | I        | 0, 13, 30, 33, 39, 4 | 32, 46, 48, 52 | 1, 35, 38, 56, 59, 63 | 29, 32, 46, 48, 52 | 25, 38, 42 |
| FSIRXA_D0      | FSIRX-A Data Input 0                                                       | I        | 12, 3, 32, 40        | 40, 49, 53     | 36, 49, 60, 64        | 30, 40, 49, 53     | 32, 39     |
| FSIRXA_D1      | FSIRX-A Data Input 1                                                       | I        | 11, 2, 31, 41        | 31, 50, 55     | 2, 37, 61, 66         | 31, 50, 55         | 40         |
| FSITXA_CLK     | FSITX-A Output Clock                                                       | O        | 10, 27, 44, 7        | 57, 63         | 44, 68, 69, 76        | 57, 63             | 43         |
| FSITXA_D0      | FSITX-A Data Output 0                                                      | O        | 26, 45, 6, 9         | 62, 64         | 43, 73, 75, 80        | 62, 64             | 48         |
| FSITXA_D1      | FSITX-A Data Output 1                                                      | O        | 25, 46, 5, 6, 8      | 47, 61, 64     | 42, 58, 6, 74, 80     | 47, 61, 64         | 47, 48     |
| FSITXA_TDM_CLK | FSITX-A_TDM Output Clock                                                   | O        | 18, 8                | 41, 47         | 50, 58                | 41, 47             | 33         |
| FSITXA_TDM_D0  | FSITX-A_TDM Data Output 0                                                  | O        | 10, 19               | 42, 63         | 51, 76                | 42, 63             | 34         |
| FSITXA_TDM_D1  | FSITX-A_TDM Data Output 1                                                  | O        | 1                    | 51             | 62                    | 51                 | 41         |
| GPIO0          | General-Purpose Input Output 0                                             | I/O      | 0                    | 52             | 63                    | 52                 | 42         |
| GPIO1          | General-Purpose Input Output 1                                             | I/O      | 1                    | 51             | 62                    | 51                 | 41         |
| GPIO2          | General-Purpose Input Output 2                                             | I/O      | 2                    | 50             | 61                    | 50                 | 40         |
| GPIO3          | General-Purpose Input Output 3                                             | I/O      | 3                    | 49             | 60                    | 49                 | 39         |
| GPIO4          | General-Purpose Input Output 4                                             | I/O      | 4                    | 48             | 59                    | 48                 | 38         |
| GPIO5          | General-Purpose Input Output 5                                             | I/O      | 5                    | 61             | 74                    | 61                 | 47         |
| GPIO6          | General-Purpose Input Output 6                                             | I/O      | 6                    | 64             | 80                    | 64                 | 48         |
| GPIO7          | General-Purpose Input Output 7                                             | I/O      | 7                    | 57             | 68                    | 57                 | 43         |
| GPIO8          | General-Purpose Input Output 8                                             | I/O      | 8                    | 47             | 58                    | 47                 |            |
| GPIO9          | General-Purpose Input Output 9                                             | I/O      | 9                    | 62             | 75                    | 62                 |            |
| GPIO10         | General-Purpose Input Output 10                                            | I/O      | 10                   | 63             | 76                    | 63                 |            |
| GPIO11         | General-Purpose Input Output 11                                            | I/O      | 11                   | 31             | 37                    | 31                 |            |
| GPIO12         | General-Purpose Input Output 12                                            | I/O      | 12                   |                | 36                    | 30                 |            |
| GPIO13         | General-Purpose Input Output 13                                            | I/O      | 13                   |                | 35                    | 29                 |            |
| GPIO14         | General-Purpose Input Output 14                                            | I/O      | 14                   |                | 79                    |                    |            |
| GPIO15         | General-Purpose Input Output 15                                            | I/O      | 15                   |                | 78                    |                    |            |
| GPIO16         | General-Purpose Input Output 16                                            | I/O      | 16                   | 33             | 39                    | 33                 | 26         |
| GPIO17         | General-Purpose Input Output 17                                            | I/O      | 17                   | 34             | 40                    | 34                 |            |
| GPIO18_X2      | General-Purpose Input Output 18_X2                                         | I/O      | 18                   | 41             | 50                    | 41                 | 33         |
| GPIO19_X1      | General-Purpose Input Output 19_X1                                         | I/O      | 19                   | 42             | 51                    | 42                 | 34         |
| GPIO22         | General-Purpose Input Output 22                                            | I/O      | 22                   | 56             | 67                    | 56                 |            |
| GPIO23         | General-Purpose Input Output 23                                            | I/O      | 23                   | 54             | 65                    | 54                 |            |
| GPIO24         | General-Purpose Input Output 24                                            | I/O      | 24                   | 35             | 41                    | 35                 | 27         |
| GPIO25         | General-Purpose Input Output 25                                            | I/O      | 25                   |                | 42                    |                    |            |
| GPIO26         | General-Purpose Input Output 26                                            | I/O      | 26                   |                | 43                    |                    |            |
| GPIO27         | General-Purpose Input Output 27                                            | I/O      | 27                   |                | 44                    |                    |            |
| GPIO28         | General-Purpose Input Output 28                                            | I/O      | 28                   | 2              | 4                     | 2                  | 2          |

**Table 4-3. Digital Signals (continued)**

| SIGNAL NAME  | DESCRIPTION                     | PIN TYPE | GPIO       | 64 QFP-Q | 80 QFP     | 64 QFP | 48 QFP |
|--------------|---------------------------------|----------|------------|----------|------------|--------|--------|
| GPIO29       | General-Purpose Input Output 29 | I/O      | 29         | 1        | 3          | 1      | 1      |
| GPIO30       | General-Purpose Input Output 30 | I/O      | 30         |          | 1          |        |        |
| GPIO31       | General-Purpose Input Output 31 | I/O      | 31         |          | 2          |        |        |
| GPIO32       | General-Purpose Input Output 32 | I/O      | 32         | 40       | 49         | 40     | 32     |
| GPIO33       | General-Purpose Input Output 33 | I/O      | 33         | 32       | 38         | 32     | 25     |
| GPIO34       | General-Purpose Input Output 34 | I/O      | 34         |          | 77         |        |        |
| GPIO35       | General-Purpose Input Output 35 | I/O      | 35         | 39       | 48         | 39     | 31     |
| GPIO37       | General-Purpose Input Output 37 | I/O      | 37         | 37       | 46         | 37     | 29     |
| GPIO39       | General-Purpose Input Output 39 | I/O      | 39         | 46       | 56         | 46     |        |
| GPIO40       | General-Purpose Input Output 40 | I/O      | 40         | 53       | 64         | 53     |        |
| GPIO41       | General-Purpose Input Output 41 | I/O      | 41         | 55       | 66         | 55     |        |
| GPIO42       | General-Purpose Input Output 42 | I/O      | 42         |          | 57         |        |        |
| GPIO43       | General-Purpose Input Output 43 | I/O      | 43         |          | 54         |        |        |
| GPIO44       | General-Purpose Input Output 44 | I/O      | 44         |          | 69         |        |        |
| GPIO45       | General-Purpose Input Output 45 | I/O      | 45         |          | 73         |        |        |
| GPIO46       | General-Purpose Input Output 46 | I/O      | 46         |          | 6          |        |        |
| GPIO61       | General-Purpose Input Output 61 | I/O      | 61         |          |            |        |        |
| GPIO62       | General-Purpose Input Output 62 | I/O      | 62         |          |            |        |        |
| GPIO63       | General-Purpose Input Output 63 | I/O      | 63         |          |            |        |        |
| HIC_A0       | HIC Address 0                   | I        | 8          | 47       | 58         | 47     |        |
| HIC_A1       | HIC Address 1                   | I        | 2, 26      | 50       | 43, 61     | 50     | 40     |
| HIC_A2       | HIC Address 2                   | I        | 1          | 51       | 62         | 51     | 41     |
| HIC_A3       | HIC Address 3                   | I        | 23         | 54       | 65         | 54     |        |
| HIC_A4       | HIC Address 4                   | I        | 27, 41     | 55       | 44, 66     | 55     |        |
| HIC_A5       | HIC Address 5                   | I        | 22         | 56       | 67         | 56     |        |
| HIC_A6       | HIC Address 6                   | I        | 42, 7      | 57       | 57, 68     | 57     | 43     |
| HIC_A7       | HIC Address 7                   | I        | 43, 5      | 61       | 54, 74     | 61     | 47     |
| HIC_BASESEL0 | HIC Base Address Range Select 0 | I        | 25, 9      | 62       | 42, 75     | 62     |        |
| HIC_BASESEL1 | HIC Base Address Range Select 1 | I        | 0          | 52       | 63         | 52     | 42     |
| HIC_BASESEL2 | HIC Base Address Range Select 2 | I        | 4          | 48       | 59         | 48     | 38     |
| HIC_D0       | HIC Data 0                      | I/O      | 26, 33     | 32       | 38, 43     | 32     | 25     |
| HIC_D1       | HIC Data 1                      | I/O      | 16, 27     | 33       | 39, 44     | 33     | 26     |
| HIC_D2       | HIC Data 2                      | I/O      | 17, 42     | 34       | 40, 57     | 34     |        |
| HIC_D3       | HIC Data 3                      | I/O      | 24, 43     | 35       | 41, 54     | 35     | 27     |
| HIC_D4       | HIC Data 4                      | I/O      | 3, 5       | 49, 61   | 60, 74     | 49, 61 | 39, 47 |
| HIC_D5       | HIC Data 5                      | I/O      | 13, 40, 44 | 53       | 35, 64, 69 | 29, 53 |        |
| HIC_D6       | HIC Data 6                      | I/O      | 11, 45     | 31       | 37, 73     | 31     |        |
| HIC_D7       | HIC Data 7                      | I/O      | 39, 44     | 46       | 56, 69     | 46     |        |
| HIC_D8       | HIC Data 8                      | I/O      | 30, 8      | 47       | 1, 58      | 47     |        |
| HIC_D9       | HIC Data 9                      | I/O      | 2, 34      | 50       | 61, 77     | 50     | 40     |
| HIC_D10      | HIC Data 10                     | I/O      | 1, 31      | 51       | 2, 62      | 51     | 41     |
| HIC_D11      | HIC Data 11                     | I/O      | 13, 23     | 54       | 35, 65     | 29, 54 |        |
| HIC_D12      | HIC Data 12                     | I/O      | 15, 41     | 55       | 66, 78     | 55     |        |
| HIC_D13      | HIC Data 13                     | I/O      | 12, 22     | 56       | 36, 67     | 30, 56 |        |
| HIC_D14      | HIC Data 14                     | I/O      | 6, 7       | 57, 64   | 68, 80     | 57, 64 | 43, 48 |
| HIC_D15      | HIC Data 15                     | I/O      | 14, 5      | 61       | 74, 79     | 61     | 47     |

**Table 4-3. Digital Signals (continued)**

| SIGNAL NAME  | DESCRIPTION                            | PIN TYPE | GPIO                       | 64 QFP-Q           | 80 QFP                     | 64 QFP                 | 48 QFP         |
|--------------|----------------------------------------|----------|----------------------------|--------------------|----------------------------|------------------------|----------------|
| HIC_INT      | HIC Device Interrupt                   | O        | 12, 18, 32                 | 40, 41             | 36, 49, 50                 | 30, 40, 41             | 32, 33         |
| HIC_NBE0     | HIC Byte Enable 0                      | I        | 11, 19                     | 31, 42             | 37, 51                     | 31, 42                 | 34             |
| HIC_NBE1     | HIC Byte Enable 1                      | I        | 34, 40, 6                  | 53, 64             | 64, 77, 80                 | 53, 64                 | 48             |
| HIC_NCS      | HIC Chip Select                        | I        | 29                         | 1                  | 3                          | 1                      | 1              |
| HIC_NOE      | HIC Output Enable                      | O        | 28, 3                      | 2, 49              | 4, 60                      | 2, 49                  | 2, 39          |
| HIC_NRDY     | HIC Ready                              | O        | 37, 9                      | 37, 62             | 46, 75                     | 37, 62                 | 29             |
| HIC_NWE      | HIC Data Write Enable                  | I        | 10, 35, 4, 46              | 39, 48, 63         | 48, 59, 6, 76              | 39, 48, 63             | 31, 38         |
| I2CA_SCL     | I2C-A Open-Drain Bidirectional Clock   | I/OD     | 1, 18, 27, 33, 37, 43, 8   | 32, 37, 41, 47, 51 | 38, 44, 46, 50, 54, 58, 62 | 32, 37, 41, 47, 51     | 25, 29, 33, 41 |
| I2CA_SDA     | I2C-A Open-Drain Bidirectional Data    | I/OD     | 0, 10, 19, 26, 32, 35, 42  | 39, 40, 42, 52, 63 | 43, 48, 49, 51, 57, 63, 76 | 39, 40, 42, 52, 63     | 31, 32, 34, 42 |
| I2CB_SCL     | I2C-B Open-Drain Bidirectional Clock   | I/OD     | 15, 29, 3, 9               | 1, 49, 62          | 3, 60, 75, 78              | 1, 49, 62              | 1, 39          |
| I2CB_SDA     | I2C-B Open-Drain Bidirectional Data    | I/OD     | 14, 2, 28, 34              | 2, 50              | 4, 61, 77, 79              | 2, 50                  | 2, 40          |
| LINA_RX      | LIN-A Receive                          | I        | 23, 29, 33, 35, 42         | 1, 32, 39, 54      | 3, 38, 48, 57, 65          | 1, 32, 39, 54          | 1, 25, 31      |
| LINA_TX      | LIN-A Transmit                         | O        | 22, 28, 32, 37, 46         | 2, 37, 40, 56      | 4, 46, 49, 6, 67           | 2, 37, 40, 56          | 2, 29, 32      |
| LINB_RX      | LIN-B Receive                          | I        | 11, 13, 15, 19, 23, 41, 9  | 31, 42, 54, 55, 62 | 35, 37, 51, 65, 66, 75, 78 | 29, 31, 42, 54, 55, 62 | 34             |
| LINB_TX      | LIN-B Transmit                         | O        | 10, 12, 14, 18, 22, 24, 40 | 35, 41, 53, 56, 63 | 36, 41, 50, 64, 67, 76, 79 | 30, 35, 41, 53, 56, 63 | 27, 33         |
| OUTPUTXBAR1  | Output X-BAR Output 1                  | O        | 2, 24, 34                  | 35, 50             | 41, 61, 77                 | 35, 50                 | 27, 40         |
| OUTPUTXBAR2  | Output X-BAR Output 2                  | O        | 25, 3, 37                  | 37, 49             | 42, 46, 60                 | 37, 49                 | 29, 39         |
| OUTPUTXBAR3  | Output X-BAR Output 3                  | O        | 14, 26, 4, 5               | 48, 61             | 43, 59, 74, 79             | 48, 61                 | 38, 47         |
| OUTPUTXBAR4  | Output X-BAR Output 4                  | O        | 15, 27, 33, 6              | 32, 64             | 38, 44, 78, 80             | 32, 64                 | 25, 48         |
| OUTPUTXBAR5  | Output X-BAR Output 5                  | O        | 28, 42, 7                  | 2, 57              | 4, 57, 68                  | 2, 57                  | 2, 43          |
| OUTPUTXBAR6  | Output X-BAR Output 6                  | O        | 29, 43, 9                  | 1, 62              | 3, 54, 75                  | 1, 62                  | 1              |
| OUTPUTXBAR7  | Output X-BAR Output 7                  | O        | 11, 16, 30, 44             | 31, 33             | 1, 37, 39, 69              | 31, 33                 | 26             |
| OUTPUTXBAR8  | Output X-BAR Output 8                  | O        | 17, 31, 45                 | 34                 | 2, 40, 73                  | 34                     |                |
| PMBUSA_ALERT | PMBus-A Open-Drain Bidirectional Alert | I/OD     | 13, 19, 27, 37, 43         | 37, 42             | 35, 44, 46, 51, 54         | 29, 37, 42             | 29, 34         |

**Table 4-3. Digital Signals (continued)**

| SIGNAL NAME | DESCRIPTION                                                                                                                                                                                                                                                                                                                      | PIN TYPE | GPIO                  | 64 QFP-Q              | 80 QFP                 | 64 QFP                | 48 QFP            |
|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|-----------------------|------------------------|-----------------------|-------------------|
| PMBUSA_CTL  | PMBus-A Control Signal - Slave Input/Master Output                                                                                                                                                                                                                                                                               | I/O      | 12, 18, 26, 35, 42    | 39, 41                | 36, 43, 48, 50, 57     | 30, 39, 41            | 31, 33            |
| PMBUSA_SCL  | PMBus-A Open-Drain Bidirectional Clock                                                                                                                                                                                                                                                                                           | I/OD     | 15, 16, 24, 3, 35, 41 | 33, 35, 39, 49, 55    | 39, 41, 48, 60, 66, 78 | 33, 35, 39, 49, 55    | 26, 27, 31, 39    |
| PMBUSA_SDA  | PMBus-A Open-Drain Bidirectional Data                                                                                                                                                                                                                                                                                            | I/OD     | 14, 17, 2, 25, 34, 40 | 34, 50, 53            | 40, 42, 61, 64, 77, 79 | 34, 50, 53            | 40                |
| SCIA_RX     | SCI-A Receive Data                                                                                                                                                                                                                                                                                                               | I        | 17, 25, 28, 3, 35, 9  | 2, 34, 39, 49, 62     | 4, 40, 42, 48, 60, 75  | 2, 34, 39, 49, 62     | 2, 31, 39         |
| SCIA_TX     | SCI-A Transmit Data                                                                                                                                                                                                                                                                                                              | O        | 16, 2, 24, 29, 37, 8  | 1, 33, 35, 37, 47, 50 | 3, 39, 41, 46, 58, 61  | 1, 33, 35, 37, 47, 50 | 1, 26, 27, 29, 40 |
| SPIA_CLK    | SPI-A Clock                                                                                                                                                                                                                                                                                                                      | I/O      | 12, 18, 3, 9          | 41, 49, 62            | 36, 50, 60, 75         | 30, 41, 49, 62        | 33, 39            |
| SPIA_SIMO   | SPI-A Slave In, Master Out (SIMO)                                                                                                                                                                                                                                                                                                | I/O      | 11, 16, 2, 8          | 31, 33, 47, 50        | 37, 39, 58, 61         | 31, 33, 47, 50        | 26, 40            |
| SPIA_SOMI   | SPI-A Slave Out, Master In (SOMI)                                                                                                                                                                                                                                                                                                | I/O      | 1, 10, 13, 17         | 34, 51, 63            | 35, 40, 62, 76         | 29, 34, 51, 63        | 41                |
| SPIA_STE    | SPI-A Slave Transmit Enable (STE)                                                                                                                                                                                                                                                                                                | I/O      | 0, 11, 19, 5          | 31, 42, 52, 61        | 37, 51, 63, 74         | 31, 42, 52, 61        | 34, 42, 47        |
| SPIB_CLK    | SPI-B Clock                                                                                                                                                                                                                                                                                                                      | I/O      | 14, 22, 26, 28, 32, 4 | 2, 40, 48, 56         | 4, 43, 49, 59, 67, 79  | 2, 40, 48, 56         | 2, 32, 38         |
| SPIB_SIMO   | SPI-B Slave In, Master Out (SIMO)                                                                                                                                                                                                                                                                                                | I/O      | 24, 30, 40, 7         | 35, 53, 57            | 1, 41, 64, 68          | 35, 53, 57            | 27, 43            |
| SPIB_SOMI   | SPI-B Slave Out, Master In (SOMI)                                                                                                                                                                                                                                                                                                | I/O      | 16, 25, 31, 41, 6     | 33, 55, 64            | 2, 39, 42, 66, 80      | 33, 55, 64            | 26, 48            |
| SPIB_STE    | SPI-B Slave Transmit Enable (STE)                                                                                                                                                                                                                                                                                                | I/O      | 15, 23, 27, 29, 33    | 1, 32, 54             | 3, 38, 44, 65, 78      | 1, 32, 54             | 1, 25             |
| SYNCOUT     | External ePWM Synchronization Pulse                                                                                                                                                                                                                                                                                              | O        | 39, 6                 | 46, 64                | 56, 80                 | 46, 64                | 48                |
| TDI         | JTAG Test Data Input (TDI) - TDI is the default mux selection for the pin. The internal pullup is disabled by default. The internal pullup should be enabled or an external pullup added on the board if this pin is used as JTAG TDI to avoid a floating input.                                                                 | I        | 35                    | 39                    | 48                     | 39                    | 31                |
| TDO         | JTAG Test Data Output (TDO) - TDO is the default mux selection for the pin. The internal pullup is disabled by default. The TDO function will tristate when there is no JTAG activity, leaving this pin floating; the internal pullup should be enabled or an external pullup added on the board to avoid a floating GPIO input. | O        | 37                    | 37                    | 46                     | 37                    | 29                |
| X1          | Crystal oscillator input or single-ended clock input. The device initialization software must configure this pin before the crystal oscillator is enabled. To use this oscillator, a quartz crystal circuit must be connected to X1 and X2. This pin can also be used to feed a single-ended 3.3-V level clock.                  | I        | 19                    | 42                    | 51                     | 42                    | 34                |
| X2          | Crystal oscillator output.                                                                                                                                                                                                                                                                                                       | O        | 18                    | 41                    | 50                     | 41                    | 33                |
| XCLKOUT     | External Clock Output. This pin outputs a divided-down version of a chosen clock signal from within the device.                                                                                                                                                                                                                  | O        | 16, 18                | 33, 41                | 39, 50                 | 33, 41                | 26, 33            |

ADVANCE INFORMATION

### 4.3.3 Power and Ground

**Table 4-4. Power and Ground**

| SIGNAL NAME | DESCRIPTION                                                                                                                                          | PIN TYPE | GPIO | 64 QFP-Q      | 80 QFP        | 64 QFP        | 48 QFP     |
|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|---------------|---------------|---------------|------------|
| VDD         | 1.2-V Digital Logic Power Pins. TI recommends placing a decoupling capacitor near each VDD pin with a total capacitance of approximately 22 $\mu$ F. |          |      | 27, 4, 44, 59 | 31, 53, 71, 8 | 27, 4, 44, 59 | 36, 45     |
| VDDA        | 3.3-V Analog Power Pins. Place a minimum 2.2- $\mu$ F decoupling capacitor on each pin.                                                              |          |      | 22            | 26            | 22            | 18         |
| VDDIO       | 3.3-V Digital I/O Power Pins. Place a minimum 0.1- $\mu$ F decoupling capacitor on each pin.                                                         |          |      | 28, 43, 60    | 32, 52, 7, 72 | 28, 43, 60    | 35, 46     |
| VSS         | Digital Ground                                                                                                                                       |          |      | 26, 45, 5, 58 | 30, 55, 70, 9 | 26, 45, 5, 58 | 22, 37, 44 |
| VSSA        | Analog Ground                                                                                                                                        |          |      | 21            | 25            | 21            | 17         |

#### 4.3.4 Test, JTAG, and Reset

**Table 4-5. Test, JTAG, and Reset**

| SIGNAL NAME | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | PIN TYPE | GPIO | 64 QFP-Q | 80 QFP | 64 QFP | 48 QFP |
|-------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|----------|--------|--------|--------|
| FLT1        | Flash test pin 1. Reserved for TI. Must be left unconnected.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | I/O      |      | 30       | 34     |        | 24     |
| FLT2        | Flash test pin 2. Reserved for TI. Must be left unconnected.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | I/O      |      | 29       | 33     |        | 23     |
| TCK         | JTAG test clock with internal pullup.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | I        |      | 36       | 45     | 36     | 28     |
| TMS         | JTAG test-mode select (TMS) with internal pullup. This serial control input is clocked into the TAP controller on the rising edge of TCK. This device does not have a TRSTn pin. An external pullup resistor (recommended 2.2 k $\Omega$ ) on the TMS pin to VDDIO should be placed on the board to keep JTAG in reset during normal operation.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | I/O      |      | 38       | 47     | 38     | 30     |
| XRSn        | Device Reset (in) and Watchdog Reset (out). During a power-on condition, this pin is driven low by the device. An external circuit may also drive this pin to assert a device reset. This pin is also driven low by the MCU when a watchdog reset occurs. During watchdog reset, the XRSn pin is driven low for the watchdog reset duration of 512 OSCCLK cycles. A resistor between 2.2 k $\Omega$ and 10 k $\Omega$ should be placed between XRSn and VDDIO. If a capacitor is placed between XRSn and VSS for noise filtering, it should be 100 nF or smaller. These values will allow the watchdog to properly drive the XRSn pin to VOL within 512 OSCCLK cycles when the watchdog reset is asserted. This pin is an open-drain output with an internal pullup. If this pin is driven by an external device, it should be done using an open-drain device. | I/OD     |      | 3        | 5      | 3      | 3      |

## 4.4 Pin Multiplexing

### 4.4.1 GPIO Muxed Pins

Table 4-6 lists the GPIO muxed pins. The default mode for each GPIO pin is the GPIO function, except GPIO35 and GPIO37, which default to TDI and TDO, respectively. Secondary functions can be selected by setting both the GPyGMUXn.GPIOz and GPyMUXn.GPIOz register bits. The GPyGMUXn register should be configured before the GPyMUXn to avoid transient pulses on GPIOs from alternate mux selections. Columns that are not shown and blank cells are reserved GPIO Mux settings. GPIO ALT functions cannot be configured with the GPyMUXn and GPyGMUXn registers. These are special functions that need to be configured from the module.

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#### NOTE

GPIO20, GPIO21, GPIO36 and GPIO38 do not exist on this device. GPIO61 to GPIO63 exist but are not pinned out on any packages. Boot ROM enables pullups on GPIO61 to GPIO63. For more details, see [Section 4.5](#).

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Table 4-6. GPIO Muxed Pins

| 0, 4, 8, 12 | 1            | 2            | 3           | 5            | 6            | 7            | 9            | 10                  | 11                  | 13           | 14                  | 15           | ALT |
|-------------|--------------|--------------|-------------|--------------|--------------|--------------|--------------|---------------------|---------------------|--------------|---------------------|--------------|-----|
| GPIO0       | EPWM1_A      |              |             |              | I2CA_SDA     | SPIA_STE     | FSIRXA_CLK   |                     | CLB_OUTPUTXB<br>AR8 |              |                     | HIC_BASESEL1 |     |
| GPIO1       | EPWM1_B      |              |             |              | I2CA_SCL     | SPIA_SOMI    |              |                     | CLB_OUTPUTXB<br>AR7 | HIC_A2       | FSITXA_TDM_D1       | HIC_D10      |     |
| GPIO2       | EPWM2_A      |              |             | OUTPUTXBAR1  | PMBUSA_SDA   | SPIA_SIMO    | SCIA_TX      | FSIRXA_D1           | I2CB_SDA            | HIC_A1       | CANA_TX             | HIC_D9       |     |
| GPIO3       | EPWM2_B      | OUTPUTXBAR2  |             | OUTPUTXBAR2  | PMBUSA_SCL   | SPIA_CLK     | SCIA_RX      | FSIRXA_D0           | I2CB_SCL            | HIC_NOE      | CANA_RX             | HIC_D4       |     |
| GPIO4       | EPWM3_A      |              |             | OUTPUTXBAR3  | CANA_TX      | SPIB_CLK     | EQEP2_STROBE | FSIRXA_CLK          | CLB_OUTPUTXB<br>AR6 | HIC_BASESEL2 |                     | HIC_NWE      |     |
| GPIO5       | EPWM3_B      |              | OUTPUTXBAR3 |              | CANA_RX      | SPIA_STE     | FSITXA_D1    | CLB_OUTPUTXB<br>AR5 |                     | HIC_A7       | HIC_D4              | HIC_D15      |     |
| GPIO6       | EPWM4_A      | OUTPUTXBAR4  | SYNCOUT     | EQEP1_A      |              | SPIB_SOMI    | FSITXA_D0    |                     | FSITXA_D1           | HIC_NBE1     | CLB_OUTPUTXB<br>AR8 | HIC_D14      |     |
| GPIO7       | EPWM4_B      |              | OUTPUTXBAR5 | EQEP1_B      |              | SPIB_SIMO    | FSITXA_CLK   | CLB_OUTPUTXB<br>AR2 |                     | HIC_A6       |                     | HIC_D14      |     |
| GPIO8       | EPWM5_A      |              | ADCSOCA0    | EQEP1_STROBE | SCIA_TX      | SPIA_SIMO    | I2CA_SCL     | FSITXA_D1           | CLB_OUTPUTXB<br>AR5 | HIC_A0       | FSITXA_TDM_CL<br>K  | HIC_D8       |     |
| GPIO9       | EPWM5_B      |              | OUTPUTXBAR6 | EQEP1_INDEX  | SCIA_RX      | SPIA_CLK     |              | FSITXA_D0           | LINB_RX             | HIC_BASESEL0 | I2CB_SCL            | HIC_NRDY     |     |
| GPIO10      | EPWM6_A      |              | ADCSOCBO    | EQEP1_A      |              | SPIA_SOMI    | I2CA_SDA     | FSITXA_CLK          | LINB_TX             | HIC_NWE      | FSITXA_TDM_D0       |              |     |
| GPIO11      | EPWM6_B      |              | OUTPUTXBAR7 | EQEP1_B      |              | SPIA_STE     | FSIRXA_D1    | LINB_RX             | EQEP2_A             | SPIA_SIMO    | HIC_D6              | HIC_NBE0     |     |
| GPIO12      | EPWM7_A      |              |             | EQEP1_STROBE |              | PMBUSA_CTL   | FSIRXA_D0    | LINB_TX             | SPIA_CLK            | CANA_RX      | HIC_D13             | HIC_INT      |     |
| GPIO13      | EPWM7_B      |              |             | EQEP1_INDEX  |              | PMBUSA_ALERT | FSIRXA_CLK   | LINB_RX             | SPIA_SOMI           | CANA_TX      | HIC_D11             | HIC_D5       |     |
| GPIO14      |              |              |             | I2CB_SDA     | OUTPUTXBAR3  | PMBUSA_SDA   | SPIB_CLK     | EQEP2_A             | LINB_TX             | EPWM3_A      | CLB_OUTPUTXB<br>AR7 | HIC_D15      |     |
| GPIO15      |              |              |             | I2CB_SCL     | OUTPUTXBAR4  | PMBUSA_SCL   | SPIB_STE     | EQEP2_B             | LINB_RX             | EPWM3_B      | CLB_OUTPUTXB<br>AR6 | HIC_D12      |     |
| GPIO16      | SPIA_SIMO    |              | OUTPUTXBAR7 | EPWM5_A      | SCIA_TX      |              | EQEP1_STROBE | PMBUSA_SCL          | XCLKOUT             | EQEP2_B      | SPIB_SOMI           | HIC_D1       |     |
| GPIO17      | SPIA_SOMI    |              | OUTPUTXBAR8 | EPWM5_B      | SCIA_RX      |              | EQEP1_INDEX  | PMBUSA_SDA          | CANA_TX             |              |                     | HIC_D2       |     |
| GPIO18_X2   | SPIA_CLK     |              | CANA_RX     | EPWM6_A      | I2CA_SCL     |              | EQEP2_A      | PMBUSA_CTL          | XCLKOUT             | LINB_TX      | FSITXA_TDM_CL<br>K  | HIC_INT      | X2  |
| GPIO19_X1   | SPIA_STE     |              | CANA_TX     | EPWM6_B      | I2CA_SDA     |              | EQEP2_B      | PMBUSA_ALERT        | CLB_OUTPUTXB<br>AR1 | LINB_RX      | FSITXA_TDM_D0       | HIC_NBE0     | X1  |
| GPIO22      | EQEP1_STROBE |              |             |              | SPIB_CLK     |              | LINA_TX      | CLB_OUTPUTXB<br>AR1 | LINB_TX             | HIC_A5       | EPWM4_A             | HIC_D13      |     |
| GPIO23      | EQEP1_INDEX  |              |             |              | SPIB_STE     |              | LINA_RX      |                     | LINB_RX             | HIC_A3       | EPWM4_B             | HIC_D11      |     |
| GPIO24      | OUTPUTXBAR1  | EQEP2_A      |             |              | SPIB_SIMO    |              | LINB_TX      | PMBUSA_SCL          | SCIA_TX             | ERRORSTS     |                     | HIC_D3       |     |
| GPIO25      | OUTPUTXBAR2  | EQEP2_B      |             | EQEP1_A      | SPIB_SOMI    |              | FSITXA_D1    | PMBUSA_SDA          | SCIA_RX             |              | HIC_BASESEL0        |              |     |
| GPIO26      | OUTPUTXBAR3  | EQEP2_INDEX  |             | OUTPUTXBAR3  | SPIB_CLK     |              | FSITXA_D0    | PMBUSA_CTL          | I2CA_SDA            |              | HIC_D0              | HIC_A1       |     |
| GPIO27      | OUTPUTXBAR4  | EQEP2_STROBE |             | OUTPUTXBAR4  | SPIB_STE     |              | FSITXA_CLK   | PMBUSA_ALERT        | I2CA_SCL            |              | HIC_D1              | HIC_A4       |     |
| GPIO28      | SCIA_RX      |              | EPWM7_A     | OUTPUTXBAR5  | EQEP1_A      |              | EQEP2_STROBE | LINA_TX             | SPIB_CLK            | ERRORSTS     | I2CB_SDA            | HIC_NOE      |     |
| GPIO29      | SCIA_TX      |              | EPWM7_B     | OUTPUTXBAR6  | EQEP1_B      |              | EQEP2_INDEX  | LINA_RX             | SPIB_STE            | ERRORSTS     | I2CB_SCL            | HIC_NCS      |     |
| GPIO30      | CANA_RX      |              | SPIB_SIMO   | OUTPUTXBAR7  | EQEP1_STROBE |              | FSIRXA_CLK   |                     | EPWM1_A             |              | HIC_D8              |              |     |
| GPIO31      | CANA_TX      |              | SPIB_SOMI   | OUTPUTXBAR8  | EQEP1_INDEX  |              | FSIRXA_D1    |                     | EPWM1_B             |              | HIC_D10             |              |     |
| GPIO32      | I2CA_SDA     |              | SPIB_CLK    |              | LINA_TX      |              | FSIRXA_D0    | CANA_TX             |                     | ADCSOCBO     |                     | HIC_INT      |     |

**Table 4-6. GPIO Muxed Pins (continued)**

| 0, 4, 8, 12 | 1           | 2       | 3           | 5            | 6          | 7          | 9           | 10                  | 11                  | 13       | 14          | 15      | ALT |
|-------------|-------------|---------|-------------|--------------|------------|------------|-------------|---------------------|---------------------|----------|-------------|---------|-----|
| GPIO33      | I2CA_SCL    |         | SPIB_STE    | OUTPUTXBAR4  | LINA_RX    |            | FSIRXA_CLK  | CANA_RX             | EQEP2_B             | ADCSOAO  |             | HIC_D0  |     |
| GPIO34      | OUTPUTXBAR1 |         |             |              | PMBUSA_SDA |            |             |                     |                     | HIC_NBE1 | I2CB_SDA    | HIC_D9  |     |
| GPIO35      | SCIA_RX     |         | I2CA_SDA    | CANA_RX      | PMBUSA_SCL | LINA_RX    | EQEP1_A     | PMBUSA_CTL          |                     |          | HIC_NWE     | TDI     |     |
| GPIO37      | OUTPUTXBAR2 |         | I2CA_SCL    | SCIA_TX      | CANA_TX    | LINA_TX    | EQEP1_B     | PMBUSA_ALERT        |                     |          | HIC_NRDY    | TDO     |     |
| GPIO39      |             |         |             |              |            | FSIRXA_CLK | EQEP2_INDEX |                     | CLB_OUTPUTXB<br>AR2 | SYNCOUT  | EQEP1_INDEX | HIC_D7  |     |
| GPIO40      | SPIB_SIMO   |         |             | EPWM2_B      | PMBUSA_SDA | FSIRXA_D0  |             | EQEP1_A             | LINB_TX             |          | HIC_NBE1    | HIC_D5  |     |
| GPIO41      |             |         |             | EPWM2_A      | PMBUSA_SCL | FSIRXA_D1  |             | EQEP1_B             | LINB_RX             | HIC_A4   | SPIB_SOMI   | HIC_D12 |     |
| GPIO42      |             | LINA_RX | OUTPUTXBAR5 | PMBUSA_CTL   | I2CA_SDA   |            |             | EQEP1_STROBE        | CLB_OUTPUTXB<br>AR3 |          | HIC_D2      | HIC_A6  |     |
| GPIO43      |             |         | OUTPUTXBAR6 | PMBUSA_ALERT | I2CA_SCL   |            |             | EQEP1_INDEX         | CLB_OUTPUTXB<br>AR4 |          | HIC_D3      | HIC_A7  |     |
| GPIO44      |             |         | OUTPUTXBAR7 | EQEP1_A      |            | FSITXA_CLK |             | CLB_OUTPUTXB<br>AR3 |                     | HIC_D7   |             | HIC_D5  |     |
| GPIO45      |             |         | OUTPUTXBAR8 |              |            | FSITXA_D0  |             | CLB_OUTPUTXB<br>AR4 |                     |          |             | HIC_D6  |     |
| GPIO46      |             |         | LINA_TX     |              |            | FSITXA_D1  |             |                     |                     |          |             | HIC_NWE |     |
| GPIO61      |             |         |             |              |            |            |             |                     |                     |          |             |         |     |
| GPIO62      |             |         |             |              |            |            |             |                     |                     |          |             |         |     |
| GPIO63      |             |         |             |              |            |            |             |                     |                     |          |             |         |     |

#### 4.4.2 Digital Inputs on ADC Pins (AIOs)

GPIOs on port H (GPIO224–GPIO245) are multiplexed with analog pins. These are also referred to as AIOs. These pins can only function in input mode. By default, these pins will function as analog pins and the GPIOs are in a high-Z state. The GPHAMSEL register is used to configure these pins for digital or analog operation.

#### NOTE

If digital signals with sharp edges (high dv/dt) are connected to the AIOs, cross-talk can occur with adjacent analog signals. The user should therefore limit the edge rate of signals connected to AIOs if adjacent channels are being used for analog functions.

#### 4.4.3 GPIO Input X-BAR

The Input X-BAR is used to route signals from a GPIO to many different IP blocks such as the ADCs, eCAPs, ePWMs, and external interrupts (see Figure 4-5). Table 4-7 lists the input X-BAR destinations. For details on configuring the Input X-BAR, see the Crossbar (X-BAR) chapter of the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

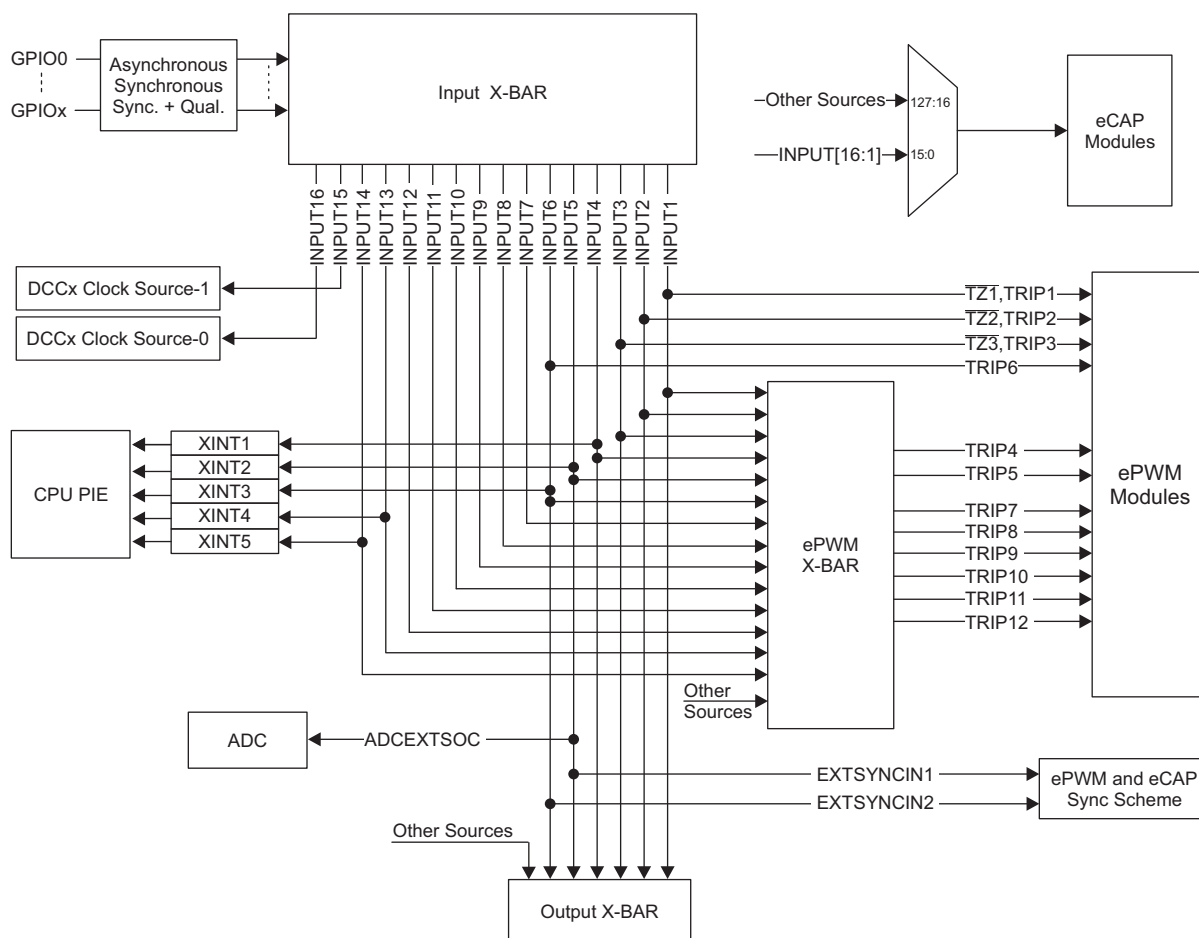


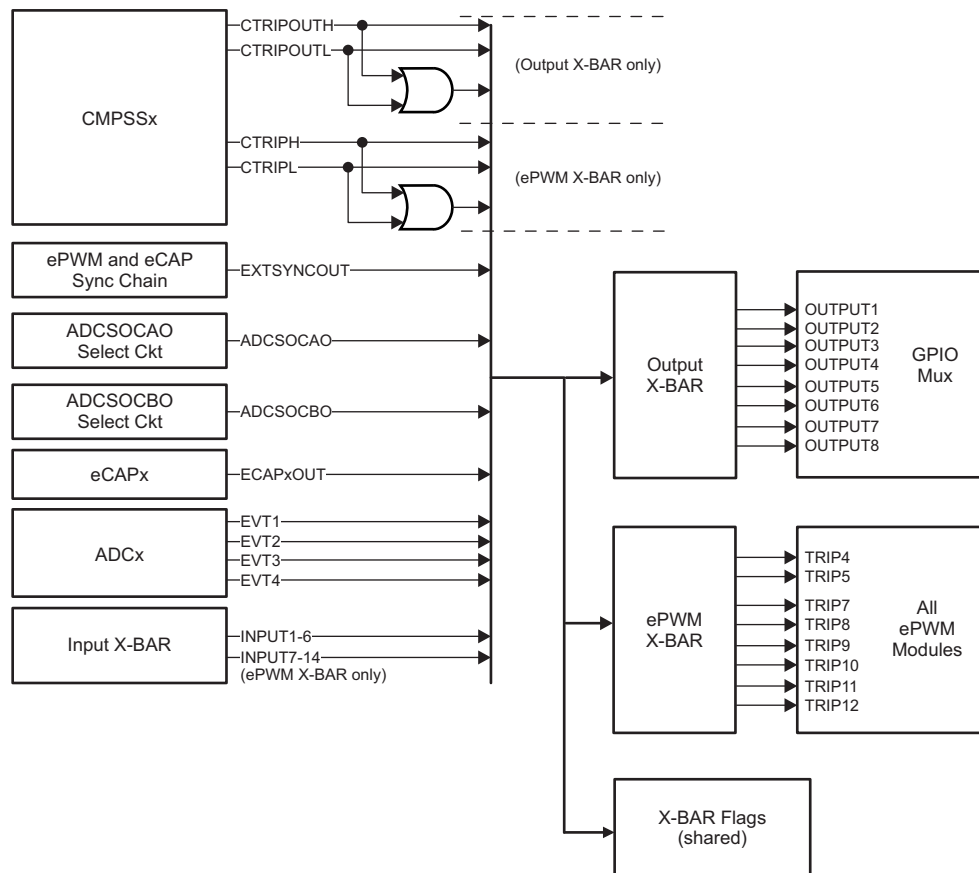
Figure 4-5. Input X-BAR

**Table 4-7. Input X-BAR Destinations**

| INPUT                      | 1             | 2             | 3             | 4     | 5              | 6              | 7   | 8   | 9   | 10  | 11  | 12  | 13    | 14    | 15   | 16   |
|----------------------------|---------------|---------------|---------------|-------|----------------|----------------|-----|-----|-----|-----|-----|-----|-------|-------|------|------|
| ECAP / HRCAP               | Yes           | Yes           | Yes           | Yes   | Yes            | Yes            | Yes | Yes | Yes | Yes | Yes | Yes | Yes   | Yes   | Yes  | Yes  |
| EPWM X-BAR                 | Yes           | Yes           | Yes           | Yes   | Yes            | Yes            | Yes | Yes | Yes | Yes | Yes | Yes | Yes   | Yes   |      |      |
| CLB X-BAR                  | Yes           | Yes           | Yes           | Yes   | Yes            | Yes            | Yes | Yes | Yes | Yes | Yes | Yes | Yes   | Yes   |      |      |
| OUTPUT X-BAR               | Yes           | Yes           | Yes           | Yes   | Yes            | Yes            |     |     |     |     |     |     |       |       |      |      |
| CPU XINT                   |               |               |               | XINT1 | XINT2          | XINT3          |     |     |     |     |     |     | XINT4 | XINT5 |      |      |
| EPWM TRIP                  | TZ1,<br>TRIP1 | TZ2,<br>TRIP2 | TZ3,<br>TRIP3 |       |                | TRIP6          |     |     |     |     |     |     |       |       |      |      |
| ADC START OF<br>CONVERSION |               |               |               |       | ADCEX<br>TSOC  |                |     |     |     |     |     |     |       |       |      |      |
| EPWM / ECAP<br>SYNC        |               |               |               |       | EXTSY<br>NCIN1 | EXTSY<br>NCIN2 |     |     |     |     |     |     |       |       |      |      |
| DCCx                       |               |               |               |       |                |                |     |     |     |     |     |     |       |       | CLK1 | CLK0 |

#### 4.4.4 GPIO Output X-BAR and ePWM X-BAR

The Output X-BAR has eight outputs which are routed to the GPIO module. The ePWM X-BAR has eight outputs which are routed to each ePWM module. [Figure 4-6](#) shows the sources for both the Output X-BAR and ePWM X-BAR. For details on the Output X-BAR and ePWM X-BAR, see the Crossbar (X-BAR) chapter of the [TMS320F28002x Microcontrollers Technical Reference Manual](#).



**Figure 4-6. Output X-BAR and ePWM X-BAR Sources**

## 4.5 Pins With Internal Pullup and Pulldown

Some pins on the device have internal pullups or pulldowns. [Table 4-8](#) lists the pull direction and when it is active. The pullups on GPIO pins are disabled by default and can be enabled through software. To avoid any floating unbonded inputs, the Boot ROM will enable internal pullups on GPIO pins that are not bonded out in a particular package. Other pins noted in [Table 4-8](#) with pullups and pulldowns are always on and cannot be disabled.

**Table 4-8. Pins With Internal Pullup and Pulldown**

| PIN                         | RESET<br>(XRSn = 0)           | DEVICE BOOT                    | APPLICATION         |
|-----------------------------|-------------------------------|--------------------------------|---------------------|
| GPIOx                       | Pullup disabled               | Pullup disabled <sup>(1)</sup> | Application defined |
| GPIO35/TDI                  | Pullup disabled               |                                | Application defined |
| GPIO37/TDO                  | Pullup disabled               |                                | Application defined |
| TCK                         | Pullup active                 |                                |                     |
| TMS                         | Pullup active                 |                                |                     |
| XRSn                        | Pullup active                 |                                |                     |
| Other pins (including AIOs) | No pullup or pulldown present |                                |                     |

(1) Pins not bonded out in a given package will have the internal pullups enabled by the Boot ROM.

## 4.6 Connections for Unused Pins

For applications that do not need to use all functions of the device, [Table 4-9](#) lists acceptable conditioning for any unused pins. When multiple options are listed in [Table 4-9](#), any option is acceptable. Pins not listed in [Table 4-9](#) must be connected according to [Section 4](#).

**Table 4-9. Connections for Unused Pins**

| SIGNAL NAME             | ACCEPTABLE PRACTICE                                                                                                                                                                                                                                                                                                        |
|-------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>ANALOG</b>           |                                                                                                                                                                                                                                                                                                                            |
| VREFHI                  | Tie to VDDA (applies only if ADC is not used in the application)                                                                                                                                                                                                                                                           |
| VREFLO                  | Tie to VSSA                                                                                                                                                                                                                                                                                                                |
| <b>DIGITAL</b>          |                                                                                                                                                                                                                                                                                                                            |
| FLT1 (Flash Test pin 1) | <ul style="list-style-type: none"> <li>No Connect</li> <li>Tie to VSS through 4.7-kΩ or larger resistor</li> </ul>                                                                                                                                                                                                         |
| FLT2 (Flash Test pin 2) | <ul style="list-style-type: none"> <li>No Connect</li> <li>Tie to VSS through 4.7-kΩ or larger resistor</li> </ul>                                                                                                                                                                                                         |
| GPIOx                   | <ul style="list-style-type: none"> <li>No connection (input mode with internal pullup enabled)</li> <li>No connection (output mode with internal pullup disabled)</li> <li>Pullup or pulldown resistor (any value resistor, input mode, and with internal pullup disabled)</li> </ul>                                      |
| GPIO35/TDI              | When TDI mux option is selected (default), the GPIO is in Input mode. <ul style="list-style-type: none"> <li>Internal pullup enabled</li> <li>External pullup resistor</li> </ul>                                                                                                                                          |
| GPIO37/TDO              | When TDO mux option is selected (default), the GPIO is in Output mode only during JTAG activity; otherwise, it is in a tri-state condition. The pin must be biased to avoid extra current on the input buffer. <ul style="list-style-type: none"> <li>Internal pullup enabled</li> <li>External pullup resistor</li> </ul> |
| TCK                     | <ul style="list-style-type: none"> <li>No Connect</li> <li>Pullup resistor</li> </ul>                                                                                                                                                                                                                                      |
| TMS                     | Pullup resistor                                                                                                                                                                                                                                                                                                            |
| GPIO19/X1               | Turn XTAL off and: <ul style="list-style-type: none"> <li>Input mode with internal pullup enabled</li> <li>Input mode with external pullup or pulldown resistor</li> <li>Output mode with internal pullup disabled</li> </ul>                                                                                              |
| GPIO18/X2               | Turn XTAL off and: <ul style="list-style-type: none"> <li>Input mode with internal pullup enabled</li> <li>Input mode with external pullup or pulldown resistor</li> <li>Output mode with internal pullup disabled</li> </ul>                                                                                              |
| <b>POWER AND GROUND</b> |                                                                                                                                                                                                                                                                                                                            |
| VDD                     | All VDD pins must be connected per <a href="#">Section 4.3</a> . Pins should not be used to bias any external circuits.                                                                                                                                                                                                    |
| VDDA                    | If a dedicated analog supply is not used, tie to VDDIO.                                                                                                                                                                                                                                                                    |
| VDDIO                   | All VDDIO pins must be connected per <a href="#">Section 4.3</a> .                                                                                                                                                                                                                                                         |
| VSS                     | All VSS pins must be connected to board ground.                                                                                                                                                                                                                                                                            |
| VSSA                    | If an analog ground is not used, tie to VSS.                                                                                                                                                                                                                                                                               |

## 5 Specifications

### 5.1 Absolute Maximum Ratings<sup>(1)(2)</sup>

over operating free-air temperature range (unless otherwise noted)

|                                    |                                                                                                                             | MIN  | MAX | UNIT |
|------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|------|-----|------|
| Supply voltage                     | VDDIO with respect to VSS                                                                                                   | –0.3 | 4.6 | V    |
|                                    | VDDA with respect to VSSA                                                                                                   | –0.3 | 4.6 |      |
| Input voltage                      | V <sub>IN</sub> (3.3 V)                                                                                                     | –0.3 | 4.6 | V    |
| Output voltage                     | V <sub>O</sub>                                                                                                              | –0.3 | 4.6 | V    |
| Input clamp current                | Digital/analog input (per pin), I <sub>IK</sub> (V <sub>IN</sub> < VSS/VSSA or V <sub>IN</sub> > VDDIO/VDDA) <sup>(3)</sup> | –20  | 20  | mA   |
|                                    | Total for all inputs, I <sub>IKTOTAL</sub> (V <sub>IN</sub> < VSS/VSSA or V <sub>IN</sub> > VDDIO/VDDA)                     | –20  | 20  |      |
| Output current                     | Digital output (per pin), I <sub>OUT</sub>                                                                                  | –20  | 20  | mA   |
| Free-Air temperature               | T <sub>A</sub>                                                                                                              | –40  | 125 | °C   |
| Operating junction temperature     | T <sub>J</sub>                                                                                                              | –40  | 150 | °C   |
| Storage temperature <sup>(4)</sup> | T <sub>sig</sub>                                                                                                            | –65  | 150 | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device beyond the *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to VSS, unless otherwise noted.
- (3) Continuous clamp current per pin is ±2 mA. Do not operate in this condition continuously as V<sub>DDIO</sub>/V<sub>DDA</sub> voltage may internally rise and impact other electrical specifications.
- (4) Long-term high-temperature storage or extended use at maximum temperature conditions may result in a reduction of overall device life. For additional information, see the [Semiconductor and IC Package Thermal Metrics Application Report](#).

## 5.2 ESD Ratings – Commercial

|                                                           |                               |                                                                                                          | VALUE | UNIT |
|-----------------------------------------------------------|-------------------------------|----------------------------------------------------------------------------------------------------------|-------|------|
| F280023C in 80-pin PN package                             |                               |                                                                                                          |       |      |
| V <sub>(ESD)</sub>                                        | Electrostatic discharge (ESD) | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>                                        | ±2000 | V    |
|                                                           |                               | Charged-device model (CDM), per JEDEC specification JESD22-C101 or ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup> | ±500  |      |
| F280025, F280025C, F280023, F280023C in 64-pin PM package |                               |                                                                                                          |       |      |
| V <sub>(ESD)</sub>                                        | Electrostatic discharge (ESD) | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>                                        | ±2000 | V    |
|                                                           |                               | Charged-device model (CDM), per JEDEC specification JESD22-C101 or ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup> | ±500  |      |
| F280023C in 48-pin PT package                             |                               |                                                                                                          |       |      |
| V <sub>(ESD)</sub>                                        | Electrostatic discharge (ESD) | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>                                        | ±2000 | V    |
|                                                           |                               | Charged-device model (CDM), per JEDEC specification JESD22-C101 or ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup> | ±500  |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 5.3 ESD Ratings – Automotive

|                                                          |                         |                                                         | VALUE                                                   | UNIT  |   |
|----------------------------------------------------------|-------------------------|---------------------------------------------------------|---------------------------------------------------------|-------|---|
| F280025, F280025C, F280023 in 80-pin PN package          |                         |                                                         |                                                         |       |   |
| V <sub>(ESD)</sub>                                       | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 <sup>(1)</sup> | All pins                                                | ±2000 | V |
|                                                          |                         | Charged device model (CDM), per AEC Q100-011            | All pins                                                | ±500  |   |
|                                                          |                         |                                                         | Corner pins on 80-pin PN: 1, 20, 21, 40, 41, 60, 61, 80 | ±750  |   |
| F280024, F280024C, F280022 in 64-pin PM package          |                         |                                                         |                                                         |       |   |
| V <sub>(ESD)</sub>                                       | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 <sup>(1)</sup> | All pins                                                | ±2000 | V |
|                                                          |                         | Charged device model (CDM), per AEC Q100-011            | All pins                                                | ±500  |   |
|                                                          |                         |                                                         | Corner pins on 64-pin PM: 1, 16, 17, 32, 33, 48, 49, 64 | ±750  |   |
| F280025, F280025C, F280023, F280021 in 48-pin PT package |                         |                                                         |                                                         |       |   |
| V <sub>(ESD)</sub>                                       | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 <sup>(1)</sup> | All pins                                                | ±2000 | V |
|                                                          |                         | Charged device model (CDM), per AEC Q100-011            | All pins                                                | ±500  |   |
|                                                          |                         |                                                         | Corner pins on 48-pin PT: 1, 12, 13, 24, 25, 36, 37, 48 | ±750  |   |

(1) AEC Q100-002 indicates HBM stressing is done in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

## 5.4 Recommended Operating Conditions

|                                       |                                                                          | MIN                                     | NOM | MAX             | UNIT |
|---------------------------------------|--------------------------------------------------------------------------|-----------------------------------------|-----|-----------------|------|
| Device supply voltage, VDDIO and VDDA | Internal BOR enabled <sup>(1)</sup>                                      | $V_{BOR-VDDIO}(MAX) + V_{BOR-GB}^{(2)}$ | 3.3 | 3.63            | V    |
|                                       | Internal BOR disabled                                                    | 2.8                                     | 3.3 | 3.63            |      |
| Device ground, VSS                    |                                                                          |                                         | 0   |                 | V    |
| Analog ground, VSSA                   |                                                                          |                                         | 0   |                 | V    |
| SR <sub>SUPPLY</sub>                  | Supply ramp rate of VDDIO, VDD, VDDA with respect to VSS. <sup>(3)</sup> |                                         |     | 10 <sup>5</sup> | V/s  |
| t <sub>VDDIO-RAMP</sub>               | VDDIO supply ramp time from 1 V to V <sub>BOR-VDDIO</sub> (MAX)          |                                         |     | 10              | ms   |
| V <sub>IN</sub>                       | Digital input voltage                                                    | VSS – 0.3                               |     | VDDIO + 0.3     | V    |
|                                       | Analog input voltage                                                     | VSSA – 0.3                              |     | VDDA + 0.3      | V    |
| V <sub>BOR-GB</sub>                   | VDDIO BOR guard band <sup>(4)</sup>                                      |                                         | 0.1 |                 | V    |
| Junction temperature, T <sub>J</sub>  | S version <sup>(5)</sup>                                                 | –40                                     |     | 125             | °C   |
| Free-Air temperature, T <sub>A</sub>  | Q version <sup>(5)</sup><br>(AEC Q100 qualification)                     | –40                                     |     | 125             | °C   |

- (1) Internal BOR is enabled by default.
- (2) The VDDIO BOR voltage (V<sub>BOR-VDDIO</sub>[MAX]) in [Electrical Characteristics](#) determines the lower voltage bound for device operation. TI recommends that system designers budget an additional guard band (V<sub>BOR-GB</sub>) as shown in [Figure 5-1](#).
- (3) Supply ramp rate faster than this can trigger the on-chip ESD protection.
- (4) TI recommends V<sub>BOR-GB</sub> to avoid BOR resets due to normal supply noise or load-transient events on the 3.3-V VDDIO system regulator. Good system regulator design and decoupling capacitance (following the system regulator specifications) are important to prevent activation of the BOR during normal device operation. The value of V<sub>BOR-GB</sub> is a system-level design consideration; the voltage listed here is typical for many applications.
- (5) Operation above T<sub>J</sub> = 105°C for extended duration will reduce the lifetime of the device. See [Calculating Useful Lifetimes of Embedded Processors](#) for more information.

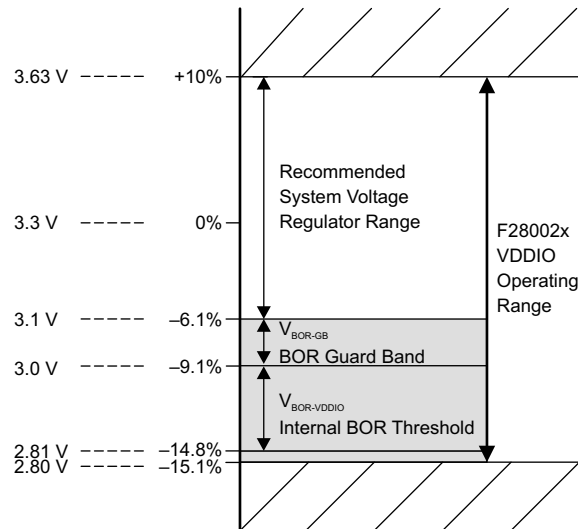


Figure 5-1. Supply Voltages

## 5.5 Power Consumption Summary

Current values listed in this section are representative for the test conditions given and not the absolute maximum possible. The actual device currents in an application will vary with application code and pin configurations. [Table 5-1](#) lists the system current consumption values.

**Table 5-1. System Current Consumption**

over operating free-air temperature range (unless otherwise noted).

TYP :  $V_{nom}$ , 30°C

| PARAMETER           |                                                                     | TEST CONDITIONS                                                                                                                                                                    | MIN  | TYP | MAX | UNIT |
|---------------------|---------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|-----|------|
| OPERATING MODE      |                                                                     |                                                                                                                                                                                    |      |     |     |      |
| I <sub>DDIO</sub>   | VDDIO current consumption during operational usage                  | This is an estimation of current for a typical heavily loaded application. Actual currents will vary depending on system activity, I/O electrical loading and switching frequency. | 35   | 65  | mA  |      |
| I <sub>DDA</sub>    | VDDA current consumption during operational usage                   |                                                                                                                                                                                    | 3    | 5   | mA  |      |
| IDLE MODE           |                                                                     |                                                                                                                                                                                    |      |     |     |      |
| I <sub>DDIO</sub>   | VDDIO current consumption while device is in Idle mode              | - CPU is in IDLE mode<br>- Flash is powered down<br>- XCLKOUT is turned off                                                                                                        | 16   | 25  | mA  |      |
| I <sub>DDA</sub>    | VDDA current consumption while device is in Idle mode               |                                                                                                                                                                                    | 0.01 | 0.1 | mA  |      |
| STANDBY MODE        |                                                                     |                                                                                                                                                                                    |      |     |     |      |
| I <sub>DDIO</sub>   | VDDIO current consumption while device is in Standby mode           | - CPU is in STANDBY mode<br>- Flash is powered down<br>- XCLKOUT is turned off                                                                                                     | 8    | 15  | mA  |      |
| I <sub>DDA</sub>    | VDDA current consumption while device is in Standby mode            |                                                                                                                                                                                    | 0.01 | 0.1 | mA  |      |
| HALT MODE           |                                                                     |                                                                                                                                                                                    |      |     |     |      |
| I <sub>DDIO</sub>   | VDDIO current consumption while device is in Halt mode              | - CPU is in HALT mode<br>- Flash is powered down<br>- XCLKOUT is turned off                                                                                                        | 1    | 10  | mA  |      |
| I <sub>DDA</sub>    | VDDA current consumption while device is in Halt mode               |                                                                                                                                                                                    | 0.01 | 0.1 | mA  |      |
| FLASH ERASE/PROGRAM |                                                                     |                                                                                                                                                                                    |      |     |     |      |
| I <sub>DDIO</sub>   | VDDIO current consumption during Erase/Program cycle <sup>(1)</sup> | - CPU is running from RAM.<br>- SYSCLK at 100 MHz.<br>- I/Os are inputs with pullups enabled.<br>- Peripheral clocks are turned off.                                               | 72   | 106 | mA  |      |
| I <sub>DDA</sub>    | VDDA current consumption during Erase/Program cycle                 |                                                                                                                                                                                    | 0.1  | 2.5 | mA  |      |
| RESET MODE          |                                                                     |                                                                                                                                                                                    |      |     |     |      |
| I <sub>DDIO</sub>   | VDDIO current consumption while reset is active <sup>(2)</sup>      |                                                                                                                                                                                    | 8.6  |     | mA  |      |
| I <sub>DDA</sub>    | VDDA current consumption while reset is active <sup>(2)</sup>       |                                                                                                                                                                                    | 0.1  |     | mA  |      |

(1) Brownout events during flash programming can corrupt flash data and permanently lock the device. Programming environments using alternate power sources (such as a USB programmer) must be capable of supplying the rated current for the device and other system components with sufficient margin to avoid supply brownout conditions.

(2) This is the current consumption while reset is active, i.e XRSn is low.

### 5.5.1 Operating Mode Test Description

Table 5-1 and Table 5-2 list the current consumption values for the operational mode of the device. The operational mode provides an estimation of what an application might encounter. The test condition for these measurements has the following properties:

- Code is executing from RAM.
- FLASH is read and kept in active state.
- No external components are driven by I/O pins.
- All peripherals have clocks enabled.
- All CPUs are actively executing code.
- All analog peripherals are powered up. ADCs and DACs are periodically converting.

### 5.5.2 Reducing Current Consumption

All C2000™ microcontrollers provide some methods to reduce the device current consumption:

- Any one of the three low-power modes—IDLE, STANDBY and HALT—could be entered to reduce the current consumption even further during idle periods in the application.
- The flash module may be powered down if the code is run from RAM.
- Disable the pullups on pins that assume an output function.
- Each peripheral has an individual clock-enable bit (PCLKCRx). Reduced current consumption may be achieved by turning off the clock to any peripheral that is not used in a given application. Table 5-2 lists the typical current reduction value per disabled peripheral at 100-MHz SYSCLK.
- To realize the lowest VDDA current consumption in an LPM, see the respective analog chapter of the [TMS320F28002x Microcontrollers Technical Reference Manual](#) to ensure each module is powered down as well.

**Table 5-2. Typical Current Reduction per Disabled Peripheral**

| PERIPHERAL           | I <sub>DDIO</sub> CURRENT REDUCTION (mA) |
|----------------------|------------------------------------------|
| ADC <sup>(1)</sup>   | 0.8                                      |
| CAN                  | 1.1                                      |
| CLB                  | 1.1                                      |
| CMPSS <sup>(1)</sup> | 0.4                                      |
| CPU TIMER            | 0.1                                      |
| DMA                  | 0.5                                      |
| eCAP1 and eCAP2      | 0.1                                      |
| eCAP3 <sup>(2)</sup> | 0.4                                      |
| ePWM                 | 0.7                                      |
| eQEP                 | 0.1                                      |
| FSI                  | 0.7                                      |
| HRPWM                | 0.8                                      |
| I2C                  | 0.3                                      |
| LIN                  | 0.4                                      |
| PMBUS                | 0.3                                      |
| SCI                  | 0.2                                      |
| SPI                  | 0.2                                      |
| DCC                  | 0.1                                      |

(1) This current represents the current drawn by the digital portion of the each module.

(2) eCAP3 can also be configured as HRCAP.

## 5.6 Electrical Characteristics

over recommended operating conditions (unless otherwise noted)

| PARAMETER               |                                                      |                                                   | TEST CONDITIONS                                               | MIN         | TYP | MAX  | UNIT |
|-------------------------|------------------------------------------------------|---------------------------------------------------|---------------------------------------------------------------|-------------|-----|------|------|
| Digital and Analog IO   |                                                      |                                                   |                                                               |             |     |      |      |
| V <sub>OH</sub>         | High-level output voltage                            |                                                   | I <sub>OH</sub> = I <sub>OH</sub> MIN                         | VDDIO * 0.8 |     |      | V    |
|                         |                                                      |                                                   | I <sub>OH</sub> = −100 μA                                     | VDDIO − 0.2 |     |      |      |
| V <sub>OL</sub>         | Low-level output voltage                             |                                                   | I <sub>OL</sub> = I <sub>OL</sub> MAX                         |             |     | 0.4  | V    |
|                         |                                                      |                                                   | I <sub>OL</sub> = 100 μA                                      |             |     | 0.2  |      |
| I <sub>OH</sub>         | High-level output source current for all output pins |                                                   |                                                               | −4          |     |      | mA   |
| I <sub>OL</sub>         | Low-level output sink current for all output pins    |                                                   |                                                               |             |     | 4    | mA   |
| R <sub>OH</sub>         | High-level output impedance for all output pins      |                                                   |                                                               | 70          |     |      | Ω    |
| R <sub>OL</sub>         | Low-level output impedance for all output pins       |                                                   |                                                               | 70          |     |      | Ω    |
| V <sub>IH</sub>         | High-level input voltage                             |                                                   |                                                               | 2.0         |     |      | V    |
| V <sub>IL</sub>         | Low-level input voltage                              |                                                   |                                                               |             |     | 0.8  | V    |
| V <sub>HYSTERESIS</sub> | Input hysteresis                                     |                                                   |                                                               | 125         |     |      | mV   |
| I <sub>PULLDOWN</sub>   | Input current                                        | Pins with pulldown                                | VDDIO = 3.3 V<br>V <sub>IN</sub> = VDDIO                      | 120         |     |      | μA   |
| I <sub>PULLUP</sub>     | Input current                                        | Digital inputs with pullup enabled <sup>(1)</sup> | VDDIO = 3.3 V<br>V <sub>IN</sub> = 0 V                        | 160         |     |      | μA   |
| I <sub>LEAK</sub>       | Pin leakage                                          | Digital inputs                                    | Pullups and outputs disabled<br>0 V ≤ V <sub>IN</sub> ≤ VDDIO |             |     | 0.1  | μA   |
|                         |                                                      | Analog pins (except ADCINA3/VDAC)                 | Analog drivers disabled<br>0 V ≤ V <sub>IN</sub> ≤ VDDA       |             |     | 0.1  |      |
|                         |                                                      | ADCINA3/VDAC                                      |                                                               | 2           | 11  |      |      |
| C <sub>I</sub>          | Input capacitance                                    | Digital inputs                                    |                                                               | 2           |     |      | pF   |
|                         |                                                      | Analog pins <sup>(2)</sup>                        |                                                               |             |     |      |      |
| VREG and BOR            |                                                      |                                                   |                                                               |             |     |      |      |
| V <sub>POR-VDDIO</sub>  | VDDIO power on reset voltage                         | VDDIO power on reset voltage                      |                                                               | 2.3         |     |      | V    |
| V <sub>BOR-VDDIO</sub>  | VDDIO brown out reset voltage <sup>(3)</sup>         |                                                   |                                                               | 2.81        |     | 3.0  | V    |
| V <sub>VREG</sub>       | Internal voltage regulator output                    |                                                   |                                                               | 1.14        | 1.2 | 1.32 | V    |

(1) See [Table 4-8](#) for a list of pins with a pullup or pulldown.

(2) The analog pins are specified separately; see [Table 5-40](#).

(3) See the Supply Voltages figure in the Recommended Operating Conditions section.

## 5.7 Thermal Design Considerations

Based on the end application design and operational profile, the I<sub>DD</sub> and I<sub>DDIO</sub> currents could vary. Systems that exceed the recommended maximum power dissipation in the end product may require additional thermal enhancements. Ambient temperature (T<sub>A</sub>) varies with the end application and product design. The critical factor that affects reliability and functionality is T<sub>J</sub>, the junction temperature, not the ambient temperature. Hence, care should be taken to keep T<sub>J</sub> within the specified limits. T<sub>case</sub> should be measured to estimate the operating junction temperature T<sub>J</sub>. T<sub>case</sub> is normally measured at the center of the package top-side surface. The thermal application report [Semiconductor and IC Package Thermal Metrics](#) helps to understand the thermal metrics and definitions.

## 5.8 System

### 5.8.1 Power Management

TMS320F28002x MCUs use an internal 1.2-V LDO Voltage Regulator (VREG) to supply the required 1.2 V to the core (VDD).

#### 5.8.1.1 Internal 1.2-V LDO Voltage Regulator (VREG)

The internal VREG is supplied by VDDIO and generates the 1.2 V required to power the VDD pins. The internal VREG is always enabled and, as such, is the required supply source for the VDD pins. Although the internal VREG eliminates the need to use an external power supply for VDD, decoupling capacitors are required on each VDD pin for VREG stability. There are two recommended capacitor configurations (described in the list that follows) for the VDD rail when using the internal VREG. The signal description for VDD can be found in [Table 4-4](#).

- Configuration 1: Place a small decoupling capacitor to VSS on each pin as close to the device as possible. In addition, a bulk capacitance must be placed on the VDD node to VSS (one 20-μF capacitor or two parallel 10-μF capacitors).
- Configuration 2: Distribute the total capacitance to VSS evenly across all VDD pins (total capacitance divided by number of available VDD pins).

#### 5.8.1.2 Power Sequencing

**Signal Pin Requirements:** Before powering the device, no voltage larger than 0.3 V above VDDIO can be applied to any digital pin, and no voltage larger than 0.3 V above VDDA can be applied to any analog pin (including VREFHI).

**VDDIO and VDDA Requirements:** The 3.3-V supplies VDDIO and VDDA should be powered up together and kept within 0.3 V of each other during functional operation.

**VDD Requirements:** The VDD sequencing requirements are handled by the device.

#### 5.8.1.3 Power-On Reset (POR)

An internal power-on reset (POR) circuit holds the device in reset and keeps the I/Os in a high-impedance state during power up. The POR is in control and forces XRSn low internally until the voltage on VDDIO crosses the POR threshold. When the voltage crosses the POR threshold, the internal brownout-reset (BOR) circuit takes control and holds the device in reset until the voltage crosses the BOR threshold (for internal BOR details, see [Section 5.8.1.4](#)).

#### 5.8.1.4 Brownout Reset (BOR)

An internal BOR circuit monitors the VDDIO rail for dips in voltage which result in the supply voltage dropping out of operational range. When the VDDIO voltage drops below the BOR threshold, the device is forced into reset, and XRSn is pulled low. XRSn will remain in reset until the voltage returns to the operational range. The BOR is enabled by default. To disable the BOR, set the BORLVMONDIS bit in the VMONCTL register. The internal BOR circuit monitors only the VDDIO rail. See [Section 5.6](#) for BOR characteristics. External supply voltage supervisor (SVS) devices can be used to monitor the voltage on the 3.3-V rail and to drive XRSn low if supplies fall outside operational specifications.

## 5.8.2 Reset Timing

XRSn is the device reset pin. It functions as an input and open-drain output. The device has a built-in power-on reset (POR). During power up, the POR circuit drives the XRSn pin low. A watchdog or NMI watchdog reset will also drive the pin low. An external open-drain circuit may drive the pin to assert a device reset.

A resistor with a value from 2.2 kΩ to 10 kΩ should be placed between XRSn and VDDIO. A capacitor should be placed between XRSn and VSS for noise filtering, it should be 100 nF or smaller. These values will allow the watchdog to properly drive the XRSn pin to  $V_{OL}$  within 512 OSCCLK cycles when the watchdog reset is asserted. Figure 5-2 shows the recommended reset circuit.

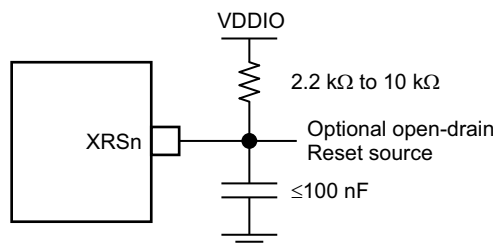


Figure 5-2. Reset Circuit

### 5.8.2.1 Reset Sources

Table 5-3 summarizes the various reset signals and their effect on the device.

Table 5-3. Reset Signals

| RESET SOURCE           | CPU CORE RESET (C28x, FPU, VCU) | PERIPHERALS RESET | JTAG/ DEBUG LOGIC RESET | I/Os | XRSn OUTPUT |
|------------------------|---------------------------------|-------------------|-------------------------|------|-------------|
| POR                    | Yes                             | Yes               | Yes                     | Hi-Z | Yes         |
| XRSn Pin               | Yes                             | Yes               | No                      | Hi-Z | –           |
| WDRS                   | Yes                             | Yes               | No                      | Hi-Z | Yes         |
| NMIWDRS                | Yes                             | Yes               | No                      | Hi-Z | Yes         |
| SYSRS (Debugger Reset) | Yes                             | Yes               | No                      | Hi-Z | No          |
| SCCRESET               | Yes                             | Yes               | No                      | Hi-Z | No          |

The parameter  $t_{h(\text{boot-mode})}$  must account for a reset initiated from any of these sources.

See the Resets section of the System Control chapter in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

#### CAUTION

Some reset sources are internally driven by the device. Some of these sources will drive XRSn low, use this to disable any other devices driving the boot pins. The SCCRESET and debugger reset sources do not drive XRSn; therefore, the pins used for boot mode should not be actively driven by other devices in the system. The boot configuration has a provision for changing the boot pins in OTP; for more details, see the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

## 5.8.2.2 Reset Electrical Data and Timing

Table 5-4 lists the reset (XRSn) timing requirements. Table 5-5 lists the reset (XRSn) switching characteristics. Figure 5-3 shows the power-on reset. Figure 5-4 shows the warm reset.

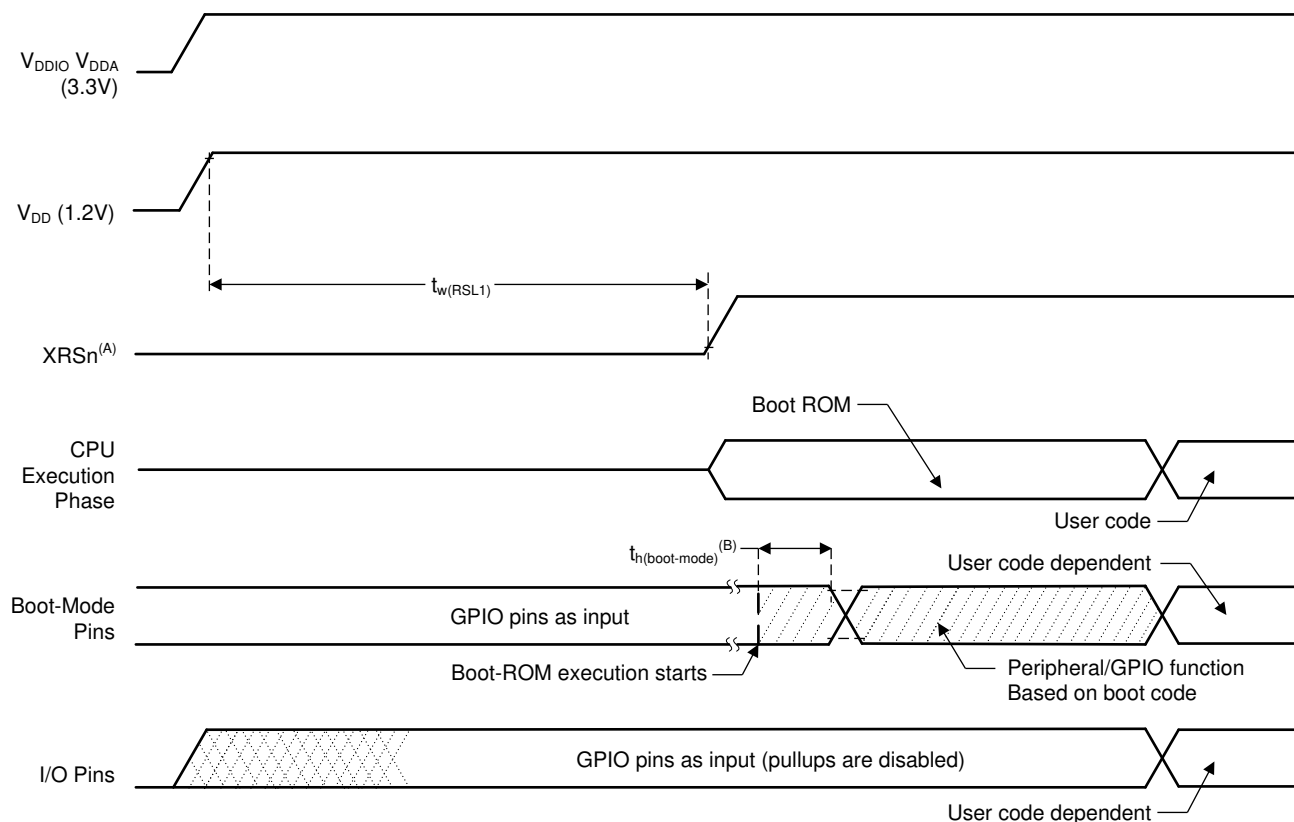
**Table 5-4. Reset (XRSn) Timing Requirements**

|                           |                                        | MIN | MAX | UNIT          |
|---------------------------|----------------------------------------|-----|-----|---------------|
| $t_{h(\text{boot-mode})}$ | Hold time for boot-mode pins           | 1.5 |     | ms            |
| $t_{w(\text{RSL2})}$      | Pulse duration, XRSn low on warm reset | 3.2 |     | $\mu\text{s}$ |

**Table 5-5. Reset (XRSn) Switching Characteristics**

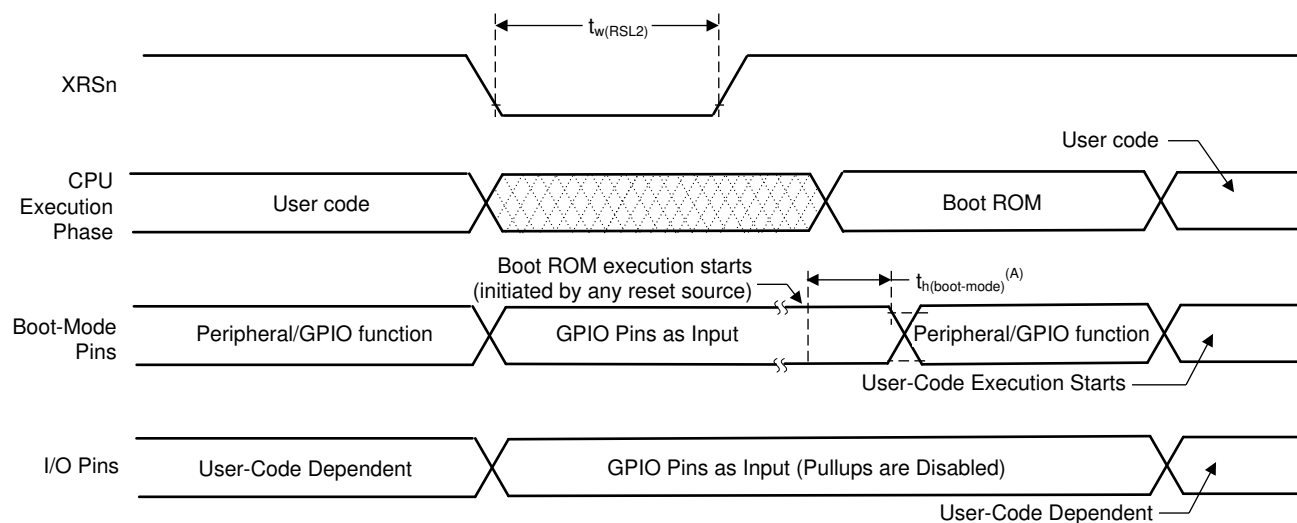
over recommended operating conditions (unless otherwise noted)

| PARAMETER            |                                                                     | MIN | TYP                       | MAX | UNIT          |
|----------------------|---------------------------------------------------------------------|-----|---------------------------|-----|---------------|
| $t_{w(\text{RSL1})}$ | Pulse duration, XRSn driven low by device after supplies are stable |     | 100                       |     | $\mu\text{s}$ |
| $t_{w(\text{WDRS})}$ | Pulse duration, reset pulse generated by watchdog                   |     | $512t_{c(\text{OSCCLK})}$ |     | cycles        |



- The XRSn pin can be driven externally by a supervisor or an external pullup resistor, see Table 4-1. On-chip POR logic will hold this pin low until the supplies are in a valid range.
- After reset from any source (see Section 5.8.2.1), the boot ROM code samples Boot Mode pins. Based on the status of the Boot Mode pin, the boot code branches to destination memory or boot code function. If boot ROM code executes after power-on conditions (in debugger environment), the boot code execution time is based on the current SYSCLK speed. The SYSCLK will be based on user environment and could be with or without PLL enabled.

**Figure 5-3. Power-on Reset**



- A. After reset from any source (see [Section 5.8.2.1](#)), the Boot ROM code samples BOOT Mode pins. Based on the status of the Boot Mode pin, the boot code branches to destination memory or boot code function. If Boot ROM code executes after power-on conditions (in debugger environment), the Boot code execution time is based on the current SYSCLK speed. The SYSCLK will be based on user environment and could be with or without PLL enabled.

**Figure 5-4. Warm Reset**

### 5.8.3 Clock Specifications

#### 5.8.3.1 Clock Sources

Table 5-6 lists clock sources. Figure 5-5 shows the clocking system. Figure 5-6 shows the PLL.

**Table 5-6. Possible Reference Clock Sources**

| CLOCK SOURCE           | DESCRIPTION                                                                                                       |
|------------------------|-------------------------------------------------------------------------------------------------------------------|
| INTOSC1                | Internal oscillator 1.<br>Zero-pin overhead 10-MHz internal oscillator.                                           |
| INTOSC2 <sup>(1)</sup> | Internal oscillator 2.<br>Zero-pin overhead 10-MHz internal oscillator.                                           |
| X1 (XTAL)              | External crystal or resonator connected between the X1 and X2 pins or single-ended clock connected to the X1 pin. |

(1) On reset, internal oscillator 2 (INTOSC2) is the default clock source for the PLL (OSCCLK).

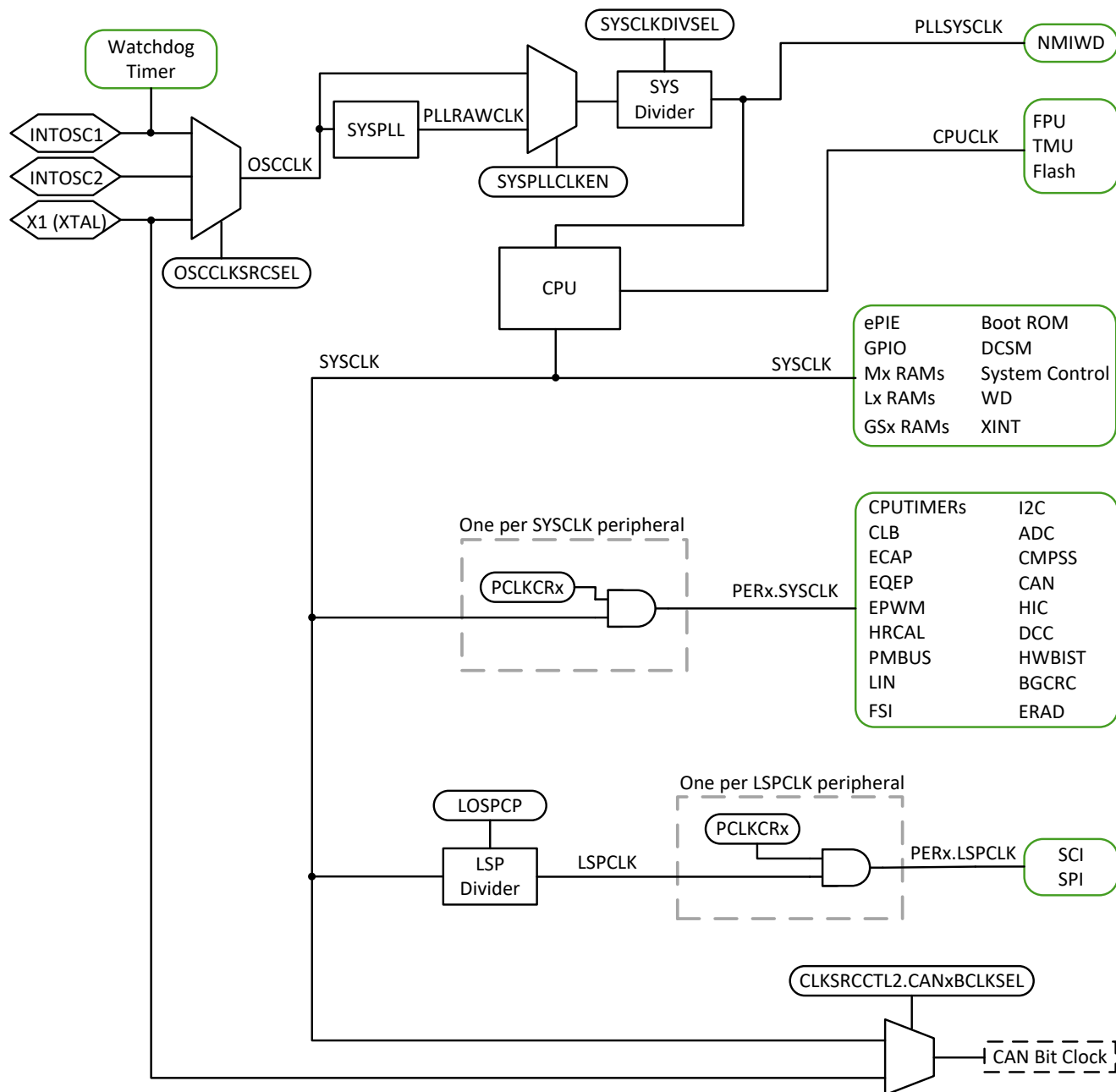


Figure 5-5. Clocking System

## SYSPLL

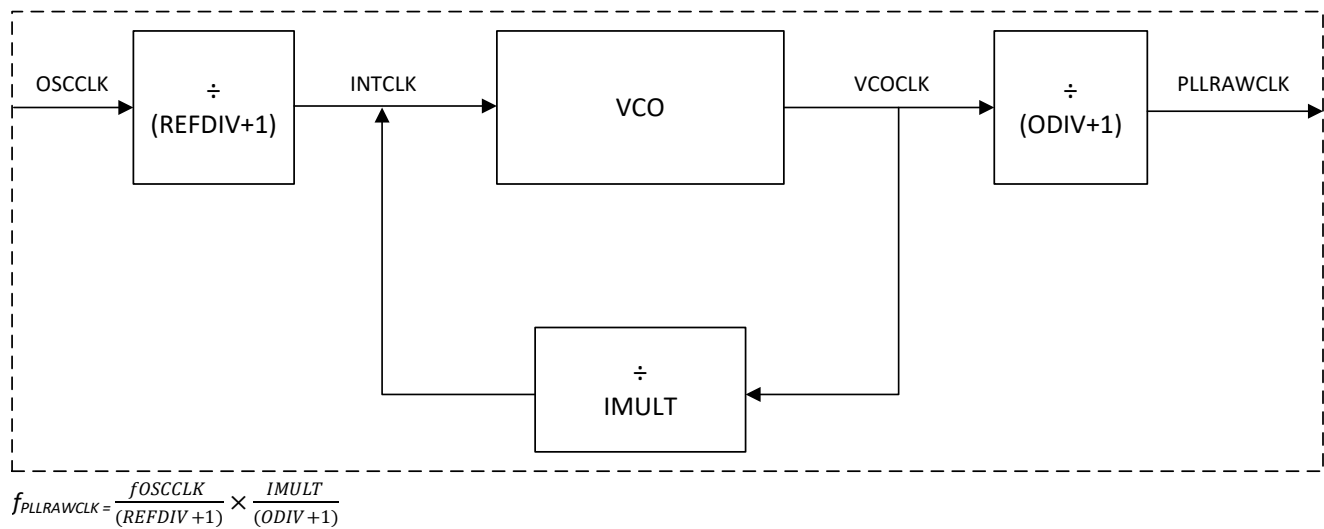


Figure 5-6. System PLL

### 5.8.3.2 Clock Frequencies, Requirements, and Characteristics

This section provides the frequencies and timing requirements of the input clocks, PLL lock times, frequencies of the internal clocks, and the frequency and switching characteristics of the output clock.

#### 5.8.3.2.1 Input Clock Frequency and Timing Requirements, PLL Lock Times

Table 5-7 lists the frequency requirements for the input clocks. Table 5-8 lists the XTAL oscillator characteristics. Table 5-9 lists the X1 timing requirements. Table 5-10 lists the APLL characteristics. Table 5-11 lists the switching characteristics of the output clock, XCLKOUT. Table 5-12 provides the clock frequencies for the internal clocks.

**Table 5-7. Input Clock Frequency**

|              |                                                      | MIN | MAX | UNIT |
|--------------|------------------------------------------------------|-----|-----|------|
| $f_{(XTAL)}$ | Frequency, X1/X2, from external crystal or resonator | 10  | 20  | MHz  |
| $f_{(X1)}$   | Frequency, X1, from external oscillator              | 10  | 25  | MHz  |

**Table 5-8. XTAL Oscillator Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER   |                                | MIN         | TYP | MAX         | UNIT |
|-------------|--------------------------------|-------------|-----|-------------|------|
| X1 $V_{IL}$ | Valid low-level input voltage  | −0.3        |     | 0.3 * VDDIO | V    |
| X1 $V_{IH}$ | Valid high-level input voltage | 0.7 * VDDIO |     | VDDIO + 0.3 | V    |

**Table 5-9. X1 Timing Requirements**

|              |                                                        | MIN | MAX | UNIT |
|--------------|--------------------------------------------------------|-----|-----|------|
| $t_{f(X1)}$  | Fall time, X1                                          |     | 6   | ns   |
| $t_{r(X1)}$  | Rise time, X1                                          |     | 6   | ns   |
| $t_{w(X1L)}$ | Pulse duration, X1 low as a percentage of $t_{c(X1)}$  | 45% | 55% |      |
| $t_{w(X1H)}$ | Pulse duration, X1 high as a percentage of $t_{c(X1)}$ | 45% | 55% |      |

**Table 5-10. APLL Characteristics**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                        | MIN | TYP                                              | MAX | UNIT |
|----------------------------------|-----|--------------------------------------------------|-----|------|
| <b>PLL Lock time</b>             |     |                                                  |     |      |
| SYS PLL Lock Time <sup>(1)</sup> |     | $5\mu s + (1024 * (REFDIV + 1) * t_{c(OSCCLK)})$ |     | us   |

- (1) The PLL lock time here defines the typical time that takes for the PLL to lock once PLL is enabled (SYSPLLCTL1[PLLENA]=1). Additional time to verify the PLL clock using Dual Clock Comparator (DCC) is not accounted here. TI recommends using the latest example software from C2000Ware for initializing the PLLs. For the system PLL, see InitSysPll() or SysCtl\_setClock().

**Table 5-11. XCLKOUT Switching Characteristics<sup>(1)(2)</sup>**

over recommended operating conditions (unless otherwise noted)

| PARAMETER     |                              | MIN   | MAX   | UNIT |
|---------------|------------------------------|-------|-------|------|
| $t_{f(XCO)}$  | Fall time, XCLKOUT           |       | 5     | ns   |
| $t_{r(XCO)}$  | Rise time, XCLKOUT           |       | 5     | ns   |
| $t_{w(XCOL)}$ | Pulse duration, XCLKOUT low  | H − 2 | H + 2 | ns   |
| $t_{w(XCOH)}$ | Pulse duration, XCLKOUT high | H − 2 | H + 2 | ns   |
| $f_{(XCO)}$   | Frequency, XCLKOUT           |       | 50    | MHz  |

- (1) A load of 40 pF is assumed for these parameters.

- (2)  $H = 0.5t_{c(XCO)}$

**Table 5-12. Internal Clock Frequencies**

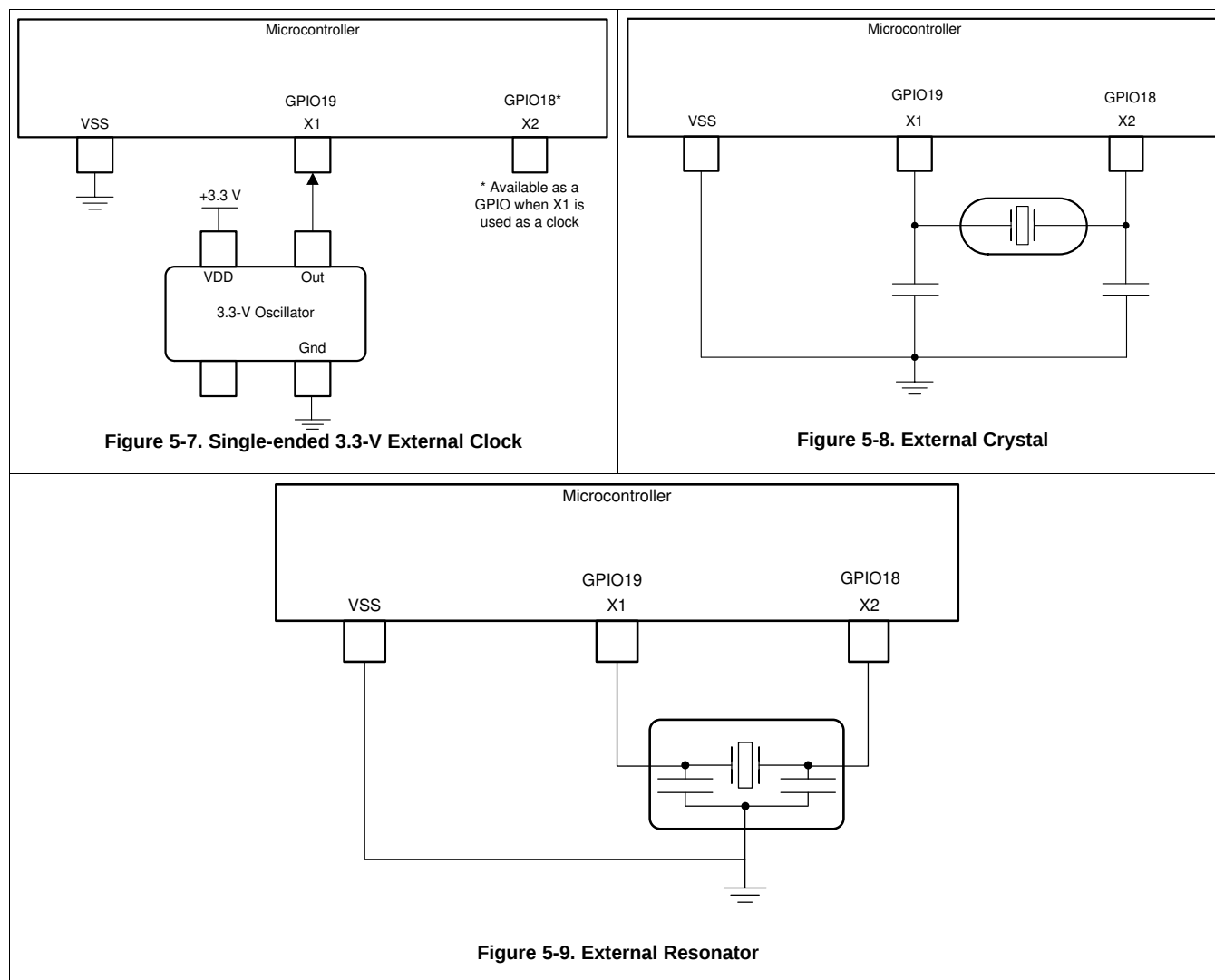
|                          |                                                      | MIN | NOM                  | MAX | UNIT |
|--------------------------|------------------------------------------------------|-----|----------------------|-----|------|
| $f_{\text{(SYSCLK)}}$    | Frequency, device (system) clock                     | 2   |                      | 100 | MHz  |
| $t_{\text{c(SYSCLK)}}$   | Period, device (system) clock                        | 10  |                      | 500 | ns   |
| $f_{\text{(INTCLK)}}$    | Frequency, system PLL going into VCO (after REFDIV)  | 10  |                      | 20  | MHz  |
| $f_{\text{(VCOCLK)}}$    | Frequency, system PLL VCO (before ODIV)              | 220 |                      | 500 | MHz  |
| $f_{\text{(PLLRAWCLK)}}$ | Frequency, system PLL output (before SYSCLK divider) | 6   |                      | 200 | MHz  |
| $f_{\text{(PLL)}}$       | Frequency, PLLSYSCLK                                 | 2   |                      | 100 | MHz  |
| $f_{\text{(PLL\_LIMP)}}$ | Frequency, PLL Limp Frequency <sup>(1)</sup>         |     | 45/(ODIV+1)          |     | MHz  |
| $f_{\text{(LSP)}}$       | Frequency, LSPCLK                                    | 2   |                      | 100 | MHz  |
| $t_{\text{c(LSPCLK)}}$   | Period, LSPCLK                                       | 10  |                      | 500 | ns   |
| $f_{\text{(OSCCLK)}}$    | Frequency, OSCCLK (INTOSC1 or INTOSC2 or XTAL or X1) |     | See respective clock |     | MHz  |
| $f_{\text{(EPWM)}}$      | Frequency, EPWMCLK                                   |     |                      | 100 | MHz  |
| $f_{\text{(HRPWM)}}$     | Frequency, HRPWMCLK                                  | 60  |                      | 100 | MHz  |

(1) PLL output frequency when OSCCLK is dead (Loss of OSCCLK causes PLL to Limp).

### 5.8.3.3 Input Clocks and PLLs

In addition to the internal 0-pin oscillators, three types of external clock sources are supported:

- A single-ended 3.3-V external clock. The clock signal should be connected to X1, as shown in [Figure 5-7](#), with the XTALCR.SE bit set to 1.
- An external crystal. The crystal should be connected across X1 and X2 with its load capacitors connected to VSS as shown in [Figure 5-8](#).
- An external resonator. The resonator should be connected across X1 and X2 with its ground connected to VSS as shown in [Figure 5-9](#).



### 5.8.3.4 Crystal Oscillator

When using a quartz crystal, it may be necessary to include a damping resistor ( $R_D$ ) in the crystal circuit to prevent overdriving the crystal (drive level can be found in the crystal data sheet). In higher-frequency applications (10 MHz or greater),  $R_D$  is generally not required. If a damping resistor is required,  $R_D$  should be as small as possible because the size of the resistance affects start-up time (smaller  $R_D$  = faster start-up time). TI recommends that the crystal manufacturer characterize the crystal with the application board. [Table 5-13](#) lists the crystal oscillator parameters. [Table 5-14](#) lists the crystal equivalent series resistance (ESR) requirements. [Table 5-15](#) lists the crystal oscillator electrical characteristics.

**Table 5-13. Crystal Oscillator Parameters**

|          |                           | MIN | MAX | UNIT |
|----------|---------------------------|-----|-----|------|
| CL1, CL2 | Load capacitance          | 12  | 24  | pF   |
| C0       | Crystal shunt capacitance |     | 7   | pF   |

**Table 5-14. Crystal Equivalent Series Resistance (ESR) Requirements<sup>(1)(2)</sup>**

| CRYSTAL FREQUENCY (MHz) | MAXIMUM ESR ( $\Omega$ )<br>(CL1 = CL2 = 12 pF) | MAXIMUM ESR ( $\Omega$ )<br>(CL1 = CL2 = 24 pF) |
|-------------------------|-------------------------------------------------|-------------------------------------------------|
| 10                      | 55                                              | 110                                             |
| 12                      | 50                                              | 95                                              |
| 14                      | 50                                              | 90                                              |
| 16                      | 45                                              | 75                                              |
| 18                      | 45                                              | 65                                              |
| 20                      | 45                                              | 50                                              |

(1) Crystal shunt capacitance (C0) should be less than or equal to 7 pF.

(2) ESR = Negative Resistance/3

**Table 5-15. Crystal Oscillator Electrical Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER                    | TEST CONDITIONS                                                       | MIN | TYP | MAX | UNIT |
|------------------------------|-----------------------------------------------------------------------|-----|-----|-----|------|
| Start-up time <sup>(1)</sup> | f = 20 MHz<br>ESR MAX = 50 $\Omega$<br>CL1 = CL2 = 24 pF<br>C0 = 7 pF |     | 2   |     | ms   |
| Crystal drive level (DL)     |                                                                       |     |     | 1   | mW   |

(1) Start-up time is dependent on the crystal and tank circuit components. TI recommends that the crystal vendor characterize the application with the chosen crystal.

### 5.8.3.5 Internal Oscillators

To reduce production board costs and application development time, all F28002x devices contain two independent internal oscillators, referred to as INTOSC1 and INTOSC2. By default, both oscillators are enabled at power up. INTOSC2 is set as the source for the system reference clock (OSCCLK) and INTOSC1 is set as the backup clock source. INTOSC1 can also be manually configured as the system reference clock (OSCCLK). [Table 5-16](#) provides the electrical characteristics of the internal oscillators to determine if this module meets the clocking requirements of the application.

**Table 5-16. INTOSC Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER                     |                                         | TEST CONDITIONS   | MIN | TYP  | MAX  | UNIT |
|-------------------------------|-----------------------------------------|-------------------|-----|------|------|------|
| $f_{\text{INTOSC}}$           | Frequency, INTOSC1 and INTOSC2          |                   | 9.7 | 10   | 10.3 | MHz  |
| $f_{\text{INTOSC-STABILITY}}$ | Frequency stability at room temperature | 30°C, Nominal VDD |     | ±0.1 |      | %    |
|                               | Frequency stability                     |                   | –3  |      | 3    | %    |
| $t_{\text{INTOSC-ST}}$        | Start-up and settling time              |                   |     |      | 20   | µs   |

## 5.8.4 Flash Parameters

Table 5-17 lists the minimum required Flash wait states with different clock sources and frequencies.

**Table 5-17. Minimum Required Flash Wait States with Different Clock Sources and Frequencies<sup>(1)</sup>**

| CPUCLK (MHz)      | EXTERNAL OSCILLATOR OR CRYSTAL |                                           | INTOSC1 OR INTOSC2    |                                                          |
|-------------------|--------------------------------|-------------------------------------------|-----------------------|----------------------------------------------------------|
|                   | FLASH READ OR EXECUTE          | PROGRAM, ERASE, BANK SLEEP, OR PUMP SLEEP | FLASH READ OR EXECUTE | PROGRAM, ERASE, BANK SLEEP, OR PUMP SLEEP <sup>(2)</sup> |
| 97 < CPUCLK ≤ 100 | 4                              |                                           | 4                     | 5                                                        |
| 80 < CPUCLK ≤ 97  |                                |                                           |                       | 4                                                        |
| 77 < CPUCLK ≤ 80  |                                |                                           |                       | 4                                                        |
| 60 < CPUCLK ≤ 77  | 3                              |                                           | 3                     | 3                                                        |
| 58 < CPUCLK ≤ 60  |                                |                                           |                       | 3                                                        |
| 40 < CPUCLK ≤ 58  | 2                              |                                           | 2                     | 2                                                        |
| 38 < CPUCLK ≤ 40  |                                |                                           |                       | 2                                                        |
| 20 < CPUCLK ≤ 38  | 1                              |                                           | 1                     | 1                                                        |
| 19 < CPUCLK ≤ 20  |                                |                                           |                       | 1                                                        |
| CPUCLK ≤ 19       | 0                              |                                           | 0                     | 0                                                        |

- (1) Minimum required FRDCNTL[RWAIT].
- (2) PROGRAM, ERASE, or SLEEP operations require an extra wait state when using INTOSC as the clock source for the frequency ranges indicated. Any wait state FRDCNTL[RWAIT] change must be made before beginning a PROGRAM, ERASE, or SLEEP mode operation. This setting impacts both flash banks. Applications which perform simultaneous READ of one bank and PROGRAM or ERASE of the other bank must use the higher RWAIT setting during the PROGRAM or ERASE operation or use a clock source or frequency with a common wait state setting.

The F28002x devices have an improved 128-bit prefetch buffer that provides high flash code execution efficiency across wait states. Figure 5-10 and Figure 5-11 illustrate typical efficiency across wait-state settings compared to previous-generation devices with a 64-bit prefetch buffer. Wait-state execution efficiency with a prefetch buffer will depend on how many branches are present in application software. Two examples of linear code and if-then-else code are provided.

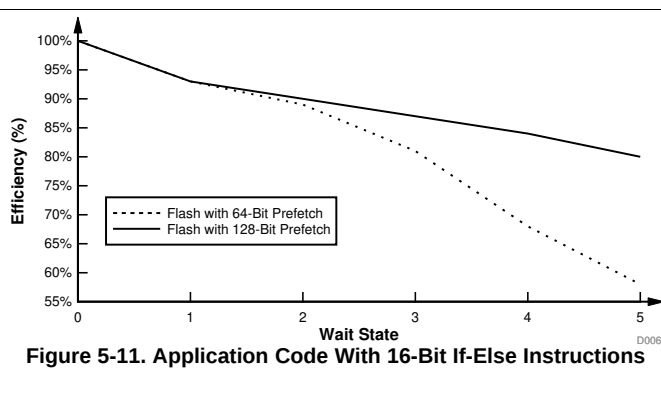
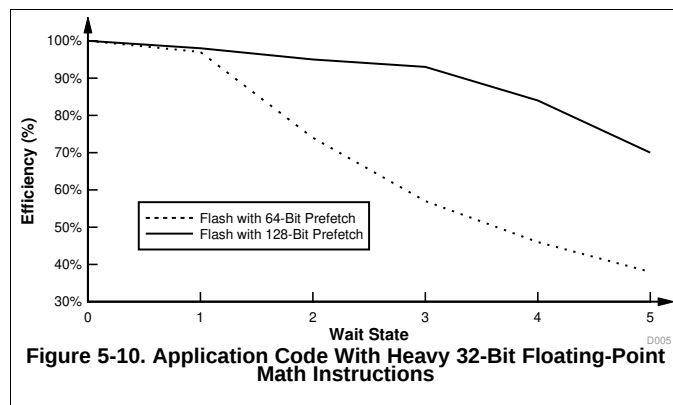


Table 5-18 lists the Flash parameters.

**Table 5-18. Flash Parameters**

| PARAMETER                                                               |                             | MIN | TYP | MAX   | UNIT   |
|-------------------------------------------------------------------------|-----------------------------|-----|-----|-------|--------|
| Program Time <sup>(1)</sup>                                             | 128 data bits + 16 ECC bits |     | 150 | 300   | μs     |
|                                                                         | 8KB sector                  |     | 50  | 100   | ms     |
| EraseTime <sup>(2)</sup> at < 25 cycles                                 | 8KB sector                  |     | 15  | 100   | ms     |
| EraseTime <sup>(2)</sup> at 1000 cycles                                 | 8KB sector                  |     | 25  | 350   | ms     |
| EraseTime <sup>(2)</sup> at 2000 cycles                                 | 8KB sector                  |     | 30  | 600   | ms     |
| EraseTime <sup>(2)</sup> at 20K cycles                                  | 8KB sector                  |     | 120 | 4000  | ms     |
| N <sub>wec</sub> Write/Erase Cycles                                     |                             |     |     | 20000 | cycles |
| t <sub>retention</sub> Data retention duration at T <sub>J</sub> = 85°C |                             | 20  |     |       | years  |

- (1) Program time is at the maximum device frequency. Program time includes overhead of the flash state machine but does not include the time to transfer the following into RAM:
- Code that uses flash API to program the flash
  - Flash API itself
  - Flash data to be programmed
- In other words, the time indicated in this table is applicable after all the required code/data is available in the device RAM, ready for programming. The transfer time will significantly vary depending on the speed of the JTAG debug probe used. Program time calculation is based on programming 144 bits at a time at the specified operating frequency. Program time includes Program verify by the CPU. The program time does not degrade with write/erase (W/E) cycling, but the erase time does. Erase time includes Erase verify by the CPU and does not involve any data transfer.
- (2) Erase time includes Erase verify by the CPU.

#### NOTE

The Main Array flash programming must be aligned to 64-bit address boundaries and each 64-bit word may only be programmed once per write/erase cycle.

The DCSM OTP programming must be aligned to 128-bit address boundaries and each 128-bit word may only be programmed once. The exceptions are:

1. The DCSM Zx-LINKPOINTER1 and Zx-LINKPOINTER2 values in the DCSM OTP should be programmed together, and may be programmed 1 bit at a time as required by the DCSM operation.
2. The DCSM Zx-LINKPOINTER3 values in the DCSM OTP may be programmed 1 bit at a time on a 64-bit boundary to separate it from Zx-PSWDLOCK, which must only be programmed once.

### 5.8.5 Emulation/JTAG

The JTAG (IEEE Standard 1149.1-1990 Standard Test Access Port and Boundary Scan Architecture) port has four dedicated pins: TMS, TDI, TDO, and TCK. The cJTAG (IEEE Standard 1149.7-2009 for Reduced-Pin and Enhanced-Functionality Test Access Port and Boundary-Scan Architecture) port is a compact JTAG interface requiring only two pins (TMS and TCK), which allows other device functionality to be muxed to the traditional GPIO35 (TDI) and GPIO37 (TDO) pins.

Typically, no buffers are needed on the JTAG signals when the distance between the MCU target and the JTAG header is smaller than 6 inches (15.24 cm), and no other devices are present on the JTAG chain. Otherwise, each signal should be buffered. Additionally, for most JTAG debug probe operations at 10 MHz, no series resistors are needed on the JTAG signals. However, if high emulation speeds are expected (35 MHz or so), 22-Ω resistors should be placed in series on each JTAG signal.

The PD (Power Detect) terminal of the JTAG debug probe header should be connected to the board's 3.3-V supply. Header GND terminals should be connected to board ground. TDIS (Cable Disconnect Sense) should also be connected to board ground. The JTAG clock should be looped from the header TCK output terminal back to the RTCK input terminal of the header (to sense clock continuity by the JTAG debug probe). This MCU does not support the EMU0 and EMU1 signals that are present on 14-pin and 20-pin emulation headers. These signals should always be pulled up at the emulation header through a pair of board pullup resistors ranging from 2.2 kΩ to 4.7 kΩ (depending on the drive strength of the debugger ports). Typically, a 2.2-kΩ value is used.

Header terminal  $\overline{\text{RESET}}$  is an open-drain output from the JTAG debug probe header that enables board components to be reset through JTAG debug probe commands (available only through the 20-pin header). [Figure 5-12](#) shows how the 14-pin JTAG header connects to the MCU's JTAG port signals. [Figure 5-13](#) shows how to connect to the 20-pin JTAG header. The 20-pin JTAG header terminals EMU2, EMU3, and EMU4 are not used and should be grounded.

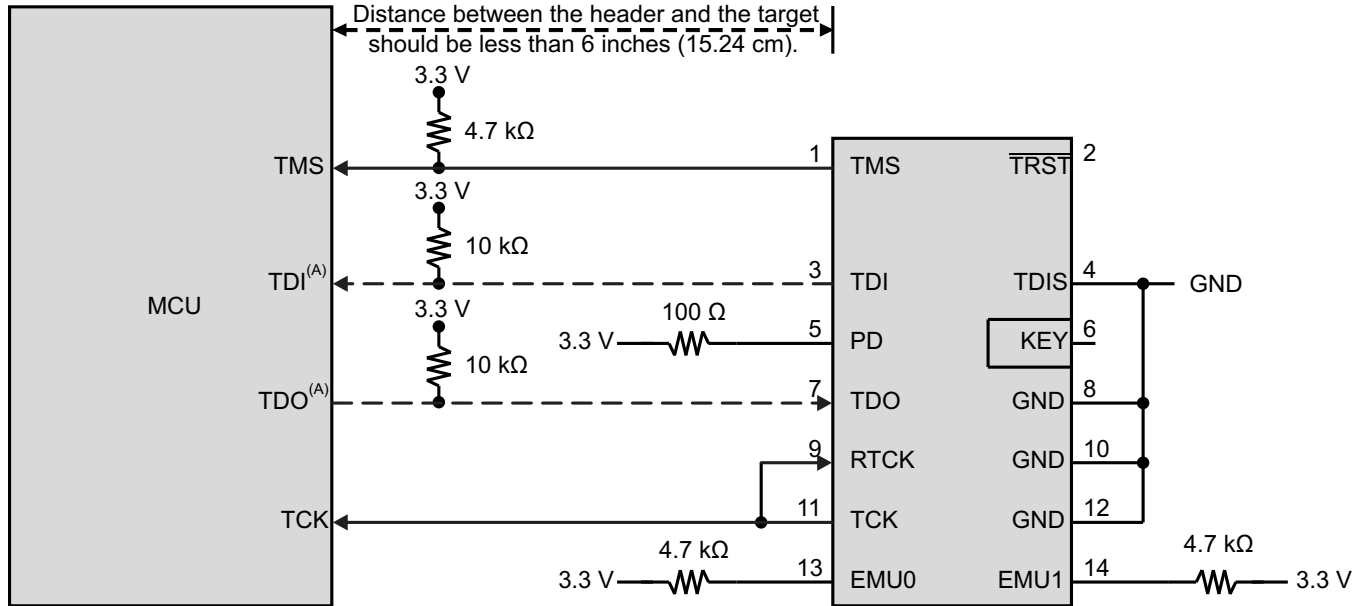
For more information about hardware breakpoints and watchpoints, see [Hardware Breakpoints and Watchpoints for C28x in CCS](#).

For more information about JTAG emulation, see the [XDS Target Connection Guide](#).

#### NOTE

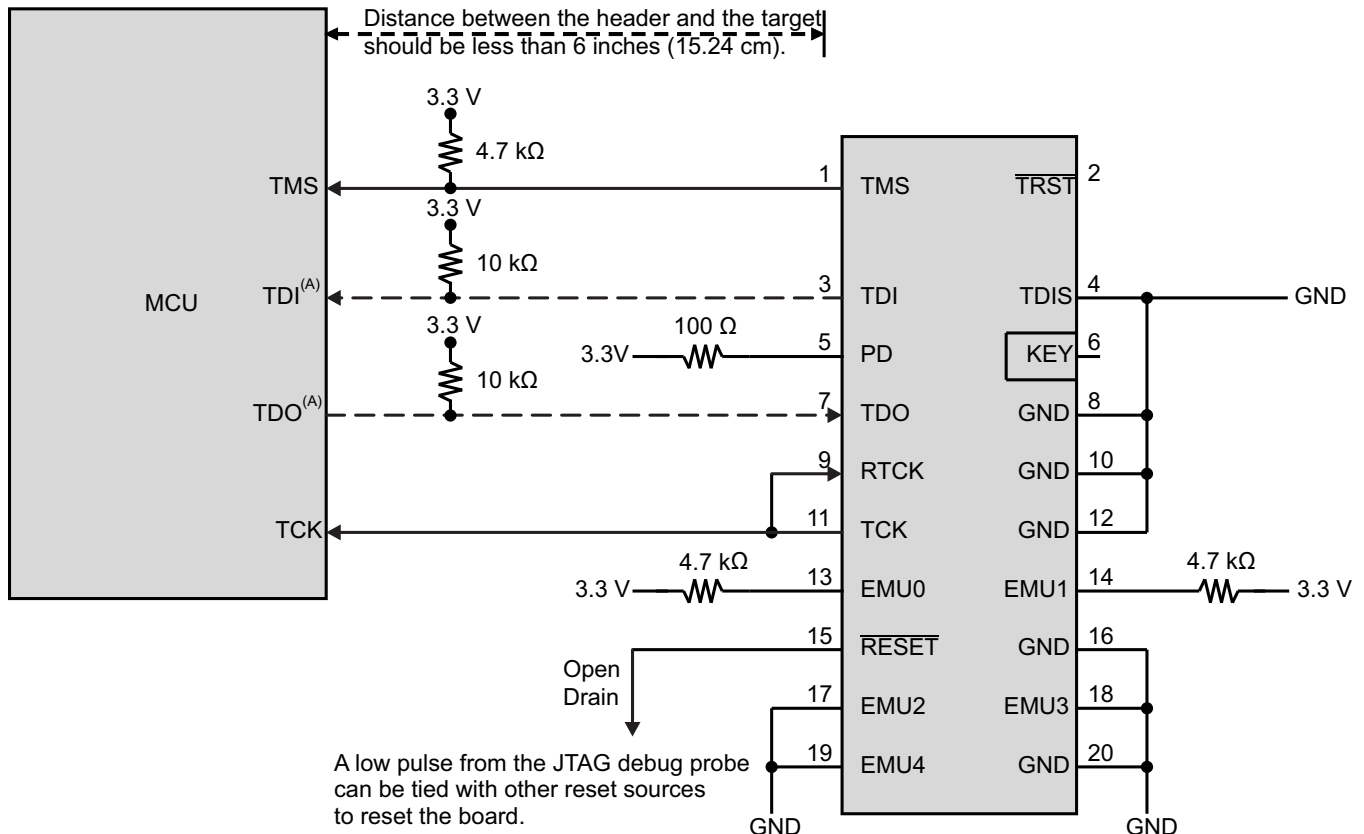
JTAG Test Data Input (TDI) is the default mux selection for the pin. The internal pullup is disabled by default. If this pin is used as JTAG TDI, the internal pullup should be enabled or an external pullup added on the board to avoid a floating input. In the cJTAG option, this pin can be used as GPIO.

JTAG Test Data Output (TDO) is the default mux selection for the pin. The internal pullup is disabled by default. The TDO function will be in a tri-state condition when there is no JTAG activity, leaving this pin floating. The internal pullup should be enabled or an external pullup added on the board to avoid a floating GPIO input. In the cJTAG option, this pin can be used as GPIO.



A. TDI and TDO connections are not required for cJTAG option and these pins can be used as GPIOs instead.

**Figure 5-12. Connecting to the 14-Pin JTAG Header**



A low pulse from the JTAG debug probe can be tied with other reset sources to reset the board.

A. TDI and TDO connections are not required for cJTAG option and these pins can be used as GPIOs instead.

**Figure 5-13. Connecting to the 20-Pin JTAG Header**

### 5.8.5.1 JTAG Electrical Data and Timing

Table 5-19 lists the JTAG timing requirements. Table 5-20 lists the JTAG switching characteristics. Figure 5-14 shows the JTAG timing.

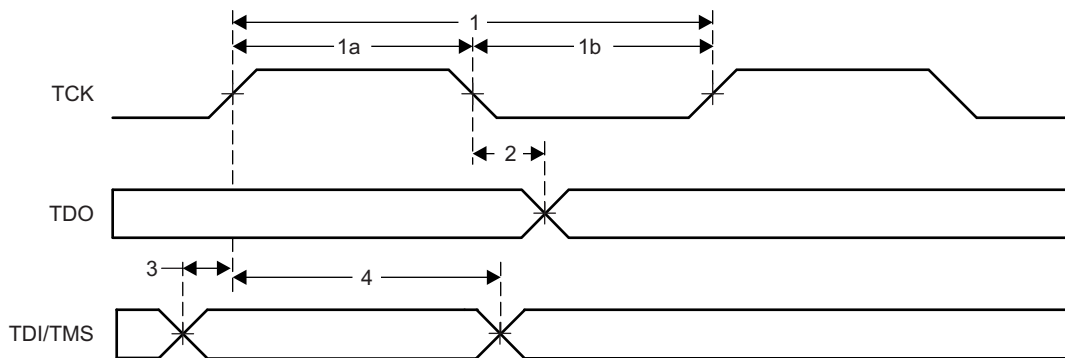
**Table 5-19. JTAG Timing Requirements**

| NO. |                           |                                          | MIN   | MAX | UNIT |
|-----|---------------------------|------------------------------------------|-------|-----|------|
| 1   | $t_c(\text{TCK})$         | Cycle time, TCK                          | 66.66 |     | ns   |
| 1a  | $t_w(\text{TCKH})$        | Pulse duration, TCK high (40% of $t_c$ ) | 26.66 |     | ns   |
| 1b  | $t_w(\text{TCKL})$        | Pulse duration, TCK low (40% of $t_c$ )  | 26.66 |     | ns   |
| 3   | $t_{su}(\text{TDI-TCKH})$ | Input setup time, TDI valid to TCK high  | 13    |     | ns   |
|     | $t_{su}(\text{TMS-TCKH})$ | Input setup time, TMS valid to TCK high  | 13    |     |      |
| 4   | $t_h(\text{TCKH-TDI})$    | Input hold time, TDI valid from TCK high | 7     |     | ns   |
|     | $t_h(\text{TCKH-TMS})$    | Input hold time, TMS valid from TCK high | 7     |     |      |

**Table 5-20. JTAG Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| NO. | PARAMETER              | MIN | MAX | UNIT |
|-----|------------------------|-----|-----|------|
| 2   | $t_d(\text{TCKL-TDO})$ | 6   | 25  | ns   |



**Figure 5-14. JTAG Timing**

### 5.8.5.2 cJTAG Electrical Data and Timing

Table 5-21 lists the cJTAG timing requirements. Table 5-22 lists the cJTAG switching characteristics. Figure 5-15 shows the cJTAG timing.

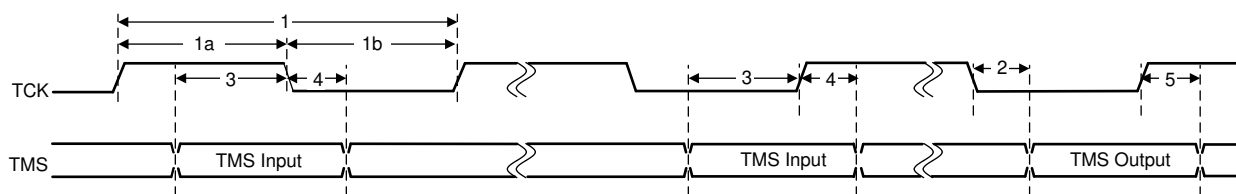
**Table 5-21. cJTAG Timing Requirements**

| NO. |                    |                                          | MIN | MAX | UNIT |
|-----|--------------------|------------------------------------------|-----|-----|------|
| 1   | $t_{c(TCK)}$       | Cycle time, TCK                          | 100 |     | ns   |
| 1a  | $t_{w(TCKH)}$      | Pulse duration, TCK high (40% of $t_c$ ) | 40  |     | ns   |
| 1b  | $t_{w(TCKL)}$      | Pulse duration, TCK low (40% of $t_c$ )  | 40  |     | ns   |
| 3   | $t_{su(TMS-TCKH)}$ | Input setup time, TMS valid to TCK high  | 15  |     | ns   |
|     | $t_{su(TMS-TCKL)}$ | Input setup time, TMS valid to TCK low   | 15  |     | ns   |
| 4   | $t_h(TCKH-TMS)$    | Input hold time, TMS valid from TCK high | 2   |     | ns   |
|     | $t_h(TCKL-TMS)$    | Input hold time, TMS valid from TCK low  | 2   |     | ns   |

**Table 5-22. cJTAG Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| NO. |                     | PARAMETER                           | MIN | MAX | UNIT |
|-----|---------------------|-------------------------------------|-----|-----|------|
| 2   | $t_d(TCKL-TMS)$     | Delay time, TCK low to TMS valid    | 6   | 20  | ns   |
| 5   | $t_{dis}(TCKH-TMS)$ | Delay time, TCK high to TMS disable |     | 20  | ns   |



**Figure 5-15. cJTAG Timing**

## 5.8.6 GPIO Electrical Data and Timing

The peripheral signals are multiplexed with general-purpose input/output (GPIO) signals. On reset, GPIO pins are configured as inputs. For specific inputs, the user can also select the number of input qualification cycles to filter unwanted noise glitches.

The GPIO module contains an Output X-BAR which allows an assortment of internal signals to be routed to a GPIO in the GPIO mux positions denoted as OUTPUTXBARx. The GPIO module also contains an Input X-BAR which is used to route signals from any GPIO input to different IP blocks such as the ADCs, eCAPs, ePWMs, and external interrupts. For more details, see the X-BAR chapter in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

### 5.8.6.1 GPIO – Output Timing

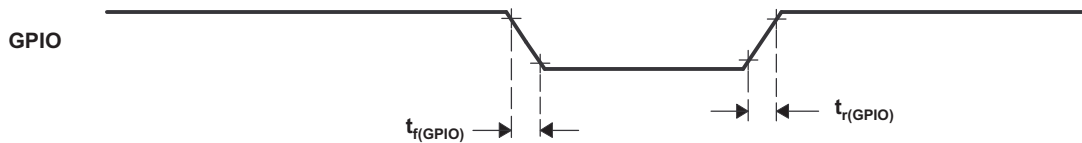
Table 5-23 lists the general-purpose output switching characteristics. Figure 5-16 shows the general-purpose output timing.

**Table 5-23. General-Purpose Output Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER     |                                       |           | MIN | MAX              | UNIT |
|---------------|---------------------------------------|-----------|-----|------------------|------|
| $t_{r(GPIO)}$ | Rise time, GPIO switching low to high | All GPIOs |     | 8 <sup>(1)</sup> | ns   |
| $t_{f(GPIO)}$ | Fall time, GPIO switching high to low | All GPIOs |     | 8 <sup>(1)</sup> | ns   |
| $f_{GPIO}$    | Toggling frequency, all GPIOs         |           |     | 25               | MHz  |

(1) Rise time and fall time vary with load. These values assume a 40-pF load.



**Figure 5-16. General-Purpose Output Timing**

## 5.8.6.2 GPIO – Input Timing

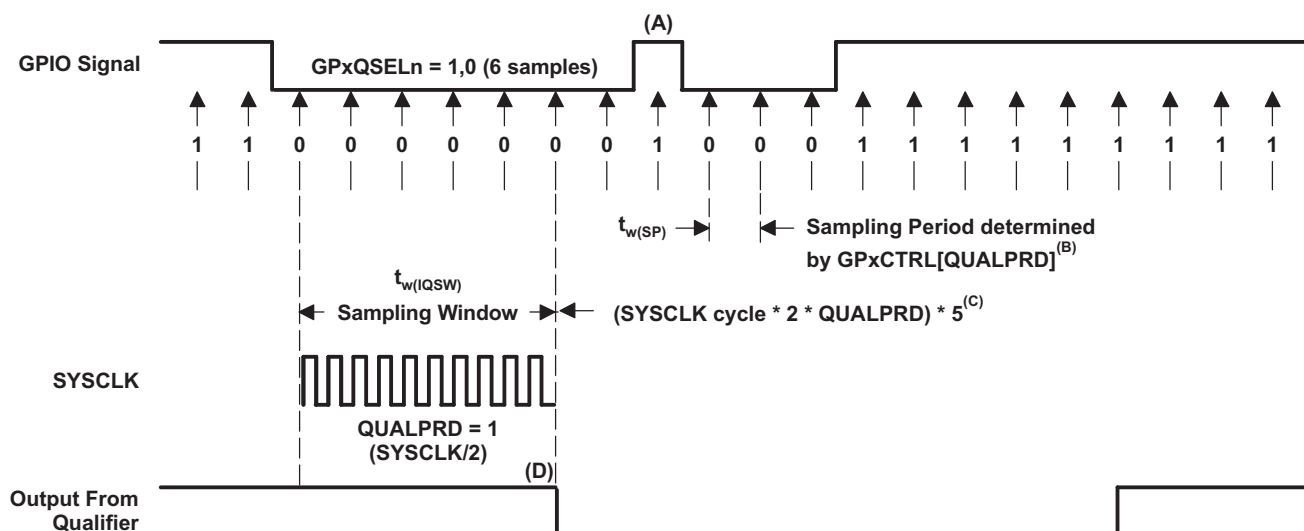
Table 5-24 lists the general-purpose input timing requirements. Figure 5-17 shows the sampling mode.

Table 5-24. General-Purpose Input Timing Requirements

|                    |                                 |                      | MIN                                        | MAX | UNIT   |
|--------------------|---------------------------------|----------------------|--------------------------------------------|-----|--------|
| $t_{w(SP)}$        | Sampling period                 | QUALPRD = 0          | $1t_{c(SYSCLK)}$                           |     | cycles |
|                    |                                 | QUALPRD $\neq$ 0     | $2t_{c(SYSCLK)} * QUALPRD$                 |     |        |
| $t_{w(IQSW)}$      | Input qualifier sampling window |                      | $t_{w(SP)} * (n^{(1)} - 1)$                |     | cycles |
| $t_{w(GPI)}^{(2)}$ | Pulse duration, GPIO low/high   | Synchronous mode     | $2t_{c(SYSCLK)}$                           |     | cycles |
|                    |                                 | With input qualifier | $t_{w(IQSW)} + t_{w(SP)} + 1t_{c(SYSCLK)}$ |     |        |

(1) "n" represents the number of qualification samples as defined by GPxQSELn register.

(2) For  $t_{w(GPI)}$ , pulse width is measured from  $V_{IL}$  to  $V_{IL}$  for an active low signal and  $V_{IH}$  to  $V_{IH}$  for an active high signal.



- This glitch will be ignored by the input qualifier. The QUALPRD bit field specifies the qualification sampling period. It can vary from 00 to 0xFF. If QUALPRD = 00, then the sampling period is 1 SYSCLK cycle. For any other value "n", the qualification sampling period is 2n SYSCLK cycles (that is, at every 2n SYSCLK cycles, the GPIO pin will be sampled).
- The qualification period selected through the GPxCTRL register applies to groups of eight GPIO pins.
- The qualification block can take either three or six samples. The GPxQSELn Register selects which sample mode is used.
- In the example shown, for the qualifier to detect the change, the input should be stable for 10 SYSCLK cycles or greater. In other words, the inputs should be stable for  $(5 \times QUALPRD \times 2)$  SYSCLK cycles. This would ensure 5 sampling periods for detection to occur. Because external signals are driven asynchronously, a 13-SYSCLK-wide pulse ensures reliable recognition.

Figure 5-17. Sampling Mode

### 5.8.6.3 Sampling Window Width for Input Signals

The following section summarizes the sampling window width for input signals for various input qualifier configurations.

Sampling frequency denotes how often a signal is sampled with respect to SYSCLK.

Sampling frequency =  $\text{SYSCLK} / (2 \times \text{QUALPRD})$ , if  $\text{QUALPRD} \neq 0$

Sampling frequency =  $\text{SYSCLK}$ , if  $\text{QUALPRD} = 0$

Sampling period =  $\text{SYSCLK cycle} \times 2 \times \text{QUALPRD}$ , if  $\text{QUALPRD} \neq 0$

In the previous equations, SYSCLK cycle indicates the time period of SYSCLK.

Sampling period =  $\text{SYSCLK cycle}$ , if  $\text{QUALPRD} = 0$

In a given sampling window, either 3 or 6 samples of the input signal are taken to determine the validity of the signal. This is determined by the value written to GPxQSELn register.

#### Case 1:

Qualification using 3 samples

Sampling window width =  $(\text{SYSCLK cycle} \times 2 \times \text{QUALPRD}) \times 2$ , if  $\text{QUALPRD} \neq 0$

Sampling window width =  $(\text{SYSCLK cycle}) \times 2$ , if  $\text{QUALPRD} = 0$

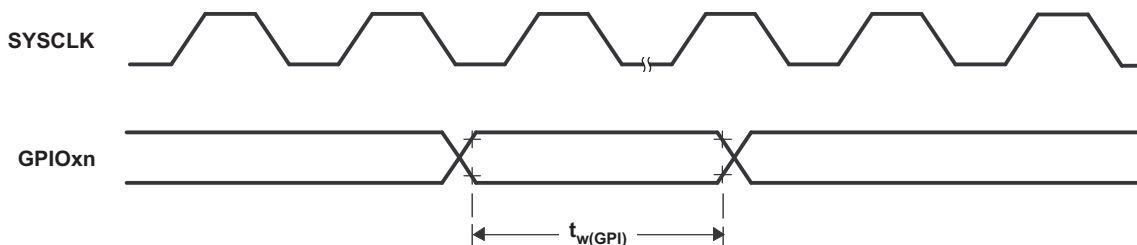
#### Case 2:

Qualification using 6 samples

Sampling window width =  $(\text{SYSCLK cycle} \times 2 \times \text{QUALPRD}) \times 5$ , if  $\text{QUALPRD} \neq 0$

Sampling window width =  $(\text{SYSCLK cycle}) \times 5$ , if  $\text{QUALPRD} = 0$

Figure 5-18 shows the general-purpose input timing.



**Figure 5-18. General-Purpose Input Timing**

## 5.8.7 Interrupts

The C28x CPU has fourteen peripheral interrupt lines. Two of them (INT13 and INT14) are connected directly to CPU timers 1 and 2, respectively. The remaining twelve are connected to peripheral interrupt signals through the enhanced Peripheral Interrupt Expansion (ePIE) module. The ePIE multiplexes up to sixteen peripheral interrupts into each CPU interrupt line. It also expands the vector table to allow each interrupt to have its own ISR. This allows the CPU to support a large number of peripherals.

An interrupt path is divided into three stages—the peripheral, the ePIE, and the CPU. Each stage has its own enable and flag registers. This system allows the CPU to handle one interrupt while others are pending, implement and prioritize nested interrupts in software, and disable interrupts during certain critical tasks.

Figure 5-19 shows the interrupt architecture for this device.

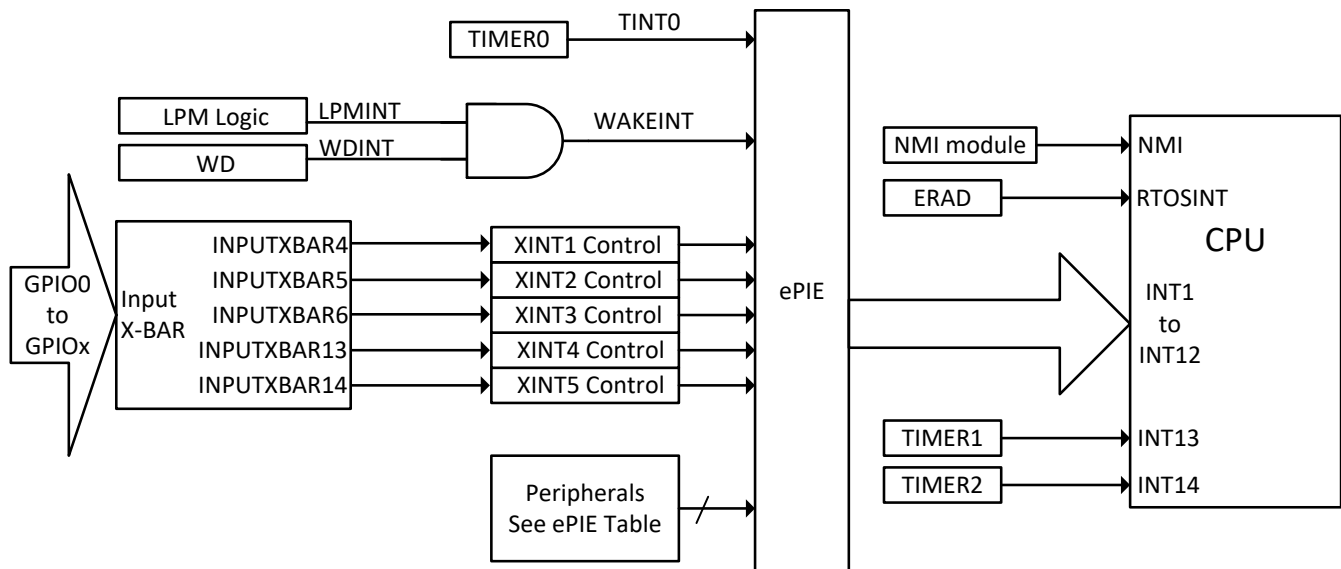


Figure 5-19. Device Interrupt Architecture

### 5.8.7.1 External Interrupt (XINT) Electrical Data and Timing

Table 5-25 lists the external interrupt timing requirements. Table 5-26 lists the external interrupt switching characteristics. Figure 5-20 shows the external interrupt timing.

**Table 5-25. External Interrupt Timing Requirements<sup>(1)</sup>**

|                                                 |                | MIN                                       | MAX | UNIT   |
|-------------------------------------------------|----------------|-------------------------------------------|-----|--------|
| $t_{W(INT)}$ Pulse duration, INT input low/high | Synchronous    | $2t_{C(SYCLK)}$                           |     | cycles |
|                                                 | With qualifier | $t_{W(IQSW)} + t_{W(SP)} + 1t_{C(SYCLK)}$ |     |        |

(1) For an explanation of the input qualifier parameters, see Table 5-24.

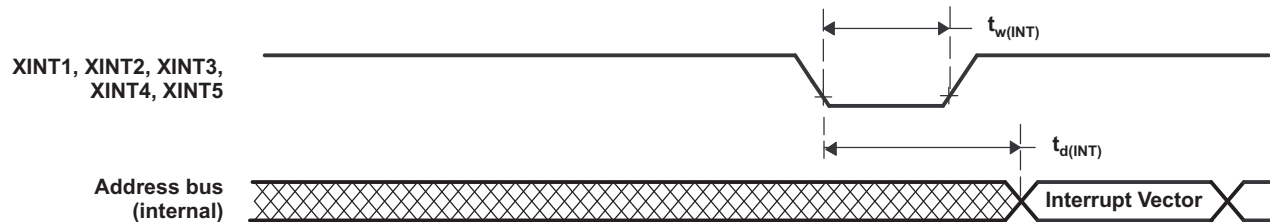
**Table 5-26. External Interrupt Switching Characteristics<sup>(1)</sup>**

over recommended operating conditions (unless otherwise noted)

| PARAMETER                                                                      | MIN                            | MAX                                        | UNIT   |
|--------------------------------------------------------------------------------|--------------------------------|--------------------------------------------|--------|
| $t_{d(INT)}$ Delay time, INT low/high to interrupt-vector fetch <sup>(2)</sup> | $t_{w(IQSW)} + 14t_{c(SYCLK)}$ | $t_{w(IQSW)} + t_{w(SP)} + 14t_{c(SYCLK)}$ | cycles |

(1) For an explanation of the input qualifier parameters, see Table 5-24.

(2) This assumes that the ISR is in a single-cycle memory.



**Figure 5-20. External Interrupt Timing**

## 5.8.8 Low-Power Modes

This device has HALT, IDLE and STANDBY as clock-gating low-power modes.

Further details, as well as the entry and exit procedure, for all of the low-power modes can be found in the Low Power Modes section of the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

### 5.8.8.1 Clock-Gating Low-Power Modes

IDLE and HALT modes on this device are similar to those on other C28x devices. [Table 5-27](#) describes the effect on the system when any of the clock-gating low-power modes are entered.

**Table 5-27. Effect of Clock-Gating Low-Power Modes on the Device**

| MODULES/<br>CLOCK DOMAIN                        | IDLE    | STANDBY | HALT                                               |
|-------------------------------------------------|---------|---------|----------------------------------------------------|
| SYSCLK                                          | Active  | Gated   | Gated                                              |
| CPUCLK                                          | Gated   | Gated   | Gated                                              |
| Clock to modules<br>connected to<br>PERx.SYSCLK | Active  | Gated   | Gated                                              |
| WDCLK                                           | Active  | Active  | Gated if CLKSRCCTL1.WDHALTI = 0                    |
| PLL                                             | Powered | Powered | Software must power down PLL before entering HALT. |
| INTOSC1                                         | Powered | Powered | Powered down if CLKSRCCTL1.WDHALTI = 0             |
| INTOSC2                                         | Powered | Powered | Powered down if CLKSRCCTL1.WDHALTI = 0             |
| Flash <sup>(1)</sup>                            | Powered | Powered | Powered                                            |
| XTAL <sup>(2)</sup>                             | Powered | Powered | Powered                                            |

- (1) The Flash module is not powered down by hardware in any LPM. It may be powered down using software if required by the application. For more information, see the Flash and OTP Memory section of the System Control chapter in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).
- (2) The XTAL is not powered down by hardware in any LPM. It may be powered down by software setting the XTALCR.OSCOFF bit to 1. This can be done at any time during the application if the XTAL is not required.

### 5.8.8.2 Low-Power Mode Wake-up Timing

Table 5-28 lists the IDLE mode timing requirements, Table 5-29 lists the switching characteristics, and Figure 5-21 shows the timing diagram for IDLE mode.

**Table 5-28. IDLE Mode Timing Requirements<sup>(1)</sup>**

|                      |                                         |                         | MIN                                           | MAX | UNIT   |
|----------------------|-----------------------------------------|-------------------------|-----------------------------------------------|-----|--------|
| t <sub>w(WAKE)</sub> | Pulse duration, external wake-up signal | Without input qualifier | 2t <sub>c(SYCLK)</sub>                        |     | cycles |
|                      |                                         | With input qualifier    | 2t <sub>c(SYCLK)</sub> + t <sub>w(IOSW)</sub> |     |        |

(1) For an explanation of the input qualifier parameters, see Table 5-24.

**Table 5-29. IDLE Mode Switching Characteristics<sup>(1)</sup>**

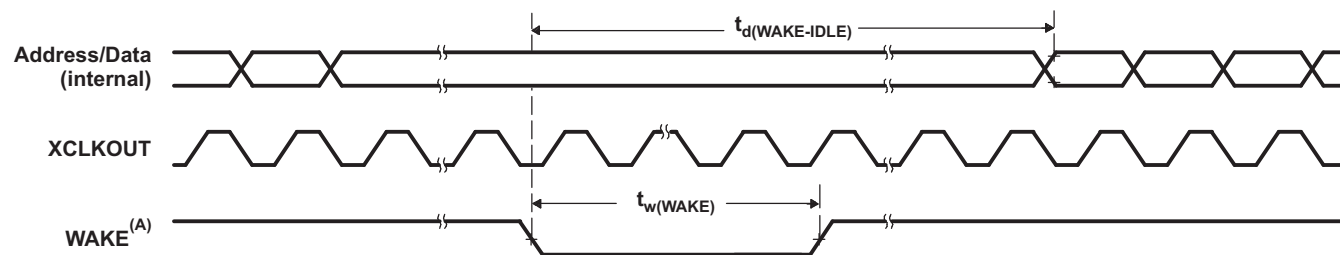
over recommended operating conditions (unless otherwise noted)

| PARAMETER          | TEST CONDITIONS           | MIN                     | MAX                                               | UNIT   |
|--------------------|---------------------------|-------------------------|---------------------------------------------------|--------|
| $t_{d(WAKE-IDLE)}$ | From Flash (active state) | Without input qualifier | $40t_{c(SYCLK)}$                                  | cycles |
|                    |                           | With input qualifier    | $40t_{c(SYCLK)} + t_{w(WAKE)}$                    | cycles |
|                    | From Flash (sleep state)  | Without input qualifier | $6700t_{c(SYCLK)}$ <sup>(3)</sup>                 | cycles |
|                    |                           | With input qualifier    | $6700t_{c(SYCLK)}$ <sup>(3)</sup> + $t_{w(WAKE)}$ | cycles |
|                    | From RAM                  | Without input qualifier | $25t_{c(SYCLK)}$                                  | cycles |
|                    |                           | With input qualifier    | $25t_{c(SYCLK)} + t_{w(WAKE)}$                    | cycles |

(1) For an explanation of the input qualifier parameters, see Table 5-24.

(2) This is the time taken to begin execution of the instruction that immediately follows the IDLE instruction. Execution of an ISR (triggered by the wake-up signal) involves additional latency.

(3) This value is based on the flash power-up time, which is a function of the SYCLK frequency, flash wait states (RWAIT), and FPAC1[PSLEEP]. This value can be realized when SYCLK is 200 MHz, RWAIT is 3, and FPAC1[PSLEEP] is 0x860.



A. WAKE can be any enabled interrupt, WDINT or XRSn. After the IDLE instruction is executed, a delay of five OSCCLK cycles (minimum) is needed before the wake-up signal could be asserted.

**Figure 5-21. IDLE Entry and Exit Timing Diagram**

Table 5-30 lists the STANDBY mode timing requirements, Table 5-31 lists the switching characteristics, and Figure 5-22 shows the timing diagram for STANDBY mode.

**Table 5-30. STANDBY Mode Timing Requirements**

|                   |                                         |                                                               | MIN                               | MAX | UNIT   |
|-------------------|-----------------------------------------|---------------------------------------------------------------|-----------------------------------|-----|--------|
| $t_{w(WAKE-INT)}$ | Pulse duration, external wake-up signal | QUALSTDBY = 0   $2t_{c(OSCCLK)}$                              | $3t_{c(OSCCLK)}$                  |     | cycles |
|                   |                                         | QUALSTDBY > 0   $(2 + QUALSTDBY)t_{c(OSCCLK)}$ <sup>(1)</sup> | $(2 + QUALSTDBY) * t_{c(OSCCLK)}$ |     |        |

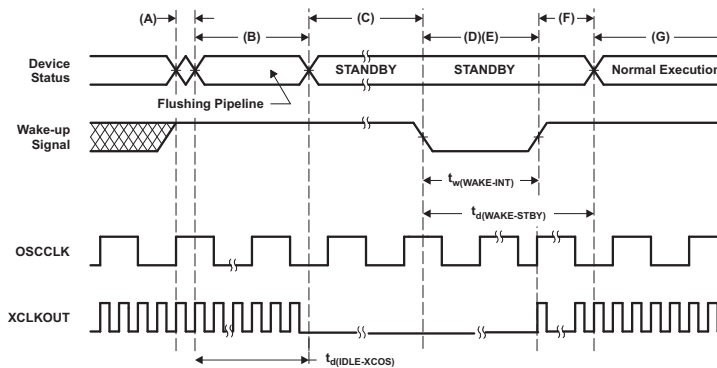
(1) QUALSTDBY is a 6-bit field in the LPMCR register.

**Table 5-31. STANDBY Mode Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER          | TEST CONDITIONS                                                             | MIN                                             | MAX                                                     | UNIT   |
|--------------------|-----------------------------------------------------------------------------|-------------------------------------------------|---------------------------------------------------------|--------|
| $t_{d(IDLE-XCOS)}$ | Delay time, IDLE instruction executed to XCLKOUT stop                       |                                                 | $16t_{c(INTOSC1)}$                                      | cycles |
| $t_{d(WAKE-STBY)}$ | Wakeup from flash (Flash module in active state)                            |                                                 | $175t_{c(SYSCCLK)} + t_{w(WAKE-INT)}$                   | cycles |
| $t_{d(WAKE-STBY)}$ | Delay time, external wake signal to program execution resume <sup>(1)</sup> | Wakeup from flash (Flash module in sleep state) | $6700t_{c(SYSCCLK)}$ <sup>(2)</sup> + $t_{w(WAKE-INT)}$ | cycles |
| $t_{d(WAKE-STBY)}$ | Wakeup from RAM                                                             |                                                 | $3t_{c(OSC)} + 15t_{c(SYSCCLK)} + t_{w(WAKE-INT)}$      | cycles |

- (1) This is the time taken to begin execution of the instruction that immediately follows the IDLE instruction. Execution of an ISR (triggered by the wake-up signal) involves additional latency.
- (2) This value is based on the flash power-up time, which is a function of the SYSCCLK frequency, flash wait states (RWAIT), and FPAC1[PSLEEP]. This value can be realized when SYSCCLK is 200 MHz, RWAIT is 3, and FPAC1[PSLEEP] is 0x860.



- A. IDLE instruction is executed to put the device into STANDBY mode.
- B. The LPM block responds to the STANDBY signal, SYSCCLK is held for a maximum 16 INTOSC1 clock cycles before being turned off. This delay enables the CPU pipeline and any other pending operations to flush properly.
- C. Clock to the peripherals are turned off. However, the PLL and watchdog are not shut down. The device is now in STANDBY mode. After the IDLE instruction is executed, a delay of five OSCCLK cycles (minimum) is needed before the wake-up signal could be asserted.
- D. The external wake-up signal is driven active.
- E. The wake-up signal fed to a GPIO pin to wake up the device must meet the minimum pulse width requirement. Furthermore, this signal must be free of glitches. If a noisy signal is fed to a GPIO pin, the wakeup behavior of the device will not be deterministic and the device may not exit low-power mode for subsequent wakeup pulses.
- F. After a latency period, the STANDBY mode is exited.
- G. Normal execution resumes. The device will respond to the interrupt (if enabled).

**Figure 5-22. STANDBY Entry and Exit Timing Diagram**

Table 5-32 lists the HALT mode timing requirements, Table 5-33 lists the switching characteristics, and Figure 5-23 shows the timing diagram for HALT mode.

**Table 5-32. HALT Mode Timing Requirements**

|                    |                                                                | MIN                          | MAX | UNIT   |
|--------------------|----------------------------------------------------------------|------------------------------|-----|--------|
| $t_{w(WAKE-GPIO)}$ | Pulse duration, GPIO wake-up signal <sup>(1)</sup>             | $t_{oscst} + 2t_{c(OSCCLK)}$ |     | cycles |
| $t_{w(WAKE-XRS)}$  | Pulse duration, $\overline{XRS}$ wake-up signal <sup>(1)</sup> | $t_{oscst} + 8t_{c(OSCCLK)}$ |     | cycles |

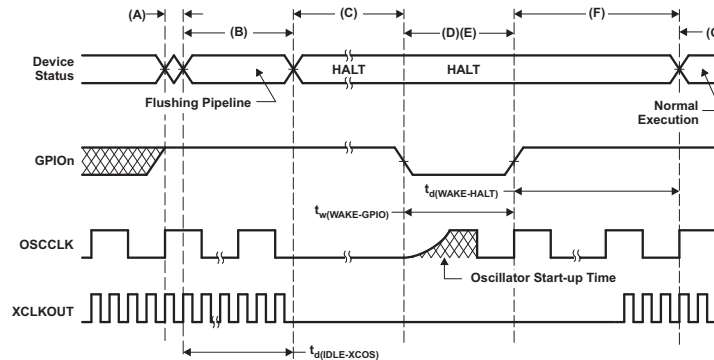
- (1) For applications using X1/X2 for OSCCLK, the user must characterize their specific oscillator start-up time as it is dependent on circuit/layout external to the device. See Table 5-15 for more information. For applications using INTOSC1 or INTOSC2 for OSCCLK, see Section 5.8.3.5 for  $t_{oscst}$ . Oscillator start-up time does not apply to applications using a single-ended crystal on the X1 pin, as it is powered externally to the device.

**Table 5-33. HALT Mode Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER          | MIN                                                                   | MAX                        | UNIT   |
|--------------------|-----------------------------------------------------------------------|----------------------------|--------|
| $t_{d(IDLE-XCOS)}$ |                                                                       | $16t_{c(INTOSC1)}$         | cycles |
| $t_{d(WAKE-HALT)}$ | Delay time, IDLE instruction executed to XCLKOUT stop                 |                            |        |
|                    | Delay time, external wake signal end to CPU1 program execution resume |                            |        |
|                    | Wakeup from Flash - Flash module in active state                      | $75t_{c(OSCCLK)}$          | cycles |
|                    | Wakeup from Flash - Flash module in sleep state                       | $17500t_{c(OSCCLK)}^{(1)}$ |        |
|                    | Wakeup from RAM                                                       | $75t_{c(OSCCLK)}$          |        |

- (1) This value is based on the flash power-up time, which is a function of the SYSCLK frequency, flash wait states (RWAIT), and FPAC1[PSLEEP]. This value can be realized when SYSCLK is 200 MHz, RWAIT is 3, and FPAC1[PSLEEP] is 0x860.



- IDLE instruction is executed to put the device into HALT mode.
- The LPM block responds to the HALT signal, SYSCLK is held for a maximum 16 INTOSC1 clock cycles before being turned off. This delay enables the CPU pipeline and any other pending operations to flush properly.
- Clocks to the peripherals are turned off and the PLL is shut down. If a quartz crystal or ceramic resonator is used as the clock source, the internal oscillator is shut down as well. The device is now in HALT mode and consumes very little power. It is possible to keep the zero-pin internal oscillators (INTOSC1 and INTOSC2) and the watchdog alive in HALT MODE. This is done by writing 1 to CLKSRCCTL1.WDHALTI. After the IDLE instruction is executed, a delay of five OSCCLK cycles (minimum) is needed before the wake-up signal could be asserted.
- When the GPIO pin (used to bring the device out of HALT) is driven low, the oscillator is turned on and the oscillator wake-up sequence is initiated. The GPIO pin should be driven high only after the oscillator has stabilized. This enables the provision of a clean clock signal during the PLL lock sequence. Because the falling edge of the GPIO pin asynchronously begins the wake-up procedure, care should be taken to maintain a low noise environment before entering and during HALT mode.
- The wake-up signal fed to a GPIO pin to wake up the device must meet the minimum pulse width requirement. Furthermore, this signal must be free of glitches. If a noisy signal is fed to a GPIO pin, the wake-up behavior of the device will not be deterministic and the device may not exit low-power mode for subsequent wake-up pulses.
- When CLKIN to the core is enabled, the device will respond to the interrupt (if enabled), after some latency. The HALT mode is now exited.
- Normal operation resumes.
- The user must relock the PLL upon HALT wake-up to ensure a stable PLL lock.

**Figure 5-23. HALT Entry and Exit Timing Diagram**

## 5.9 Analog Peripherals

The analog subsystem module is described in this section.

The analog modules on this device include the ADC, temperature sensor, and CMPSS.

The analog subsystem has the following features:

- Flexible voltage references
  - The ADCs are referenced to VREFHI and VSSA pins
    - VREFHI pin voltage can be driven in externally or can be generated by an internal bandgap voltage reference
    - The internal voltage reference range can be selected to be 0V to 3.3V or 0V to 2.5V
  - The comparator DACs are referenced to VDDA and VSSA
    - Alternately, these DACs can be referenced to the VDACC pin and VSSA
- Flexible pin usage
  - Comparator subsystem inputs and digital inputs are multiplexed with ADC inputs
  - Internal connection to  $V_{REFLO}$  on all ADCs for offset self-calibration

Figure 5-24 shows the Analog Subsystem Block Diagram for the 80-pin PN and 64-pin PM LQFPs.

Figure 5-25 shows the Analog Subsystem Block Diagram for the 48-pin PT LQFP.

Table 5-34 lists the analog pins and internal connections. Table 5-35 lists descriptions of analog signals.

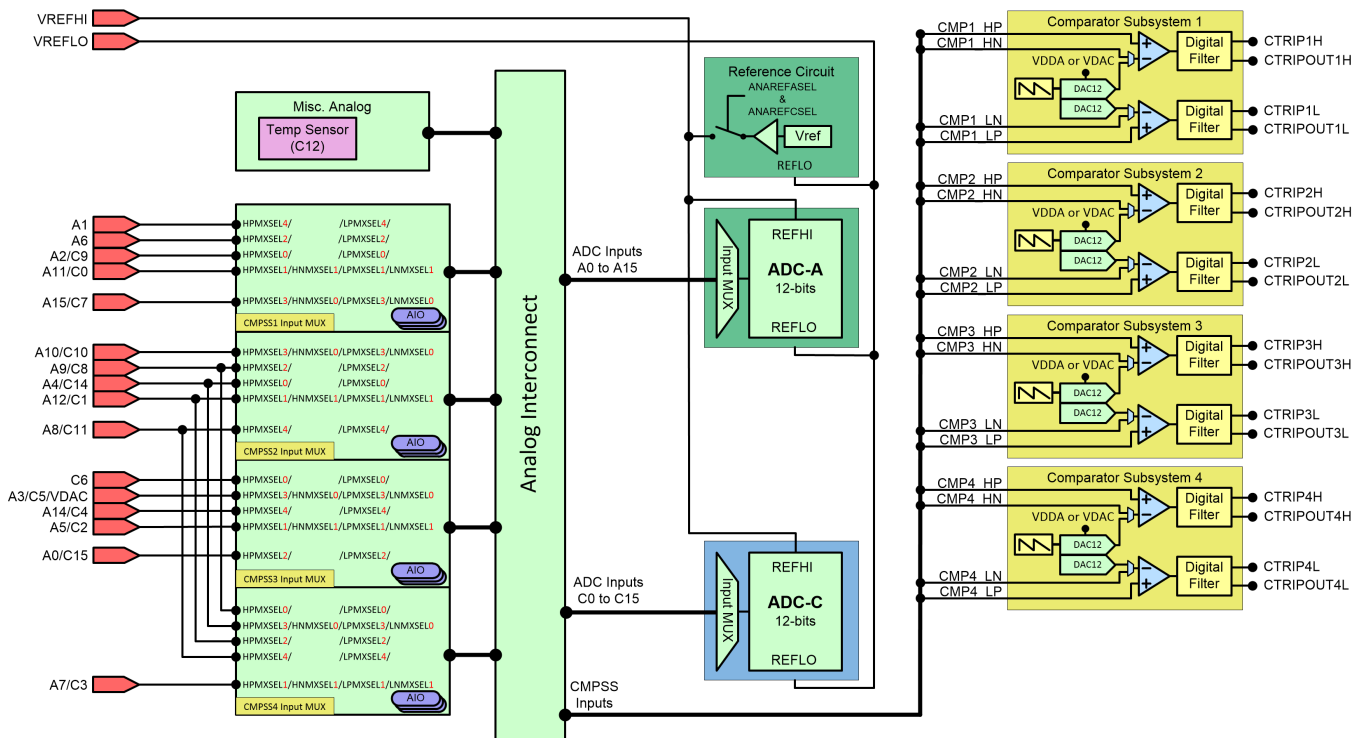


Figure 5-24. Analog Subsystem Block Diagram (80-Pin PN and 64-Pin PM LQFPs)

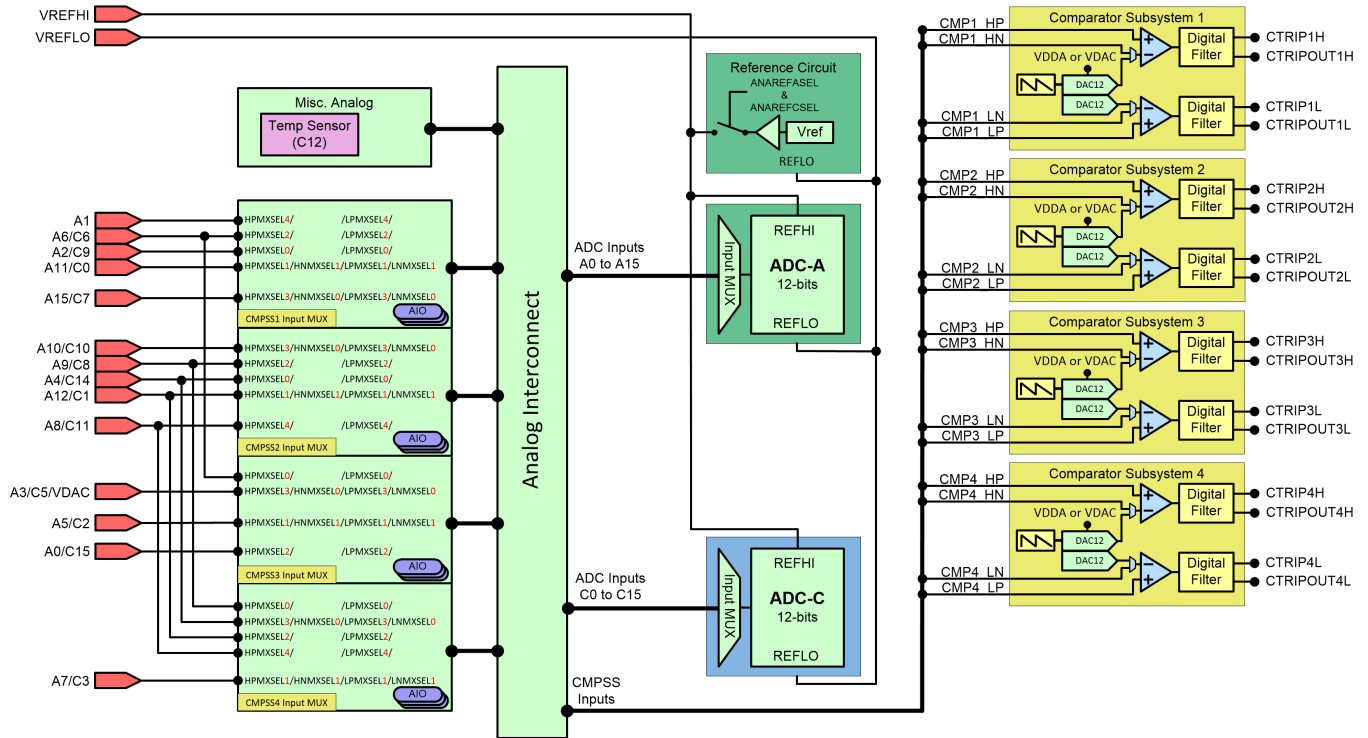


Figure 5-25. Analog Subsystem Block Diagram (48-Pin PT LQFP)

**Table 5-34. Analog Pins and Internal Connections**

| Pin Name                         | Package Pin |        |                  | ADC |     | Comparator Subsystem (MUX)           |                  |                                      |                  | AIO Input |
|----------------------------------|-------------|--------|------------------|-----|-----|--------------------------------------|------------------|--------------------------------------|------------------|-----------|
|                                  | 80 QFP      | 64 QFP | 48 QFN           | A   | C   | High Positive                        | High Negative    | Low Positive                         | Low Negative     |           |
| VREFHI                           | 20          | 16     | 12               |     |     |                                      |                  |                                      |                  |           |
| VREFLO                           | 21          | 17     | 13               | A13 | C13 |                                      |                  |                                      |                  |           |
| <b>Analog Group 1</b>            |             |        |                  |     |     | <b>CMP1</b>                          |                  |                                      |                  |           |
| A6                               | 10          | 6      | 4 <sup>(1)</sup> | A6  | -   | CMP1 (HPMXSEL=2)                     |                  | CMP1 (LPMXSEL=2)                     |                  | AIO228    |
| A2/C9                            | 13          | 9      | 6                | A2  | C9  | CMP1 (HPMXSEL=0)                     |                  | CMP1 (LPMXSEL=0)                     |                  | AIO224    |
| A15/C7                           | 14          | 10     | 7                | A15 | C7  | CMP1 (HPMXSEL=3)                     | CMP1 (HNMXSEL=0) | CMP1 (LPMXSEL=3)                     | CMP1 (LNMXSEL=0) | AIO233    |
| A11/C0                           | 16          | 12     | 8                | A11 | C0  | CMP1 (HPMXSEL=1)                     | CMP1 (HNMXSEL=1) | CMP1 (LPMXSEL=1)                     | CMP1 (LNMXSEL=1) | AIO237    |
| A1                               | 18          | 14     | 10               | A1  | -   | CMP1 (HPMXSEL=4)                     |                  | CMP1 (LPMXSEL=4)                     |                  | AIO232    |
| <b>Analog Group 2</b>            |             |        |                  |     |     | <b>CMP2</b>                          |                  |                                      |                  |           |
| A10/C10                          | 29          | 25     | 21               | A10 | C10 | CMP2 (HPMXSEL=3)                     | CMP2 (HNMXSEL=0) | CMP2 (LPMXSEL=3)                     | CMP2 (LNMXSEL=0) | AIO230    |
| <b>Analog Group 3</b>            |             |        |                  |     |     | <b>CMP3</b>                          |                  |                                      |                  |           |
| C6                               | 11          | 7      | 4 <sup>(1)</sup> | -   | C6  | CMP3 (HPMXSEL=0)                     |                  | CMP3 (LPMXSEL=0)                     |                  | AIO226    |
| A3/C5/VDAC <sup>(2)</sup>        | 12          | 8      | 5                | A3  | C5  | CMP3 (HPMXSEL=3)                     | CMP3 (HNMXSEL=0) | CMP3 (LPMXSEL=3)                     | CMP3 (LNMXSEL=0) | AIO242    |
| A14/C4                           | 15          | 11     | -                | A14 | C4  | CMP3 (HPMXSEL=4)                     |                  | CMP3 (LPMXSEL=4)                     |                  | AIO239    |
| A5/C2                            | 17          | 13     | 9                | A5  | C2  | CMP3 (HPMXSEL=1)                     | CMP3 (HNMXSEL=1) | CMP3 (LPMXSEL=1)                     | CMP3 (LNMXSEL=1) | AIO244    |
| A0/C15                           | 19          | 15     | 11               | A0  | C15 | CMP3 (HPMXSEL=2)                     |                  | CMP3 (LPMXSEL=2)                     |                  | AIO231    |
| <b>Analog Group 4</b>            |             |        |                  |     |     | <b>CMP4</b>                          |                  |                                      |                  |           |
| A7/C3                            | 23          | 19     | 15               | A7  | C3  | CMP4 (HPMXSEL=1)                     | CMP4 (HNMXSEL=1) | CMP4 (LPMXSEL=1)                     | CMP4 (LNMXSEL=1) | AIO245    |
| <b>Combined Analog Group 2/4</b> |             |        |                  |     |     | <b>CMP2/4</b>                        |                  |                                      |                  |           |
| A12/C1                           | 22          | 18     | 14               | A12 | C1  | CMP2 (HPMXSEL=1)<br>CMP4 (HPMXSEL=2) | CMP2 (HNMXSEL=1) | CMP2 (LPMXSEL=1)<br>CMP4 (LPMXSEL=2) | CMP2 (LNMXSEL=1) | AIO238    |
| A8/C11                           | 24          | 20     | 16               | A8  | C11 | CMP2 (HPMXSEL=4)<br>CMP4 (HPMXSEL=4) |                  | CMP2 (LPMXSEL=4)<br>CMP4 (LPMXSEL=4) |                  | AIO241    |
| A4/C14                           | 27          | 23     | 19               | A4  | C14 | CMP2 (HPMXSEL=0)<br>CMP4 (HPMXSEL=3) | CMP4 (HNMXSEL=0) | CMP2 (LPMXSEL=0)<br>CMP4 (LPMXSEL=3) | CMP4 (LNMXSEL=0) | AIO225    |
| A9/C8                            | 28          | 24     | 20               | A9  | C8  | CMP2 (HPMXSEL=2)<br>CMP4 (HPMXSEL=0) |                  | CMP2 (LPMXSEL=2)<br>CMP4 (LPMXSEL=0) |                  | AIO227    |
| <b>Other Analog</b>              |             |        |                  |     |     |                                      |                  |                                      |                  |           |
| TempSensor <sup>(3)</sup>        | -           | -      | -                | -   | C12 |                                      |                  |                                      |                  |           |

(1) A6 and C6 is double bonded as pin # 4.

(2) Optional external reference voltage for on-chip COMPDACs. There is an internal capacitance to VSSA on this pin whether used for ADC input or COMPDAC reference. If used as a VDAC reference, place at least a 1-μF capacitor on this pin.

(3) Internal connection only; does not come to a device pin.

**Table 5-35. Analog Signal Descriptions**

| SIGNAL NAME | DESCRIPTION                                                                                                                                                                                                                                                                                              |
|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AIOx        | Digital input on ADC pin                                                                                                                                                                                                                                                                                 |
| Ax          | ADC A Input                                                                                                                                                                                                                                                                                              |
| Cx          | ADC C Input                                                                                                                                                                                                                                                                                              |
| CMPx_HNy    | Comparator subsystem high comparator negative input                                                                                                                                                                                                                                                      |
| CMPx_HPy    | Comparator subsystem high comparator positive input                                                                                                                                                                                                                                                      |
| CMPx_LNy    | Comparator subsystem low comparator negative input                                                                                                                                                                                                                                                       |
| CMPx_LPy    | Comparator subsystem low comparator positive input                                                                                                                                                                                                                                                       |
| TempSensor  | Internal temperature sensor                                                                                                                                                                                                                                                                              |
| VDAC        | Optional external reference voltage for on-chip COMPDACs. There is an internal capacitance to VSSA on this pin whether used for ADC input or COMPDAC reference which cannot be disabled. If this pin is being used as a reference for the on-chip COMPDACs, place at least a 1-uF capacitor on this pin. |

### 5.9.1 Analog-to-Digital Converter (ADC)

The ADC module described here is a successive approximation (SAR) style ADC with resolution of 12 bits. This section refers to the analog circuits of the converter as the “core,” and includes the channel-select MUX, the sample-and-hold (S/H) circuit, the successive approximation circuits, voltage reference circuits, and other analog support circuits. The digital circuits of the converter are referred to as the “wrapper” and include logic for programmable conversions, result registers, interfaces to analog circuits, interfaces to the peripheral buses, post-processing circuits, and interfaces to other on-chip modules.

Each ADC module consists of a single sample-and-hold (S/H) circuit. The ADC module is designed to be duplicated multiple times on the same chip, allowing simultaneous sampling or independent operation of multiple ADCs. The ADC wrapper is start-of-conversion (SOC)-based (see the SOC Principle of Operation section of the Analog-to-Digital Converter (ADC) chapter in the [TMS320F28002x Microcontrollers Technical Reference Manual](#)).

Each ADC has the following features:

- Resolution of 12 bits
- Ratiometric external reference set by VREFHI/VREFLO
- Selectable internal reference of 2.5 V or 3.3 V
- Single-ended signaling
- Input multiplexer with up to 16 channels
- 16 configurable SOC
- 16 individually addressable result registers
- Multiple trigger sources
  - S/W: software immediate start
  - All ePWMs: ADCSOC A or B
  - GPIO XINT2
  - CPU Timers 0/1/2
  - ADCINT1/2
- Four flexible PIE interrupts
- Burst-mode triggering option
- Four post-processing blocks, each with:
  - Saturating offset calibration
  - Error from setpoint calculation
  - High, low, and zero-crossing compare, with interrupt and ePWM trip capability
  - Trigger-to-sample delay capture

#### NOTE

Not every channel may be pinned out from all ADCs. See to determine which channels are available.

The block diagram for the ADC core and ADC wrapper are shown in Figure 5-26.

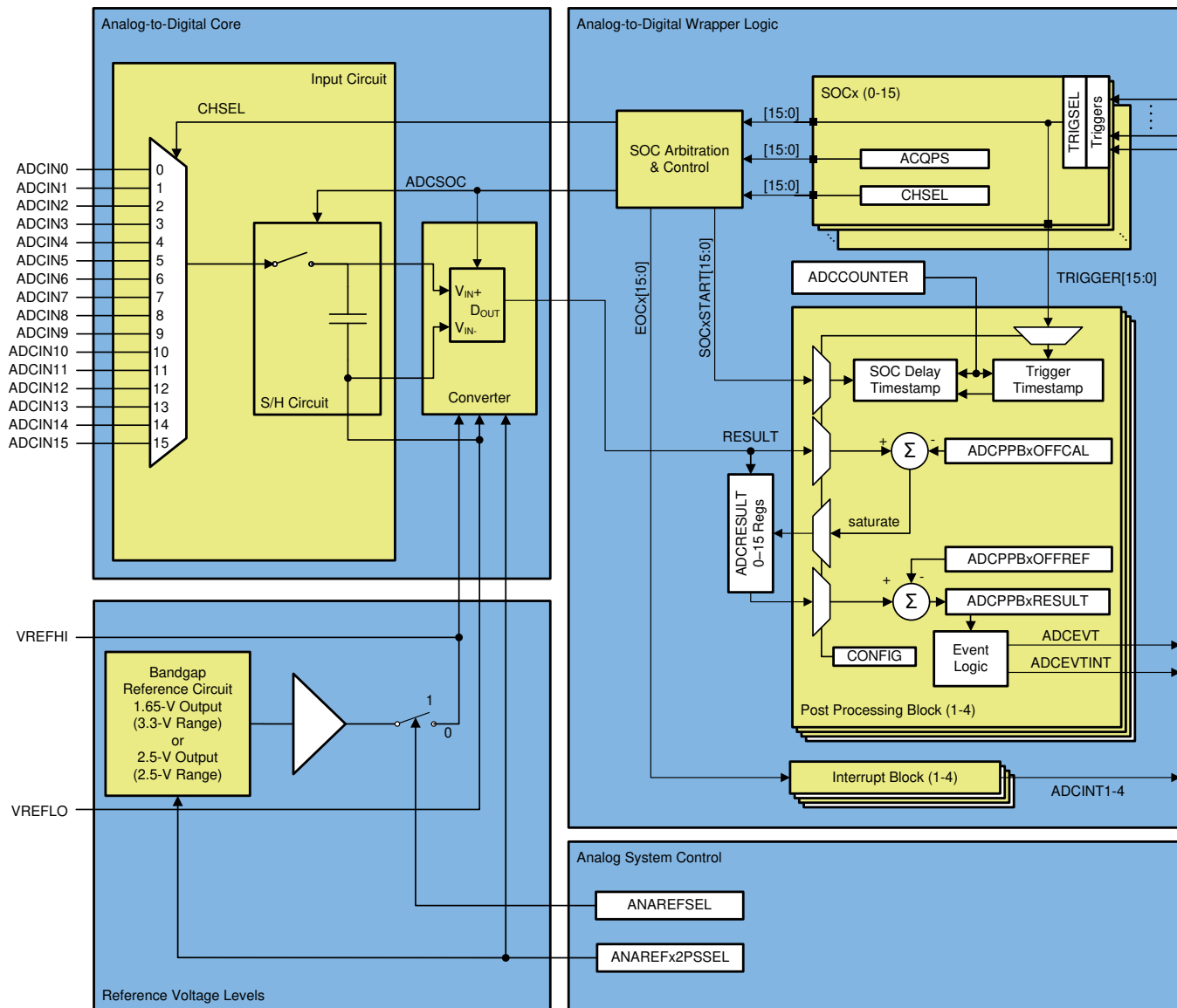


Figure 5-26. ADC Module Block Diagram

ADVANCE INFORMATION

### 5.9.1.1 ADC Configurability

Some ADC configurations are individually controlled by the SOC, while others are globally controlled per ADC module. Table 5-36 summarizes the basic ADC options and their level of configurability.

Table 5-36. ADC Options and Configuration Levels

| OPTIONS                     | CONFIGURABILITY                                  |
|-----------------------------|--------------------------------------------------|
| Clock                       | Per module <sup>(1)</sup>                        |
| Resolution                  | Not configurable (12-bit resolution only)        |
| Signal mode                 | Not configurable (single-ended signal mode only) |
| Reference voltage source    | Common for both ADC modules                      |
| Trigger source              | Per SOC <sup>(1)</sup>                           |
| Converted channel           | Per SOC                                          |
| Acquisition window duration | Per SOC <sup>(1)</sup>                           |
| EOC location                | Per module                                       |
| Burst mode                  | Per module <sup>(1)</sup>                        |

(1) Writing these values differently to different ADC modules could cause the ADCs to operate asynchronously. For guidance on when the ADCs are operating synchronously or asynchronously, see the Ensuring Synchronous Operation section of the Analog-to-Digital Converter (ADC) chapter in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

#### 5.9.1.1.1 Signal Mode

The ADC supports single-ended signaling. The input voltage to the converter is sampled through a single pin (ADCINx), referenced to VREFLO. Figure 5-27 shows the single-ended signaling mode.

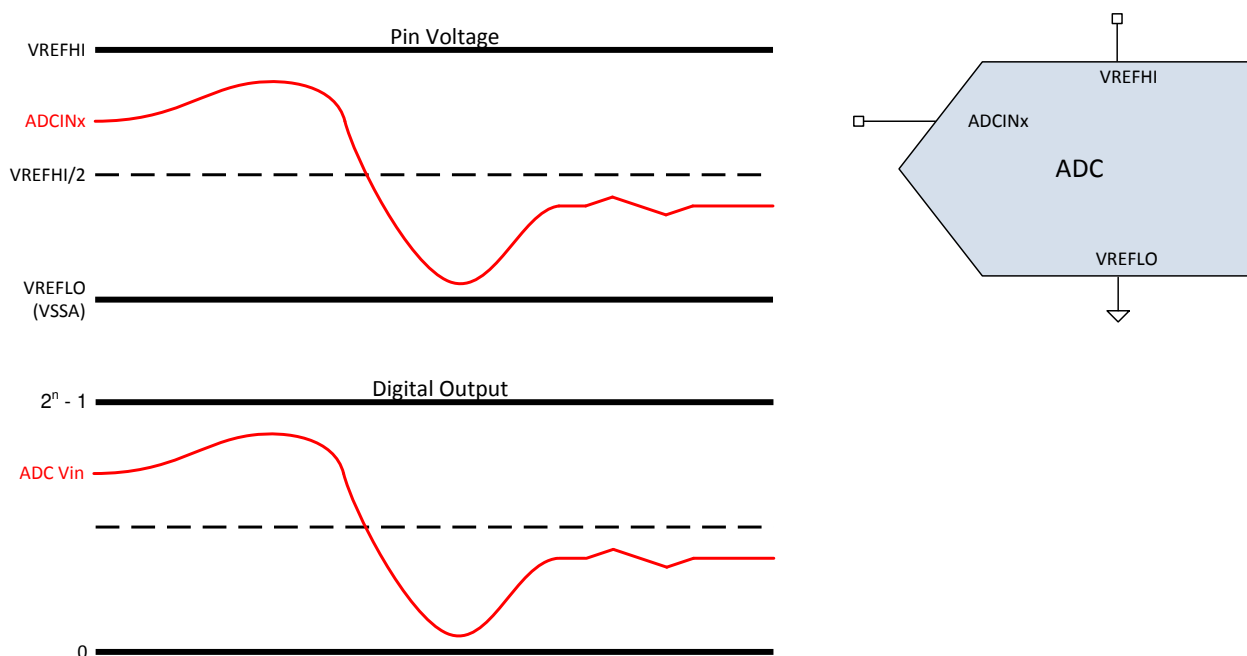


Figure 5-27. Single-ended Signaling Mode

### 5.9.1.2 ADC Electrical Data and Timing

Table 5-37 lists the ADC operating conditions. Table 5-38 lists the ADC electrical characteristics.

**Table 5-37. ADC Operating Conditions**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                            | TEST CONDITIONS                  | MIN    | TYP        | MAX    | UNIT |
|----------------------------------------------------------------------|----------------------------------|--------|------------|--------|------|
| ADCCLK (derived from PERx.SYSCLK)                                    |                                  | 5      |            | 50     | MHz  |
| Sample rate                                                          | 100-MHz SYSCLK                   |        |            | 3.45   | MSPS |
| Sample window duration (set by ACQPS and PERx.SYSCLK) <sup>(1)</sup> | With 50 $\Omega$ or less $R_s$   | 75     |            |        | ns   |
| VREFHI                                                               | External Reference               | 2.4    | 2.5 or 3.0 | VDDA   | V    |
| VREFHI <sup>(2)</sup>                                                | Internal Reference = 3.3V Range  |        | 1.65       |        | V    |
|                                                                      | Internal Reference = 2.5V Range  |        | 2.5        |        | V    |
| VREFLO                                                               |                                  | VSSA   |            | VSSA   | V    |
| VREFHI - VREFLO                                                      |                                  | 2.4    |            | VDDA   | V    |
| Conversion range                                                     | Internal Reference = 3.3 V Range | 0      |            | 3.3    | V    |
|                                                                      | Internal Reference = 2.5 V Range | 0      |            | 2.5    | V    |
|                                                                      | External Reference               | VREFLO |            | VREFHI | V    |

(1) The sample window must also be at least as long as 1 ADCCLK cycle for correct ADC operation.

(2) In internal reference mode, the reference voltage is driven out of the VREFHI pin by the device. The user should not drive a voltage into the pin in this mode.

#### NOTE

The ADC inputs should be kept below  $V_{DDA} + 0.3$  V during operation. If an ADC input exceeds this level, the  $V_{REF}$  internal to the device may be disturbed, which can impact results for other ADC inputs using the same  $V_{REF}$ .

#### NOTE

The VREFHI pin must be kept below  $V_{DDA} + 0.3$  V to ensure proper functional operation. If the VREFHI pin exceeds this level, a blocking circuit may activate, and the internal value of VREFHI may float to 0 V internally, giving improper ADC conversion.

**Table 5-38. ADC Characteristics**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                         | TEST CONDITIONS                                                              | MIN  | TYP           | MAX  | UNIT    |
|---------------------------------------------------|------------------------------------------------------------------------------|------|---------------|------|---------|
| <b>General</b>                                    |                                                                              |      |               |      |         |
| ADCCLK Conversion Cycles                          | 100-MHz SYSCLK                                                               | 10.1 |               | 11   | ADCCLKs |
| Power Up Time                                     | External Reference mode                                                      |      |               | 500  | μs      |
|                                                   | Internal Reference mode                                                      |      |               | 5000 | μs      |
|                                                   | Internal Reference mode, when switching between 2.5-V range and 3.3-V range. |      |               | 5000 | μs      |
| VREFHI input current <sup>(1)</sup>               |                                                                              |      | 130           |      | μA      |
| Internal Reference Capacitor Value <sup>(2)</sup> |                                                                              | 2.2  |               |      | μF      |
| External Reference Capacitor Value <sup>(2)</sup> |                                                                              | 2.2  |               |      | μF      |
| <b>DC Characteristics</b>                         |                                                                              |      |               |      |         |
| Gain Error                                        | Internal reference                                                           | –45  |               | 45   | LSB     |
|                                                   | External reference                                                           | –5   | ±3            | 5    |         |
| Offset Error                                      |                                                                              | –5   | ±2            | 5    | LSB     |
| Channel-to-Channel Gain Error <sup>(3)</sup>      |                                                                              |      | 2             |      | LSB     |
| Channel-to-Channel Offset Error <sup>(3)</sup>    |                                                                              |      | 2             |      | LSB     |
| ADC-to-ADC Gain Error <sup>(4)</sup>              | Identical VREFHI and VREFLO for all ADCs                                     |      | 4             |      | LSB     |
| ADC-to-ADC Offset Error <sup>(4)</sup>            | Identical VREFHI and VREFLO for all ADCs                                     |      | 2             |      | LSB     |
| DNL Error                                         |                                                                              | >–1  | ±0.5          | 1    | LSB     |
| INL Error                                         |                                                                              | –2   | ±1.0          | 2    | LSB     |
| ADC-to-ADC Isolation                              | VREFHI = 2.5 V, synchronous ADCs                                             | –1   |               | 1    | LSBs    |
| <b>AC Characteristics</b>                         |                                                                              |      |               |      |         |
| SNR <sup>(5)</sup>                                | VREFHI = 2.5 V, fin = 100 kHz, SYSCLK from X1                                |      | 68.8          |      | dB      |
|                                                   | VREFHI = 2.5 V, fin = 100 kHz, SYSCLK from INTOSC                            |      | 60.1          |      |         |
| THD <sup>(5)</sup>                                | VREFHI = 2.5 V, fin = 100 kHz                                                |      | –80.6         |      | dB      |
| SFDR <sup>(5)</sup>                               | VREFHI = 2.5 V, fin = 100 kHz                                                |      | 79.2          |      | dB      |
| SINAD <sup>(5)</sup>                              | VREFHI = 2.5 V, fin = 100 kHz, SYSCLK from X1                                |      | 68.5          |      | dB      |
|                                                   | VREFHI = 2.5 V, fin = 100 kHz, SYSCLK from INTOSC                            |      | 60.0          |      |         |
| ENOB <sup>(5)</sup>                               | VREFHI = 2.5 V, fin = 100 kHz, SYSCLK from X1, Single ADC                    |      | 11.0          |      | bits    |
|                                                   | VREFHI = 2.5 V, fin = 100 kHz, SYSCLK from X1, synchronous ADCs              |      | 11.0          |      |         |
|                                                   | VREFHI = 2.5 V, fin = 100 kHz, SYSCLK from X1, asynchronous ADCs             |      | Not Supported |      |         |
| PSRR                                              | VDD = 1.2-V DC + 100mV<br>DC up to Sine at 1 kHz                             |      | 60            |      | dB      |
|                                                   | VDD = 1.2-V DC + 100 mV<br>DC up to Sine at 300 kHz                          |      | 57            |      |         |
|                                                   | VDDA = 3.3-V DC + 200 mV<br>DC up to Sine at 1 kHz                           |      | 60            |      |         |
|                                                   | VDDA = 3.3-V DC + 200 mV<br>Sine at 900 kHz                                  |      | 57            |      |         |

(1) Load current on VREFHI increases when ADC input is greater than VDDA. This causes inaccurate conversions.

(2) A ceramic capacitor with package size of 0805 or smaller is preferred. Up to ±20% tolerance is acceptable.

(3) Variation across all channels belonging to the same ADC module.

(4) Worst case variation compared to other ADC modules.

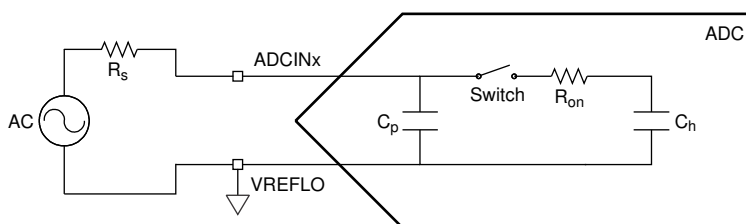
(5) IO activity is minimized on pins adjacent to ADC input and VREFHI pins as part of best practices to reduce capacitive coupling and crosstalk.

### 5.9.1.2.1 ADC Input Model

The ADC input characteristics are given by [Table 5-39](#) and [Figure 5-28](#).

**Table 5-39. Input Model Parameters**

|          | DESCRIPTION                 | REFERENCE MODE                               | VALUE                          |
|----------|-----------------------------|----------------------------------------------|--------------------------------|
| $C_p$    | Parasitic input capacitance | All                                          | See <a href="#">Table 5-40</a> |
| $R_{on}$ | Sampling switch resistance  | External Reference, 2.5-V Internal Reference | 500 $\Omega$                   |
|          |                             | 3.3-V Internal Reference                     | 860 $\Omega$                   |
| $C_h$    | Sampling capacitor          | External Reference, 2.5-V Internal Reference | 12.5 pF                        |
|          |                             | 3.3-V Internal Reference                     | 7.5 pF                         |
| $R_s$    | Nominal source impedance    | All                                          | 50 $\Omega$                    |



**Figure 5-28. Input Model**

This input model should be used with actual signal source impedance to determine the acquisition window duration. For more information, see the [Choosing an Acquisition Window Duration](#) section of the [Analog-to-Digital Converter \(ADC\) chapter](#) in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

[Table 5-40](#) lists the parasitic capacitance on each channel.

**Table 5-40. Per-Channel Parasitic Capacitance**

| ADC CHANNEL                    | $C_p$ (pF)          |                    |
|--------------------------------|---------------------|--------------------|
|                                | COMPARATOR DISABLED | COMPARATOR ENABLED |
| ADCINA0/ADCINC15               | 3.3                 | 15.8               |
| ADCINA1                        | 2.4                 | 4.9                |
| ADCINA2/ADCINC9                | 2.9                 | 5.4                |
| ADCINA3/ADCINC5 <sup>(1)</sup> | 71.4                | 73.9               |
| ADCINA4/ADCINC14               | 4.5                 | 7                  |
| ADCINA5/ADCINC2                | 2.7                 | 5.2                |
| ADCINA6                        | 2.6                 | 5.1                |
| ADCINA7/ADCINC3                | 4.2                 | 6.7                |
| ADCINA8/ADCINC11               | 4.5                 | 7                  |
| ADCINA9/ADCINC8                | 3.4                 | 5.9                |
| ADCINA10/ADCINC10              | 2.9                 | 5.4                |
| ADCINA11/ADCINC0               | 2.9                 | 5.4                |
| ADCINA12/ADCINC1               | 4.7                 | 7.2                |
| ADCINA14/ADCINC4               | 2.5                 | 5                  |
| ADCINA15/ADCINC7               | 3.3                 | 5.8                |
| ADCINC6                        | 2.9                 | 5.4                |

(1) Pin also used to supply reference voltage for COMPDAC and includes an internal decoupling capacitor.

### 5.9.1.2.2 ADC Timing Diagrams

Figure 5-29 shows the ADC conversion timings for two SOC's given the following assumptions:

- SOC0 and SOC1 are configured to use the same trigger.
- No other SOC's are converting or pending when the trigger occurs.
- The round-robin pointer is in a state that causes SOC0 to convert first.
- ADCINTSEL is configured to set an ADCINT flag upon end of conversion for SOC0 (whether this flag propagates through to the CPU to cause an interrupt is determined by the configurations in the PIE module).

Table 5-41 lists the descriptions of the ADC timing parameters. Table 5-42 lists the ADC timings.

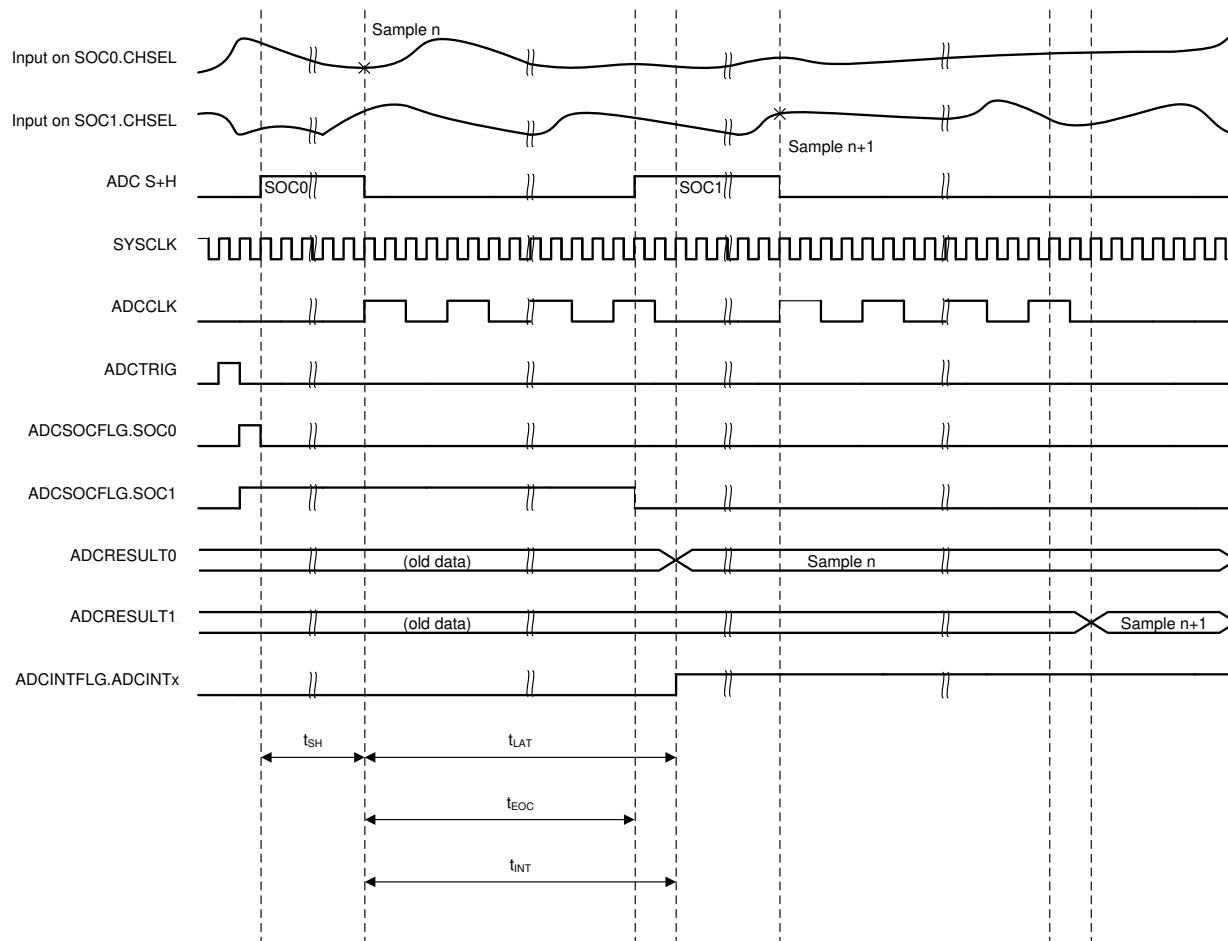


Figure 5-29. ADC Timings

**Table 5-41. ADC Timing Parameters**

| PARAMETER | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|-----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $t_{SH}$  | <p>The duration of the S+H window.</p> <p>At the end of this window, the value on the S+H capacitor becomes the voltage to be converted into a digital value. The duration is given by (ACQPS + 1) SYSCLK cycles. ACQPS can be configured individually for each SOC, so <math>t_{SH}</math> will not necessarily be the same for different SOCs.</p> <p><b>Note:</b> The value on the S+H capacitor will be captured approximately 5 ns before the end of the S+H window regardless of device clock settings.</p>                                                                                                                                                                                                                                                                                                                                                                                                                     |
| $t_{LAT}$ | <p>The time from the end of the S+H window until the ADC results latch in the ADCRESULTx register.</p> <p>If the ADCRESULTx register is read before this time, the previous conversion results will be returned.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| $t_{EOC}$ | <p>The time from the end of the S+H window until the S+H window for the next ADC conversion can begin. The subsequent sample can start before the conversion results are latched.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| $t_{INT}$ | <p>The time from the end of the S+H window until an ADCINT flag is set (if configured).</p> <p>If the INTPULSEPOS bit in the ADCCTL1 register is set, <math>t_{INT}</math> will coincide with the conversion results being latched into the result register.</p> <p>If the INTPULSEPOS bit is 0, <math>t_{INT}</math> will coincide with the end of the S+H window. If <math>t_{INT}</math> triggers a read of the ADC result register (directly through DMA or indirectly by triggering an ISR that reads the result), care must be taken to ensure the read occurs after the results latch (otherwise, the previous results will be read).</p> <p>If the INTPULSEPOS bit is 0, and the OFFSET field in the ADCINTCYCLE register is not 0, then there will be a delay of OFFSET SYSCLK cycles before the ADCINT flag is set. This delay can be used to enter the ISR or trigger the DMA at exactly the time the sample is ready.</p> |

**Table 5-42. ADC Timings**

| ADCCLK PRESCALE    |                        | SYSCLK CYCLES |                 |                        |                 | ADCCLK CYCLES |
|--------------------|------------------------|---------------|-----------------|------------------------|-----------------|---------------|
| ADCCTL2 [PRESCALE] | RATIO<br>ADCCLK:SYSCLK | $t_{EOC}$     | $t_{LAT}^{(1)}$ | $t_{INT(EARLY)}^{(2)}$ | $t_{INT(LATE)}$ | $t_{EOC}$     |
| 0                  | 1                      | 11            | 13              | 1                      | 11              | 11            |
| 2                  | 2                      | 21            | 23              | 1                      | 21              | 10.5          |
| 4                  | 3                      | 31            | 34              | 1                      | 31              | 10.3          |
| 6                  | 4                      | 41            | 44              | 1                      | 41              | 10.3          |
| 8                  | 5                      | 51            | 55              | 1                      | 51              | 10.2          |
| 10                 | 6                      | 61            | 65              | 1                      | 61              | 10.2          |
| 12                 | 7                      | 71            | 76              | 1                      | 71              | 10.1          |
| 14                 | 8                      | 81            | 86              | 1                      | 81              | 10.1          |

(1) Refer to the "ADC: DMA Read of Stale Result" advisory in the [TMS320F28002x MCUs Silicon Errata](#).

(2) By default,  $t_{INT}$  occurs one SYSCLK cycle after the S+H window if INTPULSEPOS is 0. This can be changed by writing to the OFFSET field in the ADCINTCYCLE register.

## 5.9.2 Temperature Sensor

### 5.9.2.1 Temperature Sensor Electrical Data and Timing

The temperature sensor can be used to measure the device junction temperature. The temperature sensor is sampled through an internal connection to the ADC and translated into a temperature through TI-provided software. When sampling the temperature sensor, the ADC must meet the acquisition time in [Table 5-43](#).

**Table 5-43. Temperature Sensor Characteristics**

over recommended operating conditions (unless otherwise noted)

|               | PARAMETER                                                               | TEST CONDITIONS    | MIN | TYP      | MAX | UNIT               |
|---------------|-------------------------------------------------------------------------|--------------------|-----|----------|-----|--------------------|
| $T_{acc}$     | Temperature Accuracy                                                    | External reference |     | $\pm 15$ |     | $^{\circ}\text{C}$ |
| $t_{startup}$ | Start-up time<br>(TSNSCTL[ENABLE] to<br>sampling temperature<br>sensor) |                    |     | 500      |     | $\mu\text{s}$      |
| $t_{acq}$     | ADC acquisition time                                                    |                    | 450 |          |     | ns                 |

### 5.9.3 Comparator Subsystem (CMPSS)

Each CMPSS contains two comparators, two reference 12-bit DACs, two digital filters, and one ramp generator. Comparators are denoted "H" or "L" within each module, where "H" and "L" represent high and low, respectively. Each comparator generates a digital output that indicates whether the voltage on the positive input is greater than the voltage on the negative input. The positive input of the comparator can be driven from an external pin or by the PGA. The negative input can be driven by an external pin or by the programmable reference 12-bit DAC. Each comparator output passes through a programmable digital filter that can remove spurious trip signals. An unfiltered output is also available if filtering is not required. A ramp generator circuit is optionally available to control the reference 12-bit DAC value for the high comparator in the subsystem. There are two outputs from each CMPSS module. These two outputs pass through the digital filters and crossbar before connecting to the ePWM modules or GPIO pin. Figure 5-30 shows the CMPSS connectivity.

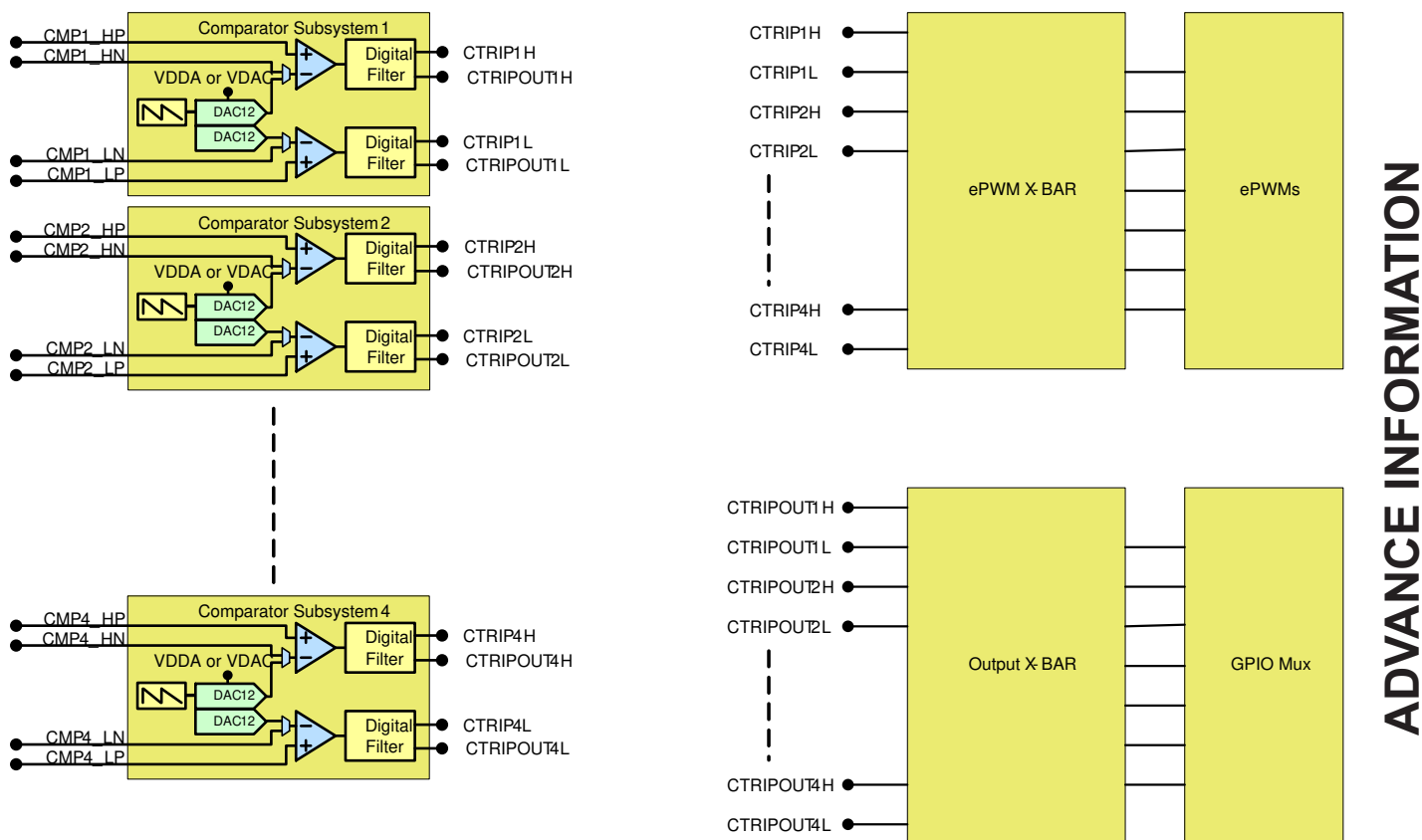


Figure 5-30. CMPSS Connectivity

### 5.9.3.1 CMPSS Electrical Data and Timing

Table 5-44 lists the comparator electrical characteristics. Figure 5-31 shows the CMPSS comparator input referred offset. Figure 5-32 shows the CMPSS comparator hysteresis.

**Table 5-44. Comparator Electrical Characteristics**

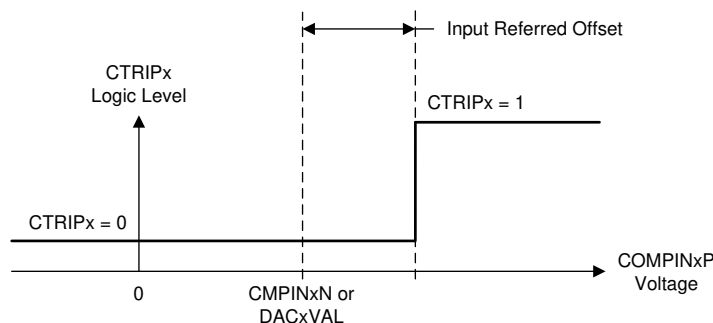
over recommended operating conditions (unless otherwise noted)

| PARAMETER                                                                              |                              | TEST CONDITIONS                              | MIN | TYP | MAX  | UNIT |
|----------------------------------------------------------------------------------------|------------------------------|----------------------------------------------|-----|-----|------|------|
| TPU                                                                                    | Power-up time                |                                              |     |     | 500  | μs   |
| Comparator input (CMPINxx) range                                                       |                              |                                              | 0   |     | VDDA | V    |
| Input referred offset error                                                            |                              | Low common mode, inverting input set to 50mV | -20 |     | 20   | mV   |
| Hysteresis <sup>(1)</sup>                                                              | 1x                           |                                              |     | 12  |      | LSB  |
|                                                                                        | 2x                           |                                              |     | 24  |      |      |
|                                                                                        | 3x                           |                                              |     | 36  |      |      |
|                                                                                        | 4x                           |                                              |     | 48  |      |      |
| Response time (delay from CMPINx input change to output on ePWM X-BAR or Output X-BAR) | Step response                |                                              |     | 21  | 60   | ns   |
|                                                                                        | Ramp response (1.65V/μs)     |                                              |     | 26  |      |      |
|                                                                                        | Ramp response (8.25mV/μs)    |                                              |     | 30  |      | ns   |
| PSRR                                                                                   | Power Supply Rejection Ratio | Up to 250 kHz                                |     | 46  |      | dB   |
| CMRR                                                                                   | Common Mode Rejection Ratio  |                                              | 40  |     |      | dB   |

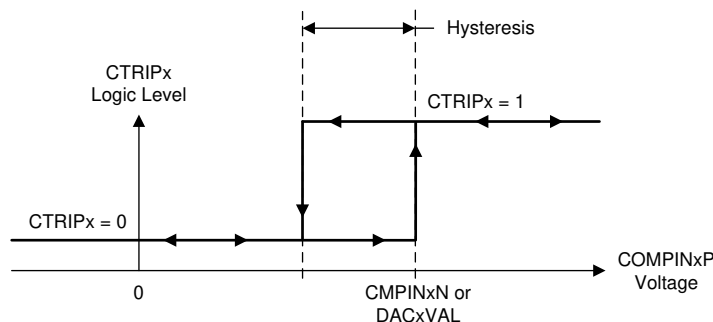
- (1) The CMPSS DAC is used as the reference to determine how much hysteresis to apply. Therefore, hysteresis will scale with the CMPSS DAC reference voltage. Hysteresis is available for all comparator input source configurations.

#### NOTE

The CMPSS inputs must be kept below VDDA + 0.3 V to ensure proper functional operation. If a CMPSS input exceeds this level, an internal blocking circuit isolates the internal comparator from the external pin until the external pin voltage returns below VDDA + 0.3 V. During this time, the internal comparator input is floating and can decay below VDDA within approximately 0.5 μs. After this time, the comparator could begin to output an incorrect result depending on the value of the other comparator input.



**Figure 5-31. CMPSS Comparator Input Referred Offset**



**Figure 5-32. CMPSS Comparator Hysteresis**

Table 5-45 lists the CMPSS DAC static electrical characteristics.

**Table 5-45. CMPSS DAC Static Electrical Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER                                   | TEST CONDITIONS                                                                        | MIN  | TYP        | MAX                 | UNIT     |
|---------------------------------------------|----------------------------------------------------------------------------------------|------|------------|---------------------|----------|
| CMPSS DAC output range                      | Internal reference                                                                     | 0    |            | VDDA                | V        |
|                                             | External reference                                                                     | 0    |            | VDAC <sup>(1)</sup> |          |
| Static offset error <sup>(2)</sup>          |                                                                                        | -25  |            | 25                  | mV       |
| Static gain error <sup>(2)</sup>            |                                                                                        | -2   |            | 2                   | % of FSR |
| Static DNL                                  | Endpoint corrected                                                                     | >-1  |            | 4                   | LSB      |
| Static INL                                  | Endpoint corrected                                                                     | -16  |            | 16                  | LSB      |
| Settling time                               | Settling to 1LSB after full-scale output change                                        |      |            | 1                   | μs       |
| Resolution                                  |                                                                                        |      | 12         |                     | bits     |
| CMPSS DAC output disturbance <sup>(3)</sup> | Error induced by comparator trip or CMPSS DAC code change within the same CMPSS module | -100 |            | 100                 | LSB      |
| CMPSS DAC disturbance time <sup>(3)</sup>   |                                                                                        |      |            | 200                 | ns       |
| VDAC reference voltage                      | When VDAC is reference                                                                 | 2.4  | 2.5 or 3.0 | VDDA                | V        |
| VDAC load <sup>(4)</sup>                    | When VDAC is reference                                                                 | 6    | 8          | 10                  | kΩ       |

(1) The maximum output voltage is VDDA when VDAC > VDDA.

(2) Includes comparator input referred errors.

(3) Disturbance error may be present on the CMPSS DAC output for a certain amount of time after a comparator trip.

(4) Per active CMPSS module.

### 5.9.3.1.1 CMPSS Illustrative Graphs

Figure 5-33 shows the CMPSS DAC static offset. Figure 5-34 shows the CMPSS DAC static gain. Figure 5-35 shows the CMPSS DAC static linearity.

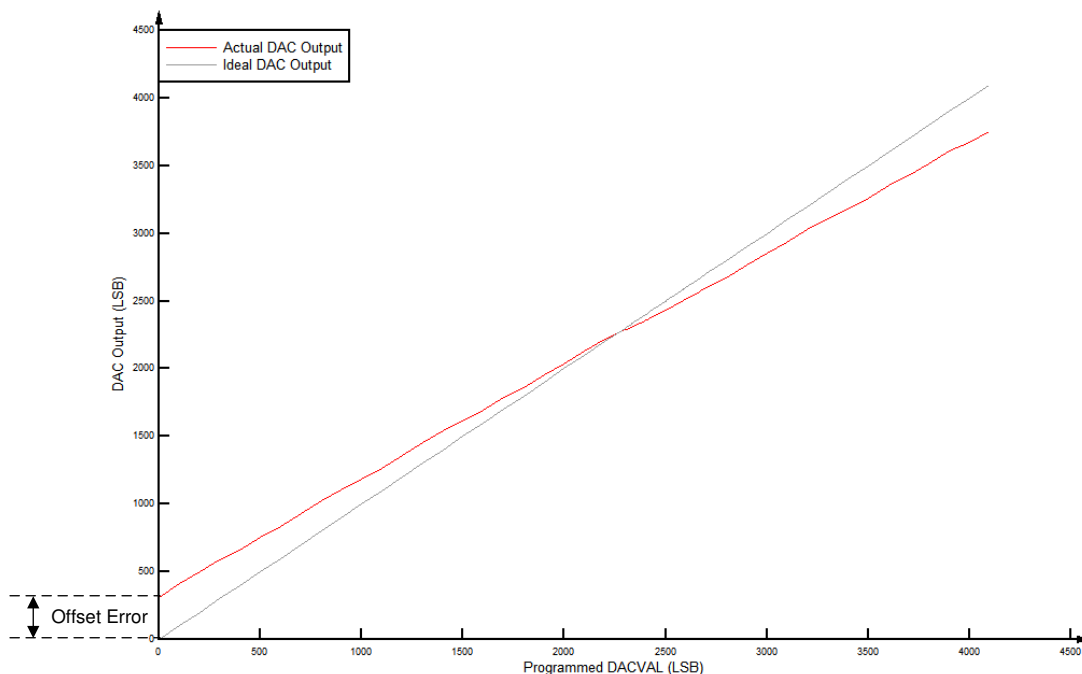


Figure 5-33. CMPSS DAC Static Offset

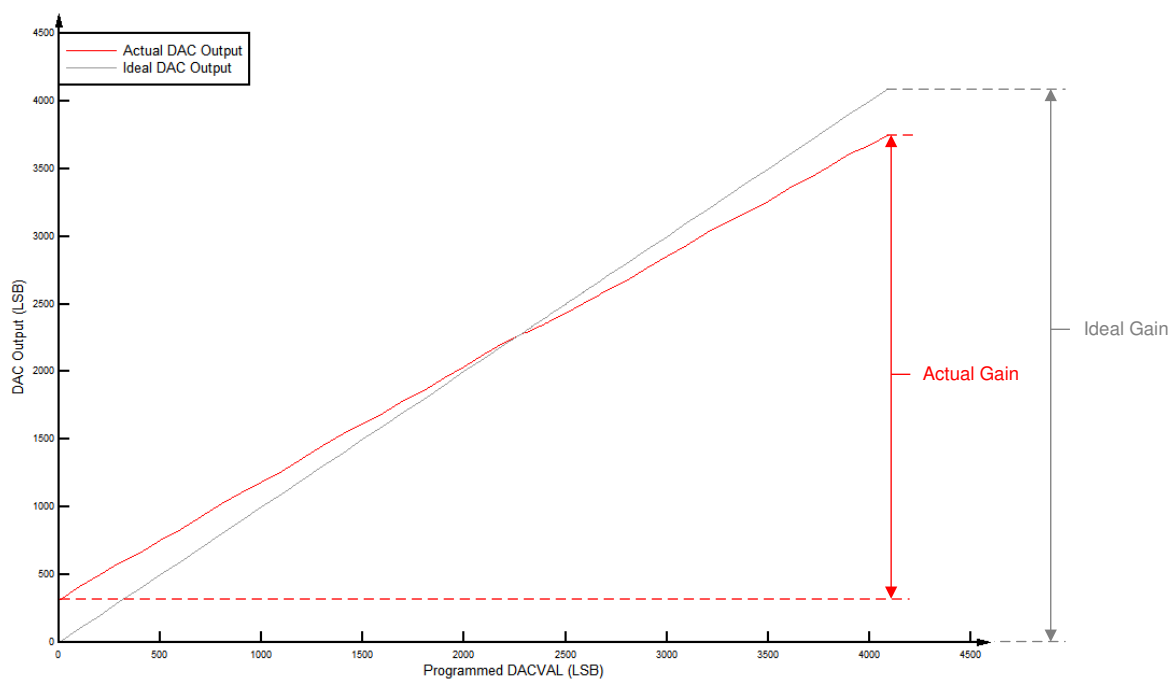
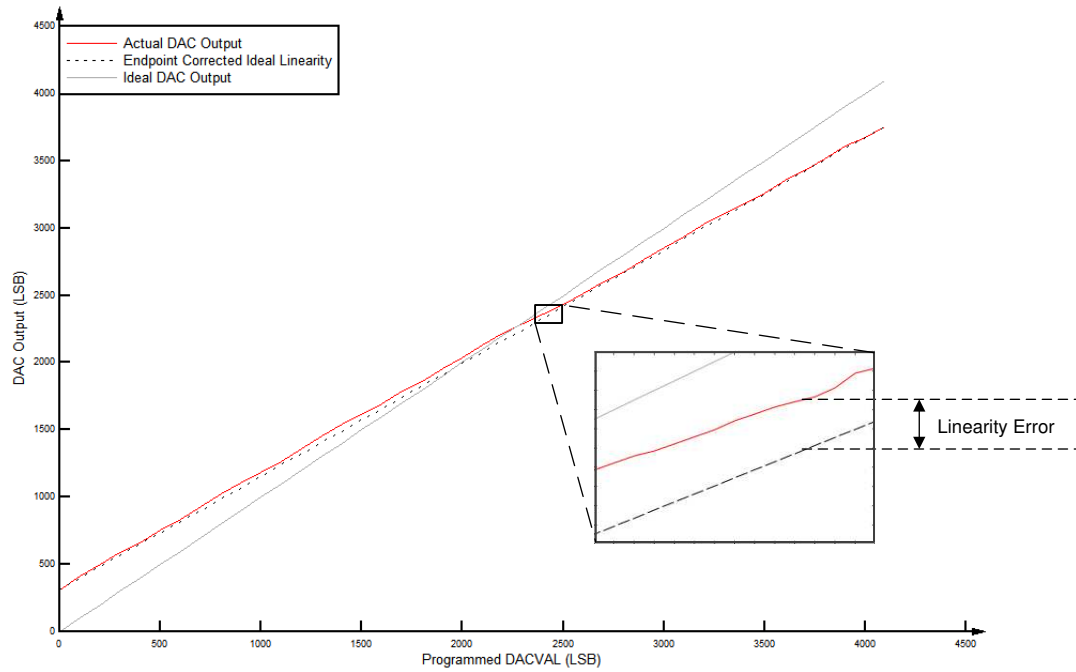


Figure 5-34. CMPSS DAC Static Gain



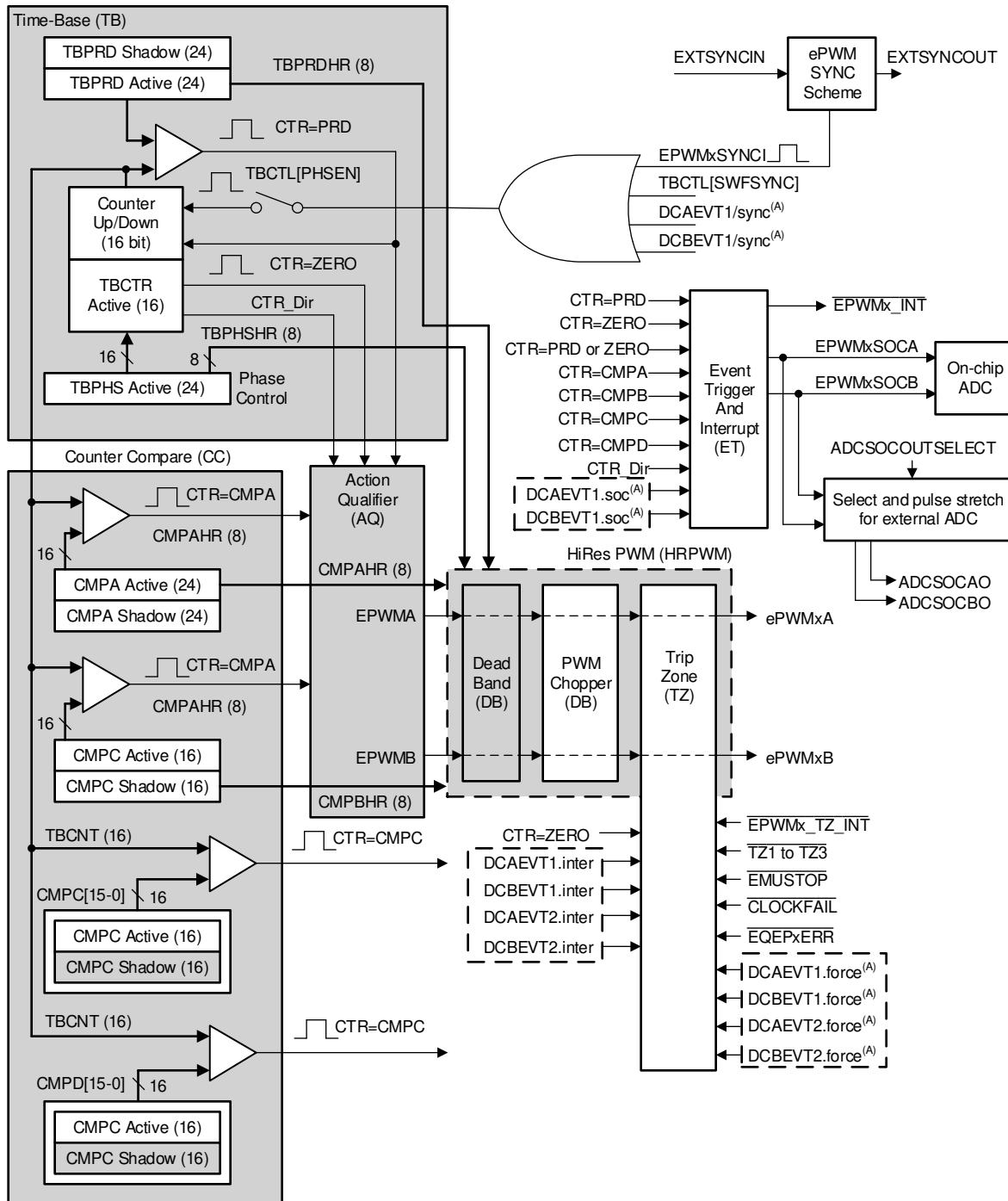
**Figure 5-35. CMPSS DAC Static Linearity**

## 5.10 Control Peripherals

### 5.10.1 Enhanced Pulse Width Modulator (ePWM)

The ePWM peripheral is a key element in controlling many of the power electronic systems found in both commercial and industrial equipment. The ePWM type-4 module is able to generate complex pulse width waveforms with minimal CPU overhead by building the peripheral up from smaller modules with separate resources that can operate together to form a system. Some of the highlights of the ePWM type-4 module include complex waveform generation, dead-band generation, a flexible synchronization scheme, advanced trip-zone functionality, and global register reload capabilities.

[Figure 5-36](#) shows the ePWM module. [Figure 5-37](#) shows the ePWM trip input connectivity.



A. These events are generated by the ePWM digital compare (DC) submodule based on the levels of the TRIPIN inputs.

**Figure 5-36. ePWM Submodules and Critical Internal Signal Interconnects**

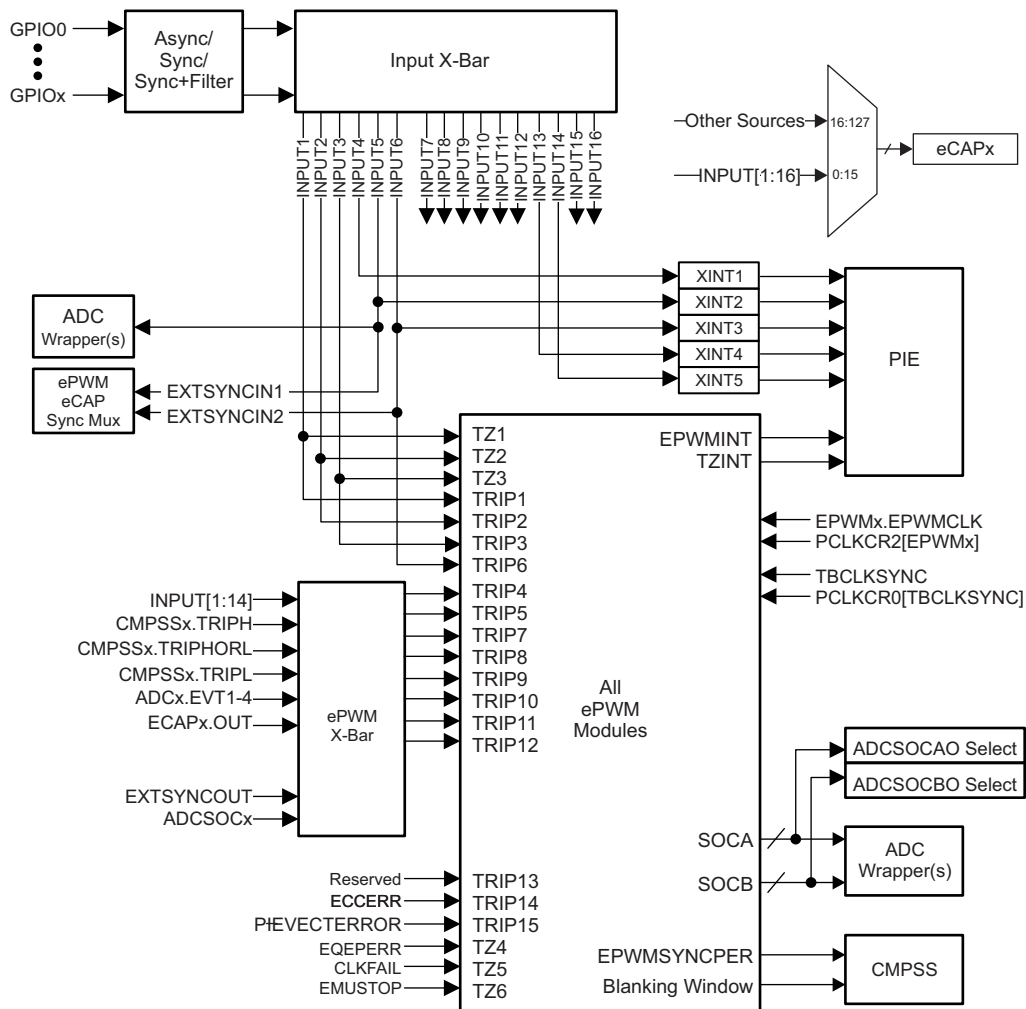


Figure 5-37. ePWM Trip Input Connectivity

### 5.10.1.1 Control Peripherals Synchronization

The ePWM and eCAP synchronization scheme on the device provides flexibility in partitioning the ePWM and eCAP modules and allows localized synchronization within the modules. Like the other peripherals, the partitioning of the ePWM and eCAP modules needs to be done using the CPUSELx registers. Figure 5-38 shows the synchronization scheme.

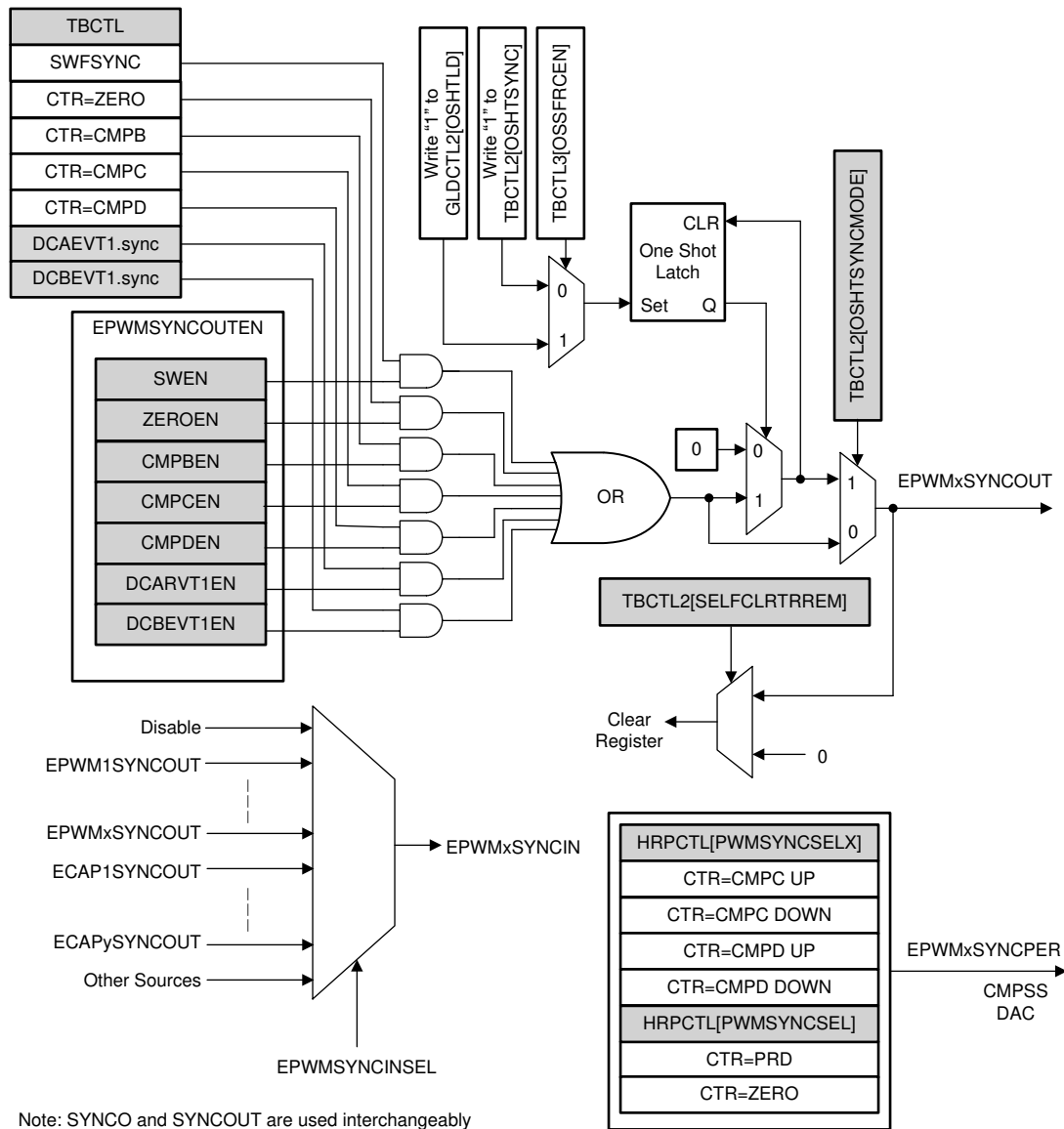


Figure 5-38. Synchronization Chain Architecture

### 5.10.1.2 ePWM Electrical Data and Timing

Table 5-46 lists the PWM timing requirements and Table 5-47 lists the PWM switching characteristics.

**Table 5-46. ePWM Timing Requirements<sup>(1)</sup>**

|                         |                        |                      | MIN                                              | MAX | UNIT   |
|-------------------------|------------------------|----------------------|--------------------------------------------------|-----|--------|
| t <sub>w</sub> (SYNCIN) | Sync input pulse width | Asynchronous         | 2t <sub>c</sub> (EPWMCLK)                        |     | cycles |
|                         |                        | Synchronous          | 2t <sub>c</sub> (EPWMCLK)                        |     |        |
|                         |                        | With input qualifier | 1t <sub>c</sub> (EPWMCLK) + t <sub>w</sub> (QSW) |     |        |

(1) For an explanation of the input qualifier parameters, see Table 5-24.

**Table 5-47. ePWM Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER       |                                                                                                                                                  | MIN               | MAX | UNIT   |
|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------|-------------------|-----|--------|
| $t_{w(PWM)}$    | Pulse duration, PWMx output high/low                                                                                                             | 20                |     | ns     |
| $t_{w(SYNOUT)}$ | Sync output pulse width                                                                                                                          | $8t_{c(SYSCCLK)}$ |     | cycles |
| $t_{d(TZ-PWM)}$ | Delay time, trip input active to PWM forced high<br>Delay time, trip input active to PWM forced low<br>Delay time, trip input active to PWM Hi-Z |                   | 25  | ns     |

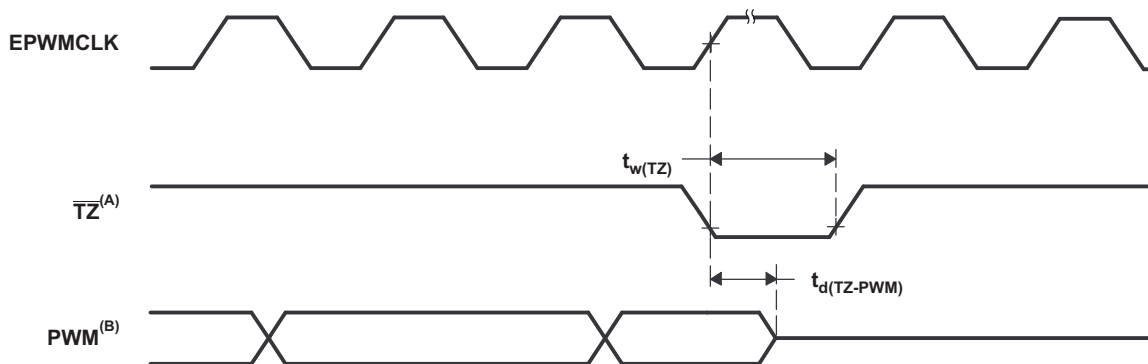
#### 5.10.1.2.1 Trip-Zone Input Timing

Table 5-48 lists the trip-zone input timing requirements. Figure 5-39 shows the PWM Hi-Z characteristics.

**Table 5-48. Trip-Zone Input Timing Requirements<sup>(1)</sup>**

|             |                                            |                      | MIN                             | MAX | UNIT   |
|-------------|--------------------------------------------|----------------------|---------------------------------|-----|--------|
| $t_{w(TZ)}$ | Pulse duration, $\overline{TZx}$ input low | Asynchronous         | $1t_{c(EPWMCLK)}$               |     | cycles |
|             |                                            | Synchronous          | $2t_{c(EPWMCLK)}$               |     | cycles |
|             |                                            | With input qualifier | $1t_{c(EPWMCLK)} + t_{w(IQSW)}$ |     | cycles |

(1) For an explanation of the input qualifier parameters, see Table 5-24.



A.  $\overline{TZ}$ :  $\overline{TZ1}$ ,  $\overline{TZ2}$ ,  $\overline{TZ3}$ , TRIP1–TRIP12

B. PWM refers to all the PWM pins in the device. The state of the PWM pins after  $\overline{TZ}$  is taken high depends on the PWM recovery software.

**Figure 5-39. PWM Hi-Z Characteristics**

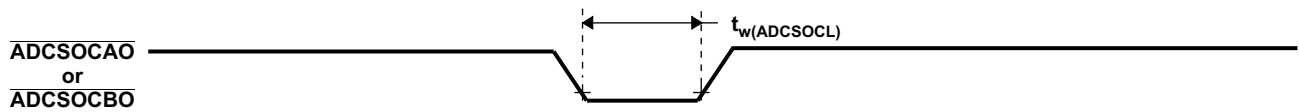
### 5.10.1.3 External ADC Start-of-Conversion Electrical Data and Timing

Table 5-49 lists the external ADC start-of-conversion switching characteristics. Figure 5-40 shows the ADCSOCAO or ADCSOCBO timing.

**Table 5-49. External ADC Start-of-Conversion Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER        |                              | MIN               | MAX | UNIT   |
|------------------|------------------------------|-------------------|-----|--------|
| $t_{w(ADCSOCL)}$ | Pulse duration, ADCSOCxO low | $32t_{c(SYSCLK)}$ |     | cycles |



**Figure 5-40. ADCSOCAO or ADCSOCBO Timing**

### 5.10.2 High-Resolution Pulse Width Modulator (HRPWM)

The HRPWM combines multiple delay lines in a single module and a simplified calibration system by using a dedicated calibration delay line. For each ePWM module, there are two HR outputs:

- HR Duty and Deadband control on Channel A
- HR Duty and Deadband control on Channel B

The HRPWM module offers PWM resolution (time granularity) that is significantly better than what can be achieved using conventionally derived digital PWM methods. The key points for the HRPWM module are:

- Significantly extends the time resolution capabilities of conventionally derived digital PWM
- This capability can be used in both single edge (duty cycle and phase-shift control) as well as dual edge control for frequency/period modulation.
- Finer time granularity control or edge positioning is controlled through extensions to the Compare A, B, phase, period and deadband registers of the ePWM module.

#### NOTE

The minimum HRPWMCLK frequency allowed for HRPWM is 60 MHz.

#### 5.10.2.1 HRPWM Electrical Data and Timing

Table 5-50 lists the high-resolution PWM switching characteristics.

**Table 5-50. High-Resolution PWM Characteristics**

| PARAMETER                                             | MIN | TYP | MAX | UNIT |
|-------------------------------------------------------|-----|-----|-----|------|
| Micro Edge Positioning (MEP) step size <sup>(1)</sup> |     | 150 | 310 | ps   |

- (1) The MEP step size will be largest at high temperature and minimum voltage on  $V_{DD}$ . MEP step size will increase with higher temperature and lower voltage and decrease with lower temperature and higher voltage. Applications that use the HRPWM feature should use MEP Scale Factor Optimizer (SFO) estimation software functions. See the TI software libraries for details of using SFO functions in end applications. SFO functions help to estimate the number of MEP steps per SYSCLK period dynamically while the HRPWM is in operation.

### 5.10.3 Enhanced Capture and High-Resolution Capture (eCAP, HRCAP)

The eCAP module can be used in systems where accurate timing of external events is important. eCAP/HRCAP on this device is Type-2.

Applications for eCAP include:

- Speed measurements of rotating machinery (for example, toothed sprockets sensed through Hall sensors)
- Elapsed time measurements between position sensor pulses
- Period and duty cycle measurements of pulse train signals
- Decoding current or voltage amplitude derived from duty cycle encoded current/voltage sensors

The eCAP module includes the following features:

- 4-event time-stamp registers (each 32 bits)
- Edge-polarity selection for up to four sequenced time-stamp capture events
- Interrupt on either of the four events
- Single shot capture of up to four event timestamps
- Continuous mode capture of timestamps in a four-deep circular buffer
- Absolute time-stamp capture
- Difference (Delta) mode time-stamp capture
- All of the above resources dedicated to a single input pin
- When not used in capture mode, the eCAP module can be configured as a single-channel PWM output (APWM).

The capture functionality of the Type-1 eCAP is enhanced from the Type-0 eCAP with the following added features:

- Event filter reset bit
  - Writing a 1 to ECCTL2[CTRFILTRESET] will clear the event filter, the modulo counter, and any pending interrupts flags. Resetting the bit is useful for initialization and debug.
- Modulo counter status bits
  - The modulo counter (ECCTL2 [MODCTRSTS]) indicates which capture register will be loaded next. In the Type-0 eCAP, it was not possible to know current state of modulo counter.
- DMA trigger source
  - eCAPxDMA is added as a DMA trigger. CEVT[1–4] can be configured as the source for eCAPxDMA.
- Input multiplexer
  - ECCTL0 [INPUTSEL] selects one of 128 input signals.
- EALLOW protection
  - EALLOW protection is added to critical registers. To maintain software compatibility with the Type-0 eCAP, configure DEV\_CFG\_REGS.ECAPTYPE to make these registers unprotected.

The capture functionality of the Type-2 eCAP is enhanced from the Type-1 eCAP with the following added features:

- ECAPxSYNCINSEL register
  - The ECAPxSYNCINSEL register is added for each eCAP to select an external SYNCIN. Every eCAP can have a separate SYNCIN signal.

The eCAP inputs connect to any GPIO input through the Input X-BAR. The APWM outputs connect to GPIO pins through the Output X-BAR to OUTPUTx positions in the GPIO mux. See and .

The eCAP module is clocked by PERx.SYSCLK.

The clock enable bits (ECAP1–ECAP3) in the PCLKCR3 register turn off the eCAP module individually (for low-power operation). Upon reset, ECAP1ENCLK is set to low, indicating that the peripheral clock is off.

### 5.10.3.1 High-Resolution Capture (HRCAP)

eCAP3 module can be configured as high-resolution capture (HRCAP) submodules. The HRCAP submodule measures the difference, in time, between pulses asynchronously to the system clock. This submodule is new to the eCAP Type 1 module, and features many enhancements over the Type 0 HRCAP module.

Applications for the HRCAP include:

- Capacitive touch applications
- High-resolution period and duty-cycle measurements of pulse train cycles
- Instantaneous speed measurements
- Instantaneous frequency measurements
- Voltage measurements across an isolation boundary
- Distance/sonar measurement and scanning
- Flow measurements

The HRCAP submodule includes the following features:

- Pulse-width capture in either non-high-resolution or high-resolution modes
- Absolute mode pulse-width capture
- Continuous or "one-shot" capture
- Capture on either falling or rising edge
- Continuous mode capture of pulse widths in 4-deep buffer

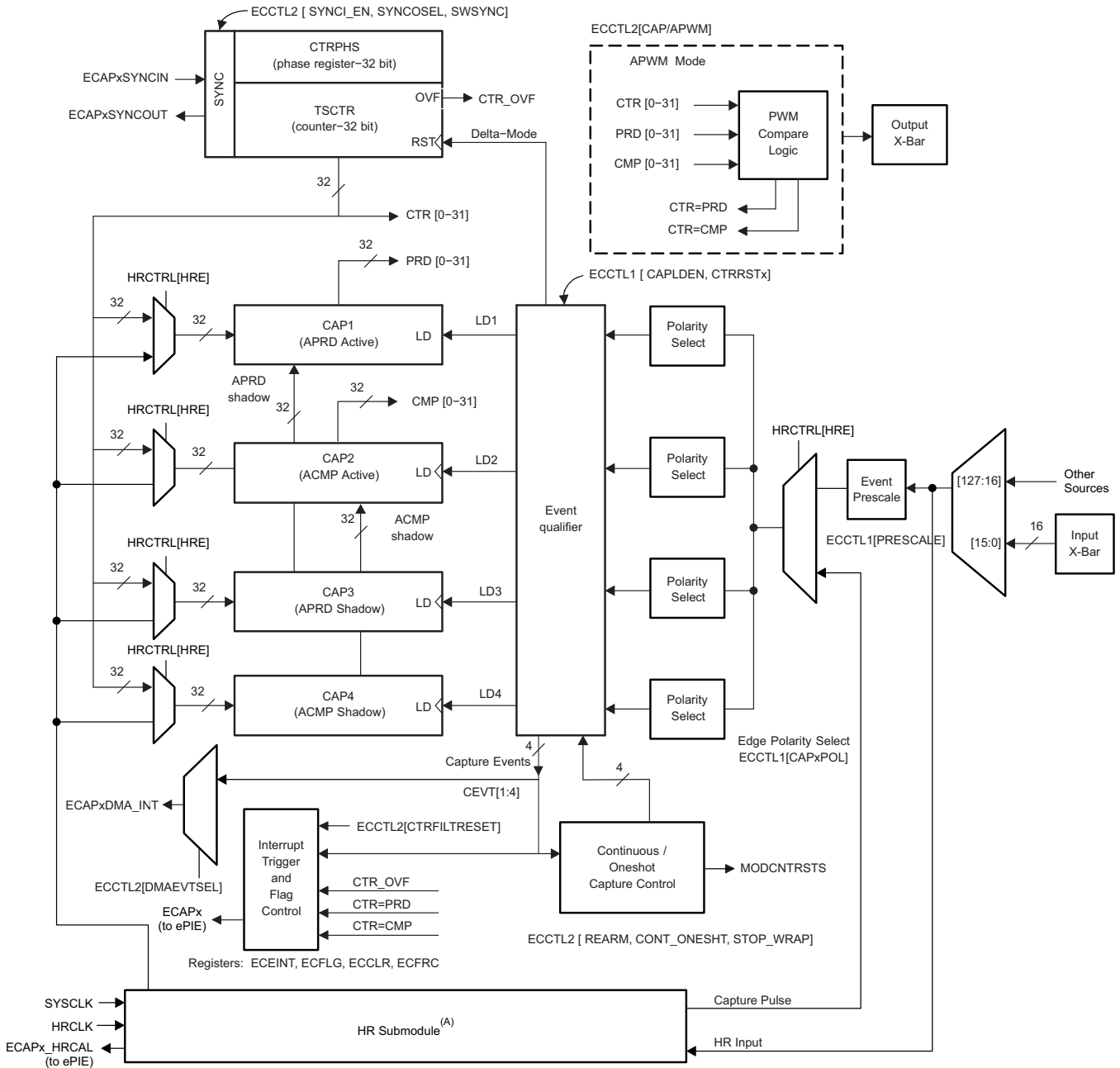
- Hardware calibration logic for precision high-resolution capture
- All of the resources in this list are available on any pin using the Input X-BAR.

The HRCAP submodule includes one high-resolution capture channel in addition to a calibration block. The calibration block allows the HRCAP submodule to be continually recalibrated, at a set interval, with no “down time”. Because the HRCAP submodule now uses the same hardware as its respective eCAP, if the HRCAP is used, the corresponding eCAP will be unavailable.

Each high-resolution-capable channel has the following independent key resources.

- All hardware of the respective eCAP
- High-resolution calibration logic
- Dedicated calibration interrupt

[Figure 5-41](#) shows the eCAP and HRCAP block diagram.



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- A. The HRCAP submodule is not available on all eCAP modules; in this case, the high-resolution muxes and hardware are not implemented.

Figure 5-41. eCAP and HRCAP Block Diagram

ADVANCE INFORMATION

### 5.10.3.2 eCAP/HRCAP Synchronization

The eCAP modules can be synchronized with each other by selecting a common SYNCIN source. SYNCIN source for eCAP can be either software sync-in or external sync-in. The external sync-in signal can come from EPWM, eCAP, or X-Bar. The SYNC signal is defined by the selection in the ECAPxSYNCINSEL[SEL] bit for ECAPx as shown in Figure 5-42.

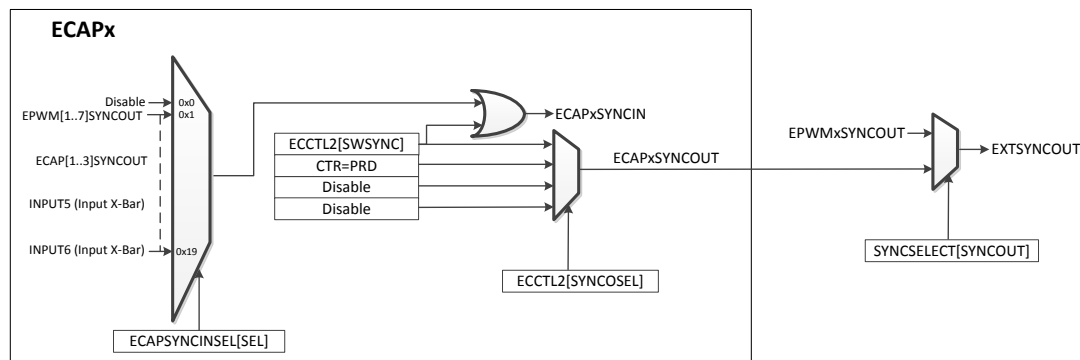


Figure 5-42. eCAPSynchronization Scheme

### 5.10.3.3 eCAP Electrical Data and Timing

Table 5-51 lists the eCAP timing requirements and Table 5-52 lists the eCAP switching characteristics.

**Table 5-51. eCAP Timing Requirements**

|              |                           |                      | MIN                            | NOM | MAX | UNIT |
|--------------|---------------------------|----------------------|--------------------------------|-----|-----|------|
| $t_{W(CAP)}$ | Capture input pulse width | Asynchronous         | $2t_{C(SYSCLK)}$               |     |     | ns   |
|              |                           | Synchronous          | $2t_{C(SYSCLK)}$               |     |     |      |
|              |                           | With input qualifier | $1t_{C(SYSCLK)} + t_{W(IOSW)}$ |     |     |      |

**Table 5-52. eCAP Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER   |                                       | MIN | TYP | MAX | UNIT |
|-------------|---------------------------------------|-----|-----|-----|------|
| $t_w(APWM)$ | Pulse duration, APWMx output high/low | 20  |     |     | ns   |

### 5.10.3.4 HRCAP Electrical Data and Timing

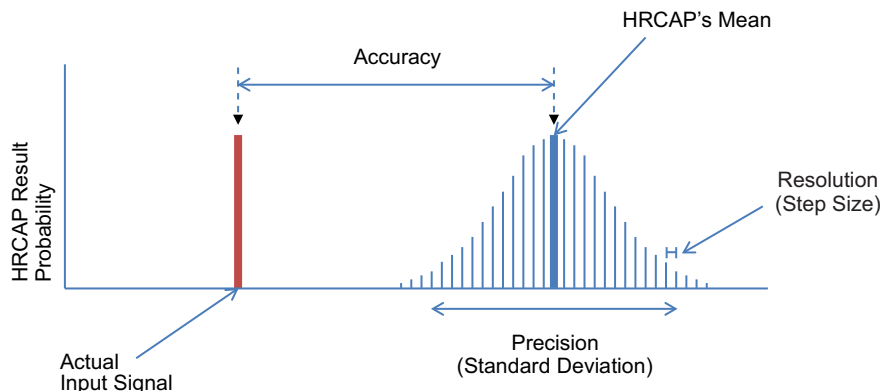
Table 5-53 lists the HRCAP switching characteristics. Figure 5-43 shows the HRCAP accuracy precision and resolution. Figure 5-44 shows the HRCAP standard deviation characteristics.

**Table 5-53. HRCAP Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

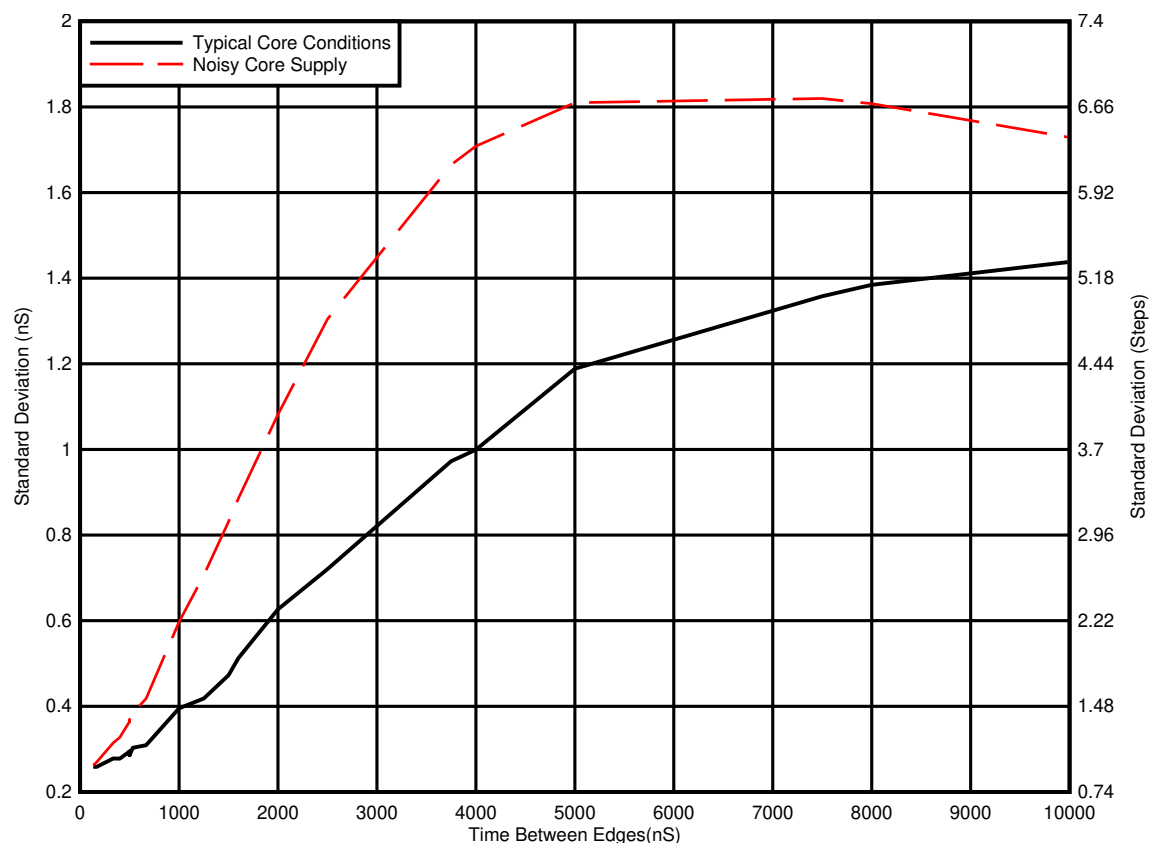
| PARAMETER                        | TEST CONDITIONS                   | MIN             | TYP       | MAX  | UNIT |
|----------------------------------|-----------------------------------|-----------------|-----------|------|------|
| Input pulse width                |                                   | 110             |           |      | ns   |
| Accuracy <sup>(1)(2)(3)(4)</sup> | Measurement length $\leq 5 \mu s$ |                 | $\pm 390$ | 540  | ps   |
|                                  | Measurement length $> 5 \mu s$    |                 | $\pm 450$ | 1450 | ps   |
| Standard deviation               |                                   | See Figure 5-44 |           |      |      |
| Resolution                       |                                   |                 | 300       |      | ps   |

- (1) Value obtained using an oscillator of 100 PPM, oscillator accuracy directly affects the HRCAP accuracy.
- (2) Measurement is completed using rising-rising or falling-falling edges
- (3) Opposite polarity edges will have an additional inaccuracy due to the difference between  $V_{IH}$  and  $V_{IL}$ . This effect is dependent on the signal's slew rate.
- (4) Accuracy only applies to time-converted measurements.



- A. The HRCAP has some variation in performance, this results in a probability distribution which is described using the following terms:
- Accuracy: The time difference between the input signal and the mean of the HRCAP's distribution.
  - Precision: The width of the HRCAP's distribution, this is given as a standard deviation.
  - Resolution: The minimum measurable increment.

**Figure 5-43. HRCAP Accuracy Precision and Resolution**



- Typical core conditions: All peripheral clocks are enabled.
- Noisy core supply: All core clocks are enabled and disabled with a regular period during the measurement.
- Fluctuations in current and voltage on the 1.2-V rail cause the standard deviation of the HRCAP to rise. Care should be taken to ensure that the 1.2-V supply is clean, and that noisy internal events, such as enabling and disabling clock trees, have been minimized while using the HRCAP.

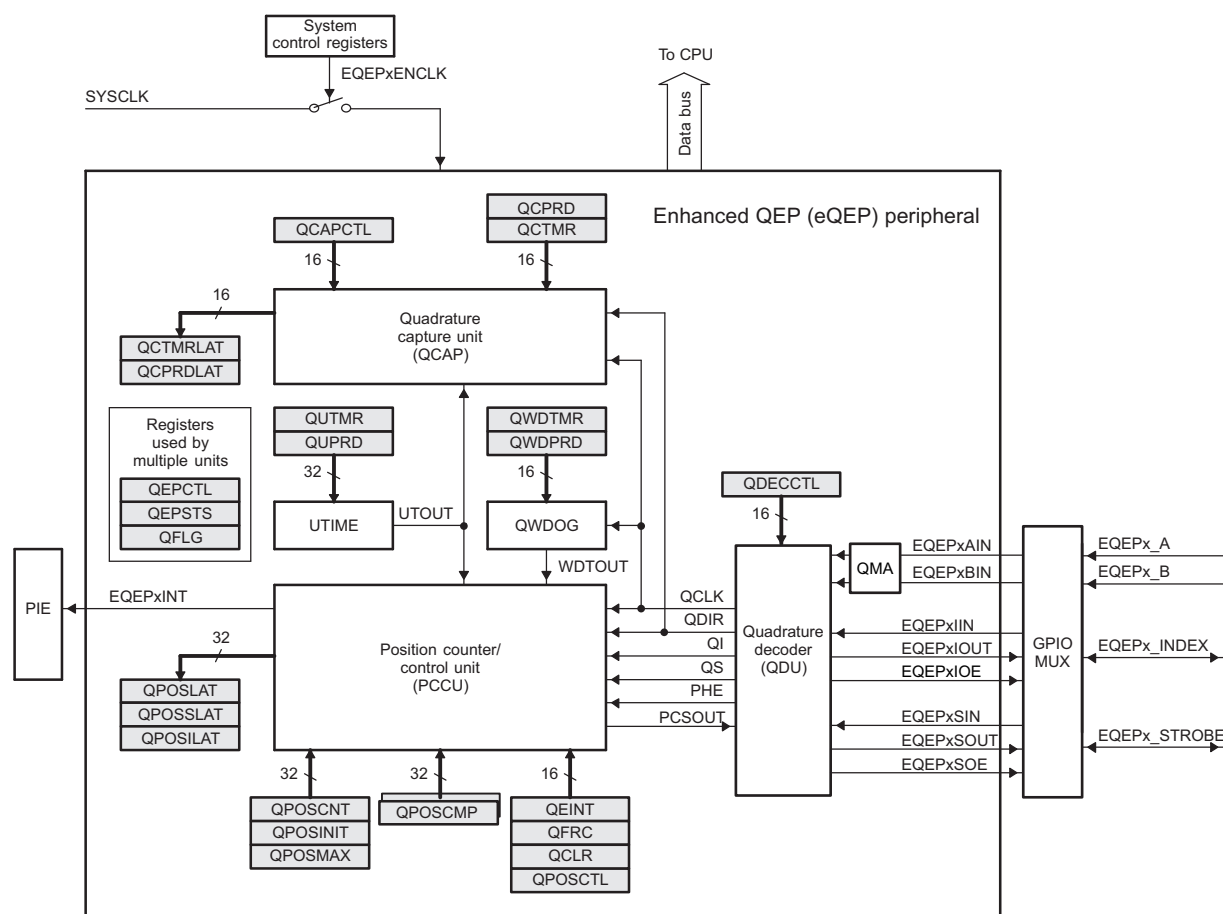
**Figure 5-44. HRCAP Standard Deviation Characteristics**

#### 5.10.4 Enhanced Quadrature Encoder Pulse (eQEP)

The eQEP module on this device is Type-2. The eQEP interfaces directly with linear or rotary incremental encoders to obtain position, direction, and speed information from rotating machines used in high-performance motion and position control systems.

The eQEP peripheral contains the following major functional units (see Figure 5-45):

- Programmable input qualification for each pin (part of the GPIO MUX)
- Quadrature decoder unit (QDU)
- Position counter and control unit for position measurement (PCCU)
- Quadrature edge-capture unit for low-speed measurement (QCAP)
- Unit time base for speed/frequency measurement (UTIME)
- Watchdog timer for detecting stalls (QWDOG)
- Quadrature Mode Adapter (QMA)



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Figure 5-45. eQEP Block Diagram

#### 5.10.4.1 eQEP Electrical Data and Timing

Table 5-54 lists the eQEP timing requirements and Table 5-55 lists the eQEP switching characteristics.

**Table 5-54. eQEP Timing Requirements<sup>(1)</sup>**

|                         |                           |                                  | MIN                                                 | MAX | UNIT   |
|-------------------------|---------------------------|----------------------------------|-----------------------------------------------------|-----|--------|
| t <sub>w</sub> (QEPP)   | QEP input period          | Synchronous <sup>(2)</sup>       | 2t <sub>c</sub> (SYSCLK)                            |     | cycles |
|                         |                           | Synchronous with input qualifier | 2[1t <sub>c</sub> (SYSCLK) + t <sub>w</sub> (IQSW)] |     |        |
| t <sub>w</sub> (INDEXH) | QEP Index Input High time | Synchronous <sup>(2)</sup>       | 2t <sub>c</sub> (SYSCLK)                            |     | cycles |
|                         |                           | Synchronous with input qualifier | 2t <sub>c</sub> (SYSCLK) + t <sub>w</sub> (IQSW)    |     |        |
| t <sub>w</sub> (INDEXL) | QEP Index Input Low time  | Synchronous <sup>(2)</sup>       | 2t <sub>c</sub> (SYSCLK)                            |     | cycles |
|                         |                           | Synchronous with input qualifier | 2t <sub>c</sub> (SYSCLK) + t <sub>w</sub> (IQSW)    |     |        |
| t <sub>w</sub> (STROBH) | QEP Strobe High time      | Synchronous <sup>(2)</sup>       | 2t <sub>c</sub> (SYSCLK)                            |     | cycles |
|                         |                           | Synchronous with input qualifier | 2t <sub>c</sub> (SYSCLK) + t <sub>w</sub> (IQSW)    |     |        |
| t <sub>w</sub> (STROBL) | QEP Strobe Input Low time | Synchronous <sup>(2)</sup>       | 2t <sub>c</sub> (SYSCLK)                            |     | cycles |
|                         |                           | Synchronous with input qualifier | 2t <sub>c</sub> (SYSCLK) + t <sub>w</sub> (IQSW)    |     |        |

(1) For an explanation of the input qualifier parameters, see Table 5-24.

(2) The GPIO GPxQSELn Asynchronous mode should not be used for eQEP module input pins.

**Table 5-55. eQEP Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

|                     | PARAMETER                                                  | MIN               | MAX | UNIT   |
|---------------------|------------------------------------------------------------|-------------------|-----|--------|
| $t_{d(CNTR)xin}$    | Delay time, external clock to counter increment            | $5t_{c(SYSCCLK)}$ |     | cycles |
| $t_{d(PCS-OUT)QEP}$ | Delay time, QEP input edge to position compare sync output | $7t_{c(SYSCCLK)}$ |     | cycles |

## 5.11 Communications Peripherals

### 5.11.1 Controller Area Network (CAN)

#### NOTE

The CAN module uses the IP known as *DCAN*. This document uses the names *CAN* and *DCAN* interchangeably to reference this peripheral.

The CAN module implements the following features:

- Complies with ISO11898-1 ( Bosch® CAN protocol specification 2.0 A and B)
- Bit rates up to 1 Mbps
- Multiple clock sources
- 32 message objects (mailboxes), each with the following properties:
  - Configurable as receive or transmit
  - Configurable with standard (11-bit) or extended (29-bit) identifier
  - Supports programmable identifier receive mask
  - Supports data and remote frames
  - Holds 0 to 8 bytes of data
  - Parity-checked configuration and data RAM
- Individual identifier mask for each message object
- Programmable FIFO mode for message objects
- Programmable loopback modes for self-test operation
- Suspend mode for debug support
- Software module reset
- Automatic bus on after bus-off state by a programmable 32-bit timer
- Two interrupt lines
- DMA support

#### NOTE

For a CAN bit clock of 100 MHz, the smallest bit rate possible is 3.90625 kbps.

#### NOTE

The accuracy of the on-chip zero-pin oscillator is in [Table 5-16](#). Depending on parameters such as the CAN bit timing settings, bit rate, bus length, and propagation delay, the accuracy of this oscillator may not meet the requirements of the CAN protocol. In this situation, an external clock source must be used.

[Figure 5-46](#) shows the CAN block diagram.

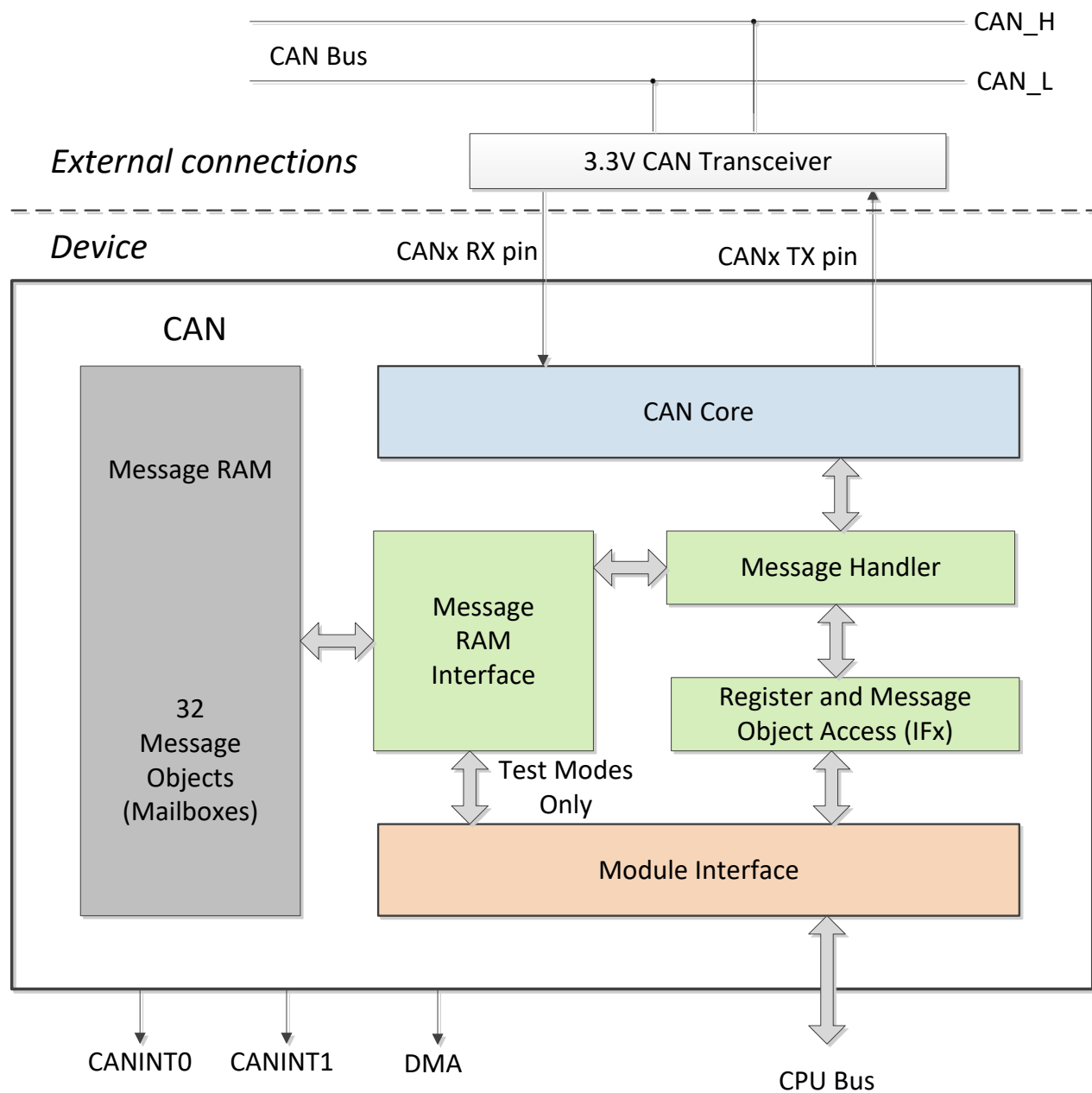


Figure 5-46. CAN Block Diagram

### 5.11.2 Inter-Integrated Circuit (I2C)

The I2C module has the following features:

- Compliance with the NXP Semiconductors I<sup>2</sup>C-bus specification (version 2.1):
  - Support for 8-bit format transfers
  - 7-bit and 10-bit addressing modes
  - General call
  - START byte mode
  - Support for multiple master-transmitters and slave-receivers
  - Support for multiple slave-transmitters and master-receivers
  - Combined master transmit/receive and receive/transmit mode
  - Data transfer rate from 10 kbps up to 400 kbps (Fast-mode)
- One 16-byte receive FIFO and one 16-byte transmit FIFO
- Supports two ePIE interrupts
  - I2Cx interrupt – Any of the below conditions can be configured to generate an I2Cx interrupt:
    - Transmit Ready
    - Receive Ready
    - Register-Access Ready
    - No-Acknowledgment
    - Arbitration-Lost
    - Stop Condition Detected
    - Addressed-as-Slave
  - I2Cx\_FIFO interrupts:
    - Transmit FIFO interrupt
    - Receive FIFO interrupt
- Module enable and disable capability
- Free data format mode

Figure 5-47 shows how the I2C peripheral module interfaces within the device.

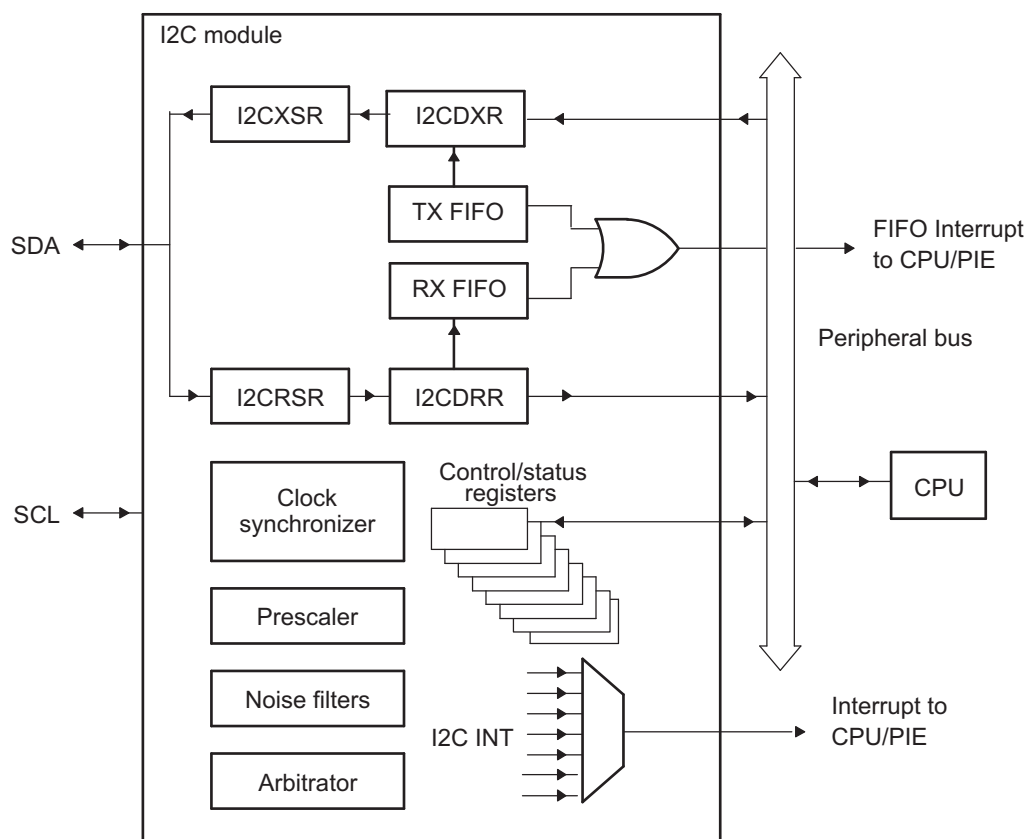


Figure 5-47. I2C Peripheral Module Interfaces

### 5.11.2.1 I2C Electrical Data and Timing

Table 5-56 lists the I2C timing requirements. Table 5-57 lists the I2C switching characteristics.

**Table 5-56. I2C Timing Requirements**

|                        |                                                            | MIN  | MAX | UNIT    |
|------------------------|------------------------------------------------------------|------|-----|---------|
| $t_{h(SDA-SCL)START}$  | Hold time, START condition, SCL fall delay after SDA fall  | 0.6  |     | $\mu s$ |
| $t_{su(SCL-SDA)START}$ | Setup time, Repeated START, SCL rise before SDA fall delay | 0.6  |     | $\mu s$ |
| $t_{h(SCL-DAT)}$       | Hold time, data after SCL fall                             | 0    |     | $\mu s$ |
| $t_{su(DAT-SCL)}$      | Setup time, data before SCL rise                           | 100  |     | ns      |
| $t_r(SDA)$             | Rise time, SDA                                             | 20   | 300 | ns      |
| $t_r(SCL)$             | Rise time, SCL                                             | 20   | 300 | ns      |
| $t_f(SDA)$             | Fall time, SDA                                             | 11.4 | 300 | ns      |
| $t_f(SCL)$             | Fall time, SCL                                             | 11.4 | 300 | ns      |
| $t_{su(SCL-SDA)STOP}$  | Setup time, STOP condition, SCL rise before SDA rise delay | 0.6  |     | $\mu s$ |

**Table 5-57. I2C Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER      | TEST CONDITIONS                                                      | MIN                               | MAX              | UNIT    |
|----------------|----------------------------------------------------------------------|-----------------------------------|------------------|---------|
| $f_{SCL}$      | SCL clock frequency                                                  | 0                                 | 400              | kHz     |
| $t_{w(SCLL)}$  | Pulse duration, SCL clock low                                        | 1.3                               |                  | $\mu s$ |
| $t_{w(SCLH)}$  | Pulse duration, SCL clock high                                       | 0.6                               |                  | $\mu s$ |
| $t_{w(SP)}$    | Pulse duration of spikes that will be suppressed by the input filter | 0                                 | 50               | ns      |
| $t_{BUF}$      | Bus free time between STOP and START conditions                      | 1.3                               |                  | $\mu s$ |
| $t_v(SCL-DAT)$ | Valid time, data after SCL fall                                      |                                   | 0.9              | $\mu s$ |
| $t_v(SCL-ACK)$ | Valid time, Acknowledge after SCL fall                               |                                   | 0.9              | $\mu s$ |
| $V_{IL}$       | Valid low-level input voltage                                        | -0.3                              | $0.3 * V_{DDIO}$ | V       |
| $V_{IH}$       | Valid high-level input voltage                                       | $0.7 * V_{DDIO}$                  | $V_{DDIO} + 0.3$ | V       |
| $V_{OL}$       | Low-level output voltage                                             | Sinking 3 mA                      | 0.4              | V       |
| $I_I$          | Input current on pins                                                | $0.1 V_{bus} < V_i < 0.9 V_{bus}$ | 10               | $\mu A$ |

#### NOTE

To meet all of the I2C protocol timing specifications, the I2C module clock must be configured in the range from 7 MHz to 12 MHz.

### 5.11.3 Power Management Bus (PMBus) Interface

The PMBus module has the following features:

- Compliance with the SMI Forum PMBus Specification (Part I v1.0 and Part II v1.1)
- Support for master and slave modes
- Support for I2C mode
- Support for two speeds:
  - Standard Mode: Up to 100 kHz
  - Fast Mode: 400 kHz
- Packet error checking
- CONTROL and ALERT signals
- Clock high and low time-outs
- Four-byte transmit and receive buffers
- One maskable interrupt, which can be generated by several conditions:
  - Receive data ready
  - Transmit buffer empty
  - Slave address received
  - End of message
  - ALERT input asserted
  - Clock low time-out
  - Clock high time-out
  - Bus free

Figure 5-48 shows the PMBus block diagram.

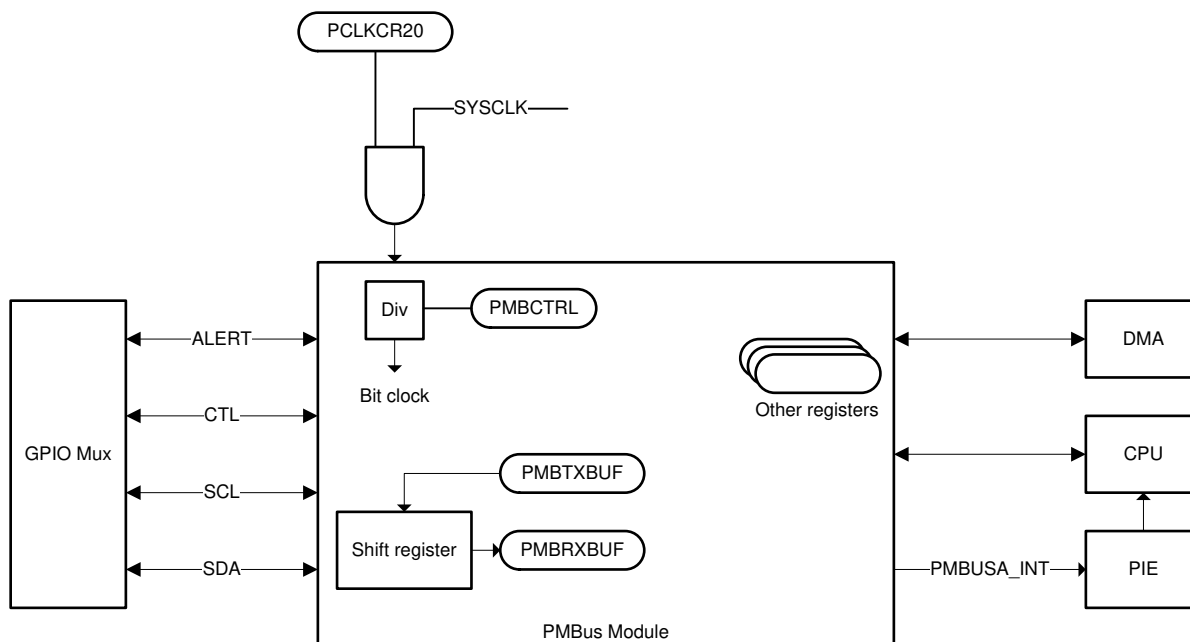


Figure 5-48. PMBus Block Diagram

### 5.11.3.1 PMBus Electrical Data and Timing

Table 5-58 lists the PMBus electrical characteristics. Table 5-59 lists the PMBUS fast mode switching characteristics. Table 5-60 lists the PMBUS standard mode switching characteristics.

**Table 5-58. PMBus Electrical Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS                                                   | MIN                           | TYP   | MAX | UNIT |
|-----------------|-------------------------------------------------------------------|-------------------------------|-------|-----|------|
| V <sub>IL</sub> | Valid low-level input voltage                                     |                               |       | 0.8 | V    |
| V <sub>IH</sub> | Valid high-level input voltage                                    | 2.1                           | VDDIO |     | V    |
| V <sub>OL</sub> | Low-level output voltage                                          | At I <sub>pullup</sub> = 4 mA |       | 0.4 | V    |
| I <sub>OL</sub> | Low-level output current                                          | V <sub>OL</sub> ≤ 0.4 V       | 4     |     | mA   |
| t <sub>SP</sub> | Pulse width of spikes that must be suppressed by the input filter | 0                             |       | 50  | ns   |
| I <sub>i</sub>  | Input leakage current on each pin                                 | 0.1 Vbus < Vi < 0.9 Vbus      | –10   | 10  | μA   |
| C <sub>i</sub>  | Capacitance on each pin                                           |                               |       | 10  | pF   |

**Table 5-59. PMBus Fast Mode Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER             | TEST CONDITIONS                                         | MIN                | TYP | MAX | UNIT |
|-----------------------|---------------------------------------------------------|--------------------|-----|-----|------|
| f <sub>SCL</sub>      | SCL clock frequency                                     | 10                 |     | 400 | kHz  |
| t <sub>BUF</sub>      | Bus free time between STOP and START conditions         | 1.3                |     |     | μs   |
| t <sub>HD;STA</sub>   | START condition hold time -- SDA fall to SCL fall delay | 0.6                |     |     | μs   |
| t <sub>SU;STA</sub>   | Repeated START setup time -- SCL rise to SDA fall delay | 0.6                |     |     | μs   |
| t <sub>SU;STO</sub>   | STOP condition setup time -- SCL rise to SDA rise delay | 0.6                |     |     | μs   |
| t <sub>HD;DAT</sub>   | Data hold time after SCL fall                           | 300                |     |     | ns   |
| t <sub>SU;DAT</sub>   | Data setup time before SCL rise                         | 100                |     |     | ns   |
| t <sub>Timeout</sub>  | Clock low time-out                                      | 25                 |     | 35  | ms   |
| t <sub>LOW</sub>      | Low period of the SCL clock                             | 1.3                |     |     | μs   |
| t <sub>HIGH</sub>     | High period of the SCL clock                            | 0.6                |     | 50  | μs   |
| t <sub>LOW;SEXT</sub> | Cumulative clock low extend time (slave device)         | From START to STOP |     | 25  | ms   |
| t <sub>LOW;MEXT</sub> | Cumulative clock low extend time (master device)        | Within each byte   |     | 10  | ms   |
| t <sub>r</sub>        | Rise time of SDA and SCL                                | 5% to 95%          | 20  | 300 | ns   |
| t <sub>f</sub>        | Fall time of SDA and SCL                                | 95% to 5%          | 20  | 300 | ns   |

**Table 5-60. PMBus Standard Mode Switching Characteristics**

over recommended operating conditions (unless otherwise noted)

| PARAMETER      |                                                         | TEST CONDITIONS    | MIN | TYP | MAX  | UNIT    |
|----------------|---------------------------------------------------------|--------------------|-----|-----|------|---------|
| $f_{SCL}$      | SCL clock frequency                                     |                    | 10  |     | 100  | kHz     |
| $t_{BUF}$      | Bus free time between STOP and START conditions         |                    | 4.7 |     |      | $\mu$ s |
| $t_{HD;STA}$   | START condition hold time -- SDA fall to SCL fall delay |                    | 4   |     |      | $\mu$ s |
| $t_{SU;STA}$   | Repeated START setup time -- SCL rise to SDA fall delay |                    | 4.7 |     |      | $\mu$ s |
| $t_{SU;STO}$   | STOP condition setup time -- SCL rise to SDA rise delay |                    | 4   |     |      | $\mu$ s |
| $t_{HD;DAT}$   | Data hold time after SCL fall                           |                    | 300 |     |      | ns      |
| $t_{SU;DAT}$   | Data setup time before SCL rise                         |                    | 250 |     |      | ns      |
| $t_{Timeout}$  | Clock low time-out                                      |                    | 25  |     | 35   | ms      |
| $t_{LOW}$      | Low period of the SCL clock                             |                    | 4.7 |     |      | $\mu$ s |
| $t_{HIGH}$     | High period of the SCL clock                            |                    | 4   |     | 50   | $\mu$ s |
| $t_{LOW;SEXT}$ | Cumulative clock low extend time (slave device)         | From START to STOP |     |     | 25   | ms      |
| $t_{LOW;MEXT}$ | Cumulative clock low extend time (master device)        | Within each byte   |     |     | 10   | ms      |
| $t_r$          | Rise time of SDA and SCL                                |                    |     |     | 1000 | ns      |
| $t_f$          | Fall time of SDA and SCL                                |                    |     |     | 300  | ns      |

### 5.11.4 Serial Communications Interface (SCI)

The SCI is a 2-wire asynchronous serial port, commonly known as a UART. The SCI module supports digital communications between the CPU and other asynchronous peripherals that use the standard non-return-to-zero (NRZ) format

The SCI receiver and transmitter each have a 16-level-deep FIFO for reducing servicing overhead, and each has its own separate enable and interrupt bits. Both can be operated independently for half-duplex communication, or simultaneously for full-duplex communication. To specify data integrity, the SCI checks received data for break detection, parity, overrun, and framing errors. The bit rate is programmable to different speeds through a 16-bit baud-select register.

Features of the SCI module include:

- Two external pins:
  - SCITXD: SCI transmit-output pin
  - SCIRXD: SCI receive-input pin
  - Baud rate programmable to 64K different rates
- Data-word format
  - 1 start bit
  - Data-word length programmable from 1 to 8 bits
  - Optional even/odd/no parity bit
  - 1 or 2 stop bits
- Four error-detection flags: parity, overrun, framing, and break detection
- Two wake-up multiprocessor modes: idle-line and address bit
- Half- or full-duplex operation
- Double-buffered receive and transmit functions
- Transmitter and receiver operations can be accomplished through interrupt-driven or polled algorithms with status flags.
  - Transmitter: TXRDY flag (transmitter-buffer register is ready to receive another character) and TX EMPTY flag (transmitter-shift register is empty)
  - Receiver: RXRDY flag (receiver-buffer register is ready to receive another character), BRKDT flag (break condition occurred), and RX ERROR flag (monitoring four interrupt conditions)
- Separate enable bits for transmitter and receiver interrupts (except BRKDT)
- NRZ format
- Auto baud-detect hardware logic
- 16-level transmit and receive FIFO

#### NOTE

All registers in this module are 8-bit registers. When a register is accessed, the register data is in the lower byte (bits 7–0), and the upper byte (bits 15–8) is read as zeros. Writing to the upper byte has no effect.

Figure 5-49 shows the SCI block diagram.

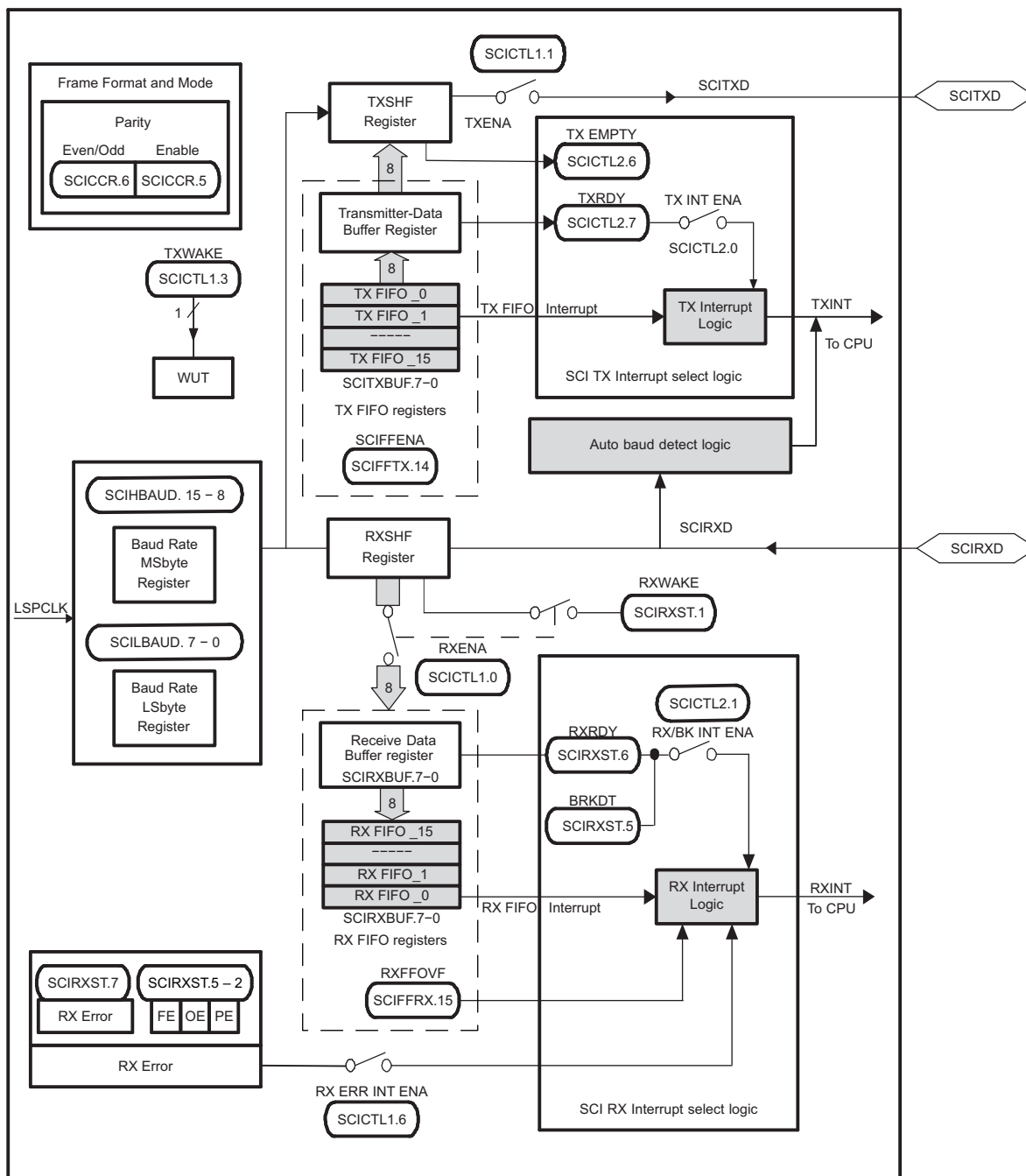


Figure 5-49. SCI Block Diagram

### 5.11.5 Serial Peripheral Interface (SPI)

The serial peripheral interface (SPI) is a high-speed synchronous serial input and output (I/O) port that allows a serial bit stream of programmed length (1 to 16 bits) to be shifted into and out of the device at a programmed bit-transfer rate. The SPI is normally used for communications between the MCU controller and external peripherals or another controller. Typical applications include external I/O or peripheral expansion through devices such as shift registers, display drivers, and analog-to-digital converters (ADCs). Multidevice communications are supported by the master or slave operation of the SPI. The port supports a 16-level, receive and transmit FIFO for reducing CPU servicing overhead.

The SPI module features include:

- SPISOMI: SPI slave-output/master-input pin
- SPISIMO: SPI slave-input/master-output pin
- $\overline{\text{SPISTE}}$ : SPI slave transmit-enable pin
- SPICLK: SPI serial-clock pin
- Two operational modes: Master and Slave
- Baud rate: 125 different programmable rates. The maximum baud rate that can be employed is limited by the maximum speed of the I/O buffers used on the SPI pins.
- Data word length: 1 to 16 data bits
- Four clocking schemes (controlled by clock polarity and clock phase bits) include:
  - Falling edge without phase delay: SPICLK active-high. SPI transmits data on the falling edge of the SPICLK signal and receives data on the rising edge of the SPICLK signal.
  - Falling edge with phase delay: SPICLK active-high. SPI transmits data one half-cycle ahead of the falling edge of the SPICLK signal and receives data on the falling edge of the SPICLK signal.
  - Rising edge without phase delay: SPICLK inactive-low. SPI transmits data on the rising edge of the SPICLK signal and receives data on the falling edge of the SPICLK signal.
  - Rising edge with phase delay: SPICLK inactive-low. SPI transmits data one half-cycle ahead of the rising edge of the SPICLK signal and receives data on the rising edge of the SPICLK signal.
- Simultaneous receive and transmit operation (transmit function can be disabled in software)
- Transmitter and receiver operations are accomplished through either interrupt-driven or polled algorithm
- 16-level transmit/receive FIFO
- DMA support
- High-speed mode
- Delayed transmit control
- 3-wire SPI mode
- $\overline{\text{SPISTE}}$  inversion for digital audio interface receive mode on devices with two SPI modules

Figure 5-50 shows the SPI CPU interfaces.

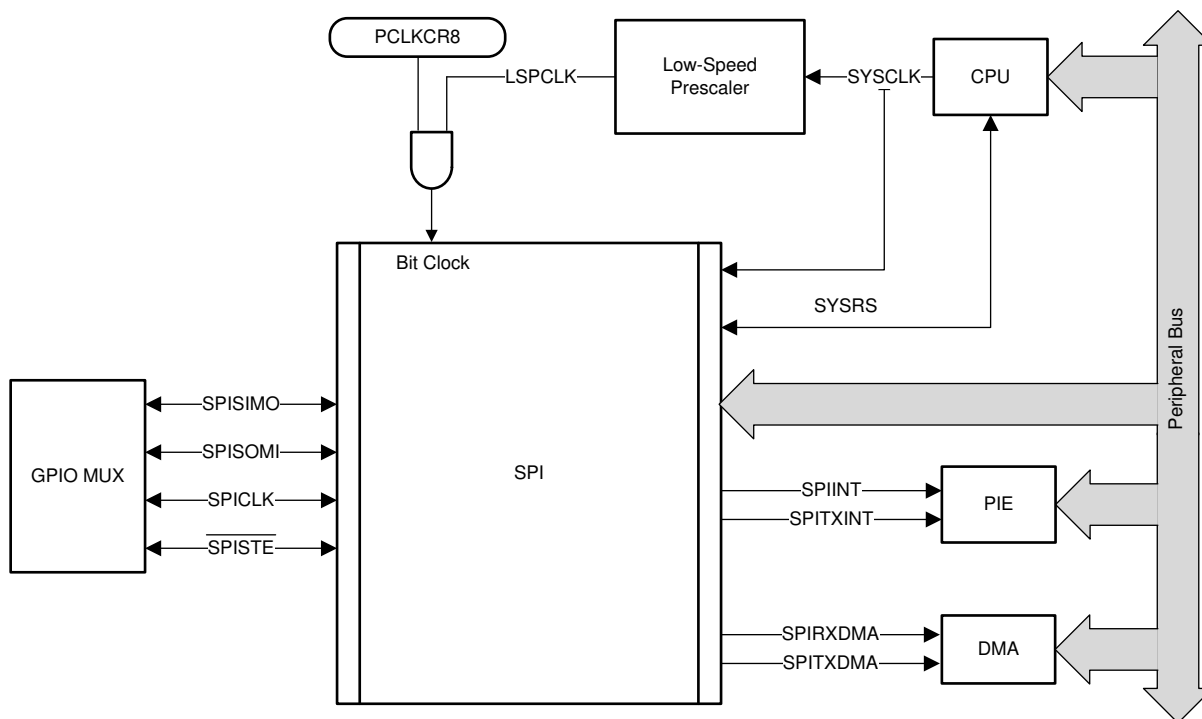


Figure 5-50. SPI CPU Interface

### 5.11.5.1 SPI Master Mode Timings

The following section contains the SPI Master Mode Timings. For more information about the SPI in High-Speed mode, see the Serial Peripheral Interface (SPI) chapter of the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

Table 5-61 lists the SPI master mode timing requirements.

Table 5-62 lists the SPI master mode switching characteristics where the clock phase = 0. Figure 5-51 shows the SPI master mode external timing where the clock phase = 0.

Table 5-63 lists the SPI master mode switching characteristics where the clock phase = 1. Figure 5-52 shows the SPI master mode external timing where the clock phase = 1.

#### NOTE

All timing parameters for SPI High-Speed Mode assume a load capacitance of 5 pF on SPICLK, SPISIMO, and SPISOMI.

**Table 5-61. SPI Master Mode Timing Requirements**

| NO.                    |                 |                                         | (BRR + 1) <sup>(1)</sup> | MIN | MAX | UNIT |
|------------------------|-----------------|-----------------------------------------|--------------------------|-----|-----|------|
| <b>High-Speed Mode</b> |                 |                                         |                          |     |     |      |
| 8                      | $t_{su(SOMI)M}$ | Setup time, SPISOMI valid before SPICLK | Even, Odd                | 1   |     | ns   |
| 9                      | $t_{h(SOMI)M}$  | Hold time, SPISOMI valid after SPICLK   | Even, Odd                | 5   |     | ns   |
| <b>Normal Mode</b>     |                 |                                         |                          |     |     |      |
| 8                      | $t_{su(SOMI)M}$ | Setup time, SPISOMI valid before SPICLK | Even, Odd                | 15  |     | ns   |
| 9                      | $t_{h(SOMI)M}$  | Hold time, SPISOMI valid after SPICLK   | Even, Odd                | 0   |     | ns   |

(1) The (BRR + 1) condition is Even when (SPIBRR + 1) is even or SPIBRR is 0 or 2. It is Odd when (SPIBRR + 1) is odd and SPIBRR is greater than 3.

**Table 5-62. SPI Master Mode Switching Characteristics (Clock Phase = 0)**

over recommended operating conditions (unless otherwise noted)

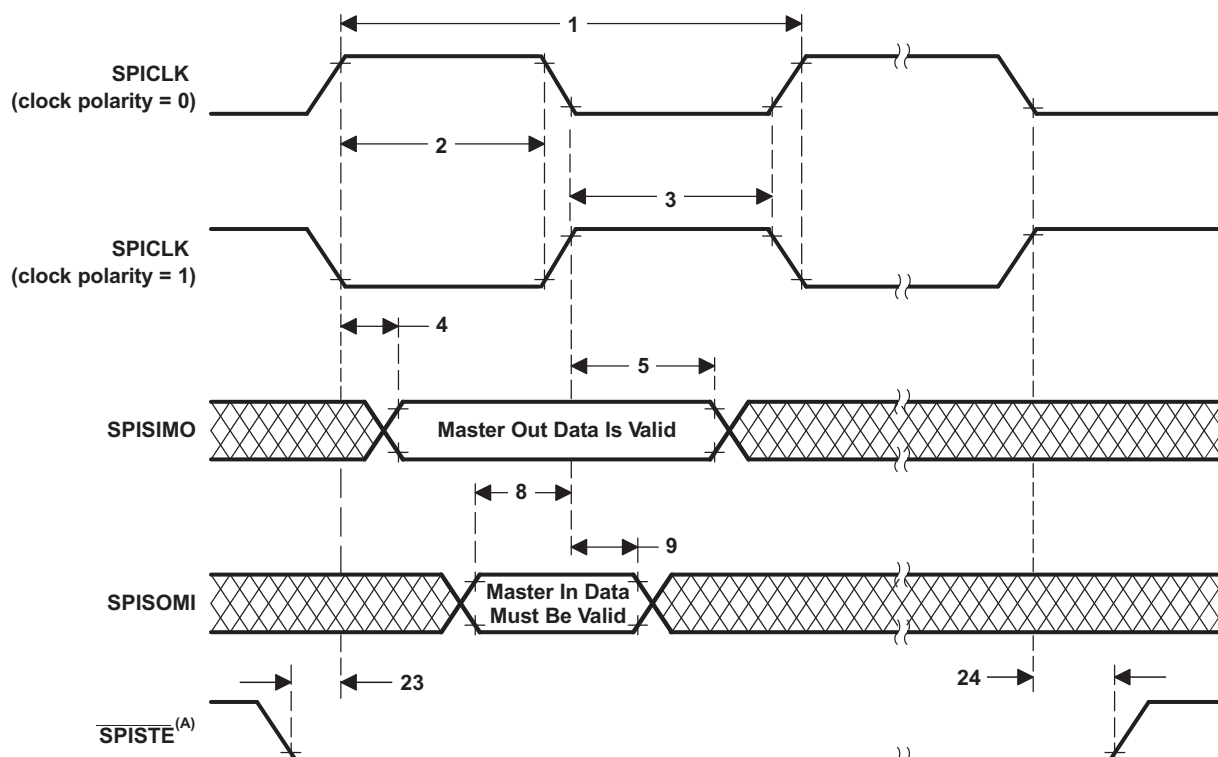
| NO.             | PARAMETER                          |                                                           | (BRR + 1) <sup>(1)</sup> | MIN                                                                   | MAX                                                                   | UNIT |
|-----------------|------------------------------------|-----------------------------------------------------------|--------------------------|-----------------------------------------------------------------------|-----------------------------------------------------------------------|------|
| General         |                                    |                                                           |                          |                                                                       |                                                                       |      |
| 1               | t <sub>c</sub> (SPC) <sub>M</sub>  | Cycle time, SPICLK                                        | Even                     | 4t <sub>c</sub> (LSPCLK)                                              | 128t <sub>c</sub> (LSPCLK)                                            | ns   |
|                 |                                    |                                                           | Odd                      | 5t <sub>c</sub> (LSPCLK)                                              | 127t <sub>c</sub> (LSPCLK)                                            |      |
| 2               | t <sub>w</sub> (SPC1) <sub>M</sub> | Pulse duration, SPICLK, first pulse                       | Even                     | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 1                              | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 1                              | ns   |
|                 |                                    |                                                           | Odd                      | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 0.5t <sub>c</sub> (LSPCLK) − 1 | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 0.5t <sub>c</sub> (LSPCLK) + 1 |      |
| 3               | t <sub>w</sub> (SPC2) <sub>M</sub> | Pulse duration, SPICLK, second pulse                      | Even                     | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 1                              | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 1                              | ns   |
|                 |                                    |                                                           | Odd                      | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 0.5t <sub>c</sub> (LSPCLK) − 1 | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 0.5t <sub>c</sub> (LSPCLK) + 1 |      |
| 23              | t <sub>d</sub> (SPC) <sub>M</sub>  | Delay time, $\overline{\text{SPISTE}}$ active to SPICLK   | Even                     | 1.5t <sub>c</sub> (SPC) <sub>M</sub> − 3t <sub>c</sub> (SYSCLK) − 3   | 1.5t <sub>c</sub> (SPC) <sub>M</sub> − 3t <sub>c</sub> (SYSCLK) + 3   | ns   |
|                 |                                    |                                                           | Odd                      | 1.5t <sub>c</sub> (SPC) <sub>M</sub> − 4t <sub>c</sub> (SYSCLK) − 3   | 1.5t <sub>c</sub> (SPC) <sub>M</sub> − 4t <sub>c</sub> (SYSCLK) + 3   |      |
| 24              | t <sub>v</sub> (STE) <sub>M</sub>  | Valid time, SPICLK to $\overline{\text{SPISTE}}$ inactive | Even                     | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 3                              | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                              | ns   |
|                 |                                    |                                                           | Odd                      | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 0.5t <sub>c</sub> (LSPCLK) − 3 | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 0.5t <sub>c</sub> (LSPCLK) + 3 |      |
| High-Speed Mode |                                    |                                                           |                          |                                                                       |                                                                       |      |
| 4               | t <sub>d</sub> (SIMO) <sub>M</sub> | Delay time, SPICLK to SPISIMO valid                       | Even, Odd                | 1                                                                     |                                                                       | ns   |
| 5               | t <sub>v</sub> (SIMO) <sub>M</sub> | Valid time, SPISIMO valid after SPICLK                    | Even                     | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 3                              |                                                                       | ns   |
|                 |                                    |                                                           | Odd                      | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 0.5t <sub>c</sub> (LSPCLK) − 3 |                                                                       |      |
| Normal Mode     |                                    |                                                           |                          |                                                                       |                                                                       |      |
| 4               | t <sub>d</sub> (SIMO) <sub>M</sub> | Delay time, SPICLK to SPISIMO valid                       | Even, Odd                | 1                                                                     |                                                                       | ns   |
| 5               | t <sub>v</sub> (SIMO) <sub>M</sub> | Valid time, SPISIMO valid after SPICLK                    | Even                     | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 3                              |                                                                       | ns   |
|                 |                                    |                                                           | Odd                      | 0.5t <sub>c</sub> (SPC) <sub>M</sub> − 0.5t <sub>c</sub> (LSPCLK) − 3 |                                                                       |      |

(1) The (BRR + 1) condition is Even when (SPIBRR + 1) is even or SPIBRR is 0 or 2. It is Odd when (SPIBRR + 1) is odd and SPIBRR is greater than 3.

**Table 5-63. SPI Master Mode Switching Characteristics (Clock Phase = 1)**

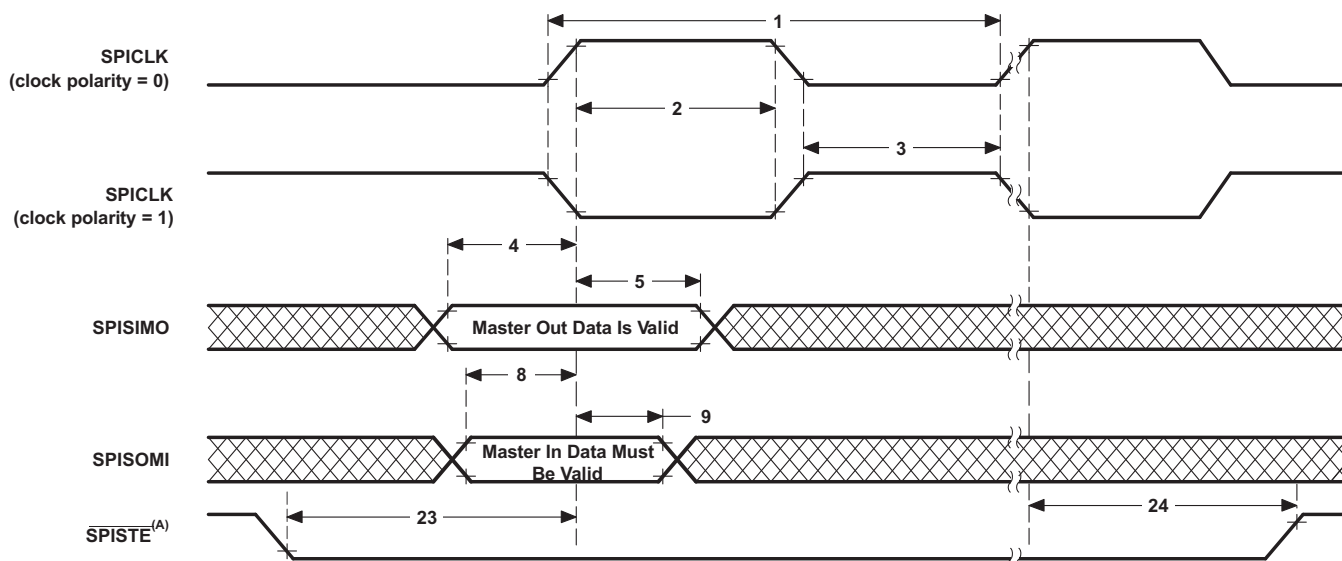
over recommended operating conditions (unless otherwise noted)

| NO.             | PARAMETER      | (BRR + 1)                                         | MIN       | MAX                                     | UNIT |
|-----------------|----------------|---------------------------------------------------|-----------|-----------------------------------------|------|
| General         |                |                                                   |           |                                         |      |
| 1               | $t_{c(SPC)M}$  | Cycle time, SPICLK                                | Even      | $4t_{c(LSPCLK)}$                        | ns   |
|                 |                |                                                   | Odd       | $5t_{c(LSPCLK)}$                        |      |
| 2               | $t_{w(SPCH)M}$ | Pulse duration, SPICLK, first pulse               | Even      | $0.5t_{c(SPC)M} - 1$                    | ns   |
|                 |                |                                                   | Odd       | $0.5t_{c(SPC)M} - 0.5t_{c(LSPCLK)} - 1$ |      |
| 3               | $t_{w(SPC2)M}$ | Pulse duration, SPICLK, second pulse              | Even      | $0.5t_{c(SPC)M} - 1$                    | ns   |
|                 |                |                                                   | Odd       | $0.5t_{c(SPC)M} + 0.5t_{c(LSPCLK)} - 1$ |      |
| 23              | $t_{d(SPC)M}$  | Delay time, $\overline{SPISTE}$ valid to SPICLK   | Even, Odd | $2t_{c(SPC)M} - 3t_{c(SYSCCLK)} - 3$    | ns   |
| 24              | $t_{d(STE)M}$  | Delay time, SPICLK to $\overline{SPISTE}$ invalid | Even      | -3                                      | ns   |
|                 |                |                                                   | Odd       | -3                                      |      |
| High-Speed Mode |                |                                                   |           |                                         |      |
| 4               | $t_{d(SIMO)M}$ | Delay time, SPISIMO valid to SPICLK               | Even      | $0.5t_{c(SPC)M} - 2$                    | ns   |
|                 |                |                                                   | Odd       | $0.5t_{c(SPC)M} + 0.5t_{c(LSPCLK)} - 2$ |      |
| 5               | $t_{v(SIMO)M}$ | Valid time, SPISIMO valid after SPICLK            | Even      | $0.5t_{c(SPC)M} - 3$                    | ns   |
|                 |                |                                                   | Odd       | $0.5t_{c(SPC)M} - 0.5t_{c(LSPCLK)} - 3$ |      |
| Normal Mode     |                |                                                   |           |                                         |      |
| 4               | $t_{d(SIMO)M}$ | Delay time, SPISIMO valid to SPICLK               | Even      | $0.5t_{c(SPC)M} - 2$                    | ns   |
|                 |                |                                                   | Odd       | $0.5t_{c(SPC)M} + 0.5t_{c(LSPCLK)} - 2$ |      |
| 5               | $t_{v(SIMO)M}$ | Valid time, SPISIMO valid after SPICLK            | Even      | $0.5t_{c(SPC)M} - 3$                    | ns   |
|                 |                |                                                   | Odd       | $0.5t_{c(SPC)M} - 0.5t_{c(LSPCLK)} - 3$ |      |



- A. On the trailing end of the word,  $\overline{\text{SPISTE}}$  will go inactive except between back-to-back transmit words in both FIFO and non-FIFO modes.

Figure 5-51. SPI Master Mode External Timing (Clock Phase = 0)



- A. On the trailing end of the word,  $\overline{\text{SPISTE}}$  will go inactive except between back-to-back transmit words in both FIFO and non-FIFO modes.

Figure 5-52. SPI Master Mode External Timing (Clock Phase = 1)



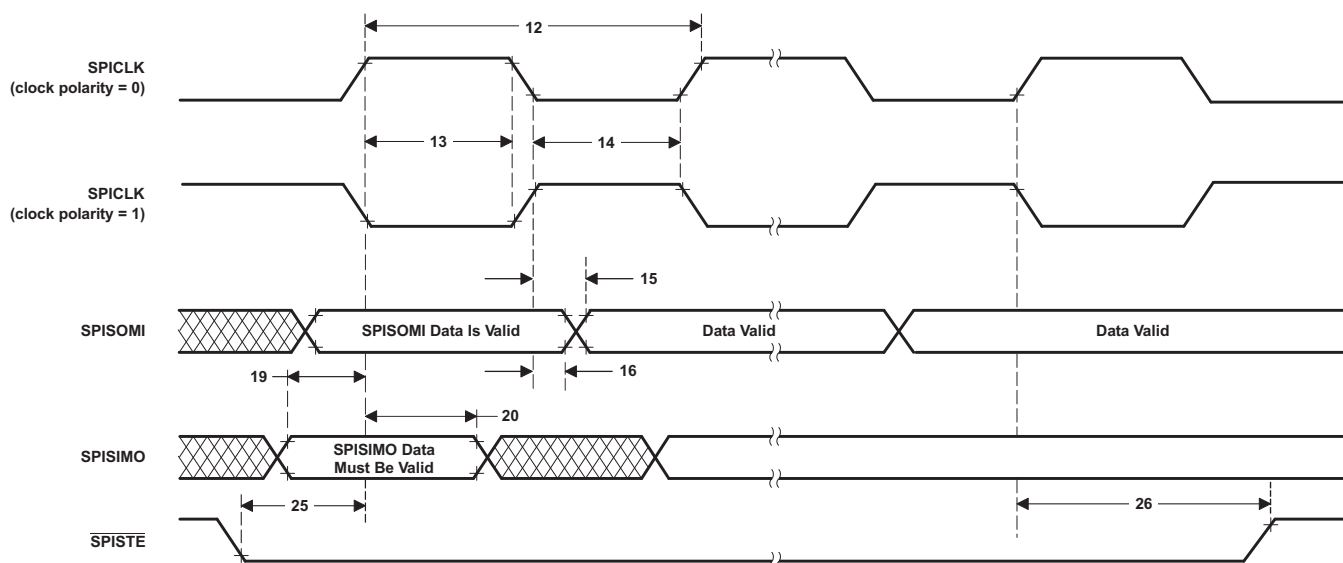


Figure 5-54. SPI Slave Mode External Timing (Clock Phase = 1)

### 5.11.6 Local Interconnect Network (LIN)

This device contains one Local Interconnect Network (LIN) module. The LIN module adheres to the LIN 2.1 standard as defined by the *LIN Specification Package Revision 2.1*. The LIN is a low-cost serial interface designed for applications where the CAN protocol may be too expensive to implement, such as small subnetworks for cabin comfort functions like interior lighting or window control in an automotive application.

The LIN standard is based on the SCI (UART) serial data link format. The communication concept is single-master and multiple-slave with a message identification for multicast transmission between any network nodes.

The LIN module can be programmed to work either as an SCI or as a LIN as the core of the module is an SCI. The hardware features of the SCI are augmented to achieve LIN compatibility. The SCI module is a universal asynchronous receiver-transmitter (UART) that implements the standard non-return-to-zero format.

Though the registers are common for LIN and SCI, the register descriptions have notes to identify the register/bit usage in different modes. Because of this, code written for this module cannot be directly ported to the stand-alone SCI module and vice versa.

The LIN module has the following features:

- Compatibility with LIN 1.3, 2.0 and 2.1 protocols
- Configurable baud rate up to 20 kbps (as per LIN 2.1 protocol)
- Two external pins: LINRX and LINTX
- Multibuffered receive and transmit units
- Identification masks for message filtering
- Automatic master header generation
  - Programmable synchronization break field
  - Synchronization field
  - Identifier field
- Slave automatic synchronization
  - Synchronization break detection
  - Optional baud rate update
  - Synchronization validation
- $2^{31}$  programmable transmission rates with 7 fractional bits
- Wakeup on LINRX dominant level from transceiver
- Automatic wakeup support
  - Wakeup signal generation
  - Expiration times on wakeup signals
- Automatic bus idle detection
- Error detection
  - Bit error
  - Bus error
  - No-response error
  - Checksum error
  - Synchronization field error
  - Parity error
- Capability to use direct memory access (DMA) for transmit and receive data

- Two interrupt lines with priority encoding for:
  - Receive
  - Transmit
  - ID, error, and status
- Support for LIN 2.0 checksum
- Enhanced synchronizer finite state machine (FSM) support for frame processing
- Enhanced handling of extended frames
- Enhanced baud rate generator
- Update wakeup/go to sleep

Figure 5-55 shows the LIN block diagram.

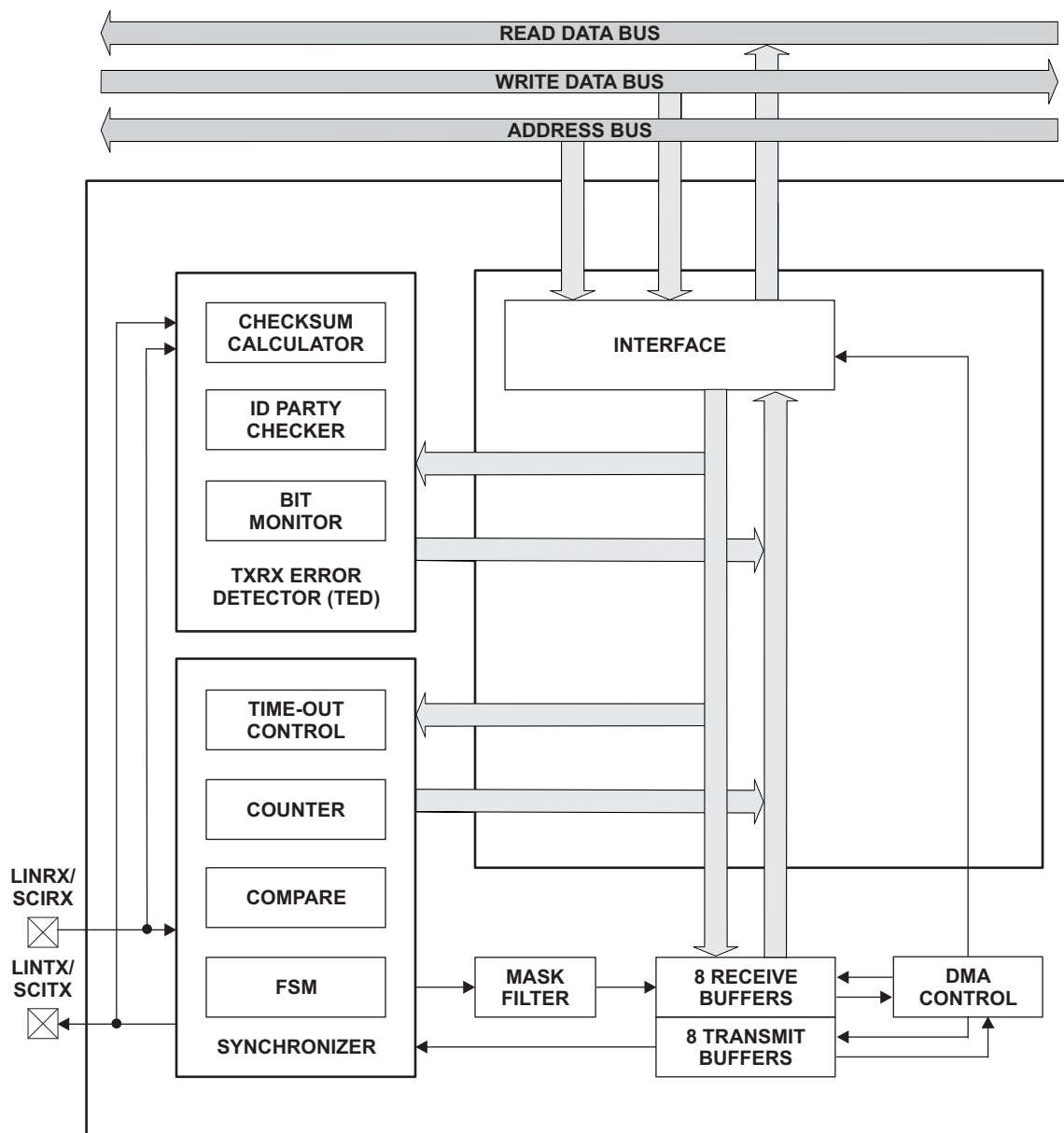


Figure 5-55. LIN Block Diagram

### 5.11.7 Fast Serial Interface (FSI)

The Fast Serial Interface (FSI) module is a serial communication peripheral capable of reliable and robust high-speed communications. The FSI is designed to ensure data robustness across many system conditions such as chip-to-chip as well as board-to-board across an isolation barrier. Payload integrity checks such as CRC, start- and end-of-frame patterns, and user-defined tags, are encoded before transmit and then verified after receipt without additional CPU interaction. Line breaks can be detected using periodic transmissions, all managed and monitored by hardware. The FSI is also tightly integrated with other control peripherals on the device. To ensure that the latest sensor data or control parameters are available, frames can be transmitted on every control loop period. An integrated skew-compensation block has been added on the receiver to handle skew that may occur between the clock and data signals due to a variety of factors, including trace-length mismatch and skews induced by an isolation chip. With embedded data robustness checks, data-link integrity checks, skew compensation, and integration with control peripherals, the FSI can enable high-speed, robust communication in any system. These and many other features of the FSI follow.

The FSI module includes the following features:

- Independent transmitter and receiver cores
- Source-synchronous transmission
- Dual data rate (DDR)
- One or two data lines
- Programmable data length
- Skew adjustment block to compensate for board and system delay mismatches
- Frame error detection
- Programmable frame tagging for message filtering
- Hardware ping to detect line breaks during communication (ping watchdog)
- Two interrupts per FSI core
- Externally triggered frame generation
- Hardware- or software-calculated CRC
- Embedded ECC computation module
- Register write protection
- DMA support
- SPI compatibility mode (limited features available)

Operating the FSI at maximum speed (50 MHz) at dual data rate (100 Mbps) may require the integrated skew compensation block to be configured according to the specific operating conditions on a case-by-case basis. The [Fast Serial Interface \(FSI\) Skew Compensation](#) Application Report provides example software on how to configure and set up the integrated skew compensation block on the Fast Serial Interface.

The FSI consists of independent transmitter (FSITX) and receiver (FSIRX) cores. The FSITX and FSIRX cores are configured and operated independently. The features available on the FSITX and FSIRX are described in [Section 5.11.7.1](#) and [Section 5.11.7.2](#), respectively.

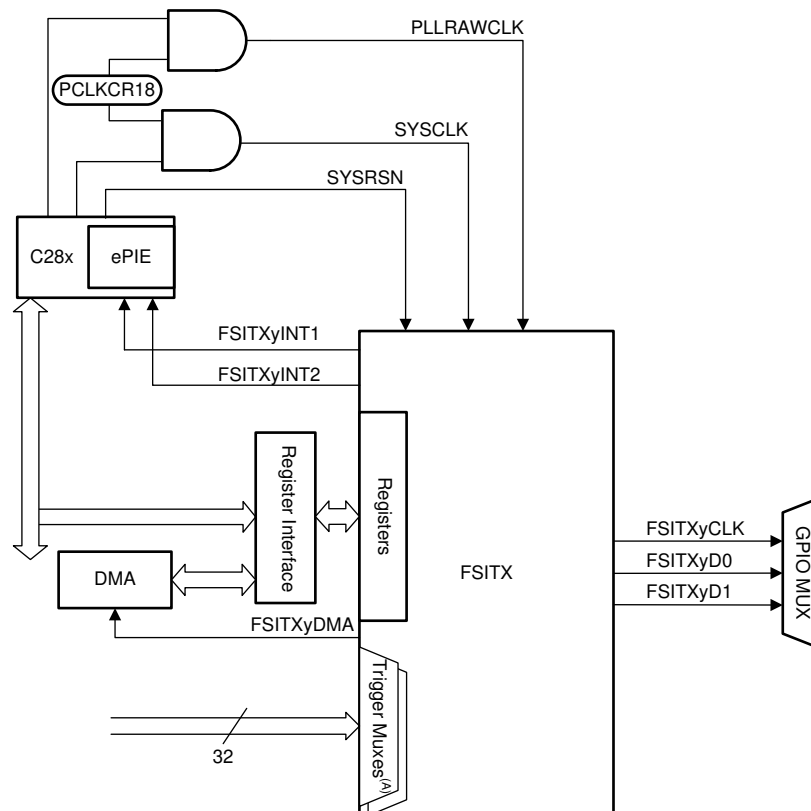
### 5.11.7.1 FSI Transmitter

The FSI transmitter module handles the framing of data, CRC generation, signal generation of TXCLK, TXD0, and TXD1, as well as interrupt generation. The operation of the transmitter core is controlled and configured through programmable control registers. The transmitter control registers let the CPU program, control, and monitor the operation of the FSI transmitter. The transmit data buffer is accessible by the CPU and the DMA.

The transmitter has the following features:

- Automated ping frame generation
- Externally triggered ping frames
- Externally triggered data frames
- Software-configurable frame lengths
- 16-word data buffer
- Data buffer underrun and overrun detection
- Hardware-generated CRC on data bits
- Software ECC calculation on select data
- DMA support

Figure 5-56 shows the FSITX CPU interface. Figure 5-57 shows the high-level block diagram of the FSITX. Not all data paths and internal connections are shown. This diagram provides a high-level overview of the internal modules present in the FSITX.



- A. The signals connected to the trigger muxes are described in the External Frame Trigger Mux section of the Fast Serial Interface (FSI) chapter in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

**Figure 5-56. FSITX CPU Interface**

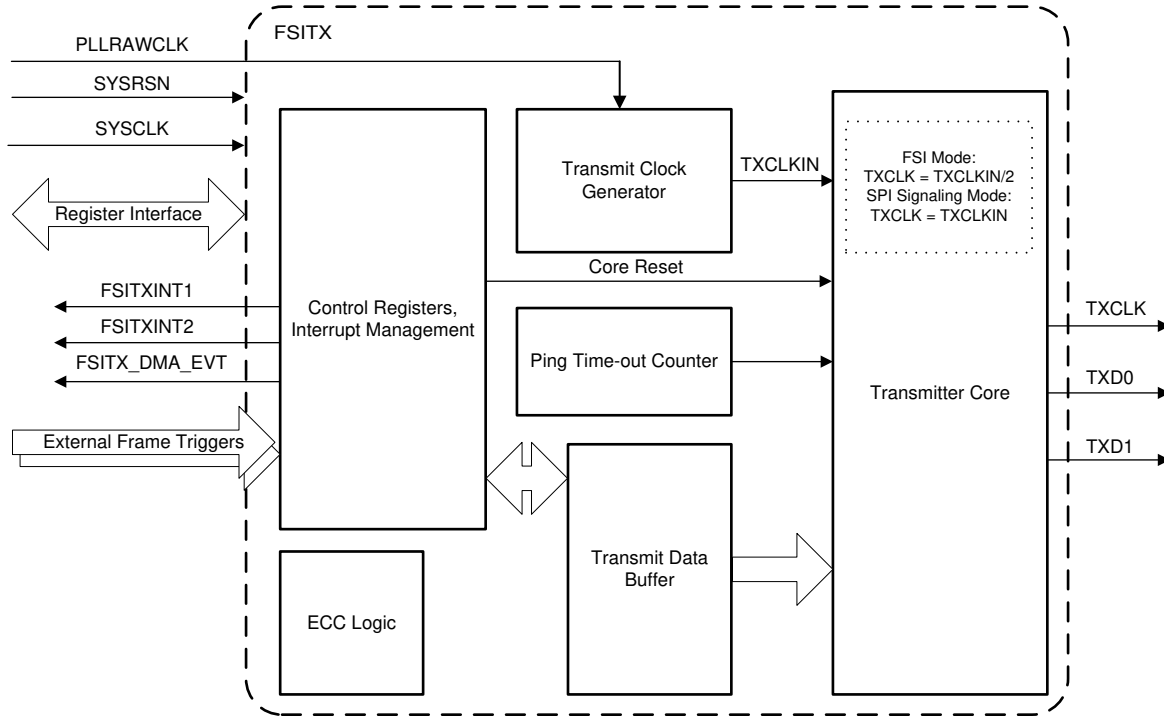


Figure 5-57. FSITX Block Diagram

#### 5.11.7.1.1 FSITX Electrical Data and Timing

Table 5-66 lists the FSITX switching characteristics. Figure 5-58 shows the FSITX timings.

Table 5-66. FSITX Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

| NO.  | PARAMETER                                  | MIN                                                                      | MAX                                                            | UNIT |
|------|--------------------------------------------|--------------------------------------------------------------------------|----------------------------------------------------------------|------|
| 1    | $t_c(\text{TXCLK})$                        | Cycle time, TXCLK                                                        | 20                                                             | ns   |
| 2    | $t_w(\text{TXCLK})$                        | Pulse width, TXCLK low or TXCLK high                                     | $(0.5t_c(\text{TXCLK})) - 1$<br>$(0.5t_c(\text{TXCLK})) + 1$   | ns   |
| 3    | $t_d(\text{TXCLK-TXD})$                    | Delay time, TXCLK rising or falling toTXD valid                          | $(0.25t_c(\text{TXCLK})) - 2$<br>$(0.25t_c(\text{TXCLK})) + 2$ | ns   |
| TDM1 | $t_{\text{skew}}(\text{TDM\_CLK-TDM\_Dx})$ | Delay skew introduced between TXCLK-TDM_CLK delay and TXDx-TDM_Dx delays | -2<br>2                                                        | ns   |

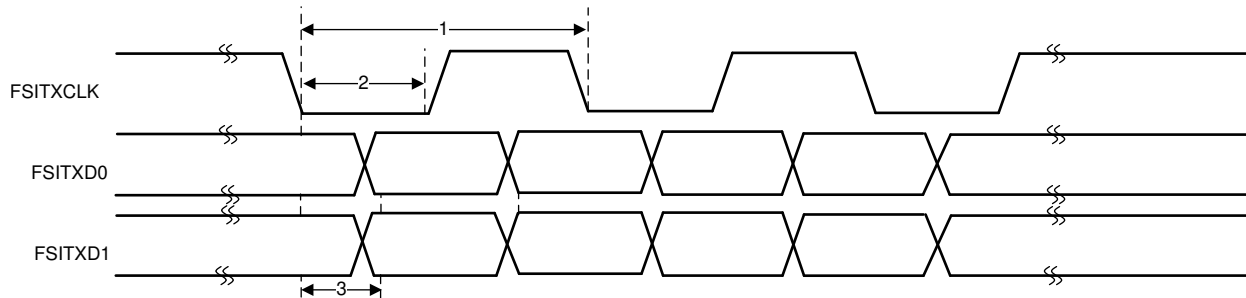


Figure 5-58. FSITX Timings

### 5.11.7.2 FSI Receiver

The receiver module interfaces to the FSI clock (RXCLK), and data lines (RXD0 and RXD1) after they pass through an optional programmable delay line. The receiver core handles the data framing, CRC computation, and frame-related error checking. The receiver bit clock and state machine are run by the RXCLK input, which is asynchronous to the device system clock.

The receiver control registers let the CPU program, control, and monitor the operation of the FSIRX. The receive data buffer is accessible by the CPU, HIC, and the DMA.

The receiver core has the following features:

- 16-word data buffer
- Multiple supported frame types
- Ping frame watchdog
- Frame watchdog
- CRC calculation and comparison in hardware
- ECC detection
- Programmable delay line control on incoming signals
- DMA support
- SPI compatibility mode

Figure 5-59 shows the FSIRX CPU interface. Figure 5-60 provides a high-level overview of the internal modules present in the FSIRX. Not all data paths and internal connections are shown.

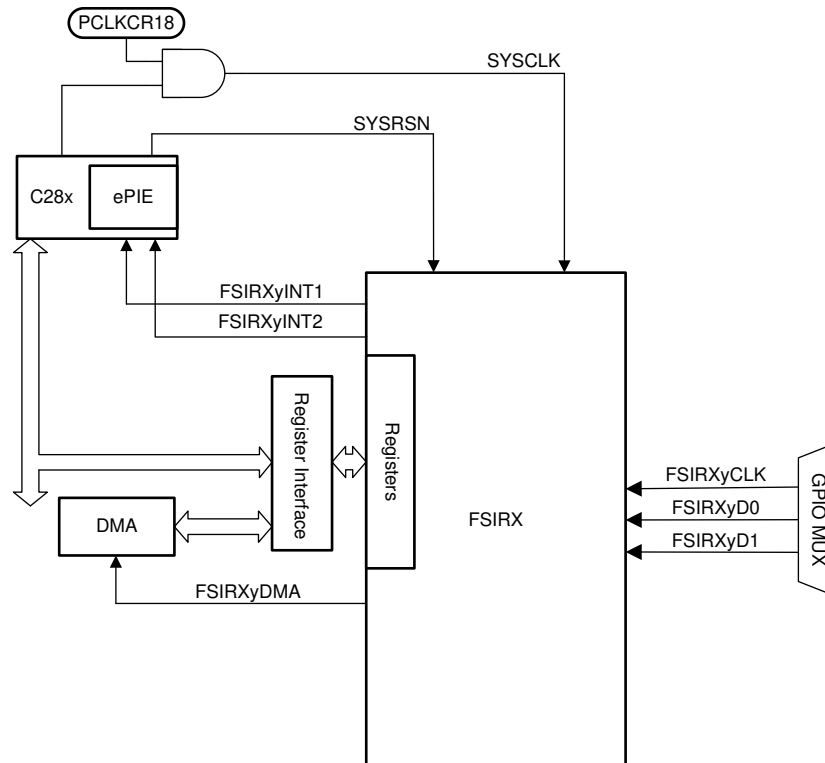


Figure 5-59. FSIRX CPU Interface

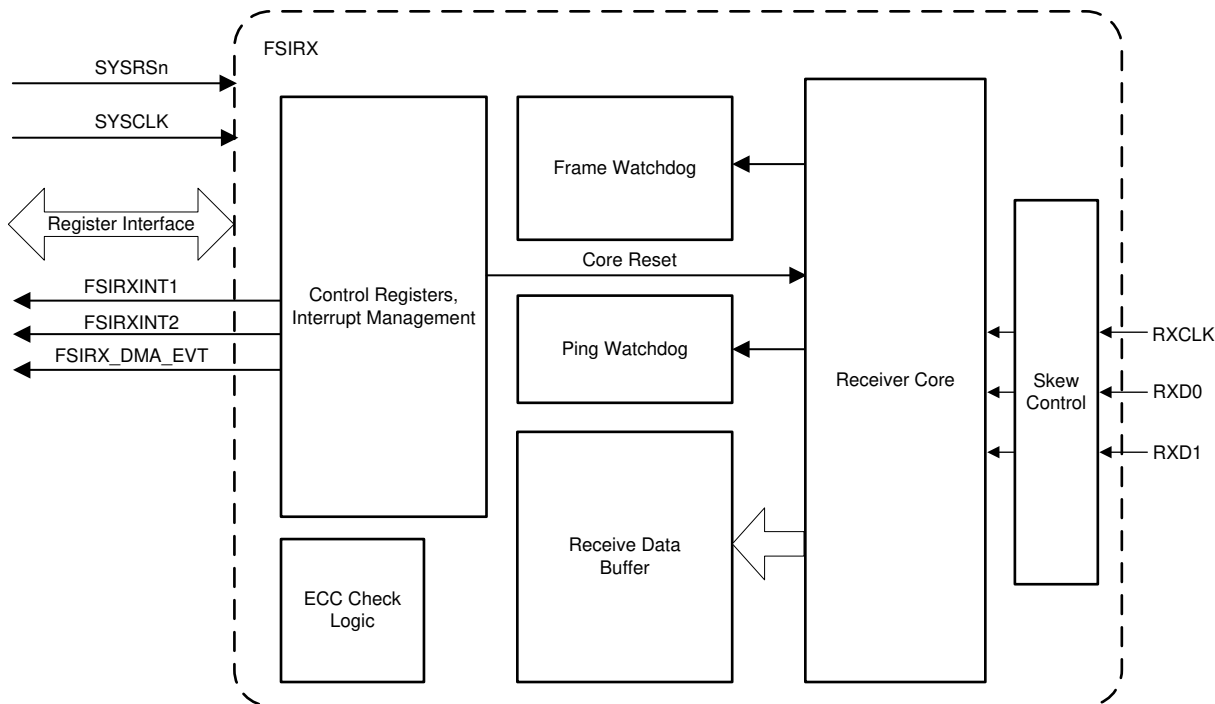


Figure 5-60. FSIRX Block Diagram

#### 5.11.7.2.1 FSIRX Electrical Data and Timing

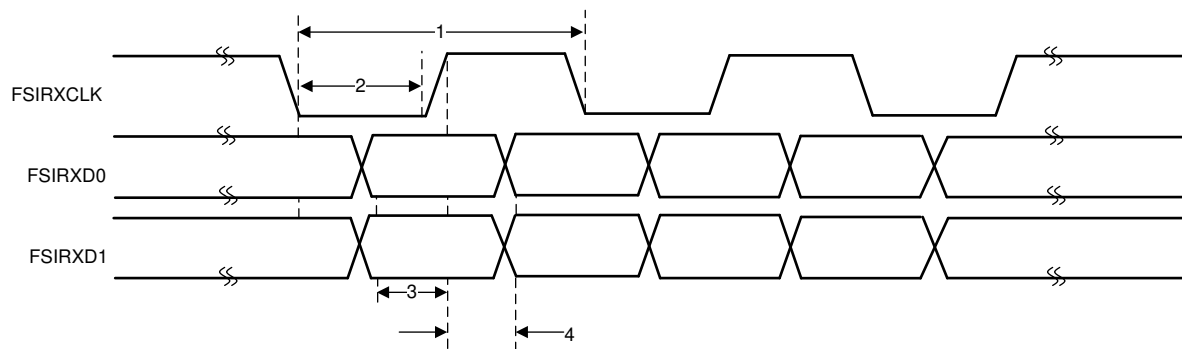
Table 5-68 lists the FSIRX timing requirements. Table 5-68 shows the FSIRX timings.

Table 5-67. FSIRX Switching Characteristics

| NO. |                         |                                                                        | MIN | MAX | UNIT |
|-----|-------------------------|------------------------------------------------------------------------|-----|-----|------|
| 1   | $t_{d(RXCLK)}$          | RXCLK delay compensation at RX_DLYLINE_CTRL[RXCLK_DLY]=31              | 10  | 30  | ns   |
| 2   | $t_{d(RXD0)}$           | RXD0 delay compensation at RX_DLYLINE_CTRL[RXD0_DLY]=31                | 10  | 30  | ns   |
| 3   | $t_{d(RXD1)}$           | RXD1 delay compensation at RX_DLYLINE_CTRL[RXD1_DLY]=31                | 10  | 30  | ns   |
| 4   | $t_{d(Delay\_Element)}$ | Incremental delay of each delay line element for RXCLK, RXD0, and RXD1 | 0.3 | 1   | ns   |

Table 5-68. FSIRX Timing Requirements

| NO. |                     |                                                                      | MIN              | MAX              | UNIT |
|-----|---------------------|----------------------------------------------------------------------|------------------|------------------|------|
| 1   | $t_c(RXCLK)$        | Cycle time, RXCLK                                                    | 20               |                  | ns   |
| 2   | $t_w(RXCLK)$        | Pulse width, RXCLK low or RXCLK high.                                | $0.35t_c(RXCLK)$ | $0.65t_c(RXCLK)$ | ns   |
| 3   | $t_{su}(RXCLK-RXD)$ | Setup time with respect to RXCLK, applies to both edges of the clock | 1.7              |                  | ns   |
| 4   | $t_h(RXCLK-RXD)$    | Hold time with respect to RXCLK, applies to both edges of the clock  | 2                |                  | ns   |



**Figure 5-61. FSIRX Timings**

### 5.11.7.3 FSI SPI Compatibility Mode

The FSI supports a SPI compatibility mode to enable communication with programmable SPI devices. In this mode, the FSI transmits its data in the same manner as a SPI in a single clock configuration mode. While the FSI is able to physically interface with a SPI in this mode, the external device must be able to encode and decode an FSI frame to communicate successfully. This is because the FSI transmits all SPI frame phases with the exception of the preamble and postamble. The FSI provides the same data validation and frame checking as if it was in standard FSI mode, allowing for more robust communication without consuming CPU cycles. The external SPI is required to send all relevant information and can access standard FSI features such as the ping frame watchdog on the FSIRX, frame tagging, or custom CRC values. The list of features of SPI compatibility mode follows:

- Data will transmit on rising edge and receive on falling edge of the clock.
- Only 16-bit word size is supported.
- TXD1 will be driven like an active-low chip-select signal. The signal will be low for the duration of the full frame transmission.
- No receiver chip-select input is required. RXD1 is not used. Data is shifted into the receiver on every active clock edge.
- No preamble or postamble clocks will be transmitted. All signals return to the idle state after the frame phase is finished.
- It is not possible to transmit in the SPI slave configuration because the FSI TXCLK cannot take an external clock source.

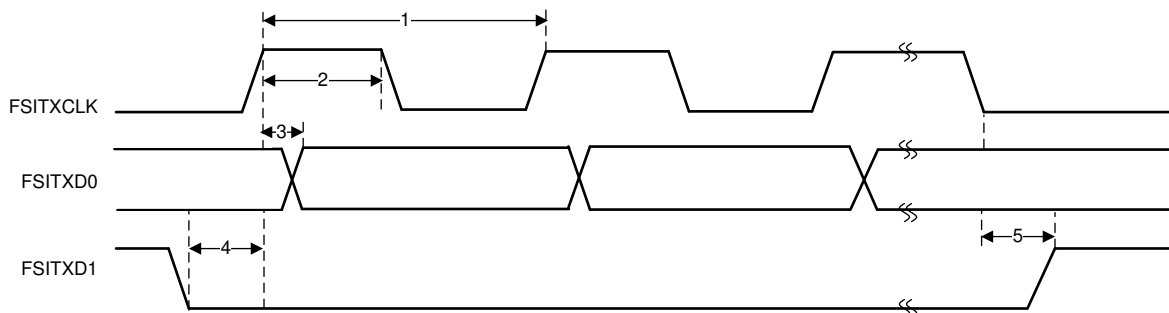
#### 5.11.7.3.1 FSITX SPI Signaling Mode Electrical Data and Timing

Table 5-69 lists the FSITX SPI signaling mode switching characteristics. Figure 5-62 shows the FSITX SPI signaling mode timings. Special timings are not required for the FSIRX in SPI signaling mode. FSIRX timings listed in Table 5-68 are applicable in SPI compatibility mode. Setup and Hold times are only valid on the falling edge of FSIRXCLK because this is the active edge in SPI signaling mode.

**Table 5-69. FSITX SPI Signaling Mode Switching Characteristics**

over operating free-air temperature range (unless otherwise noted)

| NO. | PARAMETER                                                         | MIN                          | MAX                          | UNIT |
|-----|-------------------------------------------------------------------|------------------------------|------------------------------|------|
| 1   | $t_c(\text{TXCLK})$ Cycle time, TXCLK                             | 20                           |                              | ns   |
| 2   | $t_w(\text{TXCLK})$ Pulse width, TXCLK low or TXCLK high          | $(0.5t_c(\text{TXCLK})) - 1$ | $(0.5t_c(\text{TXCLK})) + 1$ | ns   |
| 3   | $t_d(\text{TXCLKH-TXD0})$ Delay time, TXD0 valid after TXCLK high |                              | 3                            | ns   |
| 4   | $t_d(\text{TXD1-TXCLK})$ Delay time, TXCLK high after TXD1 low    | $t_w(\text{TXCLK}) - 3$      |                              | ns   |
| 5   | $t_d(\text{TXCLK-TXD1})$ Delay time, TXD1 high after TXCLK low    | $t_w(\text{TXCLK})$          |                              | ns   |



**Figure 5-62. FSITX SPI Signaling Mode Timings**

### 5.11.8 Host Interface Controller (HIC)

The HIC module allows an external host controller (master) to directly access resources of the device (slave) by emulating the ASRAM protocol. It has two modes of operation: direct access and mailbox access. In direct access mode, device resources is written to and read from directly by the external host. In mailbox access mode, external host and device write to and read from a buffer and notify each other when the buffer write/read is complete. For security reasons, the HIC has to be enabled by the device before the external host can access it. Figure 5-63 shows the block diagram of the HIC.

Features of the HIC include:

- Configurable I/O data lines of 8, 16 and 32-bit
- Direct and mailbox access modes
- 8 address lines and 8 configurable base addresses for a total of 2048 possible addressable regions
- Two 64 byte buffers for external host and device when using mailbox access mode
- Interrupt generation on buffer full/empty
- High throughput
- Trigger HIC activity from other peripherals
- Error indicators to the system or interface

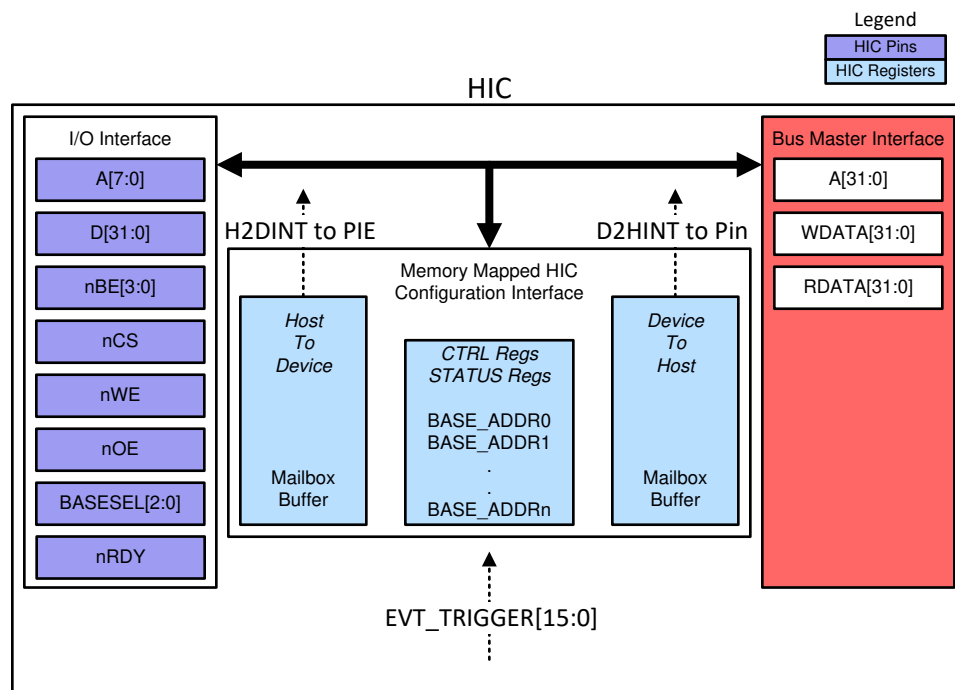


Figure 5-63. HIC Block Diagram

### 5.11.8.1 HIC Electrical Data and Timing

Table 5-70 lists the HIC timing requirements. Table 5-71 lists the HIC switching characteristics.

**Table 5-70. HIC Timing Requirements**

over operating free-air temperature range (unless otherwise noted)

|                                                                           |                                                             | MIN                 | MAX | UNIT |
|---------------------------------------------------------------------------|-------------------------------------------------------------|---------------------|-----|------|
| <b>Read/Write Parameters with nOE and nWE pins - Dual Read/Write pins</b> |                                                             |                     |     |      |
| $t_{su}(ABBV-OEV)$                                                        | Setup time, A/BASESEL/nBE before nOE active                 | 0                   |     | ns   |
| $t_{su}(ABBV-WEV)$                                                        | Setup time, A/BASESEL/nBE before nWE active                 | 0                   |     | ns   |
| $t_{su}(CSV-OEV)$                                                         | Setup time, nCS active before nOE active                    | $0.5t_{c(SYSCCLK)}$ |     | ns   |
| $t_{su}(CSV-WEV)$                                                         | Setup time, nCS active before nWE active                    | $0.5t_{c(SYSCCLK)}$ |     | ns   |
| $t_h(ABBV-OEIV)$                                                          | Hold time, A/BASESEL/nBE/nCS after nOE inactive             | 0                   |     | ns   |
| $t_h(ABBV-WEIV)$                                                          | Hold time, A/BASESEL/nBE/nCS after nWE inactive             | 0                   |     | ns   |
| $t_w(OEV)$                                                                | Active pulse width of nOE (Read) <sup>(1)</sup>             | $4t_{c(SYSCCLK)}$   |     | ns   |
| $t_w(WEV)$                                                                | Active pulse width of nWE (Write)                           | $4t_{c(SYSCCLK)}$   |     | ns   |
| $t_w(CSIV)$                                                               | Inactive pulse width of nCS <sup>(2)</sup>                  | $3t_{c(SYSCCLK)}$   |     | ns   |
| $t_w(OEIV)$                                                               | Inactive Read pulse width of nOE <sup>(2)</sup>             | $3t_{c(SYSCCLK)}$   |     | ns   |
| $t_w(WEIV)$                                                               | Inactive Write pulse width of nWE <sup>(2)</sup>            | $3t_{c(SYSCCLK)}$   |     | ns   |
| $t_{su}(DV-WEV)$                                                          | Setup time, D before nWE active                             | 0                   |     | ns   |
| $t_h(DV-WEIV)$                                                            | Hold time, D after nWE inactive                             | 0                   |     | ns   |
| <b>Read/Write Parameters with RnW pin - Single Read/Write pin</b>         |                                                             |                     |     |      |
| $t_{su}(ABBV-CSV)$                                                        | Setup time, A/BASESEL/nBE before nCS active                 | 0                   |     | ns   |
| $t_{su}(RNWV-CSV)$                                                        | Setup time, RnW before nCS active                           | $0.5t_{c(SYSCCLK)}$ |     | ns   |
| $t_h(ABBV-CSIV)$                                                          | Hold time, A/BASESEL/nBE/RnW after nCS inactive             | 0                   |     | ns   |
| $t_w(CSV\_RD)$                                                            | Active pulse width of nCS for read operation <sup>(1)</sup> | $4t_{c(SYSCCLK)}$   |     | ns   |
| $t_w(CSV\_WR)$                                                            | Active pulse width of nCS for write operation               | $4t_{c(SYSCCLK)}$   |     | ns   |
| $t_w(CSIV)$                                                               | Inactive pulse width of nCS <sup>(2)</sup>                  | $3t_{c(SYSCCLK)}$   |     | ns   |
| $t_w(RNWIV)$                                                              | Inactive pulse width of RnW <sup>(2)</sup>                  | $3t_{c(SYSCCLK)}$   |     | ns   |
| $t_{su}(DV-CSV)$                                                          | Setup time, D before nCS active                             | 0                   |     | ns   |
| $t_h(DV-CSIV)$                                                            | Hold time, D after nCS inactive                             | 0                   |     | ns   |

(1) For accesses to the device region, additional 2 SYSCCLK cycles are required.

(2) For accesses to the device region with nRDY pin, additional SYSCCLK cycle is required.

**Table 5-71. HIC Switching Characteristics**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                          |                                                                     | MIN             | MAX                  | UNIT |
|----------------------------------------------------|---------------------------------------------------------------------|-----------------|----------------------|------|
| <b>Read/Write Parameters with nOE and nWE pins</b> |                                                                     |                 |                      |      |
| $t_{d(OEV-DV)}$                                    | Output data delay time : nOE to D output valid <sup>(1)</sup>       | $3t_{c(SYCLK)}$ | $4t_{c(SYCLK)} + 14$ | ns   |
| $t_{d(OEIV-DIV)}$                                  | Output data hold time : nOE invalid to D output invalid (tri-state) | $1t_{c(SYCLK)}$ | $2t_{c(SYCLK)} + 14$ | ns   |
| $t_{d(OEV-RDYV)}$                                  | Read Ready delay time : nOE to nRDY output valid                    | 0               | 11                   | ns   |
| $t_{d(WEV-RDYV)}$                                  | Write Ready delay time : nWE to nRDY output valid                   | 0               | 11                   | ns   |
| $t_{d(RDYV-DV)}$                                   | Ready to Data delay time : nRDY output valid to D output valid      | -3              | 3                    | ns   |
| $t_{w(RDYACT)}$                                    | Active pulse width of nRDY output                                   | $2t_{c(SYCLK)}$ |                      | ns   |
| <b>Read/Write Parameters with RnW pin</b>          |                                                                     |                 |                      |      |
| $t_{d(CSV-DV)}$                                    | Output delay time : nCS active to D output valid <sup>(1)</sup>     | $3t_{c(SYCLK)}$ | $4t_{c(SYCLK)} + 14$ | ns   |
| $t_{d(CSIV-DIV)}$                                  | Output hold time : nCS inactive to D output invalid (tri-state)     | $1t_{c(SYCLK)}$ | $2t_{c(SYCLK)} + 14$ | ns   |
| $t_{d(CSV-RDYV)}$                                  | Output delay time : nCS to nRDY output valid                        | 0               | 11                   | ns   |
| $t_{d(RDYV-DV)}$                                   | Ready to Data delay time : nRDY output valid to D output valid      | -3              | 3                    | ns   |
| $t_{w(RDYACT)}$                                    | Active pulse width of nRDY output                                   | $2t_{c(SYCLK)}$ |                      | ns   |

(1) Applicable to mailbox accesses only. Direct memory map (Device) accesses are qualified with nRDY pin.

## 6 Detailed Description

### 6.1 Overview

**C2000™ 32-bit microcontrollers** are optimized for processing, sensing, and actuation to improve closed-loop performance in **real-time control applications** such as **industrial motor drives**; **solar inverters and digital power**; **electrical vehicles and transportation**; **motor control**; and **sensing and signal processing**.

The TMS320F28002x (F28002x) is a powerful 32-bit floating-point microcontroller unit (MCU) that lets designers incorporate crucial control peripherals, differentiated analog, and nonvolatile memory on a single device.

The real-time control subsystem is based on TI's 32-bit C28x CPU, which provides 100 MHz of signal processing performance. The C28x CPU is further boosted by the new TMU extended instruction set, which enables fast execution of algorithms with trigonometric operations commonly found in transforms and torque loop calculations; and the VCRC extended instruction set, which reduces the latency for complex math operations commonly found in encoded applications.

The F28002x supports up to 128KB (64KW) of flash memory in one bank. Up to 24KB (12KW) of on-chip SRAM is also available in blocks of 4KB (2KW) for efficient system partitioning. Flash ECC, SRAM ECC/parity, and dual-zone security are also supported.

High-performance analog blocks are integrated on the F28002x MCU to further enable system consolidation. Two separate 12-bit ADCs provide precise and efficient management of multiple analog signals, which ultimately boosts system throughput. Four analog comparator modules provide continuous monitoring of input voltage levels for trip conditions.

The TMS320C2000™ devices contain industry-leading control peripherals with frequency-independent ePWM/HRPWM and eCAP allow for a best-in-class level of control to the system.

Connectivity is supported through various industry-standard communication ports (such as SPI, SCI, I2C, PMBus, LIN, and CAN) and offers multiple muxing options for optimal signal placement in a variety of applications. New to the C2000™ platform is Host Interface Controller (HIC), a high throughput interface that allows an external host to access resources of the TMS320F28002x. Additionally, in an industry first, the FSI enables high-speed, robust communication to complement the rich set of peripherals that are embedded in the device.

A specially enabled device variant, TMS320F28002xC, allows access to the Configurable Logic Block (CLB) for additional interfacing features and allows access to the secure ROM, which includes a library to enable InstaSPIN-FOC™. See [Device Comparison](#) for more information.

The Embedded Real-Time Analysis and Diagnostic (ERAD) module enhances the debug and system analysis capabilities of the device by providing additional hardware breakpoints and counters for profiling.

To learn more about the C2000 MCUs, visit the C2000 Overview at [www.ti.com/c2000](http://www.ti.com/c2000).

## 6.2 Functional Block Diagram

Figure 6-1 shows the CPU system and associated peripherals.

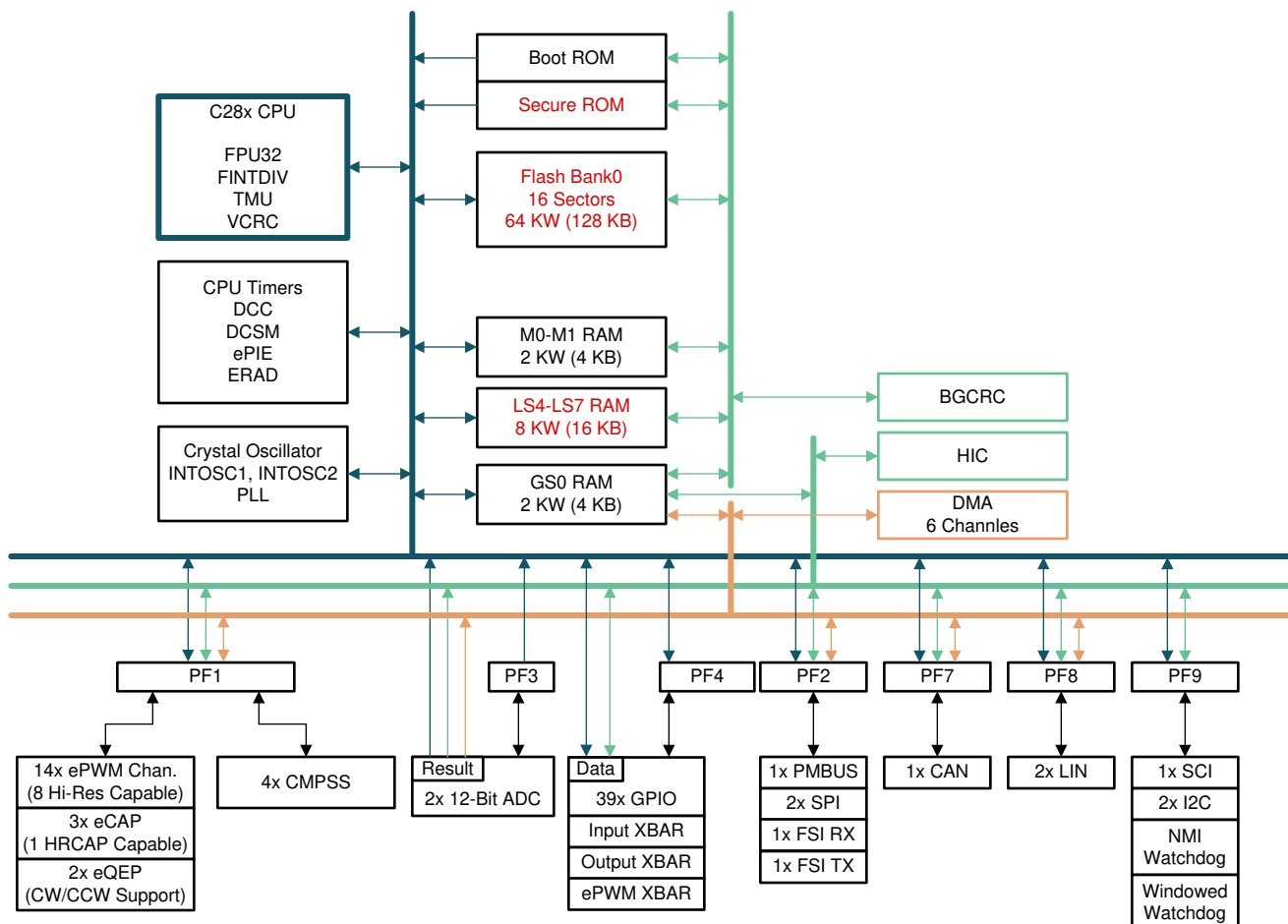


Figure 6-1. Functional Block Diagram

## 6.3 Memory

### 6.3.1 Memory Map

Table 6-1 describes the memory map. See the Memory Controller Module section of the System Control chapter in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

**Table 6-1. Memory Map**

| MEMORY                                    | SIZE     | START ADDRESS | END ADDRESS | HIC ACCESS | DMA ACCESS | ECC/PARITY | ACCESS PROTECTION | SECURITY |
|-------------------------------------------|----------|---------------|-------------|------------|------------|------------|-------------------|----------|
| M0 RAM                                    | 1K x 16  | 0x0000 0000   | 0x0000 03FF | -          | -          | ECC        | Yes               | -        |
| M1 RAM                                    | 1K x 16  | 0x0000 0400   | 0x0000 07FF | -          | -          | ECC        | Yes               | -        |
| PieVectTable                              | 512 x 16 | 0x0000 0D00   | 0x0000 0EFF | -          | -          | -          | -                 | -        |
| LS4 RAM                                   | 2K x 16  | 0x0000 A000   | 0x0000 A7FF | -          | -          | ECC        | Yes               | Yes      |
| LS5 RAM                                   | 2K x 16  | 0x0000 A800   | 0x0000 AFFF | -          | -          | ECC        | Yes               | Yes      |
| LS6 RAM                                   | 2K x 16  | 0x0000 B000   | 0x0000 B7FF | -          | -          | ECC        | Yes               | Yes      |
| LS7 RAM                                   | 2K x 16  | 0x0000 B800   | 0x0000 BFFF | -          | -          | ECC        | Yes               | Yes      |
| GS0 RAM                                   | 2K x 16  | 0x0000 C000   | 0x0000 C7FF | Yes        | Yes        | Parity     | Yes               | -        |
| CAN A Message RAM                         | 2K x 16  | 0x0004 9000   | 0x0004 97FF | -          | -          | Parity     | -                 | -        |
| TI OTP <sup>(1)</sup>                     | 1K x 16  | 0x0007 0000   | 0x0007 03FF | -          | -          | ECC        | -                 | -        |
| User OTP                                  | 1K x 16  | 0x0007 8000   | 0x0007 83FF | -          | -          | ECC        | -                 | Yes      |
| Flash                                     | 64K x 16 | 0x0008 0000   | 0x0008 FFFF | -          | -          | ECC        | -                 | Yes      |
| Secure ROM                                | 32K x 16 | 0x003E 8000   | 0x003E FFFF | -          | -          | Parity     | -                 | Yes      |
| Boot ROM                                  | 64K x 16 | 0x003F 0000   | 0x003F FFFF | -          | -          | Parity     | -                 | -        |
| Pie Vector Fetch Error (part of Boot ROM) | 1 x 16   | 0x003F FFBE   | 0x003F FFBF | -          | -          | Parity     | -                 | -        |
| Default Vectors (part of Boot ROM)        | 64 x 16  | 0x003F FFC0   | 0x003F FFFF | -          | -          | Parity     | -                 | -        |

(1) TI OTP is for TI internal use only.

#### 6.3.1.1 Dedicated RAM (Mx RAM)

The CPU subsystem has two dedicated ECC-capable RAM blocks: M0 and M1. These memories are small nonsecure blocks that are tightly coupled with the CPU (that is, only the CPU has access to them).

#### 6.3.1.2 Local Shared RAM (LSx RAM)

Local shared RAMs (LSx RAMs) are accessible to the CPU, HIC, and BGCRC. All LSx RAM blocks have ECC. These memories are secure and have CPU access protection (CPU write/CPU fetch).

#### 6.3.1.3 Global Shared RAM (GSx RAM)

Global shared RAMs (GSx RAMs) are accessible from the CPU, HIC, and DMA. The CPU, HIC, and DMA have full read and write access to these memories. All GSx RAM blocks have parity. The GSx RAMs have access protection (CPU write/CPU fetch/DMA write/HIC write).

### 6.3.2 Flash Memory Map

On the F28002x devices one flash bank (128KB [64KW]) is available. Code to program the flash should be executed out of RAM, there should not be any kind of access to the flash bank when an erase or program operation is in progress. [Table 6-2](#) lists the addresses of flash sectors available for each part number.

**Table 6-2. Addresses of Flash Sectors**

| PART NUMBER                                 | SECTOR    | ADDRESS |             |             | ECC ADDRESS |             |             |
|---------------------------------------------|-----------|---------|-------------|-------------|-------------|-------------|-------------|
|                                             |           | SIZE    | START       | END         | SIZE        | START       | END         |
| OTP Sectors                                 |           |         |             |             |             |             |             |
| All F28002x                                 | TI OTP    | 1K x 16 | 0x0007 0000 | 0x0007 03FF | 128 x 16    | 0x0107 0000 | 0x0107 007F |
|                                             | DCSM OTP  | 1K x 16 | 0x0007 8000 | 0x0007 83FF | 128 x 16    | 0x0107 1000 | 0x0107 107F |
| Bank 0 Sectors                              |           |         |             |             |             |             |             |
| All F28002x                                 | Sector 0  | 4K x 16 | 0x0008 0000 | 0x0008 0FFF | 512 x 16    | 0x0108 0000 | 0x0108 01FF |
|                                             | Sector 1  | 4K x 16 | 0x0008 1000 | 0x0008 1FFF | 512 x 16    | 0x0108 0200 | 0x0108 03FF |
|                                             | Sector 2  | 4K x 16 | 0x0008 2000 | 0x0008 2FFF | 512 x 16    | 0x0108 0400 | 0x0108 05FF |
|                                             | Sector 3  | 4K x 16 | 0x0008 3000 | 0x0008 3FFF | 512 x 16    | 0x0108 0600 | 0x0108 07FF |
| F280025,<br>F280024,<br>F280023,<br>F280022 | Sector 4  | 4K x 16 | 0x0008 4000 | 0x0008 4FFF | 512 x 16    | 0x0108 0800 | 0x0108 09FF |
|                                             | Sector 5  | 4K x 16 | 0x0008 5000 | 0x0008 5FFF | 512 x 16    | 0x0108 0A00 | 0x0108 0BFF |
|                                             | Sector 6  | 4K x 16 | 0x0008 6000 | 0x0008 6FFF | 512 x 16    | 0x0108 0C00 | 0x0108 0DFF |
|                                             | Sector 7  | 4K x 16 | 0x0008 7000 | 0x0008 7FFF | 512 x 16    | 0x0108 0E00 | 0x0108 0FFF |
| F280025,<br>F280024                         | Sector 8  | 4K x 16 | 0x0008 8000 | 0x0008 8FFF | 512 x 16    | 0x0108 1000 | 0x0108 11FF |
|                                             | Sector 9  | 4K x 16 | 0x0008 9000 | 0x0008 9FFF | 512 x 16    | 0x0108 1200 | 0x0108 13FF |
|                                             | Sector 10 | 4K x 16 | 0x0008 A000 | 0x0008 AFFF | 512 x 16    | 0x0108 1400 | 0x0108 15FF |
|                                             | Sector 11 | 4K x 16 | 0x0008 B000 | 0x0008 BFFF | 512 x 16    | 0x0108 1600 | 0x0108 17FF |
|                                             | Sector 12 | 4K x 16 | 0x0008 C000 | 0x0008 CFFF | 512 x 16    | 0x0108 1800 | 0x0108 19FF |
|                                             | Sector 13 | 4K x 16 | 0x0008 D000 | 0x0008 DFFF | 512 x 16    | 0x0108 1A00 | 0x0108 1BFF |
|                                             | Sector 14 | 4K x 16 | 0x0008 E000 | 0x0008 EFFF | 512 x 16    | 0x0108 1C00 | 0x0108 1DFF |
|                                             | Sector 15 | 4K x 16 | 0x0008 F000 | 0x0008 FFFF | 512 x 16    | 0x0108 1E00 | 0x0108 1FFF |

### 6.3.3 Peripheral Registers Memory Map

Table 6-3 lists the peripheral registers.

**Table 6-3. Peripheral Registers Memory Map (C28x)**

| Bit Field Name           |                        | DriverLib Name      | Base Address | Pipeline Protected | DMA Access | HIC Access |
|--------------------------|------------------------|---------------------|--------------|--------------------|------------|------------|
| Instance                 | Structure              |                     |              |                    |            |            |
| Peripheral Frame 0 (PF0) |                        |                     |              |                    |            |            |
| AdcaResultRegs           | ADC_RESULT_REGS        | ADCARESLT_BASE      | 0x0000_0B00  | -                  | YES        | YES        |
| AdccResultRegs           | ADC_RESULT_REGS        | ADCCRESULT_BASE     | 0x0000_0B40  | -                  | YES        | YES        |
| CpuTimer0Regs            | CPUTIMER_REGS          | CPUTIMER0_BASE      | 0x0000_0C00  | -                  | -          | -          |
| CpuTimer1Regs            | CPUTIMER_REGS          | CPUTIMER1_BASE      | 0x0000_0C08  | -                  | -          | -          |
| CpuTimer2Regs            | CPUTIMER_REGS          | CPUTIMER2_BASE      | 0x0000_0C10  | -                  | -          | -          |
| PieCtrlRegs              | PIE_CTRL_REGS          | PIECTRL_BASE        | 0x0000_0CE0  | -                  | -          | -          |
| DmaRegs                  | DMA_REGS               | DMA_BASE            | 0x0000_1000  | -                  | -          | -          |
| Dmach1Regs               | DMA_CH_REGS            | DMA_CH1_BASE        | 0x0000_1020  | -                  | -          | -          |
| Dmach2Regs               | DMA_CH_REGS            | DMA_CH2_BASE        | 0x0000_1040  | -                  | -          | -          |
| Dmach3Regs               | DMA_CH_REGS            | DMA_CH3_BASE        | 0x0000_1060  | -                  | -          | -          |
| Dmach4Regs               | DMA_CH_REGS            | DMA_CH4_BASE        | 0x0000_1080  | -                  | -          | -          |
| Dmach5Regs               | DMA_CH_REGS            | DMA_CH5_BASE        | 0x0000_10A0  | -                  | -          | -          |
| Dmach6Regs               | DMA_CH_REGS            | DMA_CH6_BASE        | 0x0000_10C0  | -                  | -          | -          |
| Peripheral Frame 1 (PF1) |                        |                     |              |                    |            |            |
| Clb1LogicCfgRegs         | CLB_LOGIC_CONFIG_REGS  | CLB1_LOGICCFG_BASE  | 0x0000_3000  | -                  | YES        | YES        |
| Clb1LogicCtrlRegs        | CLB_LOGIC_CONTROL_REGS | CLB1_LOGICCTRL_BASE | 0x0000_3100  | -                  | YES        | YES        |
| Clb1DataExchRegs         | CLB_DATA_EXCHANGE_REGS | CLB1_DATAEXCH_BASE  | 0x0000_3180  | -                  | YES        | YES        |
| Clb2LogicCfgRegs         | CLB_LOGIC_CONFIG_REGS  | CLB2_LOGICCFG_BASE  | 0x0000_3200  | -                  | YES        | YES        |
| Clb1DataExchRegs         | CLB_DATA_EXCHANGE_REGS | CLB1_DATAEXCH_BASE  | 0x0000_3300  | -                  | YES        | YES        |
| Clb2LogicCfgRegs         | CLB_LOGIC_CONFIG_REGS  | CLB2_LOGICCFG_BASE  | 0x0000_3380  | -                  | YES        | YES        |
| EPwm1Regs                | EPWM_REGS              | EPWM1_BASE          | 0x0000_4000  | YES                | YES        | YES        |
| EPwm2Regs                | EPWM_REGS              | EPWM2_BASE          | 0x0000_4100  | YES                | YES        | YES        |
| EPwm3Regs                | EPWM_REGS              | EPWM3_BASE          | 0x0000_4200  | YES                | YES        | YES        |
| EPwm4Regs                | EPWM_REGS              | EPWM4_BASE          | 0x0000_4300  | YES                | YES        | YES        |
| EPwm5Regs                | EPWM_REGS              | EPWM5_BASE          | 0x0000_4400  | YES                | YES        | YES        |
| EPwm6Regs                | EPWM_REGS              | EPWM6_BASE          | 0x0000_4500  | YES                | YES        | YES        |
| EPwm7Regs                | EPWM_REGS              | EPWM7_BASE          | 0x0000_4600  | YES                | YES        | YES        |
| EQep1Regs                | EQEP_REGS              | EQEP1_BASE          | 0x0000_5100  | YES                | YES        | YES        |
| EQep2Regs                | EQEP_REGS              | EQEP2_BASE          | 0x0000_5140  | YES                | YES        | YES        |
| ECap1Regs                | ECAP_REGS              | ECAP1_BASE          | 0x0000_5200  | YES                | YES        | YES        |
| ECap2Regs                | ECAP_REGS              | ECAP2_BASE          | 0x0000_5240  | YES                | YES        | YES        |
| ECap3Regs                | ECAP_REGS              | ECAP3_BASE          | 0x0000_5280  | YES                | YES        | YES        |
| Hrcap3Regs               | HRCAP_REGS             | HRCAP3_BASE         | 0x0000_52A0  | YES                | YES        | YES        |
| Cmpss1Regs               | CMPSS_REGS             | CMPSS1_BASE         | 0x0000_5C80  | YES                | YES        | YES        |
| Cmpss2Regs               | CMPSS_REGS             | CMPSS2_BASE         | 0x0000_5CA0  | YES                | YES        | YES        |
| Cmpss3Regs               | CMPSS_REGS             | CMPSS3_BASE         | 0x0000_5CC0  | YES                | YES        | YES        |
| Cmpss4Regs               | CMPSS_REGS             | CMPSS4_BASE         | 0x0000_5CE0  | YES                | YES        | YES        |
| Peripheral Frame 2 (PF2) |                        |                     |              |                    |            |            |
| SpiaRegs                 | SPI_REGS               | SPIA_BASE           | 0x0000_6100  | YES                | YES        | YES        |
| SpibRegs                 | SPI_REGS               | SPIB_BASE           | 0x0000_6110  | YES                | YES        | YES        |
| BgcrcCpuRegs             | BGCRC_REGS             | BGCRC_CPU_BASE      | 0x0000_6340  | YES                | YES        | YES        |
| PmbusaRegs               | PMBUS_REGS             | PMBUSA_BASE         | 0x0000_6400  | YES                | YES        | YES        |
| HicRegs                  | HIC_CFG_REGS           | HIC_BASE            | 0x0000_6500  | YES                | YES        | YES        |
| FsiTxaRegs               | FSI_TX_REGS            | FSITXA_BASE         | 0x0000_6600  | YES                | YES        | YES        |
| FsiRxaRegs               | FSI_RX_REGS            | FSIRXA_BASE         | 0x0000_6680  | YES                | YES        | YES        |

Table 6-3. Peripheral Registers Memory Map (C28x) (continued)

| Bit Field Name           |                       | DriverLib Name        | Base Address | Pipeline Protected | DMA Access | HIC Access |
|--------------------------|-----------------------|-----------------------|--------------|--------------------|------------|------------|
| Instance                 | Structure             |                       |              |                    |            |            |
| Peripheral Frame 3 (PF3) |                       |                       |              |                    |            |            |
| AdcaRegs                 | ADC_REGS              | ADCA_BASE             | 0x0000_7400  | YES                | -          | -          |
| AdccRegs                 | ADC_REGS              | ADCC_BASE             | 0x0000_7500  | YES                | -          | -          |
| Peripheral Frame 4 (PF4) |                       |                       |              |                    |            |            |
| InputXbarRegs            | INPUT_XBAR_REGS       | INPUTXBAR_BASE        | 0x0000_7900  | YES                | -          | -          |
| XbarRegs                 | XBAR_REGS             | XBAR_BASE             | 0x0000_7920  | YES                | -          | -          |
| SyncSocRegs              | SYNC_SOC_REGS         | SYNCSOC_BASE          | 0x0000_7940  | YES                | -          | -          |
| InputXbar2Regs           | INPUT_XBAR_REGS       | INPUTXBAR2_BASE       | 0x0000_7960  | YES                | -          | -          |
| DmaClaSrcSelRegs         | DMA_CLA_SRC_SEL_REGS  | DMACLASRCSEL_BASE     | 0x0000_7980  | YES                | -          | -          |
| EPwmXbarRegs             | EPWM_XBAR_REGS        | EPWMXBAR_BASE         | 0x0000_7A00  | YES                | -          | -          |
| ClbXbarRegs              | CLB_XBAR_REGS         | CLBXBAR_BASE          | 0x0000_7A40  | YES                | -          | -          |
| OutputXbarRegs           | OUTPUT_XBAR_REGS      | OUTPUTXBAR_BASE       | 0x0000_7A80  | YES                | -          | -          |
| OutputXbar2Regs          | OUTPUT_XBAR_REGS      | OUTPUTXBAR2_BASE      | 0x0000_7BC0  | YES                | -          | -          |
| GpioCtrlRegs             | GPIO_CTRL_REGS        | GPIOCTRL_BASE         | 0x0000_7C00  | YES                | -          | -          |
| GpioDataRegs             | GPIO_DATA_REGS        | GPIODATA_BASE         | 0x0000_7F00  | YES                | -          | -          |
| GpioDataReadRegs         | GPIO_DATA_READ_REGS   | GPIODATAREAD_BASE     | 0x0000_7F80  | YES                | -          | YES        |
| Peripheral Frame 5 (PF5) |                       |                       |              |                    |            |            |
| DevCfgRegs               | DEV_CFG_REGS          | DEVCFG_BASE           | 0x0005_D000  | YES                | -          | -          |
| ClkCfgRegs               | CLK_CFG_REGS          | CLKCFG_BASE           | 0x0005_D200  | YES                | -          | -          |
| CpuSysRegs               | CPU_SYS_REGS          | CPUSYS_BASE           | 0x0005_D300  | YES                | -          | -          |
| PeriphAcRegs             | PERIPH_AC_REGS        | PERIPHAC_BASE         | 0x0005_D500  | YES                | -          | -          |
| AnalogSubsysRegs         | ANALOG_SUBSYS_REGS    | ANALOGSUBSYS_BASE     | 0x0005_D700  | YES                | -          | -          |
| DcsmBank0Z1Regs          | DCSM_BANK0_Z1_REGS    | DCSM_BANK0_Z1_BASE    | 0x0005_F000  | YES                | -          | -          |
| DcsmBank0Z2Regs          | DCSM_BANK0_Z2_REGS    | DCSM_BANK0_Z2_BASE    | 0x0005_F040  | YES                | -          | -          |
| DcsmCommonRegs           | DCSM_COMMON_REGS      | DCSMCOMMON_BASE       | 0x0005_F070  | YES                | -          | -          |
| DcsmCommon2Regs          | DCSM_COMMON2_REGS     | DCSMCOMMON2_BASE      | 0x0005_F080  | YES                | -          | -          |
| Peripheral Frame 6 (PF6) |                       |                       |              |                    |            |            |
| MemCfgRegs               | MEM_CFG_REGS          | MEMCFG_BASE           | 0x0005_F400  | YES                | -          | -          |
| AccessProtectionRegs     | ACCESSPROTECTION_REGS | ACCESSPROTECTION_BASE | 0x0005_F500  | YES                | -          | -          |
| MemoryErrorRegs          | MEMORY_ERROR_REGS     | MEMORYERROR_BASE      | 0x0005_F540  | YES                | -          | -          |
| RomWaitStateRegs         | ROM_WAIT_STATE_REGS   | ROMWAITSTATE_BASE     | 0x0005_F580  | YES                | -          | -          |
| RomPrefetchRegs          | ROM_PREFETCH_REGS     | ROMPREFETCH_BASE      | 0x0005_F588  | YES                | -          | -          |
| Flash0CtrlRegs           | FLASH_CTRL_REGS       | FLASH0CTRL_BASE       | 0x0005_F800  | YES                | -          | -          |
| Flash0EccRegs            | FLASH_ECC_REGS        | FLASH0ECCREGS_BASE    | 0x0005_FB00  | YES                | -          | -          |
| Peripheral Frame 7 (PF7) |                       |                       |              |                    |            |            |
| CanaRegs                 | CAN_REGS              | CANA_BASE             | 0x0004_8000  | YES                | YES        | YES        |
| CanaMboxRegs             | CAN_MBOX              | CANAMBOX_BASE         | 0x0004_9000  | YES                | YES        | YES        |
| HwbistRegs               | HWBIST_REGS           | HWBIST_BASE           | 0x0005_E000  | YES                | -          | -          |
| MpostRegs                | MPOST_REGS            | MPOST_BASE            | 0x0005_E200  | YES                | -          | -          |
| Dcc0Regs                 | DCC_REGS              | DCC0_BASE             | 0x0005_E700  | YES                | -          | -          |
| Dcc1Regs                 | DCC_REGS              | DCC1_BASE             | 0x0005_E740  | YES                | -          | -          |
| EradGlobalRegs           | ERAD_GLOBAL_REGS      | ERADGLOBAL_BASE       | 0x0005_E800  | YES                | -          | -          |
| EradHWBP1Regs            | ERAD_HWBP_REGS        | ERADHWBP1_BASE        | 0x0005_E900  | YES                | -          | -          |
| EradHWBP2Regs            | ERAD_HWBP_REGS        | ERADHWBP2_BASE        | 0x0005_E908  | YES                | -          | -          |
| EradHWBP3Regs            | ERAD_HWBP_REGS        | ERADHWBP3_BASE        | 0x0005_E910  | YES                | -          | -          |
| EradHWBP4Regs            | ERAD_HWBP_REGS        | ERADHWBP4_BASE        | 0x0005_E918  | YES                | -          | -          |
| EradHWBP5Regs            | ERAD_HWBP_REGS        | ERADHWBP5_BASE        | 0x0005_E920  | YES                | -          | -          |
| EradHWBP6Regs            | ERAD_HWBP_REGS        | ERADHWBP6_BASE        | 0x0005_E928  | YES                | -          | -          |
| EradHWBP7Regs            | ERAD_HWBP_REGS        | ERADHWBP7_BASE        | 0x0005_E930  | YES                | -          | -          |
| EradHWBP8Regs            | ERAD_HWBP_REGS        | ERADHWBP8_BASE        | 0x0005_E938  | YES                | -          | -          |

**Table 6-3. Peripheral Registers Memory Map (C28x) (continued)**

| Bit Field Name                  |                      | DriverLib Name     | Base Address | Pipeline Protected | DMA Access | HIC Access |
|---------------------------------|----------------------|--------------------|--------------|--------------------|------------|------------|
| Instance                        | Structure            |                    |              |                    |            |            |
| EradCounter1Regs                | ERAD_COUNTER_REGS    | ERADCOUNTER1_BASE  | 0x0005_E980  | YES                | -          | -          |
| EradCounter2Regs                | ERAD_COUNTER_REGS    | ERADCOUNTER2_BASE  | 0x0005_E990  | YES                | -          | -          |
| EradCounter3Regs                | ERAD_COUNTER_REGS    | ERADCOUNTER3_BASE  | 0x0005_E9A0  | YES                | -          | -          |
| EradCounter4Regs                | ERAD_COUNTER_REGS    | ERADCOUNTER4_BASE  | 0x0005_E9B0  | YES                | -          | -          |
| EradCRCGlobalRegs               | ERAD_CRC_GLOBAL_REGS | ERADCRCGLOBAL_BASE | 0x0005_EA00  | YES                | -          | -          |
| EradCRC1Regs                    | ERAD_CRC_REGS        | ERADCRC1_BASE      | 0x0005_EA10  | YES                | -          | -          |
| EradCRC2Regs                    | ERAD_CRC_REGS        | ERADCRC2_BASE      | 0x0005_EA20  | YES                | -          | -          |
| EradCRC3Regs                    | ERAD_CRC_REGS        | ERADCRC3_BASE      | 0x0005_EA30  | YES                | -          | -          |
| EradCRC4Regs                    | ERAD_CRC_REGS        | ERADCRC4_BASE      | 0x0005_EA40  | YES                | -          | -          |
| EradCRC5Regs                    | ERAD_CRC_REGS        | ERADCRC5_BASE      | 0x0005_EA50  | YES                | -          | -          |
| EradCRC6Regs                    | ERAD_CRC_REGS        | ERADCRC6_BASE      | 0x0005_EA60  | YES                | -          | -          |
| EradCRC7Regs                    | ERAD_CRC_REGS        | ERADCRC7_BASE      | 0x0005_EA70  | YES                | -          | -          |
| EradCRC8Regs                    | ERAD_CRC_REGS        | ERADCRC8_BASE      | 0x0005_EA80  | YES                | -          | -          |
| <b>Peripheral Frame 8 (PF8)</b> |                      |                    |              |                    |            |            |
| LinaRegs                        | LIN_REGS             | LINA_BASE          | 0x0000_6A00  | YES                | YES        | YES        |
| LinbRegs                        | LIN_REGS             | LINB_BASE          | 0x0000_6B00  | YES                | YES        | YES        |
| <b>Peripheral Frame 9 (PF9)</b> |                      |                    |              |                    |            |            |
| WdRegs                          | WD_REGS              | WD_BASE            | 0x0000_7000  | YES                | -          | YES        |
| NmiIntruptRegs                  | NMI_INTRUPT_REGS     | NMI_BASE           | 0x0000_7060  | YES                | -          | YES        |
| XintRegs                        | XINT_REGS            | XINT_BASE          | 0x0000_7070  | YES                | -          | YES        |
| SciaRegs                        | SCI_REGS             | SCIA_BASE          | 0x0000_7200  | YES                | -          | YES        |
| I2caRegs                        | I2C_REGS             | I2CA_BASE          | 0x0000_7300  | YES                | -          | YES        |
| I2cbRegs                        | I2C_REGS             | I2CB_BASE          | 0x0000_7340  | YES                | -          | YES        |

## 6.4 Identification

Table 6-4 lists the Device Identification Registers. Additional information on these device identification registers can be found in the [TMS320F28002x Microcontrollers Technical Reference Manual](#).

**Table 6-4. Device Identification Registers**

| NAME       | ADDRESS     | SIZE (x16) | DESCRIPTION                                                                                                                                                                                                               |
|------------|-------------|------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PARTIDH    | 0x0005 D00A | 2          | Device part identification number                                                                                                                                                                                         |
|            |             |            | TMS320F280025 0x04FF 0500                                                                                                                                                                                                 |
|            |             |            | TMS320F280025C 0x04FF 0500                                                                                                                                                                                                |
|            |             |            | TMS320F280024 0x04FE 0500                                                                                                                                                                                                 |
|            |             |            | TMS320F280024C 0x04FE 0500                                                                                                                                                                                                |
|            |             |            | TMS320F280023 0x04FD 0500                                                                                                                                                                                                 |
|            |             |            | TMS320F280023C 0x04FD 0500                                                                                                                                                                                                |
|            |             |            | TMS320F280022 0x04FC 0500                                                                                                                                                                                                 |
|            |             |            | TMS320F280021 0x04FB 0500                                                                                                                                                                                                 |
| REVID      | 0x0005 D00C | 2          | Silicon revision number<br>Revision 0 0x0000 0000                                                                                                                                                                         |
| UID_UNIQUE | 0x0007 01E8 | 2          | Unique identification number. This number is different on each individual device with the same PARTIDH. This unique number can be used as a serial number in the application. This number is present only on TMS devices. |

## 6.5 Bus Architecture – Peripheral Connectivity

Table 6-5 lists a broad view of the peripheral and configuration register accessibility from each bus master.

**Table 6-5. Peripheral Connectivity**

| PERIPHERAL                         | C28 | DMA | HIC | BGCRC |
|------------------------------------|-----|-----|-----|-------|
| <b>SYSTEM PERIPHERALS</b>          |     |     |     |       |
| CPU Timers                         | Y   |     |     |       |
| ERAD                               | Y   |     |     |       |
| GPIO Data                          | Y   |     | Y   |       |
| GPIO Pin Mapping and Configuration | Y   |     |     |       |
| XBAR Configuration                 | Y   |     |     |       |
| System Configuration               | Y   |     |     |       |
| DCC                                | Y   |     |     |       |
| <b>MEMORY</b>                      |     |     |     |       |
| M0/M1                              | Y   |     |     | Y     |
| LSx                                | Y   |     |     | Y     |
| GS0                                | Y   | Y   | Y   | Y     |
| ROM                                | Y   |     |     | Y     |
| FLASH                              | Y   |     |     |       |
| <b>CONTROL PERIPHERALS</b>         |     |     |     |       |
| ePWM/HRPWM                         | Y   | Y   | Y   |       |
| eCAP                               | Y   | Y   | Y   |       |
| eQEP <sup>(1)</sup>                | Y   | Y   | Y   |       |
| <b>ANALOG PERIPHERALS</b>          |     |     |     |       |
| CMPSS <sup>(1)</sup>               | Y   | Y   | Y   |       |
| ADC Configuration                  | Y   |     |     |       |
| ADC Results <sup>(1)</sup>         | Y   | Y   | Y   |       |
| <b>COMMUNICATION PERIPHERALS</b>   |     |     |     |       |
| CAN                                | Y   | Y   | Y   |       |
| FSITX/FSIRX                        | Y   | Y   | Y   |       |
| I2C                                | Y   |     | Y   |       |
| LIN                                | Y   | Y   | Y   |       |
| PMBus                              | Y   | Y   | Y   |       |
| SCI                                | Y   |     | Y   |       |
| SPI                                | Y   | Y   | Y   |       |

(1) These modules are accessible from DMA but cannot trigger a DMA transfer.

## 6.6 C28x Processor

The CPU is a 32-bit fixed-point processor. This device draws from the best features of digital signal processing; reduced instruction set computing (RISC); and microcontroller architectures, firmware, and tool sets.

The CPU features include a modified Harvard architecture and circular addressing. The RISC features are single-cycle instruction execution, register-to-register operations, and modified Harvard architecture. The microcontroller features include ease of use through an intuitive instruction set, byte packing and unpacking, and bit manipulation. The modified Harvard architecture of the CPU enables instruction and data fetches to be performed in parallel. The CPU can read instructions and data while it writes data simultaneously to maintain the single-cycle instruction operation across the pipeline. The CPU does this over six separate address/data buses.

For more information on CPU architecture and instruction set, see the [TMS320C28x CPU and Instruction Set Reference Guide](#). For more information on the C28x Floating Point Unit (FPU), Trigonometric Math Unit, and Cyclic Redundancy Check (VCRC) instruction sets, see the [TMS320C28x Extended Instruction Sets Technical Reference Manual](#). A brief overview of the FPU, TMU, and VCRC are provided here.

### 6.6.1 Floating-Point Unit (FPU)

The C28x plus floating-point (C28x+FPU) processor extends the capabilities of the C28x fixed-point CPU by adding registers and instructions to support IEEE single-precision floating-point operations.

Devices with the C28x+FPU include the standard C28x register set plus an additional set of floating-point unit registers. The additional floating-point unit registers are the following:

- Eight floating-point result registers, RnH (where n = 0–7)
- Floating-point Status Register (STF)
- Repeat Block Register (RB)

All of the floating-point registers, except the RB, are shadowed. This shadowing can be used in high-priority interrupts for fast context save and restore of the floating-point registers.

### 6.6.2 Fast Integer Division Unit

The Fast Integer Division (FINTDIV) unit of the C28x CPU uniquely supports three types of integer division (Truncated, Modulus, Euclidean) of varying data type sizes (16/16, 32/16, 32/32, 64/32, 64/64) in unsigned or signed formats.

- Truncated integer division is naturally supported by C language (/ , % operators).
- Modulus and Euclidean divisions are variants that are more efficient for control algorithms and are supported by C intrinsics.

All three types of integer division produce both a quotient and remainder component, are interruptible, and execute in a minimum number of deterministic cycles (10 cycles for a 32/32 division). In addition, the Fast Division capabilities of the C28x CPU uniquely support fast execution of floating-point 32-bit (in 5 cycles) and 64-bit (in 20 cycles) division.

For more information about fast integer division, see the [Fast Integer Division – A Differentiated Offering From C2000™ Product Family Application Report](#).

### 6.6.3 Trigonometric Math Unit (TMU)

The TMU extends the capabilities of a C28x+FPU by adding instructions and leveraging existing FPU instructions to speed up the execution of common trigonometric and arithmetic operations listed in [Table 6-6](#).

**Table 6-6. TMU Supported Instructions**

| INSTRUCTIONS            | C EQUIVALENT OPERATION                     | PIPELINE CYCLES |
|-------------------------|--------------------------------------------|-----------------|
| MPY2PIF32 RaH,RbH       | $a = b * 2\pi$                             | 2/3             |
| DIV2PIF32 RaH,RbH       | $a = b / 2\pi$                             | 2/3             |
| DIVF32 RaH,RbH,RcH      | $a = b/c$                                  | 5               |
| SQRTF32 RaH,RbH         | $a = \sqrt{b}$                             | 5               |
| SINPUF32 RaH,RbH        | $a = \sin(b*2\pi)$                         | 4               |
| COSPUF32 RaH,RbH        | $a = \cos(b*2\pi)$                         | 4               |
| ATANPUF32 RaH,RbH       | $a = \tan(b)/2\pi$                         | 4               |
| QUADF32 RaH,RbH,RcH,RdH | Operation to assist in calculating ATANPU2 | 5               |

No changes have been made to existing instructions, pipeline or memory bus architecture. All TMU instructions use the existing FPU register set (R0H to R7H) to carry out their operations.

Exponent instruction IEXP2F32 and logarithmic instruction LOG2F32 have been added to support computation of floating-point power function for the non-linear proportional integral derivative control (NLPID) component of the C2000 Digital Control Library. These two added instructions reduce the power function calculations from a typical of 300 cycles using library emulation to less than 10 cycles.

### 6.6.4 VCRC Unit

Cyclic redundancy check (CRC) algorithms provide a straightforward method for verifying data integrity over large data blocks, communication packets, or code sections. The C28x+VCRC can perform 8-bit, 16-bit, 24-bit, and 32-bit CRCs. For example, the VCRC can compute the CRC for a block length of 10 bytes in 10 cycles. A CRC result register contains the current CRC, which is updated whenever a CRC instruction is executed.

The following are the CRC polynomials used by the CRC calculation logic of the VCRC:

- CRC8 polynomial = 0x07
- CRC16 polynomial 1 = 0x8005
- CRC16 polynomial 2 = 0x1021
- CRC24 polynomial = 0x5d6dcb
- CRC32 polynomial 1 = 0x04c11db7
- CRC32 polynomial 2 = 0x1edc6f41

This module can calculate CRCs for a byte of data in a single cycle. The CRC calculation for CRC8, CRC16, CRC24, and CRC32 is done byte-wise (instead of computing on a complete 16-bit or 32-bit data read by the C28x core) to match the byte-wise computation requirement mandated by various standards.

The VCRC Unit also allows the user to provide the size (1b-32b) and value of any polynomial to fit custom CRC requirements. The CRC execution time increases to three cycles when using a custom polynomial.

## 6.7 Embedded Real-Time Analysis and Diagnostic (ERAD)

The ERAD module enhances the debug and system-analysis capabilities of the device. The debug and system-analysis enhancements provided by the ERAD module is done outside of the CPU. The ERAD module consists of the Enhanced Bus Comparator units and the System Event Counter units. The Enhanced Bus Comparator units are used to generate hardware breakpoints, hardware watch points, and other output events. The System Event Counter units are used to analyze and profile the system. The ERAD module is accessible by the debugger and by the application software, which significantly increases the debug capabilities of many real-time systems, especially in situations where debuggers are not connected. In the TMS320F28002x devices, the ERAD module contains eight Enhanced Bus Comparator units (which increases the number of Hardware breakpoints from two to ten) and four Benchmark System Event Counter units.

## 6.8 Background CRC-32 (BGCRC)

The Background CRC (BGCRC) module computes a CRC-32 on a configurable block of memory. It accomplishes this by fetching the specified block of memory during idle cycles (when the CPU, HIC, or DMA is not accessing the memory block). The calculated CRC-32 value is compared against a golden CRC-32 value to indicate a pass or fail. In essence, the BGCRC helps identify memory faults and corruption.

The BGCRC module has the following features:

- One cycle CRC-32 computation on 32 bits of data
- No CPU bandwidth impact for zero wait state memory
- Minimal CPU bandwidth impact for non-zero wait state memory
- Dual operation modes (CRC-32 mode and scrub mode)
- Watchdog timer to time CRC-32 completion
- Ability to pause and resume CRC-32 computation

## 6.9 Direct Memory Access (DMA)

The DMA module provides a hardware method of transferring data between peripherals and/or memory without intervention from the CPU, thereby freeing up bandwidth for other system functions. Additionally, the DMA has the capability to orthogonally rearrange the data as it is transferred as well as “ping-pong” data between buffers. These features are useful for structuring data into blocks for optimal CPU processing. [Figure 6-2](#) shows a device-level block diagram of the DMA.

DMA features include:

- Six channels with independent PIE interrupts
- Peripheral interrupt trigger sources
  - ADC interrupts and EVT signals
  - External Interrupts
  - ePWM SOC signals
  - CPU timers
  - eCAP
  - SPI transmit and receive
  - CAN transmit and receive
  - LIN transmit and receive
- Data sources and destinations:
  - GSx RAM
  - ADC result registers
  - Control peripheral registers (ePWM, eQEP, eCAP)
  - SPI, LIN, CAN, and PMBus registers
- Word Size: 16-bit or 32-bit (SPI limited to 16-bit)
- Throughput: Four cycles per word without arbitration

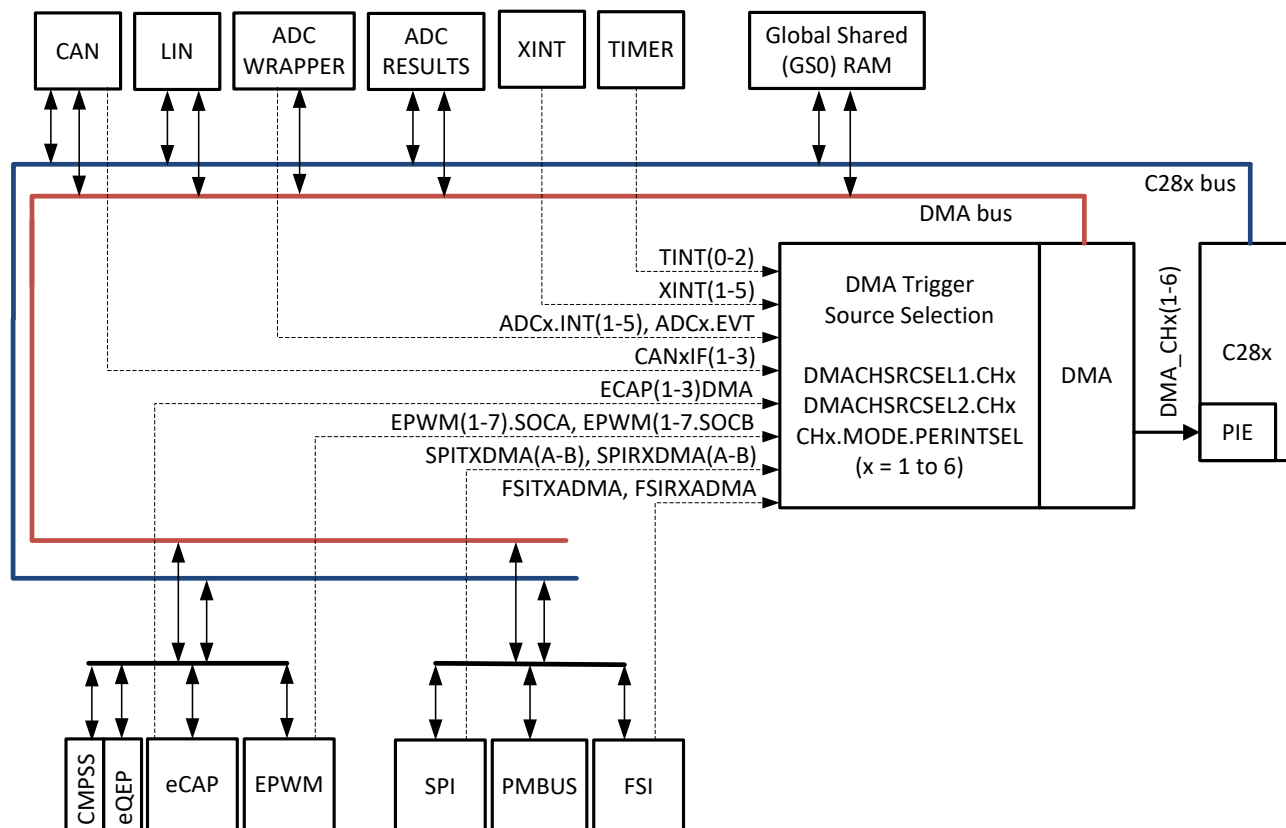


Figure 6-2. DMA Block Diagram

## 6.10 Device Boot Modes

This section explains the default boot modes, as well as all the available boot modes supported on this device. The boot ROM uses the boot mode select, general purpose input/output (GPIO) pins to determine the boot mode configuration.

Table 6-7 shows the boot mode options available for selection by the default boot mode select pins. Users have the option to program the device to customize the boot modes selectable in the boot-up table as well as the boot mode select pin GPIOs used.

All the peripheral boot modes that are supported use the first instance of the peripheral module (SCIA, SPIA, I2CA, CANA, and so forth). Whenever these boot modes are referred to in this chapter, such as SCI boot, it is actually referring to the first module instance, which means the SCI boot on the SCIA port. The same applies to the other peripheral boots.

**Table 6-7. Device Default Boot Modes**

| BOOT MODE                      | GPIO24<br>(DEFAULT BOOT MODE SELECT PIN 1) | GPIO32<br>(DEFAULT BOOT MODE SELECT PIN 0) |
|--------------------------------|--------------------------------------------|--------------------------------------------|
| Parallel IO                    | 0                                          | 0                                          |
| SCI / Wait Boot <sup>(1)</sup> | 0                                          | 1                                          |
| CAN                            | 1                                          | 0                                          |
| Flash                          | 1                                          | 1                                          |

(1) SCI boot mode can be used as a wait boot mode as long as SCI continues to wait for an 'A' or 'a' during the SCI autobaud lock process.

### 6.10.1 Device Boot Configurations

This section details what boot configurations are available and how to configure them. This device supports from 0 boot mode select pins up to 3 boot mode select pins as well as from 1 configured boot mode up to 8 configured boot modes.

To change and configure the device from the default settings to custom settings for your application, use the following process:

1. Determine all the various ways you want application to be able to boot. (For example: Primary boot option of Flash boot for your main application, secondary boot option of CAN boot for firmware updates, tertiary boot option of SCI boot for debugging, etc)
2. Based on the number of boot modes needed, determine how many boot mode select pins (BMSPs) are required to select between your selected boot modes. (For example: 2 BMSPs are required to select between 3 boot mode options)
3. Assign the required BMSPs to a physical GPIO pin. (For example, BMSP0 to GPIO10, BMSP1 to GPIO51, and BMSP2 left as default which is disabled). Refer to [Section 6.10.1.1](#) for all the details on performing these configurations.
4. Assign the determined boot mode definitions to indexes in your custom boot table that correlate to the decoded value of the BMSPs. For example, BOOTDEF0=Boot to Flash, BOOTDEF1=CAN Boot, BOOTDEF2=SCI Boot; all other BOOTDEFx are left as default/nothing). Refer to [Section 6.10.1.2](#) for all the details on setting up and configuring the custom boot mode table.

Additionally, provides some example use cases on how to configure the BMSPs and custom boot tables.

### 6.10.1.1 Configuring Boot Mode Pins

This section explains how the boot mode select pins can be customized by the user, by programming the BOOTPIN-CONFIG location (refer to [Table 6-8](#)) in the user-configurable dual-zone security module (DCSM) OTP. The location in the DCSM OTP is Z1-OTP-BOOTPIN-CONFIG or Z2-OTP-BOOTPIN-CONFIG. When debugging, EMU-BOOTPIN-CONFIG is the emulation equivalent of Z1-OTP-BOOTPIN-CONFIG/Z2-OTP-BOOTPIN-CONFIG, and can be programmed to experiment with different boot modes without writing to OTP. The device can be programmed to use 0, 1, 2, or 3 boot mode select pins as needed.

#### NOTE

When using Z2-OTP-BOOTPIN-CONFIG, the configurations programmed in this location will take priority over the configurations in Z1-OTP-BOOTPIN-CONFIG. It is recommended to use Z1-OTP-BOOTPIN-CONFIG first and then if OTP configurations need to be altered, switch to using Z2-OTP-BOOTPIN-CONFIG.

**Table 6-8. BOOTPIN-CONFIG Bit Fields**

| BITS  | NAME                           | DESCRIPTION                                                                                                                                                                                          |
|-------|--------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31:24 | Key                            | Write 0x5A to these 8-bits to indicate the bits in this register are valid                                                                                                                           |
| 23:16 | Boot Mode Select Pin 2 (BMSP2) | Refer to BMSP0 description except for BMSP2                                                                                                                                                          |
| 15:8  | Boot Mode Select Pin 1 (BMSP1) | Refer to BMSP0 description except for BMSP1                                                                                                                                                          |
| 7:0   | Boot Mode Select Pin 0 (BMSP0) | Set to the GPIO pin to be used during boot (up to 255):<br>- 0x0 = GPIO0<br>- 0x01 = GPIO1<br>- and so on<br><br>Writing 0xFF disables BMSP0 and this pin is no longer used to select the boot mode. |

The following GPIOs cannot be used as a BMSP. If selected for a particular BMSP, the boot ROM automatically selects the factory default GPIO (the factory default for BMSP2 is 0xFF, which disables the BMSP).

- GPIO 20 and GPIO 21
- GPIO 36 and GPIO 38
- GPIO 47 to GPIO 60
- GPIO 63 to GPIO 223

**Table 6-9. Standalone Boot Mode Select Pin Decoding**

| BOOTPIN_CONFIG KEY | BMSP0        | BMSP1        | BMSP2        | REALIZED BOOT MODE                                                                                                 |
|--------------------|--------------|--------------|--------------|--------------------------------------------------------------------------------------------------------------------|
| != 0x5A            | Don't Care   | Don't Care   | Don't Care   | Boot as defined by the factory default BMSPs                                                                       |
| = 0x5A             | 0xFF         | 0xFF         | 0xFF         | Boot as defined in the boot table for boot mode 0 (All BMSPs disabled)                                             |
|                    | Valid GPIO   | 0xFF         | 0xFF         | Boot as defined by the value of BMSP0 (BMSP1 and BMSP2 disabled)                                                   |
|                    | 0xFF         | Valid GPIO   | 0xFF         | Boot as defined by the value of BMSP1 (BMSP0 and BMSP2 disabled)                                                   |
|                    | 0xFF         | 0xFF         | Valid GPIO   | Boot as defined by the value of BMSP2 (BMSP0 and BMSP1 disabled)                                                   |
|                    | Valid GPIO   | Valid GPIO   | 0xFF         | Boot as defined by the values of BMSP0 and BMSP1 (BMSP2 disabled)                                                  |
|                    | Valid GPIO   | 0xFF         | Valid GPIO   | Boot as defined by the values of BMSP0 and BMSP2 (BMSP1 disabled)                                                  |
|                    | 0xFF         | Valid GPIO   | Valid GPIO   | Boot as defined by the values of BMSP1 and BMSP2 (BMSP0 disabled)                                                  |
|                    | Valid GPIO   | Valid GPIO   | Valid GPIO   | Boot as defined by the values of BMSP0, BMSP1, and BMSP2                                                           |
|                    | Invalid GPIO | Valid GPIO   | Valid GPIO   | BMSP0 is reset to the factory default BMSP0 GPIO<br>Boot as defined by the values of BMSP0, BMSP1, and BMSP2       |
|                    | Valid GPIO   | Invalid GPIO | Valid GPIO   | BMSP1 is reset to the factory default BMSP1 GPIO<br>Boot as defined by the values of BMSP0, BMSP1, and BMSP2       |
|                    | Valid GPIO   | Valid GPIO   | Invalid GPIO | BMSP2 is reset to the factory default state, which is disabled<br>Boot as defined by the values of BMSP0 and BMSP1 |

### NOTE

When decoding the boot mode, BMSP0 is the least-significant-bit and BMSP2 is the most-significant-bit of the boot table index value. It is recommended when disabling BMSPs to start with disabling BMSP2. For example, in an instance when only using BMSP2 (BMSP1 and BMSP0 are disabled), then only the boot table indexes of 0 and 4 will be selectable. In the instance when using only BMSP0, then the selectable boot table indexes are 0 and 1.

### 6.10.1.2 Configuring Boot Mode Table Options

This section explains how to configure the boot definition table, BOOTDEF, for the device and the associated boot options. The 64-bit location is located in user-configurable DCSM OTP in the Z1-OTP-BOOTDEF-LOW and Z1-OTP-BOOTDEF-HIGH locations. When debugging, EMU-BOOTDEF-LOW and EMU-BOOTDEF-HIGH are the emulation equivalents of Z1-OTP-BOOTDEF-LOW and Z1-OTP-BOOTDEF-HIGH, and can be programmed to experiment with different boot mode options without writing to OTP. The range of customization to the boot definition table depends on how many boot mode select pins (BMSP) are being used. For example, 0 BMSPs equals to 1 table entry, 1 BMSP equals to 2 table entries, 2 BMSPs equals to 4 table entries, and 3 BMSPs equals to 8 table entries. Refer to the [TMS320F28002x Microcontrollers Technical Reference Manual](#) for examples on how to set up the BOOTPIN\_CONFIG and BOOTDEF values.

#### NOTE

The locations Z2-OTP-BOOTDEF-LOW and Z2-OTP-BOOTDEF-HIGH will be used instead of Z1-OTP-BOOTDEF-LOW and Z1-OTP-BOOTDEF-HIGH locations when Z2-OTP-BOOTPIN-CONFIG is configured. Refer to [Configuring Boot Mode Pins](#) for more details on BOOTPIN\_CONFIG usage.

Table 6-10. BOOTDEF Bit Fields

| BOOTDEF NAME | BYTE POSITION | NAME                   | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                   |
|--------------|---------------|------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| BOOT_DEF0    | 7:0           | BOOT_DEF0 Mode/Options | Set the boot mode for index 0 of the boot table.<br><br>Different boot modes and their options can include, for example, a boot mode that uses different GPIOs for a specific bootloader or a different flash entry point address. Any unsupported boot mode will cause the device to either go to wait boot or boot to flash.<br><br>Refer to <a href="#">GPIO Assignments</a> for valid BOOTDEF values to set in the table. |
| BOOT_DEF1    | 15:8          | BOOT_DEF1 Mode/Options | Refer to BOOT_DEF0 description                                                                                                                                                                                                                                                                                                                                                                                                |
| BOOT_DEF2    | 23:16         | BOOT_DEF2 Mode/Options |                                                                                                                                                                                                                                                                                                                                                                                                                               |
| BOOT_DEF3    | 31:24         | BOOT_DEF3 Mode/Options |                                                                                                                                                                                                                                                                                                                                                                                                                               |
| BOOT_DEF4    | 39:32         | BOOT_DEF4 Mode/Options |                                                                                                                                                                                                                                                                                                                                                                                                                               |
| BOOT_DEF5    | 47:40         | BOOT_DEF5 Mode/Options |                                                                                                                                                                                                                                                                                                                                                                                                                               |
| BOOT_DEF6    | 55:48         | BOOT_DEF6 Mode/Options |                                                                                                                                                                                                                                                                                                                                                                                                                               |
| BOOT_DEF7    | 63:56         | BOOT_DEF7 Mode/Options |                                                                                                                                                                                                                                                                                                                                                                                                                               |

## 6.10.2 GPIO Assignments

This section details the GPIOs and boot option values used for boot mode set in the BOOT\_DEF memory location located at Z1-OTP-BOOTDEF-LOW/ Z2-OTP-BOOTDEF-LOW and Z1-OTP-BOOTDEF-HIGH/ Z2-OTP-BOOTDEF-HIGH. Refer to [Configuring Boot Mode Table Options](#) on how to configure BOOT\_DEF. When selecting a boot mode option, make sure to verify that the necessary pins are available in the pin mux options for the specific device package being used.

**Table 6-11. SCI Boot Options**

| OPTION      | BOOTDEF VALUE | SCITXDA GPIO | SCIRXDA GPIO |
|-------------|---------------|--------------|--------------|
| 0 (default) | 0x01          | GPIO29       | GPIO28       |
| 1           | 0x21          | GPIO16       | GPIO17       |
| 2           | 0x41          | GPIO8        | GPIO9        |
| 3           | 0x61          | GPIO2        | GPIO3        |
| 4           | 0x81          | GPIO16       | GPIO3        |

**Table 6-12. CAN Boot Options**

| OPTION      | BOOTDEF VALUE | CANTXA GPIO | CANRXA GPIO |
|-------------|---------------|-------------|-------------|
| 0 (default) | 0x02          | GPIO4       | GPIO5       |
| 1           | 0x22          | GPIO32      | GPIO33      |
| 2           | 0x42          | GPIO2       | GPIO3       |

**Table 6-13. I2C Boot Options**

| OPTION | BOOTDEF VALUE | SDAA GPIO | SCLA GPIO |
|--------|---------------|-----------|-----------|
| 0      | 0x07          | GPIO32    | GPIO33    |
| 1      | 0x27          | GPIO0     | GPIO1     |
| 2      | 0x47          | GPIO10    | GPIO8     |

**Table 6-14. RAM Boot Options**

| OPTION | BOOTDEF VALUE | RAM ENTRY POINT (ADDRESS) |
|--------|---------------|---------------------------|
| 0      | 0x05          | 0x0000 0000               |

**Table 6-15. Flash Boot Options**

| OPTION      | BOOTDEF VALUE | FLASH ENTRY POINT (ADDRESS) | FLASH SECTOR             |
|-------------|---------------|-----------------------------|--------------------------|
| 0 (default) | 0x03          | 0x0008 0000                 | Bank0 Sector 0           |
| 1           | 0x23          | 0x0008 4000                 | Bank 0 Sector 4          |
| 2           | 0x43          | 0x0008 8000                 | Bank 0 Sector 8          |
| 3           | 0x63          | 0x0008 EFF0                 | Bank 0, End of Sector 14 |

**Table 6-16. Wait Boot Options**

| OPTION | BOOTDEF VALUE | WATCHDOG |
|--------|---------------|----------|
| 0      | 0x04          | Enabled  |
| 1      | 0x24          | Disabled |

**Table 6-17. SPI Boot Options**

| OPTION | BOOTDEF VALUE | SPISIMOA | SPISOMIA | SPICLKA | SPISTEA |
|--------|---------------|----------|----------|---------|---------|
| 0      | 0x06          | GPIO2    | GPIO1    | GPIO3   | GPIO5   |
| 1      | 0x26          | GPIO16   | GPIO1    | GPIO3   | GPIO0   |
| 2      | 0x46          | GPIO8    | GPIO10   | GPIO9   | GPIO11  |
| 3      | 0x66          | GPIO8    | GPIO17   | GPIO9   | GPIO11  |

**Table 6-18. Parallel Boot Options**

| OPTION      | BOOTDEF VALUE | D0-D7 GPIO  | 28x(DSP) CONTROL GPIO | HOST CONTROL GPIO |
|-------------|---------------|-------------|-----------------------|-------------------|
| 0 (default) | 0x00          | D0 - GPIO28 | GPIO16                | GPIO29            |
|             |               | D1 - GPIO1  |                       |                   |
|             |               | D2 - GPIO2  |                       |                   |
|             |               | D3 - GPIO3  |                       |                   |
|             |               | D4 - GPIO4  |                       |                   |
|             |               | D5 - GPIO5  |                       |                   |
|             |               | D6 - GPIO6  |                       |                   |
|             |               | D7 - GPIO7  |                       |                   |
| 1           | 0x20          | D0 - GPIO0  | GPIO16                | GPIO11            |
|             |               | D1 - GPIO1  |                       |                   |
|             |               | D2 - GPIO2  |                       |                   |
|             |               | D3 - GPIO3  |                       |                   |
|             |               | D4 - GPIO4  |                       |                   |
|             |               | D5 - GPIO5  |                       |                   |
|             |               | D6 - GPIO6  |                       |                   |
|             |               | D7 - GPIO7  |                       |                   |

## 6.11 Dual Code Security Module

The dual code security module (DCSM) prevents access to on-chip secure memories. The term “secure” means access to secure memories and resources is blocked. The term “unsecure” means access is allowed; for example, through a debugging tool such as Code Composer Studio™ (CCS).

The code security mechanism offers protection for two zones, Zone 1 (Z1) and Zone 2 (Z2). The security implementation for both the zones is identical. Each zone has its own dedicated secure resource (OTP memory and secure ROM) and allocated secure resource (LSx RAM and flash sectors).

The security of each zone is ensured by its own 128-bit password (CSM password). The password for each zone is stored in an OTP memory location based on a zone-specific link pointer. The link pointer value can be changed to program a different set of security settings (including passwords) in OTP.

### Code Security Module Disclaimer

THE CODE SECURITY MODULE (CSM) INCLUDED ON THIS DEVICE WAS DESIGNED TO PASSWORD PROTECT THE DATA STORED IN THE ASSOCIATED MEMORY AND IS WARRANTED BY TEXAS INSTRUMENTS (TI), IN ACCORDANCE WITH ITS STANDARD TERMS AND CONDITIONS, TO CONFORM TO TI'S PUBLISHED SPECIFICATIONS FOR THE WARRANTY PERIOD APPLICABLE FOR THIS DEVICE.

TI DOES NOT, HOWEVER, WARRANT OR REPRESENT THAT THE CSM CANNOT BE COMPROMISED OR BREACHED OR THAT THE DATA STORED IN THE ASSOCIATED MEMORY CANNOT BE ACCESSED THROUGH OTHER MEANS. MOREOVER, EXCEPT AS SET FORTH ABOVE, TI MAKES NO WARRANTIES OR REPRESENTATIONS CONCERNING THE CSM OR OPERATION OF THIS DEVICE, INCLUDING ANY IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE.

IN NO EVENT SHALL TI BE LIABLE FOR ANY CONSEQUENTIAL, SPECIAL, INDIRECT, INCIDENTAL, OR PUNITIVE DAMAGES, HOWEVER CAUSED, ARISING IN ANY WAY OUT OF YOUR USE OF THE CSM OR THIS DEVICE, WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. EXCLUDED DAMAGES INCLUDE, BUT ARE NOT LIMITED TO LOSS OF DATA, LOSS OF GOODWILL, LOSS OF USE OR INTERRUPTION OF BUSINESS OR OTHER ECONOMIC LOSS.

## 6.12 Watchdog

The watchdog module is the same as the one on previous TMS320C2000 devices, but with an optional lower limit on the time between software resets of the counter. This windowed countdown is disabled by default, so the watchdog is fully backward-compatible.

The watchdog generates either a reset or an interrupt. It is clocked from the internal oscillator with a selectable frequency divider.

Figure 6-3 shows the various functional blocks within the watchdog module.

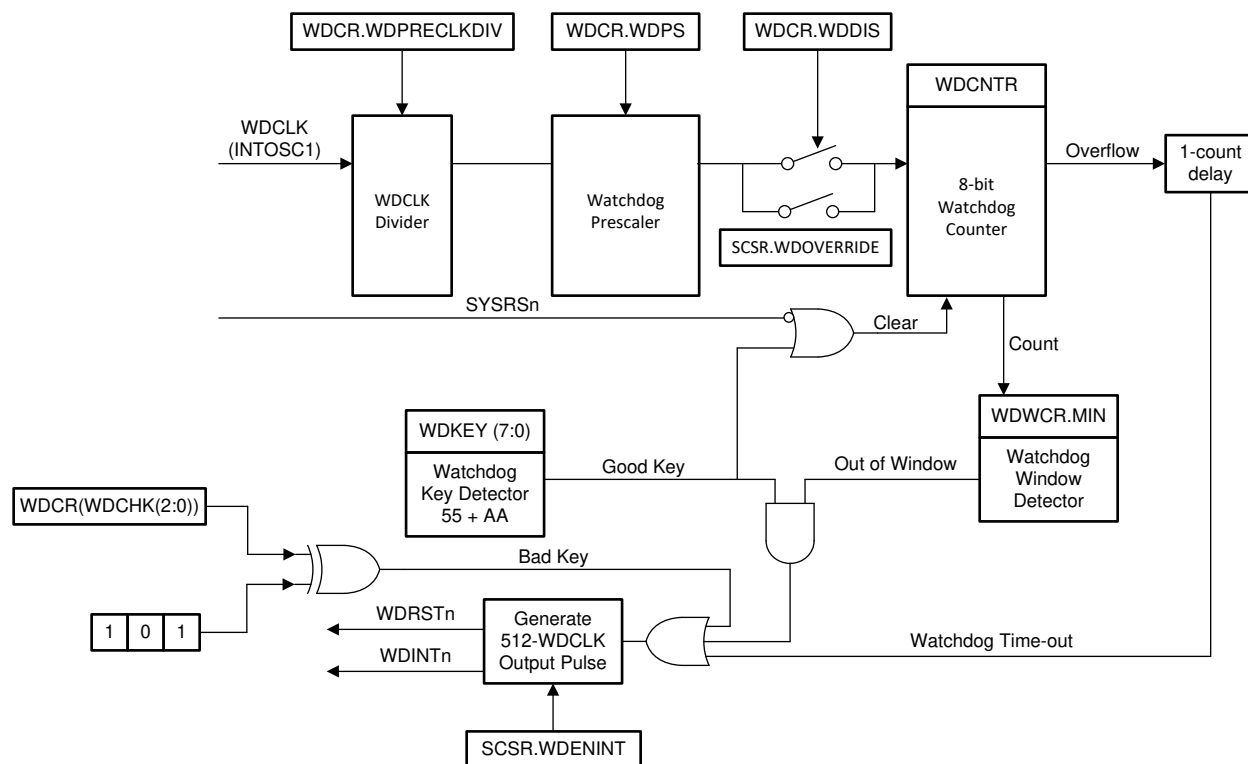


Figure 6-3. Windowed Watchdog

## 6.13 C28x Timers

CPU-Timers 0, 1, and 2 are identical 32-bit timers with presetable periods and with 16-bit clock prescaling. The timers have a 32-bit count-down register that generates an interrupt when the counter reaches zero. The counter is decremented at the CPU clock speed divided by the prescale value setting. When the counter reaches zero, it is automatically reloaded with a 32-bit period value.

CPU-Timer 0 is for general use and is connected to the PIE block. CPU-Timer 1 is also for general use and is connected to INT13 of the CPU. CPU-Timer 2 is reserved for TI-RTOS. It is connected to INT14 of the CPU. If TI-RTOS is not being used, CPU-Timer 2 is available for general use.

CPU-Timer 2 can be clocked by any one of the following:

- SYSCLK (default)
- Internal zero-pin oscillator 1 (INTOSC1)
- Internal zero-pin oscillator 2 (INTOSC2)
- X1 (XTAL)

## 6.14 Dual-Clock Comparator (DCC)

There are three Dual-Clock Comparators (DCC0 and DCC1) on the device. All three DCCs are only accessible through CPU1. The DCC module is used for evaluating and monitoring the clock input based on a second clock, which can be a more accurate and reliable version. This instrumentation is used to detect faults in clock source or clock structures, thereby enhancing the system's safety metrics.

### 6.14.1 Features

The DCC has the following features:

- Allows the application to ensure that a fixed ratio is maintained between frequencies of two clock signals.
- Supports the definition of a programmable tolerance window in terms of the number of reference clock cycles.
- Supports continuous monitoring without requiring application intervention.
- Supports a single-sequence mode for spot measurements.
- Allows the selection of a clock source for each of the counters, resulting in several specific use cases.

### 6.14.2 Mapping of DCCx (DCC0 and DCC1) Clock Source Inputs

Table 6-19 is the DCCx Clock Source0 table. Table 6-20 is the DCCx Clock Source1 table.

**Table 6-19. DCCx Clock Source0 Table**

| DCCxCLKSRC0[3:0] | CLOCK NAME                          |
|------------------|-------------------------------------|
| 0x0              | XTAL/X1                             |
| 0x1              | INTOSC1                             |
| 0x2              | INTOSC2                             |
| 0x5              | CPU1.SYSCLK                         |
| 0xC              | INPUT XBAR (Output16 of input-xbar) |
| others           | Reserved                            |

**Table 6-20. DCCx Clock Source1 Table**

| DCCxCLKSRC1[4:0] | CLOCK NAME                              |
|------------------|-----------------------------------------|
| 0x0              | PLLRAWCLK                               |
| 0x2              | INTOSC1                                 |
| 0x3              | INTOSC2                                 |
| 0x6              | CPU1.SYSCLK                             |
| 0x9              | Input XBAR (Output15 of the input-xbar) |
| 0xB              | EPWMCLK                                 |
| 0xC              | LSPCLK                                  |
| 0xD              | ADCCLK                                  |
| 0xE              | WDCLK                                   |
| 0xF              | CAN0BITCLK                              |
| others           | Reserved                                |

## 6.15 Configurable Logic Block (CLB)

The C2000 configurable logic block (CLB) is a collection of blocks that can be interconnected using software to implement custom digital logic functions or enhance existing on-chip peripherals. The CLB is able to enhance existing peripherals through a set of crossbar interconnections, which provide a high level of connectivity to existing control peripherals such as enhanced pulse width modulators (ePWM), enhanced capture modules (eCAP), and enhanced quadrature encoder pulse modules (eQEP). The crossbars also allow the CLB to be connected to external GPIO pins. In this way, the CLB can be configured to interact with device peripherals to perform small logical functions such as comparators, or to implement custom serial data exchange protocols. Through the CLB, functions that would otherwise be accomplished using external logic devices can now be implemented inside the MCU.

The CLB peripheral is configured through the CLB tool. For more information on the CLB tool, available examples, application reports and users guide, please refer to the following location in your [C2000Ware](#) package (C2000Ware\_2\_00\_00\_03 and higher):

**C2000WARE\_INSTALL\_LOCATION\utilities\clb\_tool\clb\_syscfg\doc**

[CLB Tool User Guide](#)

[How to Design with the C2000™ CLB Application Report](#)

[How to Migrate Custom Logic From an FPGA/CPLD to C2000™ CLB Application Report](#)

The CLB module and its interconnections are shown in [Figure 6-4](#).

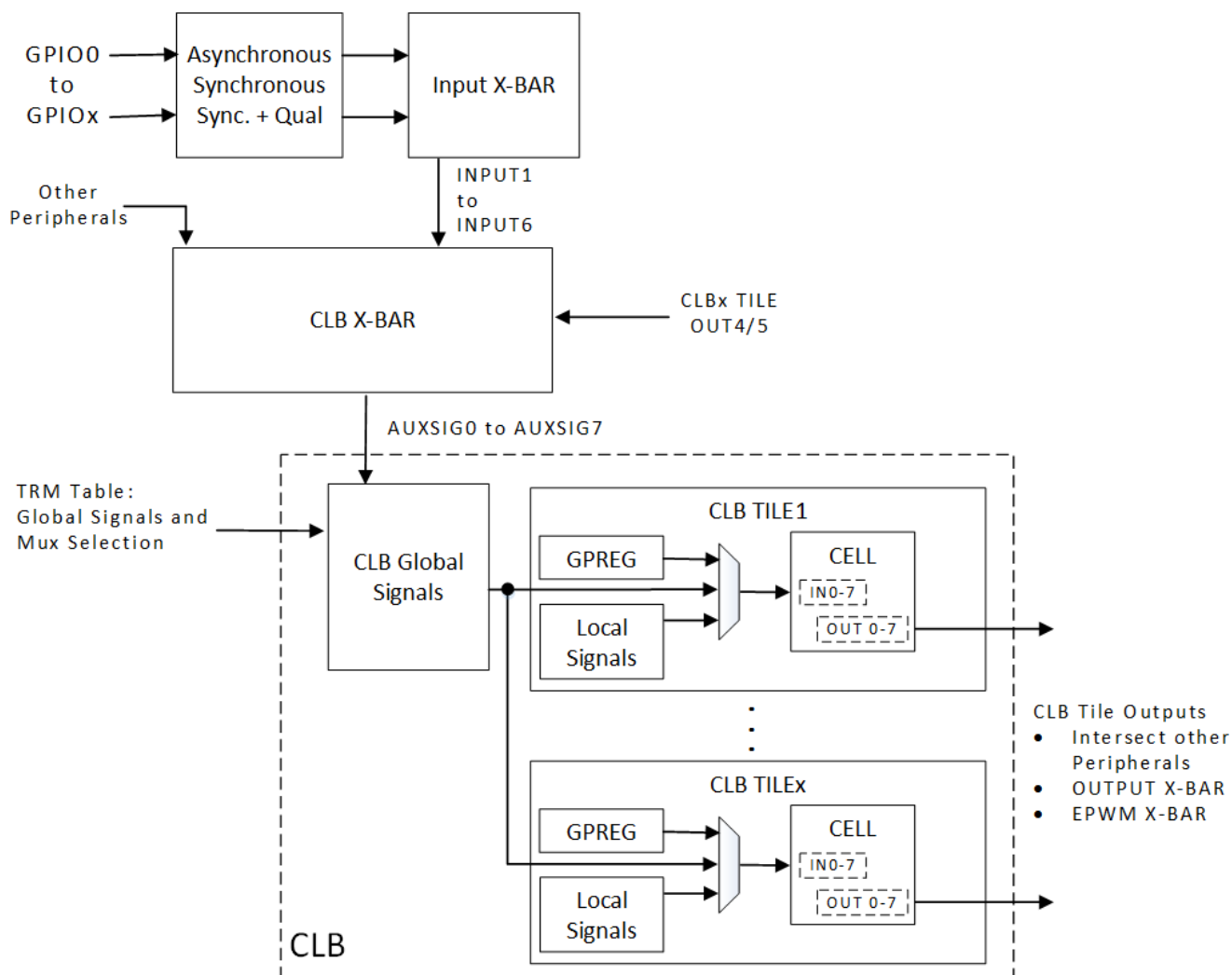


Figure 6-4. CLB Overview

Absolute encoder protocol interfaces are now provided as [Position Manager](#) solutions in the C2000Ware MotorControl SDK. Configuration files, application programmer interface (API), and use examples for such solutions are provided with [C2000Ware MotorControl SDK](#). In some solutions, the TI-configured CLB is used with other on-chip resources, such as the SPI port or the C28x CPU, to perform more complex functionality.

## 7 Applications, Implementation, and Layout

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### NOTE

Information in the following Applications section is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

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### 7.1 TI Reference Design

The TI Reference Design Library is a robust reference design library spanning analog, embedded processor, and connectivity. Created by TI experts to help you jump start your system design, all reference designs include schematic or block diagrams, BOMs, and design files to speed your time to market. Search and download designs at [Select TI reference designs](#).

## 8 Device and Documentation Support

### 8.1 Device and Development Support Tool Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all TMS320 MCU devices and support tools. Each TMS320™ MCU commercial family member has one of two prefixes: TMX or TMS (for example, **TMS**320F280025C). Texas Instruments recommends two of three possible prefix designators for its support tools: TMDX and TMDS. These prefixes represent evolutionary stages of product development from engineering prototypes (with TMX for devices and TMDX for tools) through fully qualified production devices and tools (with TMS for devices and TMDS for tools).

- TMX** Experimental device that is not necessarily representative of the final device's electrical specifications
- TMS** Fully qualified production device

Support tool development evolutionary flow:

- TMDX** Development-support product that has not yet completed Texas Instruments internal qualification testing
- TMDS** Fully qualified development-support product

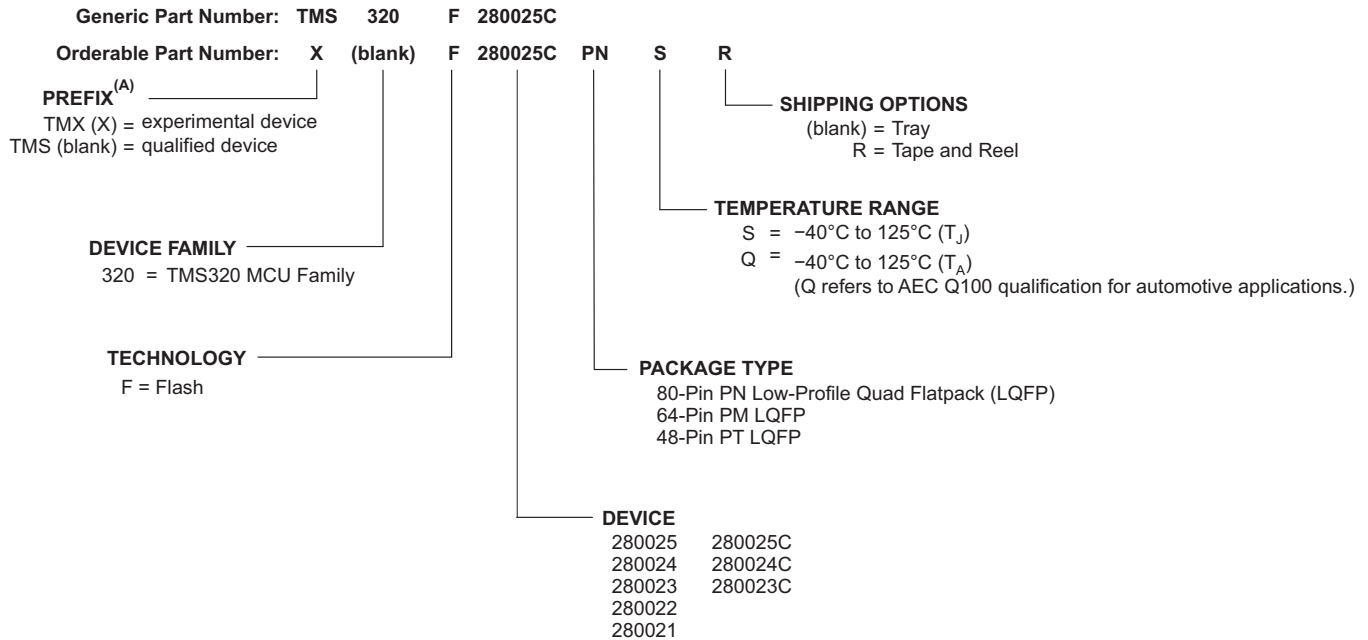
TMX devices and TMDX development-support tools are shipped against the following disclaimer:  
"Developmental product is intended for internal evaluation purposes."

TMS devices and TMDS development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (TMX) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the package type (for example, PN) and temperature range (for example, S).

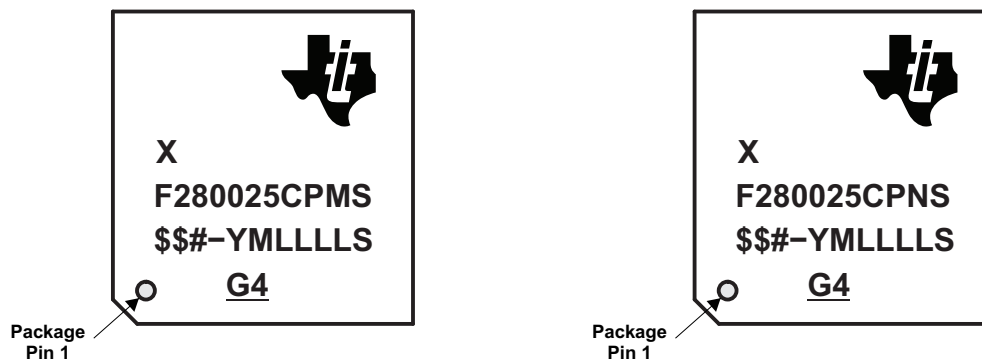
For device part numbers and further ordering information, see the TI website ([www.ti.com](http://www.ti.com)) or contact your TI sales representative.



**Figure 8-1. Device Nomenclature**

## 8.2 Markings

Figure 8-2 and Figure 8-3 show the package symbolization. Table 8-1 lists the silicon revision codes.



**YMLLLLS = Lot Trace Code**

**YM = 2-Digit Year/Month Code**  
**LLLL = Assembly Lot**  
**S = Assembly Site Code**  
**\$\$ = Wafer Fab Code (one or two characters) as applicable**  
**# = Silicon Revision Code**

**G4 = Green (Low Halogen and RoHS-compliant)**

**Figure 8-2. Package Symbolization for PM and PN Packages**

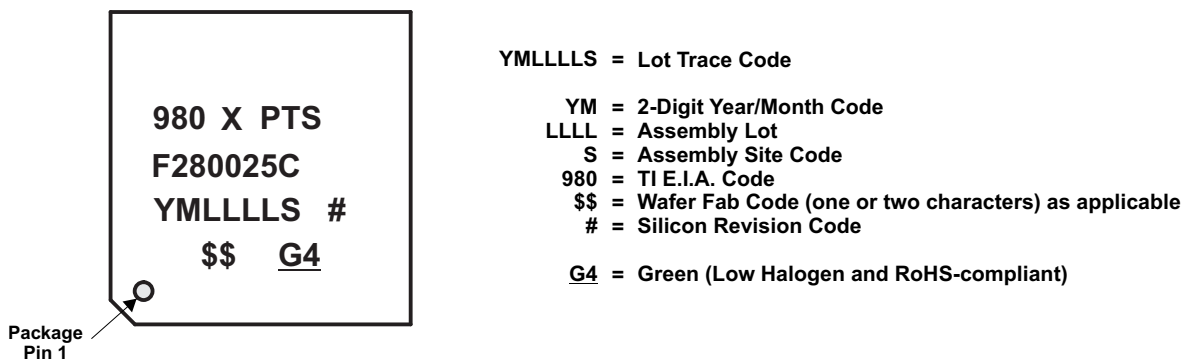


Figure 8-3. Package Symbolization for PT Package

Table 8-1. Revision Identification

| SILICON REVISION CODE | SILICON REVISION | REVID <sup>(1)</sup><br>ADDRESS: 0x5D00C | COMMENTS                                   |
|-----------------------|------------------|------------------------------------------|--------------------------------------------|
| Blank                 | 0                | 0x0000 0000                              | This silicon revision is available as TMX. |

(1) Silicon Revision ID

## 8.3 Tools and Software

TI offers an extensive line of development tools. Some of the tools and software to evaluate the performance of the device, generate code, and develop solutions follow. To view all available tools and software for C2000™ real-time control MCUs, visit the [C2000 real-time control MCUs – Design & development](#) page.

### Development Tools

#### F280025 controlCARD

The F280025 controlCARD is an HSEC180 controlCARD based evaluation and development tool for the C2000™ F28002x series of microcontroller products. controlCARDS are ideal to use for initial evaluation and system prototyping. controlCARDS are complete board-level modules that utilize one of two standard form factors (100-pin DIMM or 180-pin HSEC ) to provide a low-profile single-board controller solution. For first evaluation controlCARDS are typically purchased bundled with a baseboard or bundled in an application kit.

### Software Tools

#### C2000Ware for C2000 MCUs

C2000Ware for C2000™ microcontrollers is a cohesive set of development software and documentation designed to minimize software development time. From device-specific drivers and libraries to device peripheral examples, C2000Ware provides a solid foundation to begin development and evaluation of your product.

#### Code Composer Studio™ (CCS) Integrated Development Environment (IDE) for C2000 microcontrollers

Code Composer Studio is an integrated development environment (IDE) that supports TI's Microcontroller and Embedded Processors portfolio. Code Composer Studio comprises a suite of tools used to develop and debug embedded applications. It includes an optimizing C/C++ compiler, source code editor, project build environment, debugger, profiler, and many other features. The intuitive IDE provides a single user interface taking the user through each step of the application development flow. Familiar tools and interfaces allow users to get started faster than ever before. Code Composer Studio combines the advantages of the Eclipse software framework with advanced embedded debug capabilities from TI resulting in a compelling feature-rich development environment for embedded developers.

### SysConfig Pin Mux Tool

The SysConfig Pin Mux Utility is a software tool which provides a Graphical User Interface for configuring pin multiplexing settings, resolving conflicts and specifying I/O cell characteristics for TI MPUs. The SysConfig Pin Mux tool is integrated inside Code Composer Studio (version 9.3 or higher) and C2000Ware. Device and package specific examples are available in:

- [C2000Ware 3\_01\_00\_00 or Higher]\driverlib\28002x\examples\pinmux

### Models

Various models are available for download from the product Tools & Software pages. These models include I/O Buffer Information Specification (IBIS) Models and Boundary-Scan Description Language (BSDL) Models. To view all available models, visit the Models section of the Tools & Software page for each device, which can be found in [Table 8-2](#).

### Training

To help assist design engineers in taking full advantage of the C2000 microcontroller features and performance, TI has developed a variety of training resources. Utilizing the online training materials and downloadable hands-on workshops provides an easy means for gaining a complete working knowledge of the C2000 microcontroller family. These training resources have been designed to decrease the learning curve, while reducing development time, and accelerating product time to market. For more information on the various training resources, visit the [C2000™ real-time control MCUs – Support & training](#) site.

Specific TMS320F28004x hands-on training resources can be found at [C2000™ MCU Device Workshops](#).

### Technical Introduction to the New C2000 TMS320F28004x Device Family

Many of the peripherals and architecture of the F28002x are similar to the F28004x. This presentation will cover the technical details of the TMS320F28004x architecture and highlight the new improvements to various key peripherals which will be helpful to users of the F28002x device.

## 8.4 Documentation Support

To receive notification of documentation updates, navigate to the device product folder on [ti.com](#). In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

The current documentation that describes the processor, related peripherals, and other technical collateral follows.

### Errata

[TMS320F28002x MCUs Silicon Errata](#) describes known advisories on silicon and provides workarounds.

### Technical Reference Manual

[TMS320F28002x Microcontrollers Technical Reference Manual](#) details the integration, the environment, the functional description, and the programming models for each peripheral and subsystem in the F28002x microcontrollers.

### CPU User's Guides

[TMS320C28x CPU and Instruction Set Reference Guide](#) describes the central processing unit (CPU) and the assembly language instructions of the TMS320C28x fixed-point digital signal processors (DSPs). This Reference Guide also describes emulation features available on these DSPs.

[TMS320C28x Extended Instruction Sets Technical Reference Manual](#) describes the architecture, pipeline, and instruction set of the TMU, VCU-II, and FPU accelerators.

### Peripheral Guides

[C2000 Real-Time Control Peripherals Reference Guide](#) describes the peripheral reference guides of the 28x DSPs.

## Tools Guides

[TMS320C28x Assembly Language Tools v19.6.0.STS User's Guide](#) describes the assembly language tools (assembler and other tools used to develop assembly language code), assembler directives, macros, common object file format, and symbolic debugging directives for the TMS320C28x device.

[TMS320C28x Optimizing C/C++ Compiler v19.6.0.STS User's Guide](#) describes the TMS320C28x C/C++ compiler. This compiler accepts ANSI standard C/C++ source code and produces TMS320 DSP assembly language source code for the TMS320C28x device.

## Application Reports

The [SMT & packaging application notes](#) website lists documentation on TI's surface mount technology (SMT) and application notes on a variety of packaging-related topics.

[Semiconductor Packing Methodology](#) describes the packing methodologies employed to prepare semiconductor devices for shipment to end users.

[Calculating Useful Lifetimes of Embedded Processors](#) provides a methodology for calculating the useful lifetime of TI embedded processors (EPs) under power when used in electronic systems. It is aimed at general engineers who wish to determine if the reliability of the TI EP meets the end system reliability requirement.

[An Introduction to IBIS \(I/O Buffer Information Specification\) Modeling](#) discusses various aspects of IBIS including its history, advantages, compatibility, model generation flow, data requirements in modeling the input/output structures, and future trends.

[Serial Flash Programming of C2000™ Microcontrollers](#) discusses using a flash kernel and ROM loaders for serial programming a device.

[Fast Integer Division – A Differentiated Offering From C2000™ Product Family](#) provides an overview of the different division and modulo (remainder) functions and its associated properties.

## 8.5 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

**Table 8-2. Related Links**

| PARTS          | PRODUCT FOLDER             | ORDER NOW                  | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|----------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| TMS320F280025  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TMS320F280025C | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TMS320F280024  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TMS320F280024C | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TMS320F280023  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TMS320F280023C | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TMS320F280022  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TMS320F280021  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

## 8.6 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

## 8.7 Trademarks

TMS320C2000, C2000, InstaSPIN-FOC, Code Composer Studio, TMS320, E2E are trademarks of Texas Instruments.

Bosch is a registered trademark of Robert Bosch GmbH Corporation.

## 8.8 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 8.9 Glossary

**TI Glossary** This glossary lists and explains terms, acronyms, and definitions.

## 9 Mechanical, Packaging, and Orderable Information

### 9.1 Packaging Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

To learn more about TI packaging, visit the [Packaging information](#) website.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------|----------------------|--------------|-------------------------|---------|
| F280021PTQR      | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280021PTSR      | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280022PMQR      | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023CPMSR     | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023CPNSR     | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023CPTSR     | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023PMSR      | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023PNQR      | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023PNSR      | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023PTQR      | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280023PTSR      | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280024CPMQR     | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280024PMQR      | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025CPMSR     | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025CPNQR     | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025CPNSR     | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025CPTQR     | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025CPTSR     | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PMS       | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PMSR      | PREVIEW       | LQFP         | PM                 | 64   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PNQR      | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PNS       | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PNSR      | PREVIEW       | LQFP         | PN                 | 80   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PTQR      | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PTS       | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| F280025PTSR      | PREVIEW       | LQFP         | PT                 | 48   | 900            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         |         |
| XF280025CPMS     | ACTIVE        | LQFP         | PM                 | 64   | 160            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         | Samples |
| XF280025CPNS     | ACTIVE        | LQFP         | PN                 | 80   | 119            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         | Samples |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| XF280025CPTS     | ACTIVE        | LQFP         | PT                 | 48   | 250            | TBD             | Call TI                 | Call TI              | -40 to 125   |                         | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

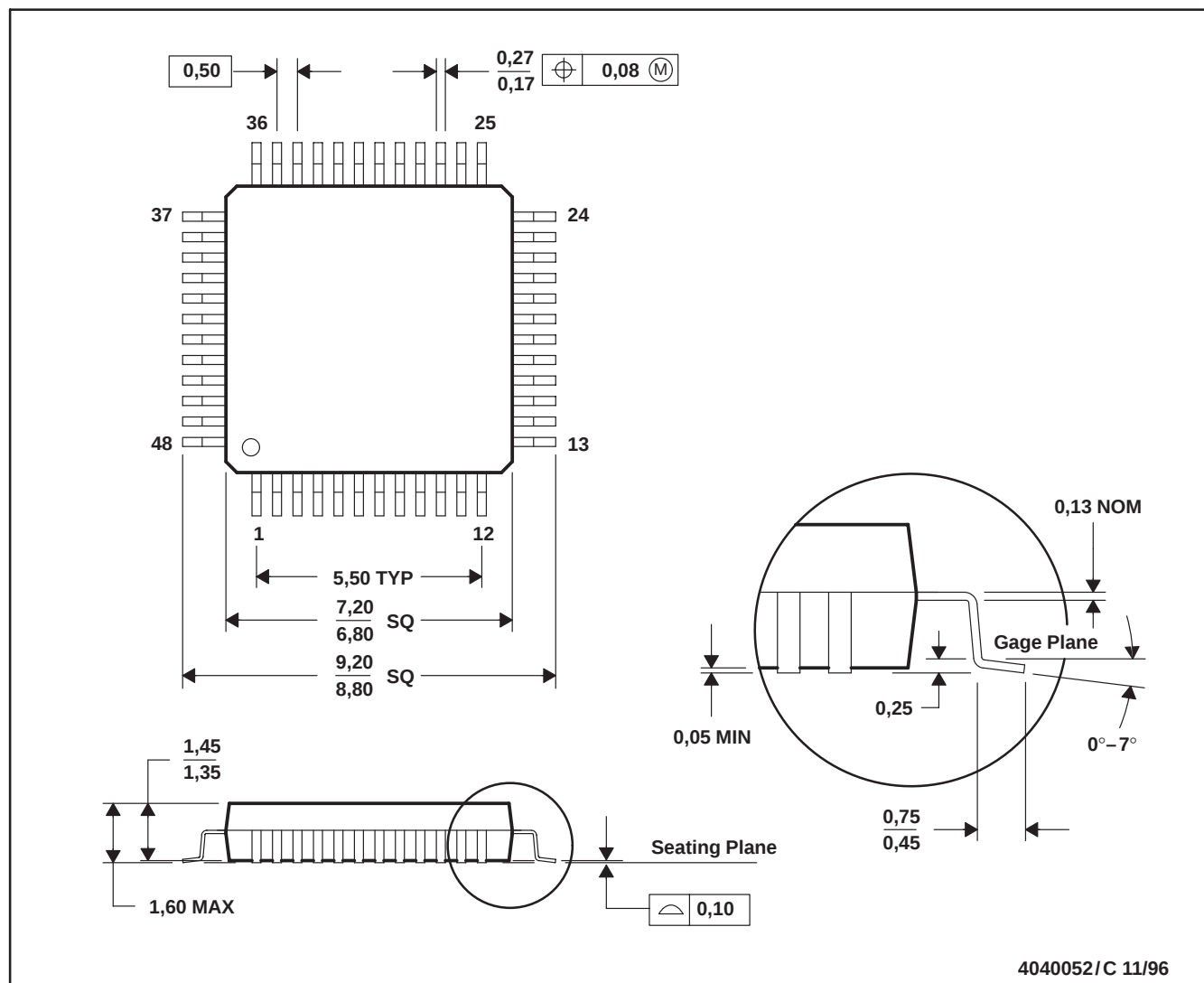
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## PT (S-PQFP-G48)

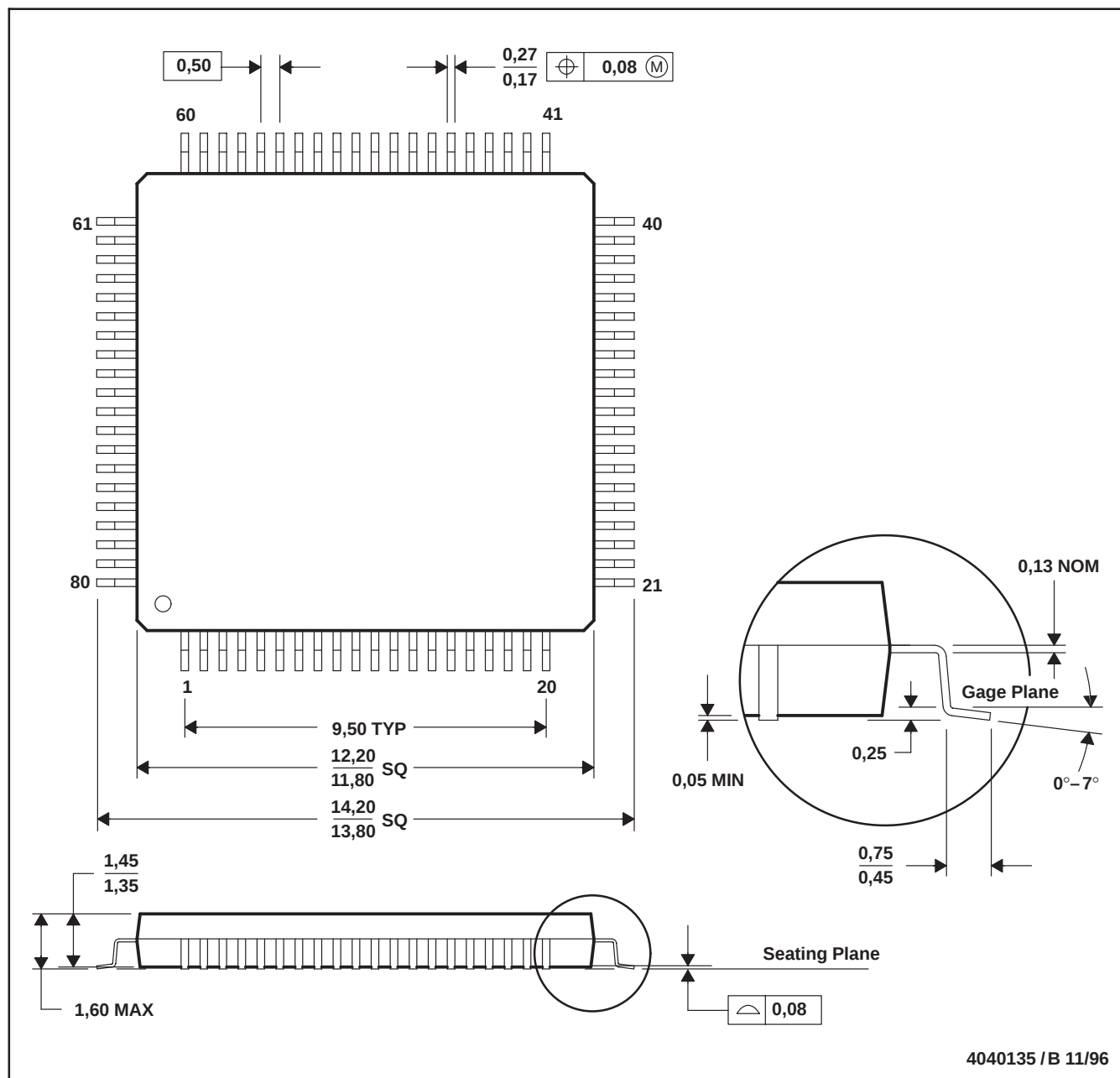
## PLASTIC QUAD FLATPACK



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Falls within JEDEC MS-026
  - This may also be a thermally enhanced plastic package with leads connected to the die pads.

## PN (S-PQFP-G80)

## PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026

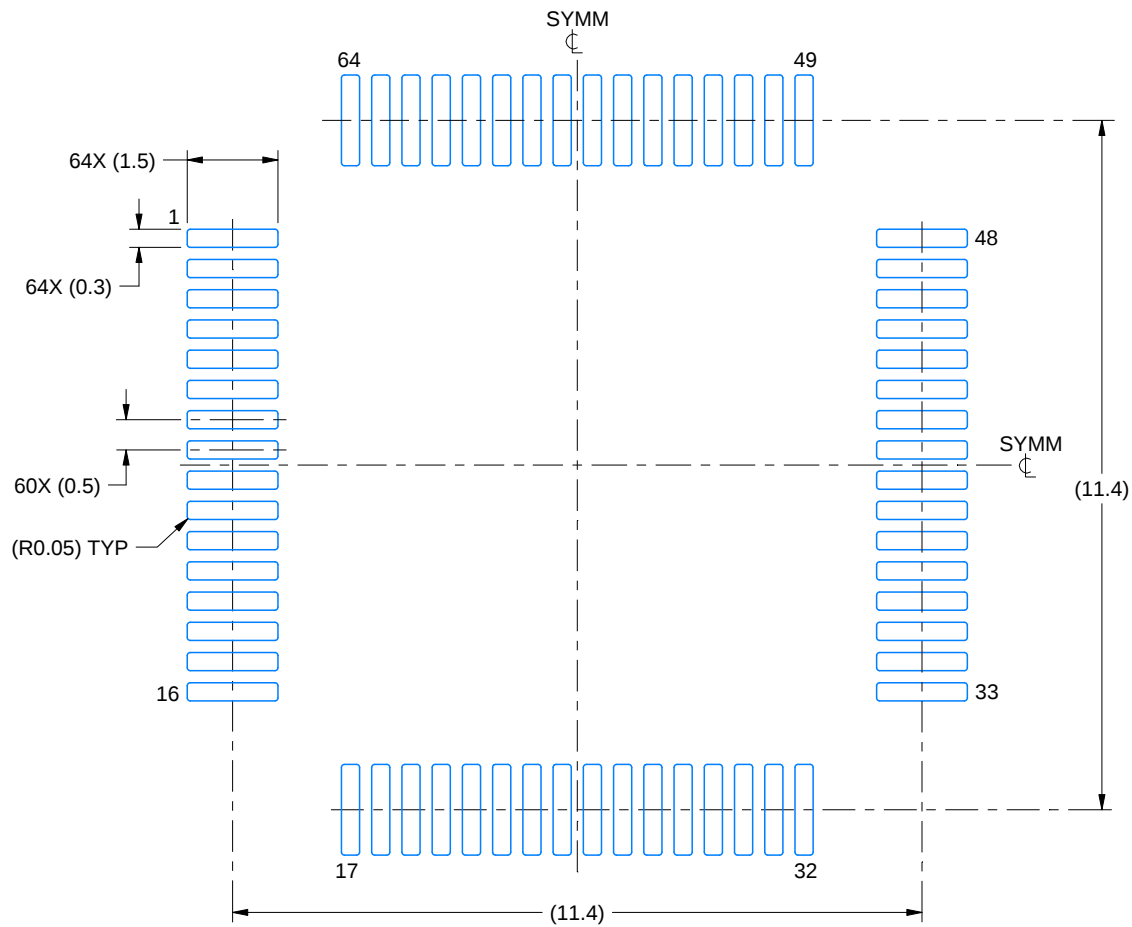


# EXAMPLE BOARD LAYOUT

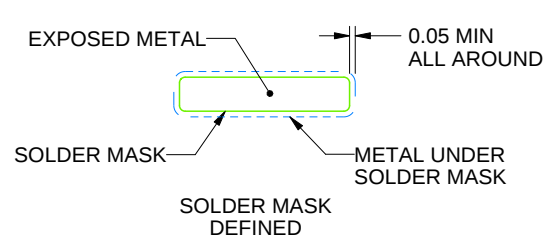
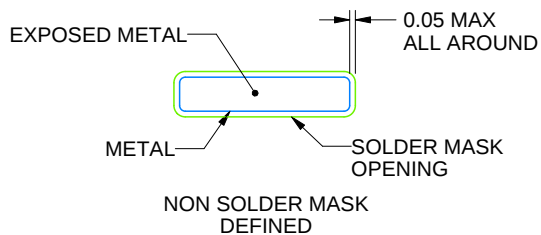
PM0064A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



SOLDER MASK DETAILS

4215162/A 03/2017

NOTES: (continued)

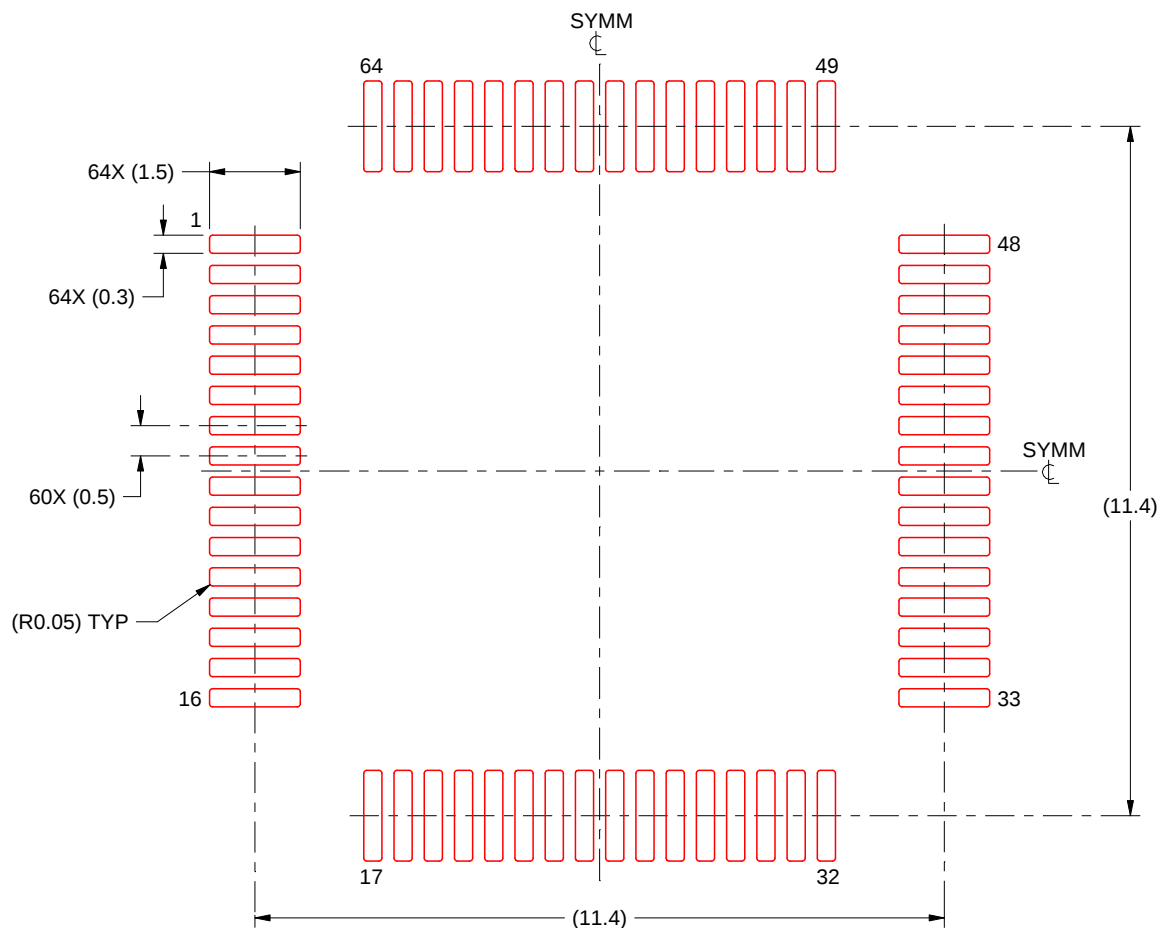
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
7. For more information, see Texas Instruments literature number SLMA004 ([www.ti.com/lit/slma004](http://www.ti.com/lit/slma004)).

# EXAMPLE STENCIL DESIGN

PM0064A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4215162/A 03/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## IMPORTANT NOTICE AND DISCLAIMER

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